

## RX140 Group Renesas MCUs

R01DS0379EJ0110  
Rev.1.10  
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48-MHz, 32-bit RX MCUs, on-chip FPU, 204 Coremark, up to 256-KB flash memory, up to 36 pins capacitive touch sensing unit, up to 9 comms channels, 12-bit A/D, D/A, RTC, IEC60730 compliance, 1.8-V to 5.5-V single supply, Encryption functions (optional)

## Features

### ■ 32-bit RXv2 CPU core

- Max. operating frequency: 48 MHz  
Capable of 204 Coremark in operation at 48 MHz
- Enhanced DSP instructions: 32-bit multiply-accumulate instructions, and 16-bit multiply-subtract instructions are supported.
- On-chip FPU: 32-bit single-precision floating point compliant with IEEE-754
- On-chip divider that operated at the fastest of two clock cycles
- Fast interrupt
- CISC Harvard architecture with 5-stage pipeline
- Variable-length instructions, ultra-compact code
- On-chip debugging circuit

### ■ Low power design and architecture

- Operation from a single 1.8-V to 5.5-V supply
- Four low power consumption modes
- Low power timer (LPT) that operates during the software standby state
- Supply current  
High-speed operating mode: 58  $\mu$ A/MHz  
Supply current in software standby mode: 0.25  $\mu$ A (typ.) ( $T_a = 25^\circ\text{C}$ )
- Recovery time from software standby mode: 6.2  $\mu$ s (typ.) (Clock Source: HOCO 32 MHz,  $T_a = 25^\circ\text{C}$ )

### ■ On-chip flash memory for code

- 64 K/128 K/256 Kbytes size capacities
- User code is programmable by on-board programming.
- Programmable at 1.8 V
- For instructions and operands

### ■ On-chip data flash memory

- 4K/8 Kbytes (1,000,000 program/erase cycles (typ.))
- BGO (Background Operation)

### ■ On-chip SRAM, no wait states

- 16 K/32 K/64 Kbytes size capacities

### ■ DTC

- Five transfer modes

### ■ ELC

- Module operation can be initiated by event signals without using interrupts.
- Linked operation between modules is possible while the CPU is sleeping.

### ■ Reset and supply management

- Seven types of reset, including the power-on reset (POR)
- Low voltage detection (LVD) with voltage settings

### ■ Clock functions

- External clock input frequency: Up to 20 MHz
- Main clock oscillator frequency: 1 to 20 MHz
- Sub clock oscillator frequency: 32.768 kHz
- PLL circuit input: 4 MHz to 12 MHz
- Low-speed on-chip oscillator: 4 MHz
- High-speed on-chip oscillator: 24/32/48 MHz  $\pm$  1%
- IWDT-dedicated on-chip oscillator: 15 kHz
- Generate a 32.768 kHz clock for the real-time clock
- On-chip clock frequency accuracy measurement circuit (CAC)

### ■ Realtime clock

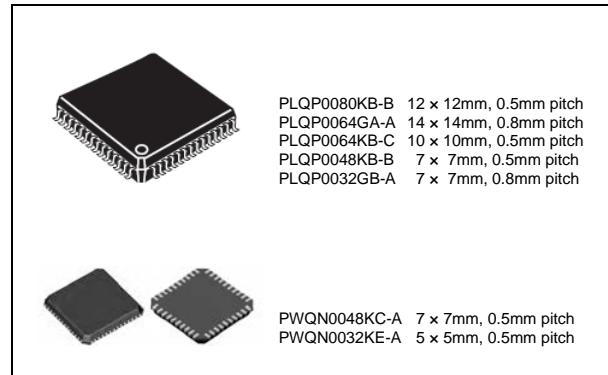
- Adjustment functions (30 seconds, leap year, and error)
- Calendar count mode or binary count mode selectable

### ■ Independent watchdog timer

- 15-kHz on-chip oscillator produces a dedicated clock signal to drive IWDT operation.

### ■ Useful functions for IEC60730 compliance

- Self-diagnostic and disconnection-detection assistance functions for the A/D converter, clock frequency accuracy measurement circuit, independent watchdog timer, RAM test assistance functions using the DOC, etc.



### ■ MPC

- Input/output functions selectable from multiple pins

### ■ Up to 9 communication functions

- One channel of CAN module compliant with ISO11898-1: Transfer at up to 1 Mbps
- SCI with many useful functions (up to 6 channels)  
Asynchronous mode (Fine adjustable baud rate: 0 to 255/255), clock synchronous mode, smart card interface mode
- I<sup>2</sup>C bus interface: Transfer at up to 400 kbps, capable of SMBus operation (one channel)
- RSPI (one channel): Transfer at up to 16 Mbps

### ■ Up to 12 extended-function timers

- 16-bit MTU: input capture, output compare, complementary PWM output, phase counting mode (six channels)
- 8-bit TMR (four channels)
- 16-bit compare-match timers (two channels)

### ■ 12-bit A/D converter

- Capable of conversion within 0.67  $\mu$ s
- 17 (external pin input) +1 (internal input) channels
- Sampling time can be set for each channel
- Conversion results compare features
- Self-diagnostic function and analog input disconnection detection assistance function
- Double trigger (data duplication) function for motor control

### ■ D/A converter

- Two channels

### ■ Capacitive touch sensing unit

- Self-capacitance method: A single pin configures a single key, supporting up to 36 keys
- Mutual capacitance method: Matrix configuration with 8 x 8, supporting up to 64 keys

### ■ Comparator B

- Two channels

### ■ General I/O ports

- 5-V tolerant, open drain, input pull-up

### ■ Encryption functions (optional)

- AES (key lengths: 128 and 256 bits)
- RNG (True random number generator)

### ■ Temperature sensor

#### ■ Unique ID

- 32-byte ID code for the MCU

### ■ Operating temperature range

- 40 to +85°C
- 40 to +105°C

### ■ Applications

- General industrial and consumer equipment

## 1. Overview

### 1.1 Outline of Specifications

Table 1.1 lists the specifications, and Table 1.2 gives a comparison of the functions of the products in different packages.

Table 1.1 is for products with the greatest number of functions, so the number of peripheral modules and channels will differ in accordance with the package type. For details, see Table 1.2, Comparison of Functions for Different Packages in the RX140 Group.

**Table 1.1 Outline of Specifications (1/4)**

| Classification     | Module/Function                                | Description  |
|--------------------|--|--|
| CPU                | CPU  | <ul style="list-style-type: none"> <li>• Maximum operating frequency: 48 MHz</li> <li>• 32-bit RX CPU (RX v2)</li> <li>• Minimum instruction execution time: One instruction per clock cycle</li> <li>• Address space: 4-Gbyte linear</li> <li>• Register set           <ul style="list-style-type: none"> <li>General purpose: Sixteen 32-bit registers</li> <li>Control: Ten 32-bit registers</li> <li>Accumulator: Two 72-bit registers</li> </ul> </li> <li>• Basic instructions: 75 (variable-length instruction format)</li> <li>• Floating point instructions: 11</li> <li>• DSP instructions: 23</li> <li>• Addressing modes: 11</li> <li>• Data arrangement           <ul style="list-style-type: none"> <li>Instructions: Little endian</li> <li>Data: Selectable as little endian or big endian</li> </ul> </li> <li>• On-chip 32-bit multiplier: 32-bit × 32-bit → 64-bit</li> <li>• On-chip divider: 32-bit ÷ 32-bit → 32 bits</li> <li>• Barrel shifter: 32 bits</li> </ul>  |
|                    | FPU  | <ul style="list-style-type: none"> <li>• Single precision (32-bit) floating point</li> <li>• Data types and exceptions in conformance with the IEEE754 standard</li> </ul>   |
| Memory             | ROM  | <ul style="list-style-type: none"> <li>• Capacity: 64 K/128 K/256 Kbytes</li> <li>• 32 MHz ≤: No-wait cycle access</li> <li>• 32 MHz to 48 MHz: One-wait cycle access</li> <li>• Programming/erasing method:           <ul style="list-style-type: none"> <li>Serial programming (asynchronous serial communication), self-programming</li> </ul> </li> </ul>  |
|                    | RAM  | <ul style="list-style-type: none"> <li>• Capacity: 16 K/32 K/64 Kbytes</li> <li>• No-wait memory access</li> </ul>   |
|                    | E2 DataFlash                                   | <ul style="list-style-type: none"> <li>• Capacity: 4 K/8 Kbytes</li> <li>• Number of erase/write cycles: 1,000,000 (typ.)</li> </ul>   |
| MCU operating mode |  | Single-chip mode   |
| Clock              | Clock generation circuit                       | <ul style="list-style-type: none"> <li>• Main clock oscillator, sub-clock oscillator, low-speed on-chip oscillator, high-speed on-chip oscillator, PLL frequency synthesizer, and IWDT-dedicated on-chip oscillator</li> <li>• Oscillation stop detection: Available</li> <li>• Clock frequency accuracy measurement circuit (CAC)</li> <li>• Independent settings for the system clock (ICLK), peripheral module clock (PCLK), and FlashIF clock (FCLK)           <ul style="list-style-type: none"> <li>The CPU and system sections such as other bus masters run in synchronization with the system clock (ICLK): 48 MHz (at max.)</li> <li>Peripheral modules run in synchronization with the PCLKB: 32 MHz (at max.)</li> <li>The flash peripheral circuit runs in synchronization with the FCLK: 48 MHz (at max.)</li> </ul> </li> <li>• ADCLK in the S12AD runs in synchronization with PCLKD: Up to 48 MHz</li> <li>• The ICLK frequency can only be set to FCLK, PCLKB, or PCLKD multiplied by n (n: 1, 2, 4, 8, 16, 32, 64)</li> </ul> |
| Resets             |  | RES# pin reset, power-on reset, voltage monitoring reset, independent watchdog timer reset, and software reset   |
| Voltage detection  | Voltage detection circuit (LVDA <sub>b</sub> ) | <ul style="list-style-type: none"> <li>• When the voltage on VCC falls below the voltage detection level, an internal reset or internal interrupt is generated.</li> <li>Voltage detection circuit 0 is capable of selecting the detection voltage from 4 levels</li> <li>Voltage detection circuit 1 is capable of selecting the detection voltage from 14 levels</li> <li>Voltage detection circuit 2 is capable of selecting the detection voltage from 4 levels</li> </ul>   |

**Table 1.1 Outline of Specifications (2/4)**

| Classification                      | Module/Function                                | Description  |
|-------------------------------------|--|--|
| Low power consumption               | Low power consumption functions                | <ul style="list-style-type: none"> <li>Module stop function</li> <li>Four low power consumption modes<br/>Sleep mode, deep sleep mode, software standby mode, and snooze mode</li> </ul>   |
|                                     | Function for lower operating power consumption | <ul style="list-style-type: none"> <li>Operating power control modes<br/>High-speed operating mode, middle-speed operating mode, middle-speed operating mode 2 and low-speed operating mode</li> </ul>   |
| Interrupt                           | Interrupt controller (ICUb)                    | <ul style="list-style-type: none"> <li>Interrupt vectors: 256</li> <li>External interrupts: 9 (NMI, IRQ0 to IRQ7 pins)</li> <li>Non-maskable interrupts: 5 (The NMI pin, oscillation stop detection interrupt, voltage monitoring 1 interrupt, voltage monitoring 2 interrupt, and IWDT interrupt)</li> <li>16 levels specifiable for the order of priority</li> </ul>   |
| DMA                                 | Data transfer controller (DTCb)                | <ul style="list-style-type: none"> <li>Transfer modes: Normal transfer, repeat transfer, and block transfer</li> <li>Activation sources: Interrupts</li> <li>Sequence transfer</li> </ul>  |
| I/O ports                           | General I/O ports                              | <ul style="list-style-type: none"> <li>80-pin/64-pin (ROM capacity: product with 128 Kbytes or more)/64-pins (ROM capacity: product with 64 Kbytes)/48-pin/32-pin</li> <li>I/O: 69/53/53/39/23</li> <li>Input: 3/3/1/1</li> <li>Pull-up resistors: 69/53/53/39/23</li> <li>Open-drain outputs: 47/35/35/27/20</li> <li>5-V tolerance: 4/2/2/2/2</li> </ul>   |
| Event link controller (ELC)         |  | <ul style="list-style-type: none"> <li>Event signals of 48 types can be directly connected to the module</li> <li>Operations of timer modules are selectable at event input</li> <li>Capable of event link operation for port B</li> </ul>   |
| Multi-function pin controller (MPC) |  | Capable of selecting the input/output function from multiple pins  |
| Timers                              | Multi-function timer pulse unit 2 (MTU2a)      | <ul style="list-style-type: none"> <li>(16 bits × 6 channels) × 1 unit</li> <li>Up to 16 pulse-input/output lines and three pulse-input lines are available based on the six 16-bit timer channels</li> <li>Select from among eight or seven counter-input clock signals for each channel (PCLK/1, PCLK/4, PCLK/16, PCLK/64, PCLK/256, PCLK/1024, MTCLKA, MTCLKB, MTCLKC, MTCLKD) other than channel 5, for which only four signals are available.</li> <li>Input capture function</li> <li>21 output compare/input capture registers</li> <li>Pulse output mode</li> <li>Complementary PWM output mode</li> <li>Reset synchronous PWM mode</li> <li>Phase-counting mode</li> <li>Capable of generating conversion start triggers for the A/D converter</li> </ul> |
|                                     | Port output enable 2 (POE2a)                   | Controls the high-impedance state of the MTU's waveform output pins  |
|                                     | Compare match timer (CMT)                      | <ul style="list-style-type: none"> <li>(16 bits × 2 channels) × 1 unit</li> <li>Select from among four clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)</li> </ul>  |
|                                     | Independent watchdog timer (IWDTa)             | <ul style="list-style-type: none"> <li>14 bits × 1 channel</li> <li>Count clock: Dedicated low-speed clock for the IWDT<br/>Frequency divided by 1, 16, 32, 64, 128, or 256</li> </ul>   |
|                                     | Realtime clock (RTCB)                          | <ul style="list-style-type: none"> <li>Clock source: Sub-clock</li> <li>Calendar count mode or binary count mode selectable</li> <li>Interrupts: Alarm interrupt, periodic interrupt, and carry interrupt</li> </ul>   |
|                                     | Low power timer (LPTa)                         | <ul style="list-style-type: none"> <li>16 bits × 1 channel</li> <li>Clock source: Sub-clock, LOCO clock divided by 4, or dedicated low-speed clock for the IWDT selectable</li> <li>Clock division ratio: Frequency divided by 1, 2, 4, 8, 16, or 32 selectable</li> <li>PWM output mode</li> </ul>  |
|                                     | 8-bit timer (TMRa)                             | <ul style="list-style-type: none"> <li>(8 bits × 2 channels) × 2 units</li> <li>Seven internal clocks (PCLK/1, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, and PCLK/8192) and an external clock can be selected</li> <li>Pulse output and PWM output with any duty cycle are available</li> <li>Two channels can be cascaded and used as a 16-bit timer</li> </ul>  |

**Table 1.1 Outline of Specifications (3/4)**

| Classification                | Module/Function                                     | Description  |
|-------------------------------|---|--|
| Communication functions       | Serial communications interfaces (SCIg, SCIf, SCIk) | <ul style="list-style-type: none"> <li>• 6 channels (channel 1, 5: SCIk, 6, 8, 9: SCIf, channel 12: SCIf)</li> <li>• SCIf</li> </ul> <p>Serial communications modes: Asynchronous, clock synchronous, and smart-card interface<br/>On-chip baud rate generator allows selection of the desired bit rate<br/>Choice of LSB-first or MSB-first transfer<br/>Average transfer rate clock can be input from TMR timers for SCI5, SCI6, and SCI12<br/>Start-bit detection: Level or edge detection is selectable.<br/>Simple I<sup>2</sup>C<br/>Simple SPI<br/>7, 8, or 9-bit transfer mode<br/>Bit rate modulation<br/>Event linking by the ELC (only on SCI5)</p> <ul style="list-style-type: none"> <li>• SCIk (the following functions are added) <ul style="list-style-type: none"> <li>Data matching detection</li> <li>Adjustment function of the asynchronous RXD sampling</li> </ul> </li> <li>• SCIf (the following functions are added to SCIf) <ul style="list-style-type: none"> <li>Supports the serial communications protocol, which contains the start frame and information frame</li> <li>Supports the LIN format</li> </ul> </li> </ul> |
|                               | I <sup>2</sup> C bus interface (RIICa)              | <ul style="list-style-type: none"> <li>• 1 channel</li> <li>• Communications formats: I<sup>2</sup>C bus format/SMBus format</li> <li>• Master mode or slave mode selectable</li> <li>• Supports fast mode</li> </ul>  |
| Communication functions       | Serial peripheral interface (RSPPIc)                | <ul style="list-style-type: none"> <li>• 1 channel</li> <li>• Transfer facility</li> </ul> <p>Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPPI clock) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines)</p> <ul style="list-style-type: none"> <li>• Capable of handling serial transfer as a master or slave</li> <li>• Data formats</li> <li>• Choice of LSB-first or MSB-first transfer</li> </ul> <p>The number of bits in each transfer can be changed to 8, 9, 10, 11, 12, 13, 14, 15, 16, 20, 24, or 32 bits.</p> <p>128-bit buffers for transmission and reception<br/>Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits)</p> <ul style="list-style-type: none"> <li>• Transit/receive data can be swapped in byte units</li> <li>• Double buffers for both transmission and reception</li> <li>• RSPCK can be stopped with the receive buffer full for master reception.</li> </ul>   |
|                               | CAN module (RSCAN)                                  | <ul style="list-style-type: none"> <li>• 1 channel</li> <li>• Compliance with the ISO11898-1 specification (standard frame and extended frame)</li> <li>• 16 mailboxes</li> </ul>  |
| 12-bit A/D converter (S12ADE) |   | <ul style="list-style-type: none"> <li>• 12 bits (18 channels × 1 unit*1)</li> <li>• 12-bit resolution</li> <li>• Minimum conversion time: 0.67 µs per channel when the ADCLK is operating at 48 MHz</li> <li>• Operating modes <ul style="list-style-type: none"> <li>Scan mode (single scan mode, continuous scan mode, and group scan mode)</li> <li>Group A priority control (only for group scan mode)</li> </ul> </li> <li>• Sampling variable <ul style="list-style-type: none"> <li>Sampling time can be set up for each channel.</li> </ul> </li> <li>• Self-diagnostic function</li> <li>• Double trigger mode (A/D conversion data duplicated)</li> <li>• Detection of analog input disconnection</li> <li>• Conversion results compare features</li> <li>• A/D conversion start conditions <ul style="list-style-type: none"> <li>A software trigger, a trigger from a timer (MTU), an external trigger signal, or ELC</li> </ul> </li> <li>• Event linking by the ELC</li> </ul>  |
| Temperature sensor (TEMPSA)   |   | <ul style="list-style-type: none"> <li>• 1 channel</li> <li>• The voltage output from the temperature sensor is converted into a digital value by the 12-bit A/D converter.</li> </ul>   |
| D/A converter (DA)            |   | <ul style="list-style-type: none"> <li>• 2 channels</li> <li>• 8-bit resolution</li> <li>• Output voltage: 0V to AVCC0</li> </ul>  |
| CRC calculator (CRC)          |   | <ul style="list-style-type: none"> <li>• CRC code generation for arbitrary amounts of data in 8-bit units</li> <li>• Select any of three generating polynomials:<br/><math>X^8 + X^2 + X + 1</math>, <math>X^{16} + X^{15} + X^2 + 1</math>, or <math>X^{16} + X^{12} + X^5 + 1</math></li> <li>• Generation of CRC codes for use with LSB-first or MSB-first communications is selectable.</li> </ul>   |
| Comparator B (CMPBa)          |   | <ul style="list-style-type: none"> <li>• 2 channels</li> <li>• Function to compare the reference voltage and the analog input voltage</li> <li>• Window comparator operation or standard comparator operation is selectable</li> </ul>   |

**Table 1.1 Outline of Specifications (4/4)**

| Classification                                     | Module/Function   | Description  |
|--|---|--|
| Capacitive touch sensing unit<br>(CTSU2SL, CTSU2L) |   | <ul style="list-style-type: none"> <li>• CTSU2L</li> <li>Self-capacitance method: A single pin configures a single key, supporting up to 36 keys</li> <li>Mutual capacitance method: Matrix configuration with 8 × 8, supporting up to 64 keys</li> <li>• CTSU2SL (The following functions are added to CTSU2L)</li> <li>Automatic correction</li> <li>Automatic judgment</li> </ul>       |
| Data operation circuit (DOC)                       |   | Comparison, addition, and subtraction of 16-bit data   |
| Unique ID  |   | 32-byte ID code for the MCU  |
| Encryption function                                | Advanced encryption standard hardware accelerator (AES-A) | <ul style="list-style-type: none"> <li>• Key lengths: 128 and 256 bits</li> <li>• Support for ECB, CBC, and CTR operating modes</li> <li>• Speed of calculations:<br/>128-bit key length in 176 cycles<br/>256-bit key length in 240 cycles</li> <li>• Compliant with FIPS PUB 197</li> </ul>  |
|  | True random number generator (RNGA)                       | <ul style="list-style-type: none"> <li>• Length of random numbers: 32 bits</li> <li>• Generation of random-number-generated interrupts after a number is generated</li> </ul>  |
| Power supply voltages/Operating frequencies        |   | VCC = 1.8 to 5.5 V; 48 MHz   |
| Operating temperature range                        |   | D version: -40 to +85°C, G version: -40 to +105°C  |
| Packages   |   | 80-pin LFQFP (PLQP0080KB-B) 12 × 12 mm, 0.5 mm pitch<br>64-pin LFQFP (PLQP0064KB-C) 10 × 10 mm, 0.5 mm pitch<br>64-pin LQFP (PLQP0064GA-A) 14 × 14 mm, 0.8 mm pitch<br>48-pin LFQFP (PLQP0048KB-B) 7 × 7 mm, 0.5 mm pitch<br>48-pin HWQFN (PWQN0048KC-A) 7 × 7 mm, 0.5 mm pitch<br>32-pin LQFP (PLQP0032GB-A) 7 × 7 mm, 0.8 mm pitch<br>32-pin HWQFN (PWQN0032KE-A) 5 × 5 mm, 0.5 mm pitch |
| Debugging interfaces                               |   | FINE interface   |

Note 1. The 12-bit A/D converter has 17 external input channels and a single internal input channel. For details, refer to section 35, 12-Bit A/D Converter (S12ADE) in the User's Manual: Hardware.

**Table 1.2 Comparison of Functions for Different Packages in the RX140 Group**

| Module/Functions        |  | Products with 128-Kbyte or larger ROM |   |  | Products with 64-Kbyte ROM                    |  |   |  |  |
|-------------------------|--|---------------------------------------|---|--|---|--|---|--|--|
|                         |  | 80 Pins                               | 64 Pins                                       | 48 Pins  | 64 Pins                                       | 48 Pins  | 32 Pins                                       |  |  |
| Interrupts              | External interrupts                                      | NMI,<br>IRQ0 to IRQ7                  | NMI,<br>IRQ0 to IRQ2,<br>IRQ4 to IRQ7         | NMI,<br>IRQ0 to IRQ2,<br>IRQ4 to IRQ7          | NMI,<br>IRQ0 to IRQ2,<br>IRQ4 to IRQ7         | NMI,<br>IRQ0 to IRQ2,<br>IRQ4 to IRQ7          | NMI,<br>IRQ0 to IRQ2,<br>IRQ5 to IRQ7         |  |  |
| DTC                     | Data transfer controller                                 | Available                             |   |  | Available                                     |  |   |  |  |
| Timers                  | Multi-function timer pulse unit 2                        | 6 channels                            |   |  | 6 channels                                    |  |   |  |  |
|                         | Port output enable 2                                     | POE0# to POE3#, POE8#                 |   |  | POE0# to POE3#, POE8#                         |  | POE0#,<br>POE8#                               |  |  |
|                         | 8-bit timer  | 2 channels × 2 units                  |   |  | 2 channels × 2 units                          |  |   |  |  |
|                         | Compare match timer                                      | 2 channels × 1 unit                   |   |  | 2 channels × 1 unit                           |  |   |  |  |
|                         | Low power timer  | 1 channel                             |   |  | 1 channel                                     |  |   |  |  |
|                         | Realtime clock   | Available                             |   | Not supported                                  | Available                                     | Not supported                                  |   |  |  |
| Communication functions | Independent watchdog timer                               | Available                             |   |  | Available                                     |  |   |  |  |
|                         | Serial communications interfaces (SCIk)                  | 2 channels (SCI1, 5)                  |   |  | 2 channels (SCI1, 5)                          |  |   |  |  |
|                         | Serial communications interfaces (SCIg)                  | 3 channels (SCI6, 8, 9)               |   | 2 channels (SCI6, 8)                           | Not supported                                 |  |   |  |  |
| Communication functions | Serial communications interfaces (SCIh)                  | 1 channel (SCI12)                     |   |  | 1 channel (SCI12)                             |  |   |  |  |
|                         | I <sup>2</sup> C bus interface                           | 1 channel                             |   |  | 1 channel                                     |  |   |  |  |
|                         | Serial peripheral interface                              | 1 channel                             |   |  | 1 channel                                     |  |   |  |  |
|                         | CAN module   | 1 channel                             |   |  | Not supported                                 |  |   |  |  |
|                         | Capacitive touch sensing unit (CTSU2SL)                  | 36 channels                           | 32 channels                                   | 24 channels                                    | Not supported                                 |  |   |  |  |
|                         | Capacitive touch sensing unit (CTSU2L)                   | Not supported                         |   |  | 12 channels                                   | 12 channels                                    | 12 channels                                   |  |  |
| 12-bit A/D converter    |  | 18 channels *1                        | 15 channels *1                                | 11 channels *1                                 | 15 channels *1                                | 11 channels *1                                 | 8 channels *1                                 |  |  |
| Temperature sensor      |  | Available                             |   |  | Available                                     |  |   |  |  |
| D/A converter           |  | 2 channels                            |   | Not supported                                  | 2 channels                                    | Not supported                                  |   |  |  |
| CRC calculator          |  | Available                             |   |  | Available                                     |  |   |  |  |
| Event link controller   |  | Available                             |   |  | Available                                     |  |   |  |  |
| Comparator B            |  | 2 channels                            |   |  | 2 channels                                    |  |   |  |  |
| Encryption function     | Advanced encryption standard hardware accelerator (AES)A | Available/Not supported               |   |  | Not supported                                 |  |   |  |  |
|                         | True random number generator (RNG)A                      | Available/Not supported               |   |  | Not supported                                 |  |   |  |  |
| Packages                |  | 80-pin LFQFP (0.5 mm)                 | 64-pin LQFP (0.8 mm)<br>64-pin LFQFP (0.5 mm) | 48-pin LFQFP (0.5 mm)<br>48-pin HWQFN (0.5 mm) | 64-pin LQFP (0.8 mm)<br>64-pin LFQFP (0.5 mm) | 48-pin LFQFP (0.5 mm)<br>48-pin HWQFN (0.5 mm) | 32-pin LQFP (0.8 mm)<br>32-pin HWQFN (0.5 mm) |  |  |

Note 1. This number includes a single internal input channel. For details, refer to section 35, 12-Bit A/D Converter (S12ADE) in the User's Manual: Hardware.

## 1.2 List of Products

Table 1.3 is a lists of products, and Figure 1.1 shows how to read the product part no., memory capacity, and package type.

**Table 1.3 List of Products (1/2)**

| Group        | Part No.        | Part No. (for Orders) | Package      | ROM Capacity | RAM Capacity | E2 DataFlash | Operating Frequency (Max.) | Encryption Module | Operating Temperature |
|--------------|-----------------|-----------------------|--------------|--------------|--------------|--------------|----------------------------|-------------------|-----------------------|
| RX140        | R5F51406ADFN    | R5F51406ADFN#30       | PLQP0080KB-B | 256 Kbytes   | 64 Kbytes    | 8 Kbytes     | 48 MHz                     | Not supported     | −40 to +85°C          |
|              | R5F51406ADFM    | R5F51406ADFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|              | R5F51406ADFK    | R5F51406ADFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|              | R5F51406ADFL    | R5F51406ADFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|              | R5F51406ADNE    | R5F51406ADNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
|              | R5F51406AGFN    | R5F51406AGFN#30       | PLQP0080KB-B |              |              |              |                            |                   |                       |
|              | R5F51406AGFM    | R5F51406AGFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|              | R5F51406AGFK    | R5F51406AGFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|              | R5F51406AGFL    | R5F51406AGFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|              | R5F51406AGNE    | R5F51406AGNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
| R5F51405     | R5F51405ADFN    | R5F51405ADFN#30       | PLQP0080KB-B | 128 Kbytes   | 32 Kbytes    | 8 Kbytes     | 48 MHz                     | Not supported     | −40 to +85°C          |
|              | R5F51405ADFM    | R5F51405ADFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|              | R5F51405ADFK    | R5F51405ADFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|              | R5F51405ADFL    | R5F51405ADFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|              | R5F51405ADNE    | R5F51405ADNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
|              | R5F51405AGFN    | R5F51405AGFN#30       | PLQP0080KB-B |              |              |              |                            |                   |                       |
|              | R5F51405AGFM    | R5F51405AGFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|              | R5F51405AGFK    | R5F51405AGFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|              | R5F51405AGFL    | R5F51405AGFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|              | R5F51405AGNE    | R5F51405AGNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
| R5F51403     | R5F51403ADFM    | R5F51403ADFM#30       | PLQP0064KB-C | 64 Kbytes    | 16 Kbytes    | 4 Kbytes     | 48 MHz                     | Not supported     | −40 to +85°C          |
|              | R5F51403ADFK    | R5F51403ADFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|              | R5F51403ADFL    | R5F51403ADFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|              | R5F51403ADNE    | R5F51403ADNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
|              | R5F51403ADFJ    | R5F51403ADFJ#30       | PLQP0032GB-A |              |              |              |                            |                   |                       |
|              | R5F51403ADNH    | R5F51403ADNH#30       | PWQN0032KE-A |              |              |              |                            |                   |                       |
|              | R5F51403AGFM    | R5F51403AGFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|              | R5F51403AGFK    | R5F51403AGFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|              | R5F51403AGFL    | R5F51403AGFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|              | R5F51403AGNE    | R5F51403AGNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
| R5F51403AGFJ | R5F51403AGFJ#30 | PLQP0032GB-A          |              |              |              |              |                            |                   |                       |
|              | R5F51403AGNH    | R5F51403AGNH#30       | PWQN0032KE-A |              |              |              |                            |                   |                       |

**Table 1.3 List of Products (2/2)**

| Group | Part No.     | Part No. (for Orders) | Package      | ROM Capacity | RAM Capacity | E2 DataFlash | Operating Frequency (Max.) | Encryption Module | Operating Temperature |
|-------|--------------|-----------------------|--------------|--------------|--------------|--------------|----------------------------|-------------------|-----------------------|
| RX140 | R5F51406BDFN | R5F51406BDFN#30       | PLQP0080KB-B | 256 Kbytes   | 64 Kbytes    | Available    | 48 MHz                     |                   | –40 to +85°C          |
|       | R5F51406BDFM | R5F51406BDFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|       | R5F51406BDFK | R5F51406BDFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|       | R5F51406BDFL | R5F51406BDFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|       | R5F51406BDNE | R5F51406BDNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
|       | R5F51406BGFN | R5F51406BGFN#30       | PLQP0080KB-B |              |              |              |                            |                   |                       |
|       | R5F51406BGFM | R5F51406BGFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|       | R5F51406BGFK | R5F51406BGFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|       | R5F51406BGFL | R5F51406BGFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|       | R5F51406BGNE | R5F51406BGNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
| RX140 | R5F51405BDFN | R5F51405BDFN#30       | PLQP0080KB-B | 128 Kbytes   | 32 Kbytes    | Available    | 48 MHz                     |                   | –40 to +85°C          |
|       | R5F51405BDFM | R5F51405BDFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|       | R5F51405BDFK | R5F51405BDFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|       | R5F51405BDFL | R5F51405BDFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|       | R5F51405BDNE | R5F51405BDNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |
|       | R5F51405BGFN | R5F51405BGFN#30       | PLQP0080KB-B |              |              |              |                            |                   |                       |
|       | R5F51405BGFM | R5F51405BGFM#30       | PLQP0064KB-C |              |              |              |                            |                   |                       |
|       | R5F51405BGFK | R5F51405BGFK#30       | PLQP0064GA-A |              |              |              |                            |                   |                       |
|       | R5F51405BGFL | R5F51405BGFL#30       | PLQP0048KB-B |              |              |              |                            |                   |                       |
|       | R5F51405BGNE | R5F51405BGNE#30       | PWQN0048KC-A |              |              |              |                            |                   |                       |

Note: The part numbers for orders above are used for products in mass production or under development when this manual is issued. Refer to the Renesas Electronics Corporation website for the latest part numbers.

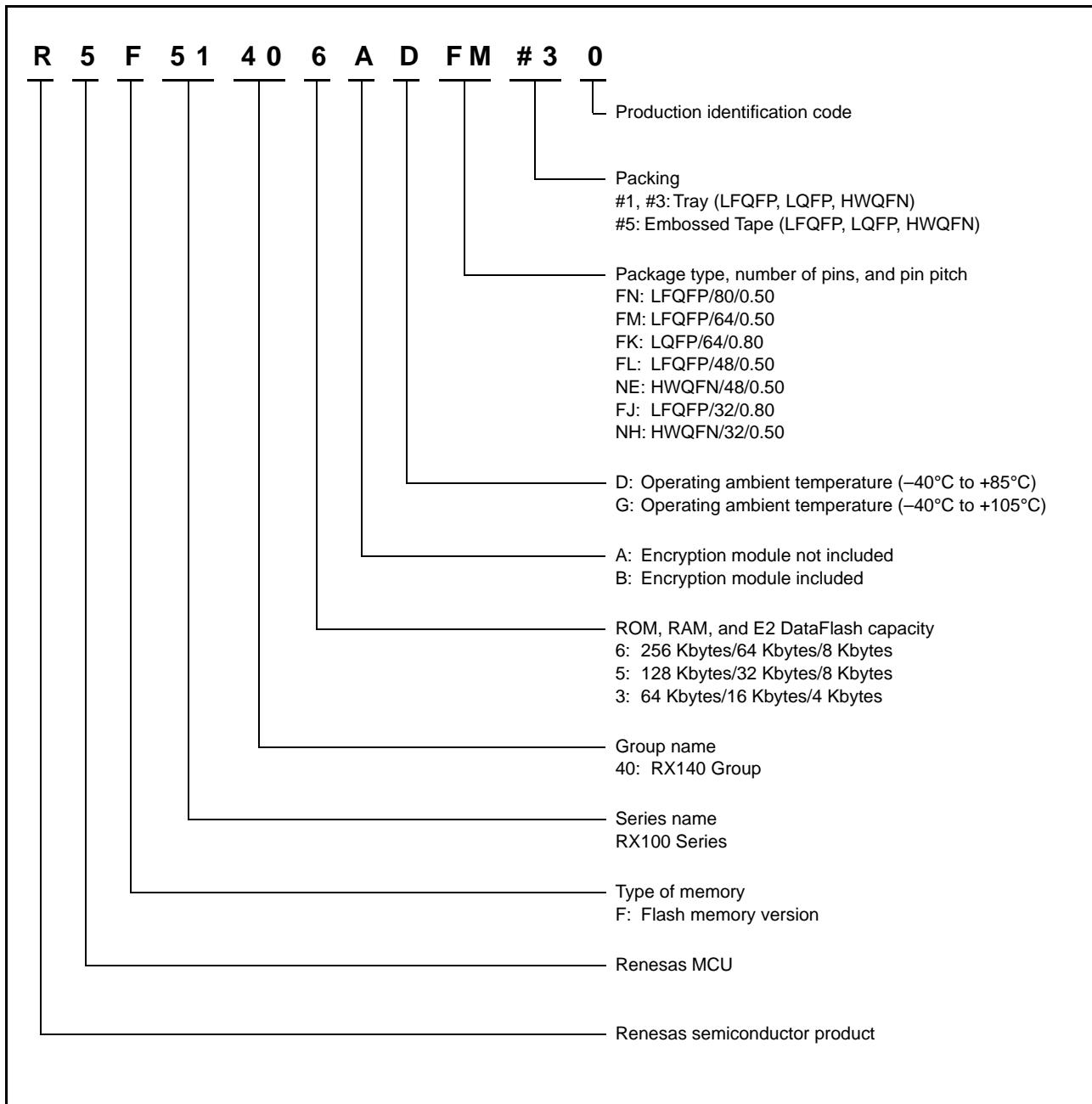


Figure 1.1 How to Read the Product Part Number

### 1.3 Block Diagram

Figure 1.2 shows a block diagram.

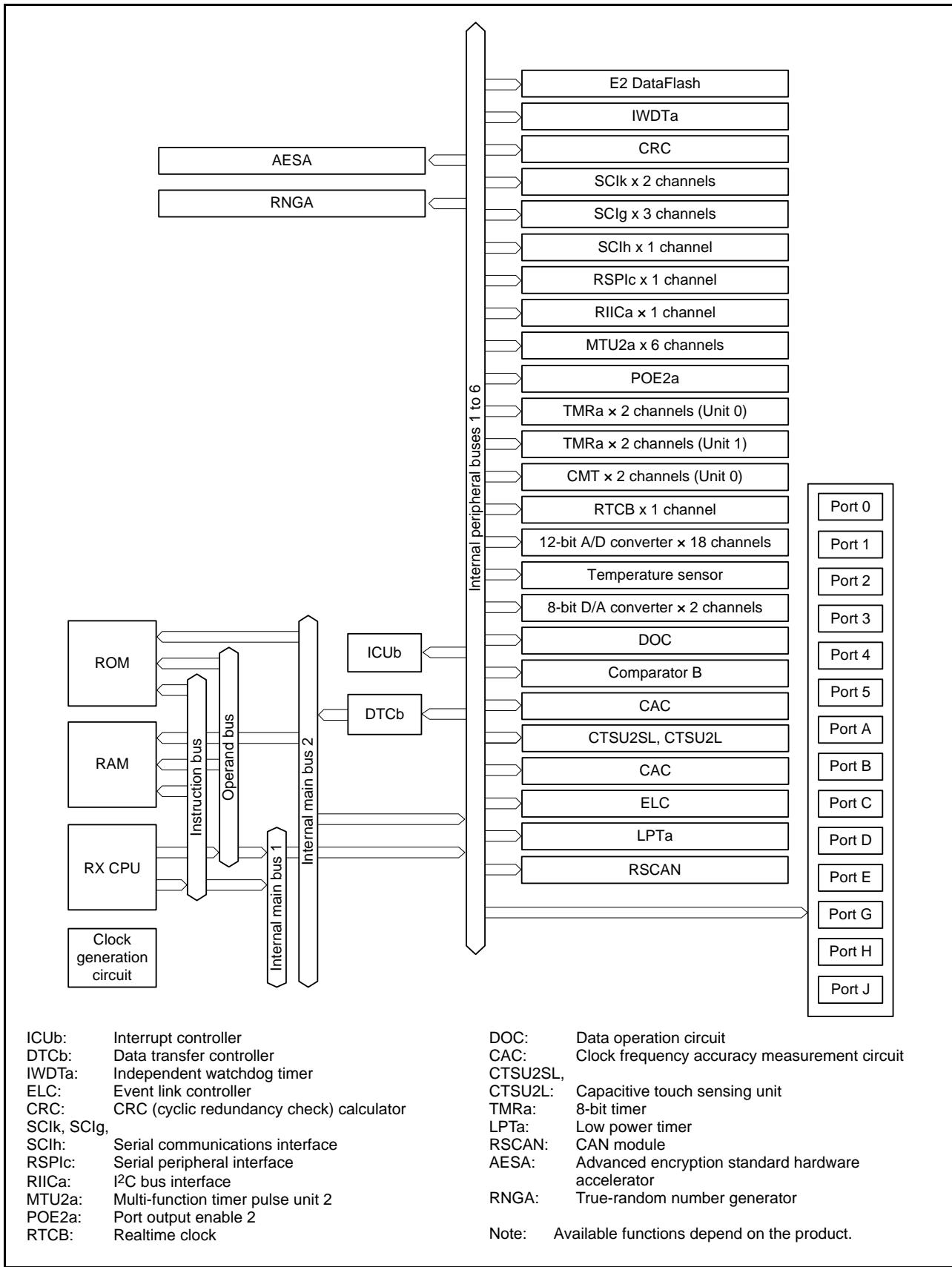


Figure 1.2 Block Diagram

## 1.4 Pin Functions

Table 1.4 lists the pin functions.

**Table 1.4 Pin Functions (1/3)**

| Classifications                              | Pin Name                           | I/O    | Description  |
|--|------------------------------------|--------|--|
| Power supply                                 | VCC                                | Input  | Power supply pin. Connect it to the system power supply.   |
|  | VCL                                | —      | Connect this pin to the VSS pin via the 4.7 $\mu$ F smoothing capacitor used to stabilize the internal power supply. Place the capacitor close to the pin. |
|  | VSS                                | Input  | Ground pin. Connect it to the system power supply (0 V).   |
| Clock  | XTAL                               | Output | Pins for connecting a crystal. An external clock can be input through the EXTAL pin.   |
|  | EXTAL                              | Input  |  |
|  | XCIN                               | Input  | Input/output pins for the sub-clock oscillator. Connect a crystal between XCIN and XCOUT.  |
|  | XCOUT                              | Output |  |
|  | CLKOUT                             | Output | Clock output pin.  |
| Operating mode control                       | MD                                 | Input  | Pin for setting the operating mode. For usage, refer to section 3.1, Operating Mode Types and Selection in the User's Manual: Hardware.                    |
| System control                               | RES#                               | Input  | Reset pin. This MCU enters the reset state when this signal goes low.  |
| Voltage detection circuit                    | CMPA2                              | Input  | Detection target voltage pin for voltage detection 2.  |
| Clock frequency accuracy measurement circuit | CACREF                             | Input  | Input pin for the clock frequency accuracy measurement circuit.  |
| On-chip emulator                             | FINED                              | I/O    | FINE interface pin.  |
| Interrupts                                   | NMI                                | Input  | Non-maskable interrupt request pin.  |
|  | IRQ0 to IRQ7                       | Input  | Interrupt request pins.  |
| Multi-function timer pulse unit 2            | MTIOC0A, MTIOC0B, MTIOC0C, MTIOC0D | I/O    | The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins.  |
|  | MTIOC1A, MTIOC1B                   | I/O    | The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins.   |
|  | MTIOC2A, MTIOC2B                   | I/O    | The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins.   |
|  | MTIOC3A, MTIOC3B, MTIOC3C, MTIOC3D | I/O    | The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins.  |
|  | MTIOC4A, MTIOC4B, MTIOC4C, MTIOC4D | I/O    | The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins.  |
|  | MTIC5U, MTIC5V, MTIC5W             | Input  | The TGRU5, TGRV5, and TGRW5 input capture input/external pulse input pins.   |
|  | MTCLKA, MTCLKB, MTCLKC, MTCLKD     | Input  | Input pins for the external clock.   |
| Port output enable 2                         | POE0# to POE3#, POE8#              | Input  | Input pins for request signals to place the MTU pins in the high impedance state.  |
| Realtime clock                               | RTCOUT                             | Output | Output pin for the 1-Hz/64-Hz clock.   |
| 8-bit timer                                  | TMO0 to TMO3                       | Output | Compare match output pins.   |
|  | TMCI0 to TMCI3                     | Input  | Input pins for the external clock to be input to the counter.  |
|  | TMRI0 to TMRI3                     | Input  | Counter reset input pins.  |
| Low power timer                              | LPTO                               | Output | PWM output pin   |

**Table 1.4 Pin Functions (2/3)**

| Classifications                              | Pin Name                                   | I/O    | Description  |
|--|--|--------|--|
| Serial communications interface (SCIg, SCIk) | • Asynchronous mode/clock synchronous mode |        |  |
|  | SCK1, SCK5, SCK6, SCK8, SCK9               | I/O    | Input/output pins for the clock.   |
|  | RXD1, RXD5, RXD6, RXD8, RXD9               | Input  | Input pins for received data.  |
|  | TXD1, TXD5, TXD6, TXD8, TXD9               | Output | Output pins for transmitted data.  |
|  | CTS1#, CTS5#, CTS6#, CTS8#, CTS9#          | Input  | Input pins for controlling the start of transmission and reception.  |
|  | RTS1#, RTS5#, RTS6#, RTS8#, RTS9#          | Output | Output pins for controlling the start of transmission and reception.   |
|  | • Simple I <sup>2</sup> C mode             |        |  |
|  | SSCL1, SSCL5, SSCL6, SSCL8, SSCL9          | I/O    | Input/output pins for the I <sup>2</sup> C clock.  |
|  | SSDA1, SSDA5, SSDA6, SSDA8, SSDA9          | I/O    | Input/output pins for the I <sup>2</sup> C data.   |
|  | • Simple SPI mode                          |        |  |
|  | SCK1, SCK5, SCK6, SCK8, SCK9               | I/O    | Input/output pins for the clock.   |
|  | SMISO1, SMISO5, SMISO6, SMISO8, SMISO9     | I/O    | Input/output pins for slave transmit data.   |
|  | SMOSI1, SMOSI5, SMOSI6, SMOSI8, SMOSI9     | I/O    | Input/output pins for master transmit data.  |
|  | SS1#, SS5#, SS6#, SS8#, SS9#               | Input  | Slave-select input pins.   |
| Serial communications interface (SCIh)       | • Asynchronous mode/clock synchronous mode |        |  |
|  | SCK12                                      | I/O    | Input/output pin for the clock.  |
|  | RXD12                                      | Input  | Input pin for receiving data.  |
|  | TXD12                                      | Output | Output pin for transmitting data.  |
|  | CTS12#                                     | Input  | Input pin for controlling the start of transmission and reception.   |
|  | RTS12#                                     | Output | Output pin for controlling the start of transmission and reception.  |
|  | • Simple I <sup>2</sup> C mode             |        |  |
|  | SSCL12                                     | I/O    | Input/output pin for the I <sup>2</sup> C clock.   |
|  | SSDA12                                     | I/O    | Input/output pin for the I <sup>2</sup> C data.  |
|  | • Simple SPI mode                          |        |  |
|  | SCK12                                      | I/O    | Input/output pin for the clock.  |
|  | SMISO12                                    | I/O    | Input/output pin for slave transmit data.  |
|  | SMOSI12                                    | I/O    | Input/output pin for master transmit data.   |
|  | SS12#                                      | Input  | Slave-select input pin.  |
|  | • Extended serial mode                     |        |  |
|  | RDXD12                                     | Input  | Input pin for data reception by SCIg.  |
|  | TXDX12                                     | Output | Output pin for data transmission by SCIg.  |
|  | SIOX12                                     | I/O    | Input/output pin for data reception or transmission by SCIg.   |
| I <sup>2</sup> C bus interface               | SCL0                                       | I/O    | Input/output pin for I <sup>2</sup> C bus interface clocks. Bus can be directly driven by the N-channel open drain output. |
|  | SDA0                                       | I/O    | Input/output pin for I <sup>2</sup> C bus interface data. Bus can be directly driven by the N-channel open drain output.   |

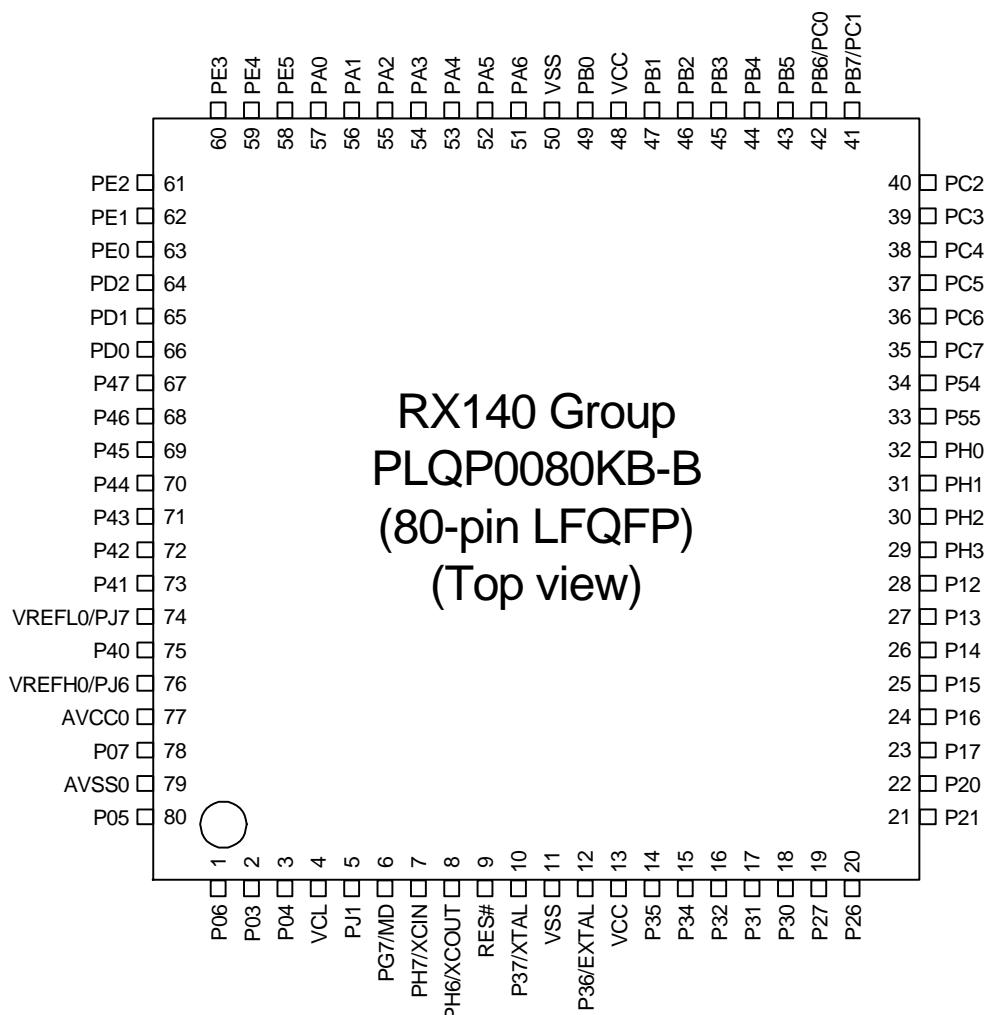
**Table 1.4 Pin Functions (3/3)**

| <b>Classifications</b>        | <b>Pin Name</b>                                      | <b>I/O</b> | <b>Description</b>   |
|-------------------------------|--|------------|--|
| Serial peripheral interface   | RSPCKA   | I/O        | Input/output pin for the RSPI clock.   |
|                               | MOSIA  | I/O        | Input/output pin for transmitting data from the RSPI master.   |
|                               | MISOA  | I/O        | Input/output pin for transmitting data from the RSPI slave.  |
|                               | SSLA0  | I/O        | Input/output pin to select the slave for the RSPI.   |
|                               | SSLA1 to SSA3  | Output     | Output pins to select the slave for the RSPI.  |
| CAN module                    | CRXD0  | Input      | Input pin  |
|                               | CTXD0  | Output     | Output pin   |
| 12-bit A/D converter          | AN000 to AN007,<br>AN016 to AN021, AN024 to<br>AN026 | Input      | Input pins for the analog signals to be processed by the A/D converter.  |
|                               | ADTRG0#  | Input      | Input pin for the external trigger signal that start the A/D conversion.   |
| D/A converter                 | DA0, DA1   | Output     | Analog output pins of the D/A converter.   |
| Comparator B                  | CMPB0, CMPB1   | Input      | Input pin for the analog signal to be processed by comparator B.   |
|                               | CVREFB0, CVREFB1                                     | Input      | Analog reference voltage supply pin for comparator B.  |
|                               | CMPOB0, CMPOB1                                       | Output     | Output pin for comparator B.   |
| Capacitive touch sensing unit | TS0 to TS35  | I/O        | Electrostatic capacitance measurement pins (touch pins).   |
|                               | TSCAP  | —          | Connect to the VSS via a decoupling capacitor (10 nF) for stabilizing the internal voltage   |
| Analog power supply           | AVCC0  | Input      | Analog voltage supply pin for the 12-bit A/D converter and D/A converter. Connect this pin to VCC when not using the 12-bit A/D converter and D/A converter. |
|                               | AVSS0  | Input      | Analog ground pin for the 12-bit A/D converter and D/A converter. Connect this pin to VSS when not using the 12-bit A/D converter and D/A converter.         |
|                               | VREFH0   | Input      | Analog reference voltage supply pin for the 12-bit A/D converter.  |
|                               | VREFL0   | Input      | Analog reference ground pin for the 12-bit A/D converter.  |
| I/O ports                     | P03 to P07   | I/O        | 5-bit input/output pins.   |
|                               | P12 to P17   | I/O        | 6-bit input/output pins.   |
|                               | P20, P21, P26, P27                                   | I/O        | 4-bit input/output pins.   |
|                               | P30 to P32, P34 to P37                               | I/O        | 7-bit input/output pins (P35 input pin).   |
|                               | P40 to P47   | I/O        | 8-bit input/output pins.   |
|                               | P54, P55   | I/O        | 2-bit input/output pins.   |
|                               | PA0 to PA6   | I/O        | 7-bit input/output pins.   |
|                               | PB0 to PB7   | I/O        | 8-bit input/output pins.   |
|                               | PC2 to PC7   | I/O        | 6-bit input/output pins.   |
|                               | PD0 to PD2   | I/O        | 3-bit input/output pins.   |
|                               | PE0 to PE5   | I/O        | 6-bit input/output pins.   |
|                               | PG7  | I/O        | 1-bit input/output pin.  |
|                               | PH0 to PH3, PH6*1, PH7*1                             | I/O        | 6-bit input/output pins (PH6, PH7: input pins).  |
|                               | PJ1, PJ6, PJ7  | I/O        | 3-bit input/output pins.   |

Note 1. This is not supported by products with 64 Kbytes of ROM.

## 1.5 Pin Assignments

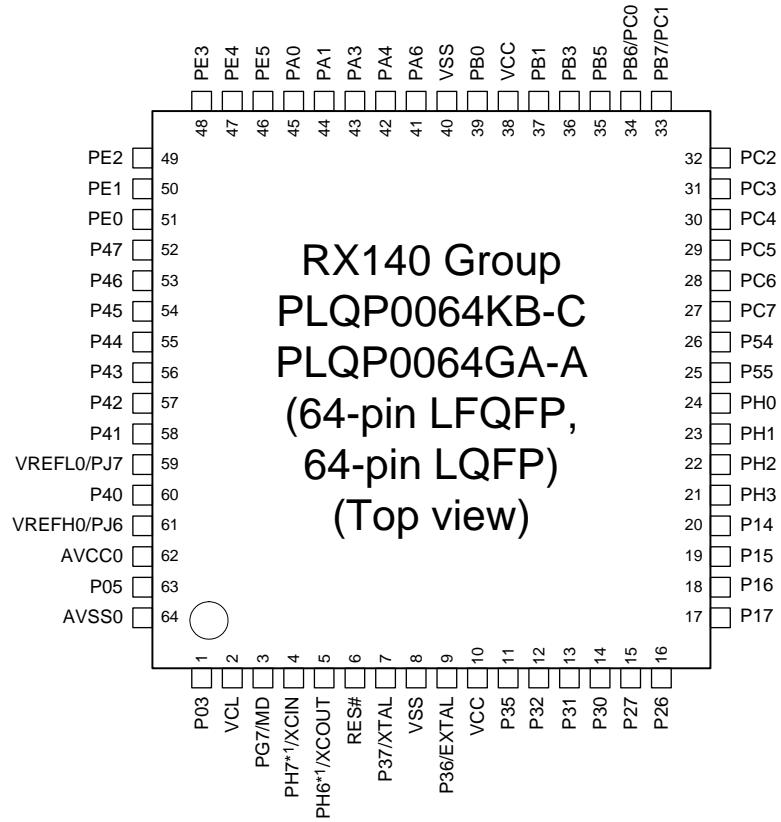
### 1.5.1 80-pin LFQFP



Note: This figure indicates the power supply pins and I/O ports.  
For the pin configuration, see the table "List of Pins and Pin Functions (80-Pin LFQFP)".

**Figure 1.3 Pin Assignments of the 80-Pin LFQFP**

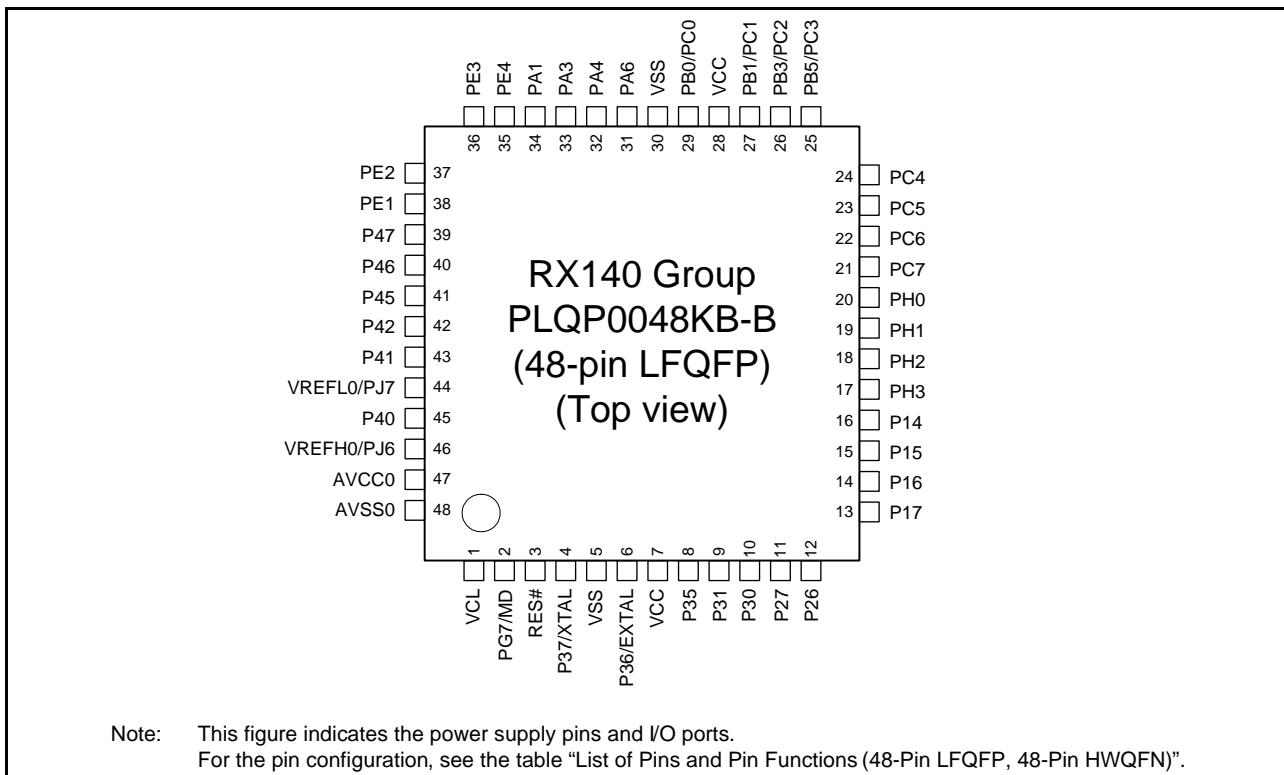
## 1.5.2 64-pin LFQFP, 64-pin LQFP



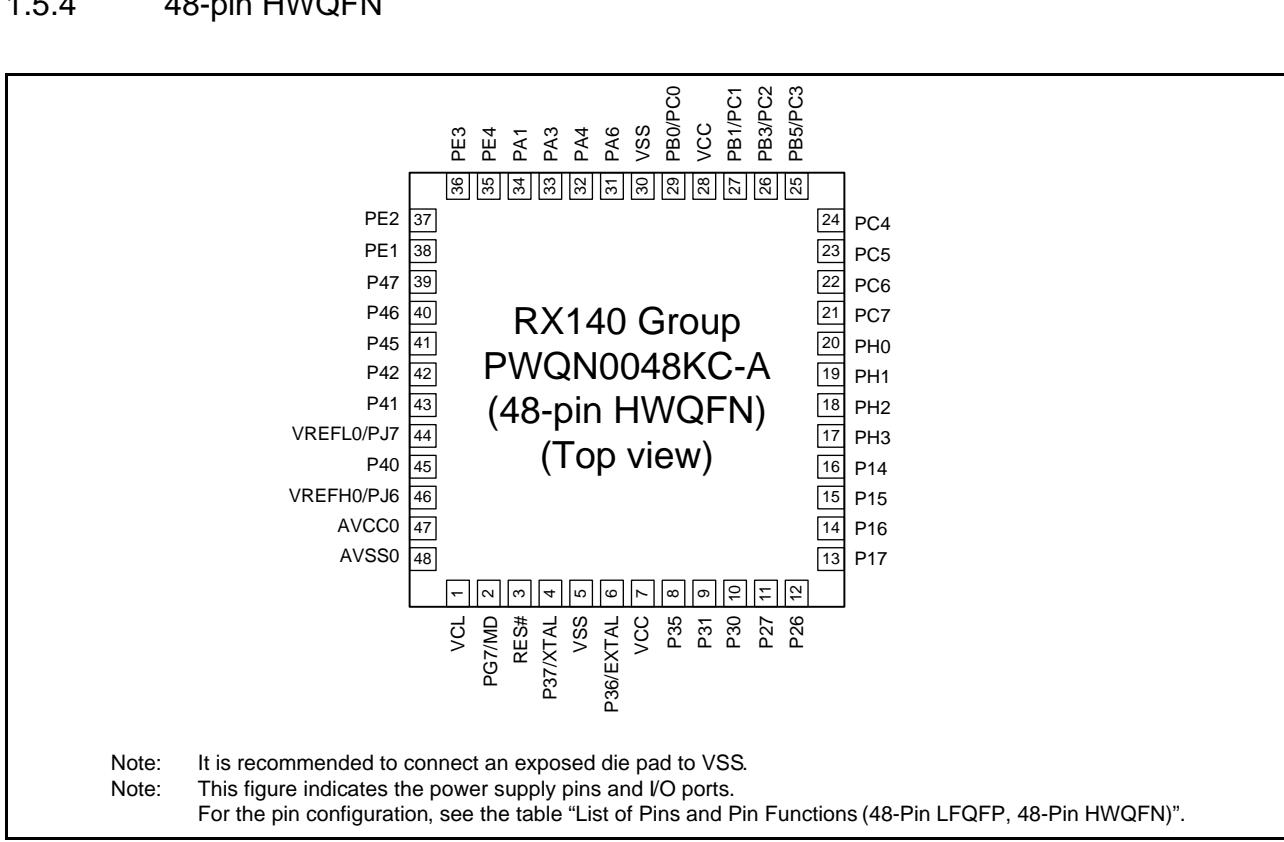
Note: This figure indicates the power supply pins and I/O ports.  
 For the pin configuration, see the table "List of Pins and Pin Functions (64-Pin LFQFP, 64-Pin LQFP)".  
 Note 1. This is not supported by products with 64 Kbytes of ROM.

**Figure 1.4 Pin Assignments of the 64-Pin LFQFP, 64-Pin LQFP**

### 1.5.3 48-pin LFQFP

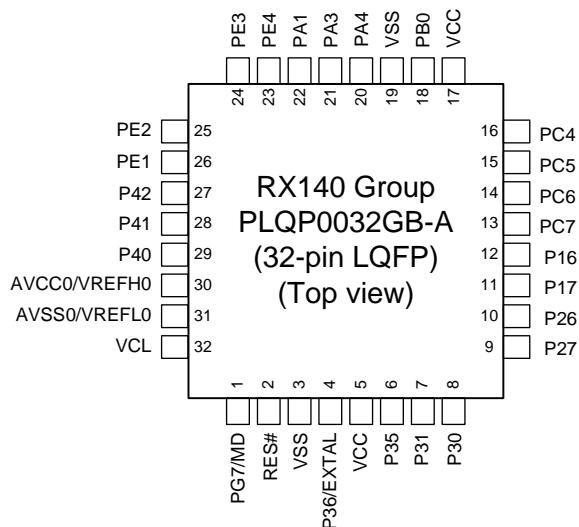


**Figure 1.5** Pin Assignments of the 48-Pin LQFP



**Figure 1.6** Pin Assignments of the 48-Pin HWQFN

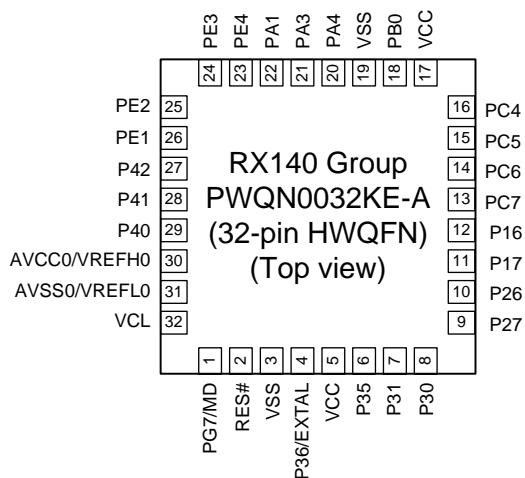
### 1.5.5 32-pin LQFP



Note: This figure indicates the power supply pins and I/O ports.  
For the pin configuration, see the table "List of Pins and Pin Functions (32-Pin LQFP, 32-Pin HWQFN)".

**Figure 1.7 Pin Assignments of the 32-Pin LQFP**

### 1.5.6 32-pin HWQFN



Note: It is recommended to connect an exposed die pad to VSS.  
Note: This figure indicates the power supply pins and I/O ports.  
For the pin configuration, see the table "List of Pins and Pin Functions (32-Pin LQFP, 32-Pin LQFPHWQFN)".

**Figure 1.8 Pin Assignments of the 32-Pin HWQFN**

## 1.6 List of Pins and Pin Functions

### 1.6.1 80-pin LFQFP

**Table 1.5 List of Pins and Pin Functions (80-Pin LFQFP) (1/2)**

| Pin No. | Power Supply, Clock, System Control | I/O Port  | Timers (MTU, TMR, POE, LPT)        | Communications (SCIg, SC Ih, SC Ik, RSPI, RIIC, RSCAN) | Touch sensing | Others              |
|---------|-------------------------------------|-----------|------------------------------------|--|---------------|---------------------|
| 1       |                                     | P06*1     |                                    |  |               |                     |
| 2       |                                     | P03*1     |                                    |  |               | DA0                 |
| 3       |                                     | P04*1     |                                    |  |               |                     |
| 4       | VCL                                 |           |                                    |  |               |                     |
| 5       |                                     | PJ1       | MTIOC3A                            |  |               |                     |
| 6       | MD                                  | PG7       |                                    |  |               | FINED               |
| 7       | XCIN                                | PH7       |                                    |  |               |                     |
| 8       | XCOUT                               | PH6       |                                    |  |               |                     |
| 9       | RES#                                |           |                                    |  |               |                     |
| 10      | XTAL                                | P37       |                                    |  |               | IRQ4                |
| 11      | VSS                                 |           |                                    |  |               |                     |
| 12      | EXTAL                               | P36       |                                    |  |               | IRQ2                |
| 13      | VCC                                 |           |                                    |  |               |                     |
| 14      |                                     | P35       |                                    |  |               | NMI                 |
| 15      |                                     | P34       | MTIOC0A/TMCI3/POE2#                | SCK6   |               | IRQ4                |
| 16      |                                     | P32       | MTIOC0C/TMO3                       | TXD6/SMOSI6/SSDA6                                      | TS0           | IRQ2/RTCOUT         |
| 17      |                                     | P31       | MTIOC4D/TMCI2                      | CTS1#/RTS1#/SS1#                                       | TS1           | IRQ1                |
| 18      |                                     | P30       | MTIOC4B/TMRI3/POE8#                | RXD1/SMISO1/SSCL1                                      | TS2           | IRQ0                |
| 19      |                                     | P27       | MTIOC2B/TMCI3                      | SCK1   | TS3           |                     |
| 20      |                                     | P26       | MTIOC2A/TMO1/LPTO                  | TXD1/SMOSI1/SSDA1                                      | TS4           |                     |
| 21      |                                     | P21       | MTIOC1B/TMCI0                      |  |               |                     |
| 22      |                                     | P20       | MTIOC1A/TMRI0                      |  |               |                     |
| 23      | (5V tolerant)                       | P17       | MTIOC3A/MTIOC3B/TMO1/POE8#         | SCK1/MISOA/SDA0  |               | IRQ7                |
| 24      | (5V tolerant)                       | P16       | MTIOC3C/MTIOC3D/TMO2               | TXD1/SMOSI1/SSDA1/MOSIA/SCL0                           |               | IRQ6/RTCOUT/ADTRG0# |
| 25      |                                     | P15       | MTIOC0B/MTCLKB/TMCI2               | RXD1/SMISO1/SSCL1/CRXD0                                | TS5           | IRQ5                |
| 26      |                                     | P14       | MTIOC3A/MTCLKA/TMRI2               | CTS1#/RTS1#/SS1#/CTXD0                                 | TS6           | IRQ4                |
| 27      | (5V tolerant)                       | P13       | MTIOC0B/TMO3                       | SDA0   |               | IRQ3                |
| 28      | (5V tolerant)                       | P12       | TMCI1                              | SCL0   |               | IRQ2                |
| 29      |                                     | PH3       | MTIOC4D/TMCI0                      |  | TS7           |                     |
| 30      |                                     | PH2       | MTIOC4C/TMRI0                      |  | TS8           | IRQ1                |
| 31      |                                     | PH1       | MTIOC3D/TMO0                       |  | TS9           | IRQ0                |
| 32      |                                     | PH0       | MTIOC3B                            |  | TS10          | CACREF              |
| 33      |                                     | P55       | MTIOC4A/MTIOC4D/TMO3               | CRXD0  | TS11          |                     |
| 34      |                                     | P54       | MTIOC4B/TMCI1                      | CTXD0  | TS12          |                     |
| 35      |                                     | PC7       | MTCLKB/MTIOC3A/TMO2/LPTO           | MISOA/TXD8/SMOSI8/SSDA8                                | TS13          | CACREF              |
| 36      |                                     | PC6       | MTIOC3C/MTCLKA/TMCI2               | MOSIA/RXD8/SMISO8/SSCL8                                | TS14          |                     |
| 37      |                                     | PC5       | MTIOC0C/MTIOC3B/MTCLKD/TMRI2       | RSPCKA/SCK8  | TS15          |                     |
| 38      |                                     | PC4       | MTIOC0A/MTIOC3D/MTCLKC/TMCI1/POE0# | SCK5/CTS8#/RTS8#/SS8#/SSLA0                            | TSCAP         |                     |
| 39      |                                     | PC3       | MTIOC4D                            | TXD5/SMOSI5/SSDA5                                      | TS16          |                     |
| 40      |                                     | PC2       | MTIOC4B                            | RXD5/SMISO5/SSCL5/SSLA3                                | TS17          |                     |
| 41      |                                     | PB7/PC1*2 | MTIOC3B                            | TXD9/SMOSI9/SSDA9                                      | TS18          |                     |
| 42      |                                     | PB6/PC0*2 | MTIOC3D                            | RXD9/SMISO9/SSCL9                                      | TS19          |                     |
| 43      |                                     | PB5       | MTIOC2A/MTIOC1B/TMRI1/POE1#        | SCK9   | TS20          |                     |
| 44      |                                     | PB4       |                                    | CTS9#/RTS9#/SS9#                                       | TS21          |                     |

**Table 1.5 List of Pins and Pin Functions (80-Pin LFQFP) (2/2)**

| Pin No. | Power Supply, Clock, System Control | I/O Port | Timers (MTU, TMR, POE, LPT)       | Communications (SCIg, SC Ih, SC Ik, RSPI, RIIC, RSCAN) | Touch sensing | Others             |
|---------|-------------------------------------|----------|-----------------------------------|--|---------------|--------------------|
| 45      |                                     | PB3      | MTIOC0A/MTIOC4A/TMO0/POE3#/LPTO   | SCK6   | TS22          |                    |
| 46      |                                     | PB2      |                                   | CTS6#/RTS6#/SS6#                                       | TS23          |                    |
| 47      |                                     | PB1      | MTIOC0C/MTIOC4C/TMC10             | TXD6/SMOSI6/SSDA6                                      | TS24          | IRQ4/CMPOB1        |
| 48      | VCC                                 |          |                                   |  |               |                    |
| 49      |                                     | PB0      | MTIOC3D/MTIC5W                    | RXD6/SMISO6/SSCL6/RSPCKA                               | TS25          |                    |
| 50      | VSS                                 |          |                                   |  |               |                    |
| 51      |                                     | PA6      | MTIOC3D/MTIC5V/MTCLKB/TMC13/POE2# | CTS5#/RTS5#/SS5#/MOSIA                                 | TS26          |                    |
| 52      |                                     | PA5      |                                   | RSPCKA   | TS27          |                    |
| 53      |                                     | PA4      | MTIOC4C/MTIC5U/MTCLKA/TMRO        | TXD5/SMOSI5/SSDA5/SSLA0                                | TS28          | IRQ5/CVREFB1       |
| 54      |                                     | PA3      | MTIOC0D/MTIOC4D/MTIC5V/MTCLKD     | RXD5/SMISO5/SSCL5                                      | TS29          | IRQ6/CMPB1         |
| 55      |                                     | PA2      |                                   | RXD5/SMISO5/SSCL5/SSLA3                                | TS30          |                    |
| 56      |                                     | PA1      | MTIOC0B/MTIOC3B/MTCLKC            | SCK5/SSLA2   | TS31          |                    |
| 57      |                                     | PA0      | MTIOC4A                           | SSLA1  | TS32          | CACREF             |
| 58      |                                     | PE5      | MTIOC4C/MTIOC2B                   |  |               | IRQ5/AN021/CMPOB0  |
| 59      |                                     | PE4      | MTIOC4D/MTIOC1A/MTIOC4A           |  | TS33          | AN020/CMPA2/CLKOUT |
| 60      |                                     | PE3      | MTIOC1B/MTIOC4B/POE8#             | CTS12#/RTS12#/SS12#                                    | TS34          | AN019/CLKOUT       |
| 61      |                                     | PE2      | MTIOC4A                           | RXD12/RDXD12/SMISO12/SSCL12                            | TS35          | IRQ7/AN018/CVREFB0 |
| 62      |                                     | PE1      | MTIOC4C                           | TXD12/TXDX12/SIOX12/SMOSI12/SSDA12                     |               | AN017/CMPB0        |
| 63      |                                     | PE0      |                                   | SCK12  |               | AN016              |
| 64      |                                     | PD2      | MTIOC4D                           | SCK6   |               | IRQ2/AN026         |
| 65      |                                     | PD1      | MTIOC4B                           | RXD6/SMISO6/SSCL6                                      |               | IRQ1/AN025         |
| 66      |                                     | PD0      |                                   | TXD6/SMOSI6/SSDA6                                      |               | IRQ0/AN024         |
| 67      |                                     | P47*1    |                                   |  |               | AN007              |
| 68      |                                     | P46*1    |                                   |  |               | AN006              |
| 69      |                                     | P45*1    |                                   |  |               | AN005              |
| 70      |                                     | P44*1    |                                   |  |               | AN004              |
| 71      |                                     | P43*1    |                                   |  |               | AN003              |
| 72      |                                     | P42*1    |                                   |  |               | AN002              |
| 73      |                                     | P41*1    |                                   |  |               | AN001              |
| 74      | VREFL0                              | PJ7*1    |                                   |  |               |                    |
| 75      |                                     | P40*1    |                                   |  |               | AN000              |
| 76      | VREFH0                              | PJ6*1    |                                   |  |               |                    |
| 77      | AVCC0                               |          |                                   |  |               |                    |
| 78      |                                     | P07*1    |                                   |  |               | ADTRG0#            |
| 79      | AVSS0                               |          |                                   |  |               |                    |
| 80      |                                     | P05*1    |                                   |  |               | DA1                |

Note 1. The power source of the I/O buffer for these pins is AVCC0.

Note 2. PC0 and PC1 are valid only when the port switching function is selected.

## 1.6.2 64-pin LFQFP, 64-pin LQFP

**Table 1.6 List of Pins and Pin Functions (64-Pin LFQFP, 64-Pin LQFP) (1/2)**

| Pin No. | Power Supply, Clock, System Control | I/O Port  | Timers (MTU, TMR, POE, LPT)        | Communications (SCIg, SC Ih, SC Ik, RSPI, RIIC, RSCAN) | Touch sensing | Others              |
|---------|-------------------------------------|-----------|------------------------------------|--|---------------|---------------------|
| 1       |                                     | P03*1     |                                    |  |               | DA0                 |
| 2       | VCL                                 |           |                                    |  |               |                     |
| 3       | MD                                  | PG7       |                                    |  |               | FINED               |
| 4       | XCIN                                | PH7*3     |                                    |  |               |                     |
| 5       | XCOUT                               | PH6*3     |                                    |  |               |                     |
| 6       | RES#                                |           |                                    |  |               |                     |
| 7       | XTAL                                | P37       |                                    |  |               | IRQ4                |
| 8       | VSS                                 |           |                                    |  |               |                     |
| 9       | EXTAL                               | P36       |                                    |  |               | IRQ2                |
| 10      | VCC                                 |           |                                    |  |               |                     |
| 11      |                                     | P35       |                                    |  |               | NMI                 |
| 12      |                                     | P32       | MTIOC0C/TMO3                       | TXD6*3/SMOSI6*3/SSDA6*3                                | TS0*3         | IRQ2/RTCOUT         |
| 13      |                                     | P31       | MTIOC4D/TMCI2                      | CTS1#/RTS1#/SS1#                                       | TS1*3         | IRQ1                |
| 14      |                                     | P30       | MTIOC4B/TMRI3/POE8#                | RXD1/SMISO1/SSCL1                                      | TS2*3         | IRQ0                |
| 15      |                                     | P27       | MTIOC2B/TMCI3                      | SCK1   | TS3           |                     |
| 16      |                                     | P26       | MTIOC2A/TMO1/LPTO                  | TXD1/SMOSI1/SSDA1                                      | TS4           |                     |
| 17      | (5V tolerant)                       | P17       | MTIOC3A/MTIOC3B/TMO1/POE8#         | SCK1/MISOA/SDA0  |               | IRQ7                |
| 18      | (5V tolerant)                       | P16       | MTIOC3C/MTIOC3D/TMO2               | TXD1/SMOSI1/SSDA1/MOSIA/SCL0                           |               | IRQ6/RTCOUT/ADTRG0# |
| 19      |                                     | P15       | MTIOC0B/MTCLKB/TMCI2               | RXD1/SMISO1/SSCL1/CRXD0                                | TS5*3         | IRQ5                |
| 20      |                                     | P14       | MTIOC3A/MTCLKA/TMRI2               | CTS1#/RTS1#/SS1#/CTXD0                                 | TS6*3         | IRQ4                |
| 21      |                                     | PH3       | MTIOC4D/TMCI0                      |  | TS7*3         |                     |
| 22      |                                     | PH2       | MTIOC4C/TMRI0                      |  | TS8*3         | IRQ1                |
| 23      |                                     | PH1       | MTIOC3D/TMO0                       |  | TS9*3         | IRQ0                |
| 24      |                                     | PH0       | MTIOC3B                            |  | TS10*3        | CACREF              |
| 25      |                                     | P55       | MTIOC4A/MTIOC4D/TMO3               | CRXD0*3  | TS11*3        |                     |
| 26      |                                     | P54       | MTIOC4B/TMCI1                      | CTXD0*3  | TS12*3        |                     |
| 27      |                                     | PC7       | MTIOC3A/MTCLKB/TMO2/LPTO           | TXD8*3/SMOSI8*3/SSDA8*3/MISOA                          | TS13          | CACREF              |
| 28      |                                     | PC6       | MTIOC3C/MTCLKA/TMCI2               | RXD8*3/SMISO8*3/SSCL8*3/MOSIA                          | TS14          |                     |
| 29      |                                     | PC5       | MTIOC0C/MTIOC3B/MTCLKD/TMRI2       | SCK8*3/RSPCKA  | TS15          |                     |
| 30      |                                     | PC4       | MTIOC0A/MTIOC3D/MTCLKC/TMCI1/POE0# | SCK5/CTS8#*3/RTS8#*3/SS8#*3/SSLA0                      | TSCAP         |                     |
| 31      |                                     | PC3       | MTIOC4D                            | TXD5/SMOSI5/SSDA5                                      | TS16*3        |                     |
| 32      |                                     | PC2       | MTIOC4B                            | RXD5/SMISO5/SSCL5/SSLA3                                | TS17*3        |                     |
| 33      |                                     | PB7/PC1*2 | MTIOC3B                            | TXD9*3/SMOSI9*3/SSDA9*3                                | TS18*3        |                     |
| 34      |                                     | PB6/PC0*2 | MTIOC3D                            | RXD9*3/SMISO9*3/SSCL9*3                                | TS19*3        |                     |
| 35      |                                     | PB5       | MTIOC2A/MTIOC1B/TMRI1/POE1#        | SCK9*3   | TS20*3        |                     |
| 36      |                                     | PB3       | MTIOC0A/MTIOC4A/TMO0/POE3#/LPTO    | SCK6*3   | TS22*3        |                     |
| 37      |                                     | PB1       | MTIOC0C/MTIOC4C/TMCI0              | TXD6*3/SMOSI6*3/SSDA6*3                                | TS24*3        | IRQ4/CMPOB1         |
| 38      | VCC                                 |           |                                    |  |               |                     |
| 39      |                                     | PB0       | MTIOC3D/MTIC5W                     | RXD6*3/SMISO6*3/SSCL6*3/RSPCKA                         | TS25          |                     |
| 40      | VSS                                 |           |                                    |  |               |                     |
| 41      |                                     | PA6       | MTIOC3D/MTIC5V/MTCLKB/TMCI3/POE2#  | CTS5#/RTS5#/SS5#/MOSIA                                 | TS26*3        |                     |
| 42      |                                     | PA4       | MTIOC4C/MTIC5U/MTCLKA/TMRI0        | TXD5/SMOSI5/SSDA5/SSLA0                                | TS28          | IRQ5/CVREFB1        |
| 43      |                                     | PA3       | MTIOC0D/MTIOC4D/MTIC5V/MTCLKD      | RXD5/SMISO5/SSCL5                                      | TS29          | IRQ6/CMPB1          |

**Table 1.6 List of Pins and Pin Functions (64-Pin LFQFP, 64-Pin LQFP) (2/2)**

| Pin No. | Power Supply, Clock, System Control | I/O Port          | Timers (MTU, TMR, POE, LPT) | Communications (SCIg, SC Ih, SC Ik, RSPI, RIIC, RSCAN) | Touch sensing      | Others             |
|---------|-------------------------------------|-------------------|-----------------------------|--|--------------------|--------------------|
| 44      |                                     | PA1               | MTIOC0B/MTIOC3B/MTCLKC      | SCK5/SSLA2   | TS31               |                    |
| 45      |                                     | PA0               | MTIOC4A                     | SSLA1  | TS32* <sup>3</sup> | CACREF             |
| 46      |                                     | PE5               | MTIOC4C/MTIOC2B             |  |                    | IRQ5/AN021/CMPBO0  |
| 47      |                                     | PE4               | MTIOC4D/MTIOC1A/MTIOC4A     |  | TS33               | AN020/CMPA2/CLKOUT |
| 48      |                                     | PE3               | MTIOC1B/MTIOC4B/POE8#       | CTS12#/RTS12#/SS12#                                    | TS34               | AN019/CLKOUT       |
| 49      |                                     | PE2               | MTIOC4A                     | RXD12/RDXD12/SMISO12/SSCL12                            | TS35               | IRQ7/AN018/CVREFB0 |
| 50      |                                     | PE1               | MTIOC4C                     | TXD12/TDXD12/SIOX12/SMOSI12/SSDA12                     |                    | AN017/CMPB0        |
| 51      |                                     | PE0               |                             | SCK12  |                    | AN016              |
| 52      |                                     | P47* <sup>1</sup> |                             |  |                    | AN007              |
| 53      |                                     | P46* <sup>1</sup> |                             |  |                    | AN006              |
| 54      |                                     | P45* <sup>1</sup> |                             |  |                    | AN005              |
| 55      |                                     | P44* <sup>1</sup> |                             |  |                    | AN004              |
| 56      |                                     | P43* <sup>1</sup> |                             |  |                    | AN003              |
| 57      |                                     | P42* <sup>1</sup> |                             |  |                    | AN002              |
| 58      |                                     | P41* <sup>1</sup> |                             |  |                    | AN001              |
| 59      | VREFL0                              | PJ7* <sup>1</sup> |                             |  |                    |                    |
| 60      |                                     | P40* <sup>1</sup> |                             |  |                    | AN000              |
| 61      | VREFH0                              | PJ6* <sup>1</sup> |                             |  |                    |                    |
| 62      | AVCC0                               |                   |                             |  |                    |                    |
| 63      |                                     | P05* <sup>1</sup> |                             |  |                    | DA1                |
| 64      | AVSS0                               |                   |                             |  |                    |                    |

Note 1. The power source of the I/O buffer for these pins is AVCC0.

Note 2. PC0 and PC1 are valid only when the port switching function is selected.

Note 3. This is not supported by products with 64 Kbytes of ROM.

### 1.6.3 48-pin LFQFP, 48-pin HWQFN

**Table 1.7 List of Pins and Pin Functions (48-Pin LFQFP, 48-Pin HWQFN) (1/2)**

| Pin No. | Power Supply, Clock, System Control | I/O Port  | Timers (MTU, TMR, POE, LPT)        | Communications (SCIg, SCIf, SCIk, RSPI, RIIC, RSCAN) | Touch sensing | Others              |
|---------|-------------------------------------|-----------|------------------------------------|--|---------------|---------------------|
| 1       | VCL                                 |           |                                    |  |               |                     |
| 2       | MD                                  | PG7       |                                    |  |               | FINED               |
| 3       | RES#                                |           |                                    |  |               |                     |
| 4       | XTAL                                | P37       |                                    |  |               | IRQ4                |
| 5       | VSS                                 |           |                                    |  |               |                     |
| 6       | EXTAL                               | P36       |                                    |  |               | IRQ2                |
| 7       | VCC                                 |           |                                    |  |               |                     |
| 8       |                                     | P35       |                                    |  |               | NMI                 |
| 9       |                                     | P31       | MTIOC4D/TMCI2                      | CTS1#/RTS1#/SS1#                                     | TS1*3         | IRQ1                |
| 10      |                                     | P30       | MTIOC4B/TMRI3/POE8#                | RXD1/SMISO1/SSCL1                                    | TS2*3         | IRQ0                |
| 11      |                                     | P27       | MTIOC2B/TMCI3                      | SCK1   | TS3           |                     |
| 12      |                                     | P26       | MTIOC2A/TMO1/LPTO                  | TXD1/SMOSI1/SSDA1                                    | TS4           |                     |
| 13      | (5V tolerant)                       | P17       | MTIOC3A/MTIOC3B/TMO1/POE8#         | SCK1/MISOA/SDA0                                      |               | IRQ7                |
| 14      | (5V tolerant)                       | P16       | MTIOC3C/MTIOC3D/TMO2               | TXD1/SMOSI1/SSDA1/MOSIA/SCL0                         |               | IRQ6/ADTRG0#/RTCOUT |
| 15      |                                     | P15       | MTIOC0B/MTCLKB/TMCI2               | RXD1/SMISO1/SSCL1/CRXD0*3                            | TS5*3         | IRQ5                |
| 16      |                                     | P14       | MTIOC3A/MTCLKA/TMRI2               | CTS1#/RTS1#/SS1#/CTXD0*3                             | TS6*3         | IRQ4                |
| 17      |                                     | PH3       | MTIOC4D/TMCI0                      |  | TS7*3         |                     |
| 18      |                                     | PH2       | MTIOC4C/TMRI0                      |  | TS8*3         | IRQ1                |
| 19      |                                     | PH1       | MTIOC3D/TMO0                       |  | TS9*3         | IRQ0                |
| 20      |                                     | PH0       | MTIOC3B                            |  | TS10*3        | CACREF              |
| 21      |                                     | PC7       | MTIOC3A/TMO2/MTCLKB/LPTO           | TXD8*3/SMOSI8*3/SSDA8*3/MISOA                        | TS13          | CACREF              |
| 22      |                                     | PC6       | MTIOC3C/MTCLKA/TMCI2               | RXD8*3/SMISO8*3/SSCL8*3/MOSIA                        | TS14          |                     |
| 23      |                                     | PC5       | MTIOC0C/MTIOC3B/MTCLKD/TMRI2       | SCK8*3/RSPCKA  | TS15          |                     |
| 24      |                                     | PC4       | MTIOC0A/MTIOC3D/MTCLKC/TMCI1/POE0# | SCK5/CTS8#*3/RTS8#*3/SS8#*3/SSLA0                    | TSCAP         |                     |
| 25      |                                     | PB5/PC3*1 | MTIOC2A/MTIOC1B/TMRI1/POE1#        |  | TS20*3        |                     |
| 26      |                                     | PB3/PC2*1 | MTIOC0A/MTIOC4A/TMO0/POE3#/LPTO    | SCK6*3   | TS22*3        |                     |
| 27      |                                     | PB1/PC1*1 | MTIOC0C/MTIOC4C/TMCI0              | TXD6*3/SMOSI6*3/SSDA6*3                              | TS24*3        | IRQ4/CMPOB1         |
| 28      | VCC                                 |           |                                    |  |               |                     |
| 29      |                                     | PB0/PC0*1 | MTIOC3D/MTIC5W                     | RXD6*3/SMISO6*3/SSCL6*3/RSPCKA                       | TS25          |                     |
| 30      | VSS                                 |           |                                    |  |               |                     |
| 31      |                                     | PA6       | MTIOC3D/MTIC5V/MTCLKB/TMCI3/POE2#  | CTS5#/RTS5#/SS5#/MOSIA                               | TS26*3        |                     |
| 32      |                                     | PA4       | MTIOC4C/MTIC5U/MTCLKA/TMRI0        | TXD5/SMOSI5/SSDA5/SSLA0                              | TS28          | IRQ5/CVREFB1        |
| 33      |                                     | PA3       | MTIOC0D/MTIOC4D/MTIC5V/MTCLKD      | RXD5/SMISO5/SSCL5                                    | TS29          | IRQ6/CMPB1          |
| 34      |                                     | PA1       | MTIOC0B/MTIOC3B/MTCLKC             | SCK5/SSLA2   | TS31          |                     |
| 35      |                                     | PE4       | MTIOC4D/MTIOC1A/MTIOC4A            |  | TS33          | AN020/CMPA2/CLKOUT  |
| 36      |                                     | PE3       | MTIOC1B/MTIOC4B/POE8#              | CTS12#/RTS12#  | TS34          | AN019/CLKOUT        |
| 37      |                                     | PE2       | MTIOC4A                            | RXD12/RDXD12/SSCL12                                  | TS35          | IRQ7/AN018/CVREFB0  |
| 38      |                                     | PE1       | MTIOC4C                            | TXD12/TDXD12/SIOX12/SSDA12                           |               | AN017/CMPB0         |
| 39      |                                     | P47*2     |                                    |  |               | AN007               |
| 40      |                                     | P46*2     |                                    |  |               | AN006               |
| 41      |                                     | P45*2     |                                    |  |               | AN005               |
| 42      |                                     | P42*2     |                                    |  |               | AN002               |
| 43      |                                     | P41*2     |                                    |  |               | AN001               |

**Table 1.7 List of Pins and Pin Functions (48-Pin LFQFP, 48-Pin HWQFN) (2/2)**

| Pin No. | Power Supply, Clock, System Control | I/O Port | Timers (MTU, TMR, POE, LPT) | Communications (SCIg, SC Ih, SC Ik, RSPI, RIIC, RSCAN) | Touch sensing | Others |
|---------|-------------------------------------|----------|-----------------------------|--|---------------|--------|
| 44      | VREFL0                              | PJ7*2    |                             |  |               |        |
| 45      |                                     | P40*2    |                             |  |               | AN000  |
| 46      | VREFH0                              | PJ6*2    |                             |  |               |        |
| 47      | AVCC0                               |          |                             |  |               |        |
| 48      | AVSS0                               |          |                             |  |               |        |

Note 1. PC0 to PC3 are valid only when the port switching function is selected.

Note 2. The power source of the I/O buffer for these pins is AVCC0.

Note 3. This is not supported by products with 64 Kbytes of ROM.

### 1.6.4 32-pin LQFP, 32-pin HWQFN

**Table 1.8 List of Pins and Pin Functions (32-Pin LQFP, 32-Pin HWQFN)**

| Pin No. | Power Supply, Clock, System Control | I/O Port | Timers (MTU, TMR, POE, LPT)        | Communications (SCIg, SC1h, SC1k, RSPI, RIIC) | Touch sensing | Others              |
|---------|-------------------------------------|----------|------------------------------------|---|---------------|---------------------|
| 1       | MD                                  | PG7      |                                    |   |               | FINED               |
| 2       | RES#                                |          |                                    |   |               |                     |
| 3       | VSS                                 |          |                                    |   |               |                     |
| 4       | EXTAL                               | P36      |                                    |   |               | IRQ2                |
| 5       | VCC                                 |          |                                    |   |               |                     |
| 6       |                                     | P35      |                                    |   |               | NMI                 |
| 7       |                                     | P31      | MTIOC4D/TMCI2                      | CTS1#/RTS1#/SS1#                              |               | IRQ1                |
| 8       |                                     | P30      | MTIOC4B/TMRI3/POE8#                | RXD1/SMISO1/SSCL1                             |               | IRQ0                |
| 9       |                                     | P27      | MTIOC2B/TMCI3                      | SCK1  | TS3           |                     |
| 10      |                                     | P26      | MTIOC2A/TMO1/LPTO                  | TXD1/SMOSI1/SSDA1                             | TS4           |                     |
| 11      | (5V tolerant)                       | P17      | MTIOC3A/MTIOC3B/TMO1/POE8#         | SCK1/MISOA/SDA0                               |               | IRQ7                |
| 12      | (5V tolerant)                       | P16      | MTIOC3C/MTIOC3D/TMO2               | TXD1/SMOSI1/SSDA1/MOSIA/SCL0                  |               | IRQ6/ADTRG0#/RTCOUT |
| 13      |                                     | PC7      | MTIOC3A/MTCLKB/TMO2/LPTO           | MISOA   | TS13          | CACREF              |
| 14      |                                     | PC6      | MTIOC3C/MTCLKA/TMCI2               | MOSIA   | TS14          |                     |
| 15      |                                     | PC5      | MTIOC0C/MTIOC3B/MTCLKD/TMRI2       | RSPCKA  | TS15          |                     |
| 16      |                                     | PC4      | MTIOC0A/MTIOC3D/MTCLKC/TMCI1/POE0# | SCK5/SSLA0                                    | TSCAP         |                     |
| 17      | VCC                                 |          |                                    |   |               |                     |
| 18      |                                     | PB0      | MTIOC3D/MTIC5W                     | RSPCKA  | TS25          |                     |
| 19      | VSS                                 |          |                                    |   |               |                     |
| 20      |                                     | PA4      | MTIOC4C/MTIC5U/MTCLKA/TMRI0        | TXD5/SMOSI5/SSDA5/SSLA0                       | TS28          | IRQ5/CVREFB1        |
| 21      |                                     | PA3      | MTIOC0D/MTIOC4D/MTIC5V/MTCLKD      | RXD5/SMISO5/SSCL5                             | TS29          | IRQ6/CMPB1          |
| 22      |                                     | PA1      | MTIOC0B/MTIOC3B/MTCLKC             | SCK5/SSLA2                                    | TS31          |                     |
| 23      |                                     | PE4      | MTIOC1A/MTIOC4A/MTIOC4D            |   | TS33          | AN020/CMPA2/CLKOUT  |
| 24      |                                     | PE3      | MTIOC1B/MTIOC4B/POE8#              | CTS12#/RTS12#                                 | TS34          | AN019/CLKOUT        |
| 25      |                                     | PE2      | MTIOC4A                            | RXD12/SSCL12/RXDX12                           | TS35          | IRQ7/AN018/CVREFB0  |
| 26      |                                     | PE1      | MTIOC4C                            | TXD12/SSDA12/TXDX12/SIOX12                    |               | AN017/CMPB0         |
| 27      |                                     | P42*1    |                                    |   |               | AN002               |
| 28      |                                     | P41*1    |                                    |   |               | AN001               |
| 29      |                                     | P40*1    |                                    |   |               | AN000               |
| 30      | AVCC0/VREFH0                        |          |                                    |   |               |                     |
| 31      | AVSS0/VREFL0                        |          |                                    |   |               |                     |
| 32      | VCL                                 |          |                                    |   |               |                     |

Note 1. The power source of the I/O buffer for these pins is AVCC0.

## 2. Electrical Characteristics

### 2.1 Absolute Maximum Ratings

**Table 2.1 Absolute Maximum Ratings**

Conditions: VSS = AVSS0 = VREFL0 = 0 V

| Item                           |   | Symbol    | Value               | Unit |
|--------------------------------|---|-----------|---------------------|------|
| Power supply voltage           |   | VCC       | -0.3 to +6.5        | V    |
| Input voltage                  | Ports for 5 V tolerant*1                    | $V_{in}$  | -0.3 to +6.5        | V    |
|                                | P03 to P07,<br>P40 to P47,<br>PJ6, PJ7      |           | -0.3 to AVCC0 + 0.3 | V    |
|                                | Ports other than above                      |           | -0.3 to VCC + 0.3   |      |
|                                |   |           |                     |      |
| Reference power supply voltage |   | VREFH0    | -0.3 to AVCC0 + 0.3 | V    |
| Analog power supply voltage    |   | AVCC0     | -0.3 to +6.5        | V    |
| Analog input voltage           | When AN000 to AN007 used                    | $V_{AN}$  | -0.3 to AVCC0 + 0.3 | V    |
|                                | When AN016 to AN021,<br>AN024 to AN026 used |           | -0.3 to VCC + 0.3   |      |
| Junction temperature           | D-version                                   | $T_j$     | -40 to +105         | °C   |
|                                | G-version                                   |           | -40 to +112         |      |
| Storage temperature            |   | $T_{stg}$ | -55 to +125         | °C   |

Caution: Permanent damage to the MCU may result if absolute maximum ratings are exceeded.

To preclude any malfunctions due to noise interference, insert capacitors of high frequency characteristics between the VCC and VSS pins, between the AVCC0 and AVSS0 pins, and between the VREFH0 and VREFL0 pins. Place capacitors of about 0.1  $\mu$ F as close as possible to every power supply pin and use the shortest and heaviest possible traces.

Connect the VCL pin to a VSS pin via a 4.7  $\mu$ F capacitor. The capacitor must be placed close to the pin, refer to section 2.15.1, Connecting VCL Capacitor and Bypass Capacitors.

Do not input signals or an I/O pull-up power supply to ports other than 5-V tolerant ports while the device is not powered.

The current injection that results from input of such a signal or I/O pull-up may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements.

Even if -0.3 to +6.5 V is input to 5-V tolerant ports, it will not cause problems such as damage to the MCU.

Note 1. P12, P13, P16, and P17 are 5 V tolerant.

## 2.2 Recommended Operating Conditions

**Table 2.2 Recommended Operating Conditions (1)**

| Item                                | Symbol  | Symbol           | Min. | Typ. | Max.        | Unit |
|-------------------------------------|---|------------------|------|------|-------------|------|
| Power supply voltages               | VCC <sup>*1, *2</sup>                         |                  | 1.8  | —    | 5.5         | V    |
|                                     | VSS   |                  | —    | 0    | —           |      |
| Analog power supply voltages        | AVCC0 <sup>*1</sup>                           |                  | 1.8  | —    | 5.5         | V    |
|                                     | AVSS0   |                  | —    | 0    | —           |      |
|                                     | VREFH0  |                  | 1.8  | —    | AVCC0       |      |
|                                     | VREFL0  |                  | —    | 0    | —           |      |
| Input voltage                       | Ports for 5 V tolerant:<br>P12, P13, P16, P17 | V <sub>in</sub>  | -0.3 | —    | 5.8         | V    |
|                                     | P03 to P07,<br>P40 to P47,<br>PJ6, PJ7        |                  | -0.3 | —    | AVCC0 + 0.3 |      |
|                                     | Ports other than above                        |                  | -0.3 | —    | VCC + 0.3   |      |
| Operating temperature <sup>*3</sup> | D version                                     | T <sub>opr</sub> | -40  | —    | 85          | °C   |
|                                     | G version                                     |                  | -40  | —    | 105         |      |

Note 1. When powering on the VCC and AVCC0 pins, power them on at the same time or the VCC pin first and then the AVCC0 pin.

Note 2. When VCC < 2.4 V, normal operating mode functions of the CTSU are restricted. For details, refer to section 32, Capacitive Touch Sensing Unit (CTSU2SL, CTSU2L) in the User's Manual: Hardware.

Note 3. The upper limit of operating temperature is 85°C or 105°C, depending on the product. For details, refer to section 1.2, List of Products.

**Table 2.3 Recommended Operating Conditions (2)**

| Item   | Symbol           | Value         |
|--|------------------|---------------|
| Decoupling capacitance to stabilize the internal voltage | C <sub>VCL</sub> | 4.7μF ± 30%*1 |

Note 1. Use a multilayer ceramic capacitor whose nominal capacitance is 4.7 μF and a capacitance tolerance is ±30% or better.

## 2.3 DC Characteristics

**Table 2.4 DC Characteristics (1)**

Conditions:  $2.7 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $2.7 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

| Item  |   | Symbol       | Min.                      | Typ. | Max.                      | Unit | Test Conditions |
|---|---|--------------|---------------------------|------|---------------------------|------|-----------------|
| Schmitt trigger input voltage                               | RIIC input pin (except for SMBus)   | $V_{IH}$     | $0.7 \times \text{VCC}$   | —    | —                         | V    |                 |
|   |   | $V_{IL}$     | —                         | —    | $0.3 \times \text{VCC}$   |      |                 |
|   |   | $\Delta V_T$ | $0.05 \times \text{VCC}$  | —    | —                         |      |                 |
|   | IRQ input pin, MTU2 input pin, POE2 input pin, TMR input pin, SCI input pin, RSPI input pin, CAC input pin, CAN input pin, ADTRG0# input pin*1, RES#, NMI, MD   | $V_{IH}$     | $0.8 \times \text{VCC}$   | —    | —                         |      |                 |
|   |   | $V_{IL}$     | —                         | —    | $0.2 \times \text{VCC}$   |      |                 |
|   |   | $\Delta V_T$ | $0.1 \times \text{VCC}$   | —    | —                         |      |                 |
|   | ADTRG0# input pin*2   | $V_{IH}$     | $0.8 \times \text{AVCC0}$ | —    | —                         |      |                 |
|   |   | $V_{IL}$     | —                         | —    | $0.2 \times \text{AVCC0}$ |      |                 |
|   |   | $\Delta V_T$ | $0.1 \times \text{AVCC0}$ | —    | —                         |      |                 |
| Input level voltage (except for schmitt trigger input pins) | EXTAL (external clock input)  | $V_{IH}$     | $0.8 \times \text{VCC}$   | —    | —                         | V    |                 |
|   |   | $V_{IL}$     | —                         | —    | $0.2 \times \text{VCC}$   |      |                 |
|   | RIIC input pin (SMBus)  | $V_{IH}$     | 2.2                       | —    | —                         |      |                 |
|   |   |              | 2.0                       | —    | —                         |      |                 |
|   |   | $V_{IL}$     | —                         | —    | 0.8                       |      |                 |
|   |   |              | —                         | —    | 0.5                       |      |                 |
|   | P12 to P17, P20, P21, P26, P27, P30 to P32, P34 to P37, P54, P55, PA0 to PA6, PB0 to PB7, PC2 to PC7, PDO to PD2, PE0 to PE5, PH0 to PH3, PH6*3, PH7*3 PJ1, PG7 | $V_{IH}$     | $0.8 \times \text{VCC}$   | —    | —                         |      |                 |
|   |   | $V_{IL}$     | —                         | —    | $0.2 \times \text{VCC}$   |      |                 |
|   | P03 to P07, P40 to P47, PJ6, PJ7  | $V_{IH}$     | $0.8 \times \text{AVCC}$  | —    | —                         |      |                 |
|   |   | $V_{IL}$     | —                         | —    | $0.2 \times \text{AVCC}$  |      |                 |

Note 1. The ADTRG0# input pin is assigned to P16.

Note 2. The ADTRG0# input pin is assigned to P07.

Note 3. This pin function is not provided for products with 64 Kbytes of ROM.

**Table 2.5 DC Characteristics (2)**Conditions:  $1.8 \text{ V} \leq \text{VCC} < 2.7 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} < 2.7 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item  |  | Symbol       | Min.                       | Typ. | Max.                      | Unit | Test Conditions |
|---|--|--------------|----------------------------|------|---------------------------|------|-----------------|
| Schmitt trigger input voltage                               | IRQ input pin, MTU2 input pin, POE2 input pin, TMR input pin, SCI input pin, RSPI input pin, CAC input pin, CAN input pin, ADTRG0# input pin <sup>*1</sup> , RES#, NMI, MD                 | $V_{IH}$     | $0.8 \times \text{VCC}$    | —    | —                         | V    |                 |
|   |  | $V_{IL}$     | —                          | —    | $0.2 \times \text{VCC}$   |      |                 |
|   |  | $\Delta V_T$ | $0.01 \times \text{VCC}$   | —    | —                         |      |                 |
|   | ADTRG0# input pin <sup>*2</sup>  | $V_{IH}$     | $0.8 \times \text{AVCC0}$  | —    | —                         |      |                 |
|   |  | $V_{IL}$     | —                          | —    | $0.2 \times \text{AVCC0}$ |      |                 |
|   |  | $\Delta V_T$ | $0.01 \times \text{AVCC0}$ | —    | —                         |      |                 |
| Input level voltage (except for schmitt trigger input pins) | EXTAL (external clock input)   | $V_{IH}$     | $0.8 \times \text{VCC}$    | —    | —                         | V    |                 |
|   |  | $V_{IL}$     | —                          | —    | $0.2 \times \text{VCC}$   |      |                 |
|   | P12 to P17, P20, P21, P26, P27, P30 to P32, P34 to P37, P54, P55, PA0 to PA6, PB0 to PB7, PC2 to PC7, PD0 to PD2, PE0 to PE5, PH0 to PH3, PH6 <sup>*3</sup> , PH7 <sup>*3</sup> , PJ1, PG7 | $V_{IH}$     | $0.8 \times \text{VCC}$    | —    | —                         |      |                 |
|   |  | $V_{IL}$     | —                          | —    | $0.2 \times \text{VCC}$   |      |                 |
|   |  | $V_{IH}$     | $0.8 \times \text{AVCC}$   | —    | —                         |      |                 |
|   | P03 to P07, P40 to P47, PJ6, PJ7   | $V_{IL}$     | —                          | —    | $0.2 \times \text{AVCC}$  |      |                 |
|   |  | $V_{IL}$     | —                          | —    | $0.2 \times \text{AVCC}$  |      |                 |

Note 1. The ADTRG0# input pin is assigned to P16.

Note 2. The ADTRG0# input pin is assigned to P07.

Note 3. This pin function is not provided for products with 64 Kbytes of ROM.

**Table 2.6 DC Characteristics (3)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                                    |  | Symbol      | Min. | Typ. | Max. | Unit          | Test Conditions  |
|---|--|-------------|------|------|------|---------------|--|
| Input leakage current                   | RES#, P35, PH6 <sup>*1</sup> , PH7 <sup>*1</sup> | $ I_{in} $  | —    | —    | 1.0  | $\mu\text{A}$ | $V_{in} = 0 \text{ V}$ , $\text{VCC}$                                    |
| Three-state leakage current (off-state) | Ports for 5-V tolerant                           | $ I_{TSI} $ | —    | —    | 1.0  | $\mu\text{A}$ | $V_{in} = 0 \text{ V}$ , $5.8 \text{ V}$                                 |
|   | PJ6, PJ7   |             | —    | —    | 1.0  |               | $V_{in} = 0 \text{ V}$ , $\text{VCC}$                                    |
|   | Other than ports for 5 V tolerant and PJ6, PJ7   |             | —    | —    | 0.2  |               | $V_{in} = 0 \text{ V}$ , $\text{VCC}$                                    |
| Input capacitance                       | All input pins (except for P35)                  | $C_{in}$    | —    | —    | 15   | $\text{pF}$   | $V_{in} = 0 \text{ mV}$ , $f = 1 \text{ MHz}$ , $T_a = 25^\circ\text{C}$ |
|   | P35  |             | —    | —    | 30   |               |  |

Note 1. This pin function is not provided for products with 64 Kbytes of ROM.

**Table 2.7 DC Characteristics (4)**Conditions:  $1.8 \text{ V} \leq \text{VCC} < 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} < 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                   |  | Symbol | Min. | Typ. | Max. | Unit             | Test Conditions        |
|------------------------|--|--------|------|------|------|------------------|------------------------|
| Input pull-up resistor | All ports (except for P35, PH6 <sup>*1</sup> , PH7 <sup>*1</sup> ) | $R_U$  | 10   | 20   | 50   | $\text{k}\Omega$ | $V_{in} = 0 \text{ V}$ |

Note 1. This pin function is not provided for products with 64 Kbytes of ROM.

[Products with 64-Kbyte ROM]

**Table 2.8 DC Characteristics (5)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item             |                             |                                    |                                    | Symbol          | Typ.<br>*4      | Max. |      | Test<br>Conditions |  |
|------------------|-----------------------------|------------------------------------|------------------------------------|-----------------|-----------------|------|------|--------------------|--|
| Supply current*1 | High-speed operating mode   | Normal operating mode              | No peripheral operation*2          | ICLK = 48 MHz   | I <sub>CC</sub> | 2.5  | —    | mA                 |  |
|                  |                             |                                    |                                    | ICLK = 32 MHz   |                 | 1.8  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 16 MHz   |                 | 1.3  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 1.0  | —    |                    |  |
|                  |                             |                                    | All peripheral operation: Normal*3 | ICLK = 48 MHz   | I <sub>CC</sub> | 9.0  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 32 MHz   |                 | 7.4  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 16 MHz   |                 | 4.2  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 2.5  | —    |                    |  |
|                  |                             |                                    | All peripheral operation: Max.*3   | ICLK = 48 MHz   | I <sub>CC</sub> | —    | 20.1 |                    |  |
|                  |                             |                                    |                                    | ICLK = 32 MHz   |                 | 1.4  | —    |                    |  |
|                  | Sleep mode                  | No peripheral operation*2          |                                    | ICLK = 16 MHz   | I <sub>CC</sub> | 1.1  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 0.8  | —    |                    |  |
|                  |                             | All peripheral operation: Normal*3 | ICLK = 48 MHz                      | 0.7             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 32 MHz                      | 4.0             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 16 MHz                      | 4.0             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 8 MHz                       | 2.3             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 48 MHz                      | I <sub>CC</sub> | 1.5             | —    |      |                    |  |
|                  |                             |                                    | Deep sleep mode                    |                 | ICLK = 32 MHz   | 1.0  | —    |                    |  |
|                  |                             |                                    |                                    |                 | ICLK = 16 MHz   | 0.8  | —    |                    |  |
|                  |                             |                                    |                                    |                 | ICLK = 8 MHz    | 0.7  | —    |                    |  |
|                  |                             | All peripheral operation: Normal*3 | ICLK = 48 MHz                      |                 | 0.6             | —    |      |                    |  |
|                  |                             |                                    | ICLK = 32 MHz                      | I <sub>CC</sub> | 3.1             | —    |      |                    |  |
|                  |                             |                                    | ICLK = 16 MHz                      |                 | 3.1             | —    |      |                    |  |
|                  |                             |                                    | ICLK = 8 MHz                       |                 | 1.9             | —    |      |                    |  |
|                  | Middle-speed operating mode | Normal operating mode              | No peripheral operation*6          | ICLK = 24 MHz   | I <sub>CC</sub> | 1.2  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 2.1  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 4 MHz    |                 | 1.0  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 1 MHz    |                 | 0.8  | —    |                    |  |
|                  |                             |                                    | All peripheral operation: Normal*7 | ICLK = 24 MHz   | I <sub>CC</sub> | 0.6  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 5.8  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 4 MHz    |                 | 2.3  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 1 MHz    |                 | 1.5  | —    |                    |  |
|                  |                             |                                    | All peripheral operation: Max.*7   | ICLK = 24 MHz   | I <sub>CC</sub> | 0.8  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | —    | 13.1 |                    |  |
|                  |                             | Sleep mode                         | No peripheral operation*6          | ICLK = 24 MHz   | I <sub>CC</sub> | 1.1  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 0.6  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 4 MHz    |                 | 0.2  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 1 MHz    |                 | 0.2  | —    |                    |  |

| Item             |                               |                                    |  | Symbol            | Typ.<br>*4      | Max. |      | Test<br>Conditions |
|------------------|-------------------------------|------------------------------------|--|-------------------|-----------------|------|------|--------------------|
| Supply current*1 | Middle-speed operating mode   | Sleep mode                         | All peripheral operation: Normal*7       |                   |                 |      |      |                    |
| Supply current*1 | Middle-speed operating mode   | Sleep mode                         | All peripheral operation: Normal*7       | ICLK = 24 MHz     | I <sub>CC</sub> | 3.3  | —    | mA                 |
|                  |                               |                                    |  | ICLK = 8 MHz      |                 | 1.5  | —    |                    |
|                  |                               |                                    |  | ICLK = 4 MHz      |                 | 1.0  | —    |                    |
|                  |                               |                                    |  | ICLK = 1 MHz      |                 | 0.7  | —    |                    |
|                  |                               | Deep sleep mode                    | No peripheral operation*6                | ICLK = 24 MHz     |                 | 0.8  | —    |                    |
|                  |                               |                                    |  | ICLK = 8 MHz      |                 | 0.5  | —    |                    |
|                  |                               |                                    |  | ICLK = 4 MHz      |                 | 0.1  | —    |                    |
|                  |                               |                                    |  | ICLK = 1 MHz      |                 | 0.1  | —    |                    |
|                  |                               | All peripheral operation: Normal*7 | All peripheral operation: Normal*7       | ICLK = 24 MHz     |                 | 2.6  | —    |                    |
|                  |                               |                                    |  | ICLK = 8 MHz      |                 | 1.3  | —    |                    |
|                  |                               |                                    |  | ICLK = 4 MHz      |                 | 0.9  | —    |                    |
|                  |                               |                                    |  | ICLK = 1 MHz      |                 | 0.7  | —    |                    |
|                  |                               | Increase during flash rewrite*5    |  |                   |                 | 2.1  | —    |                    |
|                  | Middle-speed operating mode 2 | Normal operating mode              | No peripheral operation*8                | ICLK = 1 MHz      |                 | 0.1  | —    |                    |
|                  |                               |                                    | All peripheral operation: Normal*9       | ICLK = 1 MHz      |                 | 0.8  | —    |                    |
|                  |                               |                                    | All peripheral operation: Max.*9         | ICLK = 1 MHz      |                 | —    | 3.0  |                    |
|                  |                               | Sleep mode                         | No peripheral operation*8                | ICLK = 1 MHz      |                 | 0.1  | —    |                    |
|                  |                               |                                    | All peripheral operation: Normal*9       | ICLK = 1 MHz      |                 | 0.7  | —    |                    |
|                  |                               | Deep sleep mode                    | No peripheral operation*8                | ICLK = 1 MHz      |                 | 0.1  | —    |                    |
|                  |                               |                                    | All peripheral operation: Normal*9       | ICLK = 1 MHz      |                 | 0.7  | —    |                    |
|                  |                               | Increase during flash rewrite*5    |  |                   |                 | 1.4  | —    |                    |
|                  | Low-speed operating mode      | Normal operating mode              | No peripheral operation*10               | ICLK = 32.768 kHz |                 | 2.4  | —    | μA                 |
|                  |                               |                                    | All peripheral operation: Normal*11, *12 | ICLK = 32.768 kHz |                 | 7.5  | —    |                    |
|                  |                               |                                    | All peripheral operation: Max. *11, *12  | ICLK = 32.768 kHz |                 | —    | 88.4 |                    |
|                  |                               | Sleep mode                         | No peripheral operation*10               | ICLK = 32.768 kHz |                 | 1.4  | —    |                    |
|                  |                               |                                    | All peripheral operation: Normal*11      | ICLK = 32.768 kHz |                 | 3.8  | —    |                    |
|                  |                               | Deep sleep mode                    | No peripheral operation*10               | ICLK = 32.768 kHz |                 | 1.0  | —    |                    |
|                  |                               |                                    | All peripheral operation: Normal*11      | ICLK = 32.768 kHz |                 | 2.8  | —    |                    |

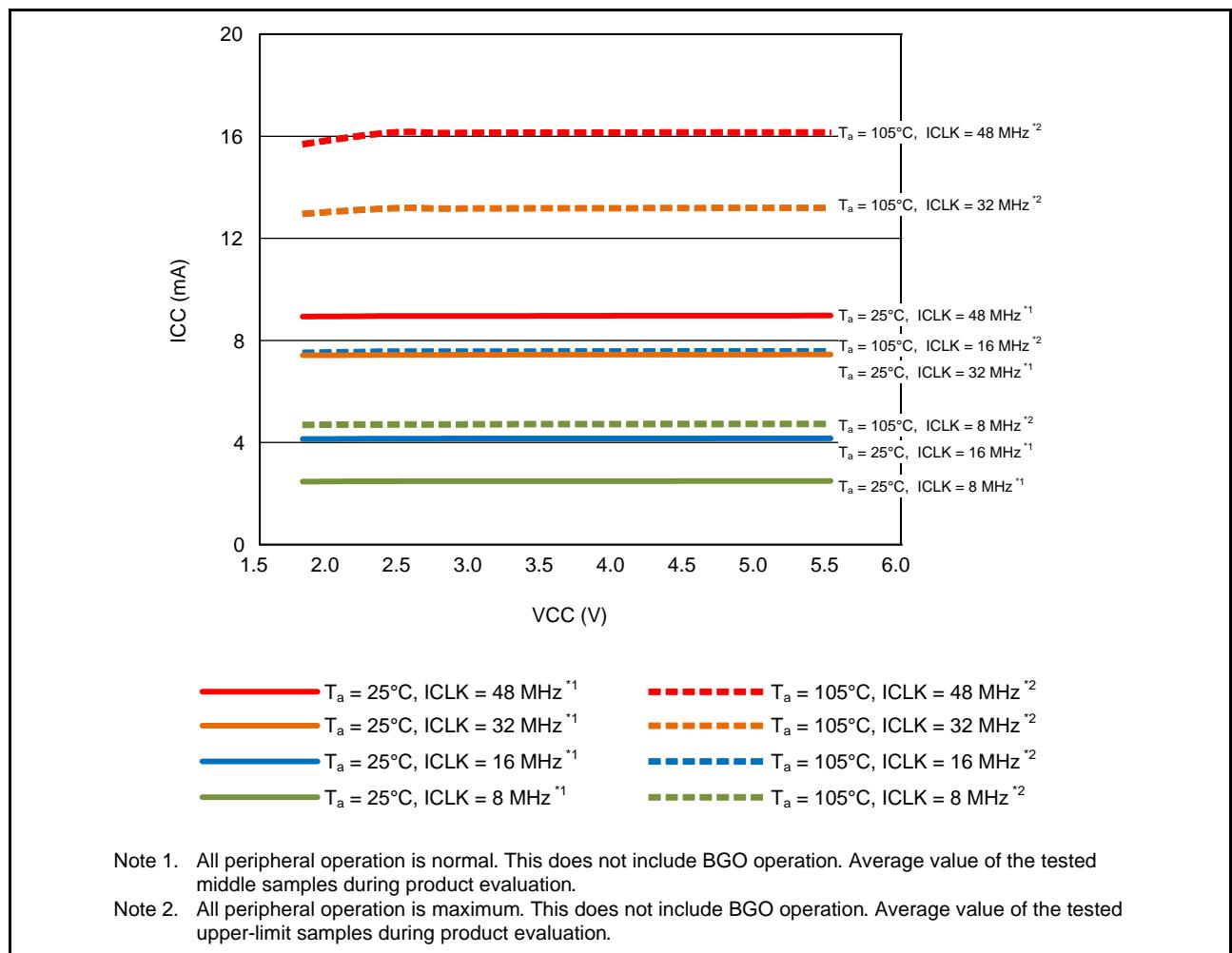
Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.

Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are set to divided by 64.

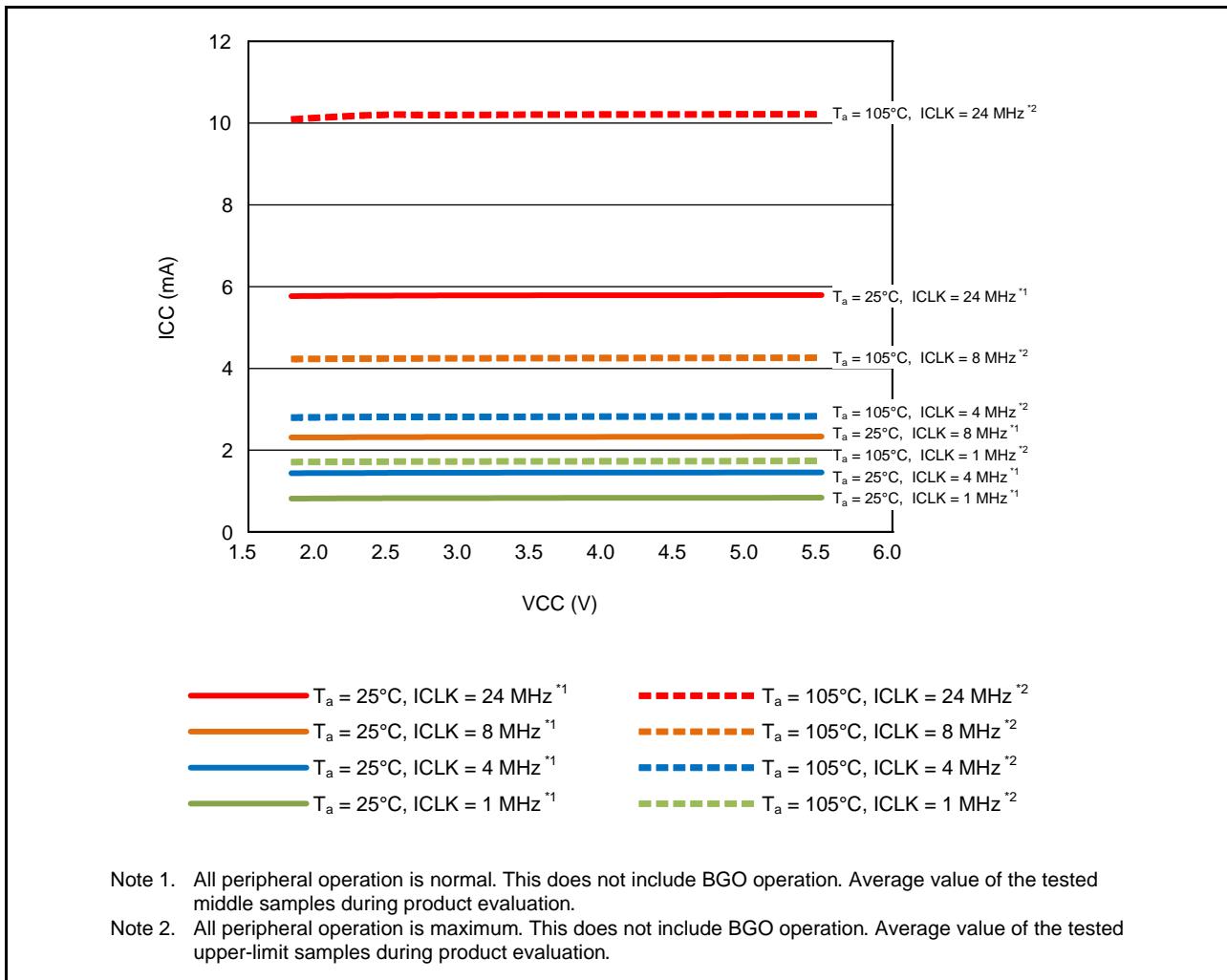
Note 3. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL. FCLK is set to the same frequency as ICLK and PCLK is set to divided by 2 when ICLK is 48 MHz. FCLK and PCLK are set to the same frequency as ICLK when ICLK is 32 MHz or less.

Note 4. Values when VCC = 3.3 V.

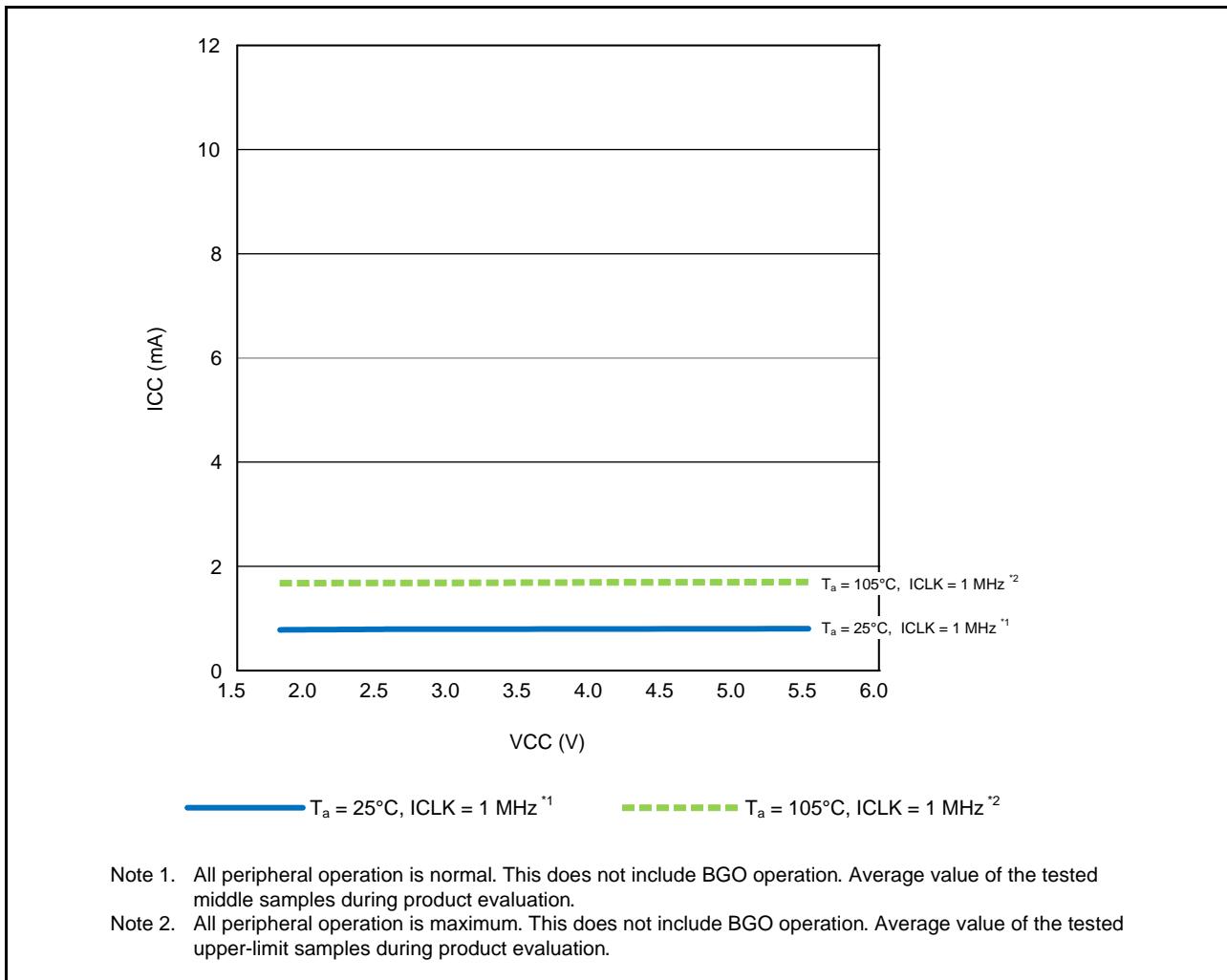
- Note 5. This is the increase for programming or erasure of the ROM or E2 DataFlash during program execution.
- Note 6. Clock supply to the peripheral function is stopped. The clock source is PLL when ICLK is 24 MHz, HOCO when ICLK is 8 MHz, and LOCO otherwise. FCLK and PCLK are set to divided by 64.
- Note 7. Clocks are supplied to the peripheral functions. The clock source is PLL when ICLK is 24 MHz, HOCO when ICLK is (MHz, and LOCO otherwise. FCLK and PCLK are set to the same frequency as ICLK.
- Note 8. Clock supply to the peripheral function is stopped. The clock source is LOCO when ICLK is 1 MHz, FCLK and PCLK are set to divided by 64.
- Note 9. Clocks are supplied to the peripheral functions. The clock source is LOCO when ICLK is 1 MHz, FCLK and PCLK are set to the same frequency as ICLK.
- Note 10. Clock supply to the peripheral functions is stopped. The clock source is the sub-clock oscillator. FCLK and PCLK are set to divided by 64.
- Note 11. Clocks are supplied to the peripheral functions. The clock source is the sub-clock oscillator. FCLK and PCLK are set to the same frequency as ICLK.
- Note 12. Values when the MSTPCRA.MSTPA17 bit (12-bit A/D converter module stop bit) is set to “transition to the module stop state is made”.



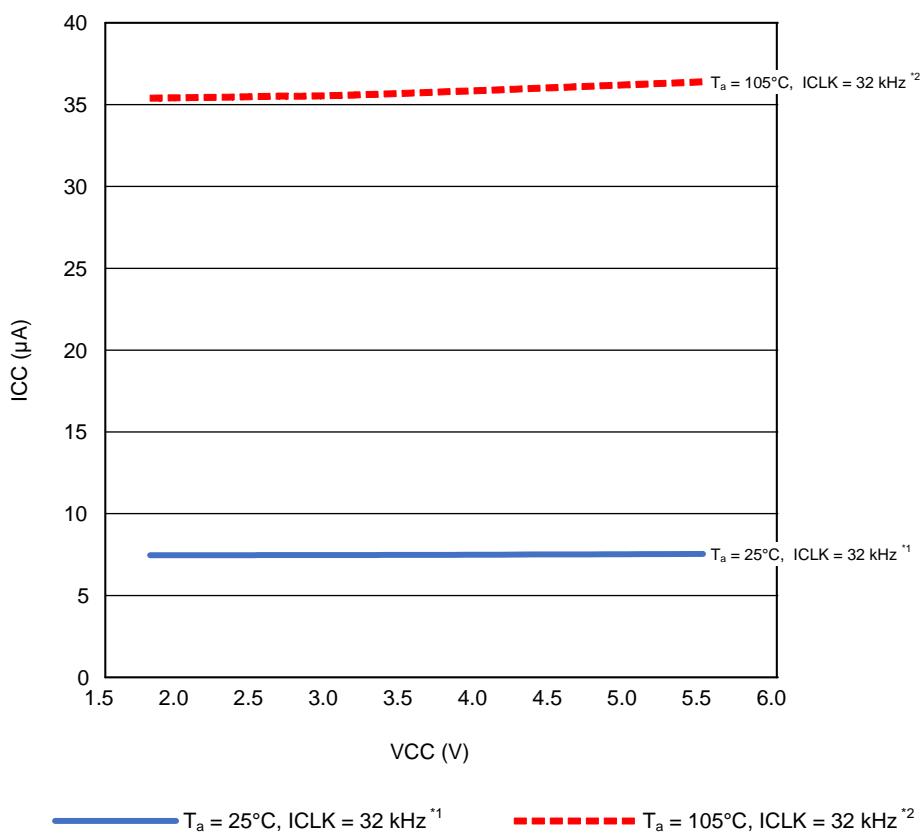
**Figure 2.1** Voltage Dependency in High-Speed Operating Mode (Reference Data for Products with 64-Kbyte ROM)



**Figure 2.2 Voltage Dependency in Middle-Speed Operating Mode (Reference Data for Products with 64-Kbyte ROM)**



**Figure 2.3      Voltage Dependency in Middle-Speed Operating Mode 2 (Reference Data for Products with 64-Kbyte ROM)**



- Note 1. All peripheral operation is normal. This does not include BGO operation. Average value of the tested middle samples during product evaluation.
- Note 2. All peripheral operation is maximum. This does not include BGO operation. Average value of the tested upper-limit samples during product evaluation.

**Figure 2.4      Voltage Dependency in Low-Speed Operating Mode (Reference Data for Products with 64-Kbyte ROM)**

[Products with 128-Kbyte or larger ROM]

**Table 2.9 DC Characteristics (5)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item             |                             |                                    |                                    | Symbol          | Typ.<br>*4      | Max. | Unit | Test<br>Conditions |  |
|------------------|-----------------------------|------------------------------------|------------------------------------|-----------------|-----------------|------|------|--------------------|--|
| Supply current*1 | High-speed operating mode   | Normal operating mode              | No peripheral operation*2          | ICLK = 48 MHz   | I <sub>CC</sub> | 2.6  | —    | mA                 |  |
|                  |                             |                                    |                                    | ICLK = 32 MHz   |                 | 1.9  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 16 MHz   |                 | 1.3  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 1.0  | —    |                    |  |
|                  |                             |                                    | All peripheral operation: Normal*3 | ICLK = 48 MHz   | I <sub>CC</sub> | 10.4 | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 32 MHz   |                 | 8.9  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 16 MHz   |                 | 4.9  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 2.9  | —    |                    |  |
|                  |                             |                                    | All peripheral operation: Max.*3   | ICLK = 48 MHz   | I <sub>CC</sub> | —    | 22.8 |                    |  |
|                  |                             |                                    |                                    | ICLK = 32 MHz   |                 | 1.4  | —    |                    |  |
|                  | Sleep mode                  | No peripheral operation*2          |                                    | ICLK = 16 MHz   | I <sub>CC</sub> | 1.1  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 0.8  | —    |                    |  |
|                  |                             | All peripheral operation: Normal*3 | ICLK = 48 MHz                      | 0.7             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 32 MHz                      | 4.7             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 16 MHz                      | 4.9             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 8 MHz                       | 2.8             |                 | —    |      |                    |  |
|                  |                             |                                    | ICLK = 48 MHz                      | I <sub>CC</sub> | 1.7             | —    |      |                    |  |
|                  |                             |                                    | Deep sleep mode                    |                 | ICLK = 32 MHz   | 1.0  | —    |                    |  |
|                  |                             |                                    |                                    |                 | ICLK = 16 MHz   | 0.8  | —    |                    |  |
|                  |                             |                                    |                                    |                 | ICLK = 8 MHz    | 0.7  | —    |                    |  |
|                  |                             | All peripheral operation: Normal*3 | ICLK = 48 MHz                      |                 | 0.6             | —    |      |                    |  |
|                  |                             |                                    | ICLK = 32 MHz                      |                 | 3.7             | —    |      |                    |  |
|                  |                             |                                    | ICLK = 16 MHz                      |                 | 3.9             | —    |      |                    |  |
|                  |                             |                                    | ICLK = 8 MHz                       |                 | 2.3             | —    |      |                    |  |
|                  |                             |                                    | ICLK = 48 MHz                      |                 | 1.4             | —    |      |                    |  |
|                  | Middle-speed operating mode | Normal operating mode              | No peripheral operation*6          | ICLK = 24 MHz   | I <sub>CC</sub> | 2.1  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | —    | 3.9  |                    |  |
|                  |                             |                                    |                                    | ICLK = 4 MHz    |                 | 1.7  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 1 MHz    |                 | 0.9  | —    |                    |  |
|                  |                             |                                    | All peripheral operation: Normal*7 | ICLK = 24 MHz   | I <sub>CC</sub> | 0.3  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 6.9  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 4 MHz    |                 | 2.8  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 1 MHz    |                 | 1.7  | —    |                    |  |
|                  |                             | All peripheral operation: Max.*7   |                                    | ICLK = 24 MHz   | I <sub>CC</sub> | 0.9  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | —    | 15.4 |                    |  |
|                  |                             |                                    |                                    | ICLK = 4 MHz    |                 | 1.1  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 1 MHz    |                 | 0.7  | —    |                    |  |
|                  |                             | Sleep mode                         | No peripheral operation*6          | ICLK = 24 MHz   | I <sub>CC</sub> | 0.2  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 8 MHz    |                 | 0.2  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 4 MHz    |                 | 0.2  | —    |                    |  |
|                  |                             |                                    |                                    | ICLK = 1 MHz    |                 | 0.2  | —    |                    |  |

| Item             |                               |                                    |  | Symbol            | Typ.<br>*4      | Max. | Unit  | Test<br>Conditions |
|------------------|-------------------------------|------------------------------------|--|-------------------|-----------------|------|-------|--------------------|
| Supply current*1 | Middle-speed operating mode   | Sleep mode                         | All peripheral operation: Normal*7       | ICLK = 24 MHz     | I <sub>CC</sub> | 4.0  | —     | mA                 |
|                  |                               |                                    |  | ICLK = 8 MHz      |                 | 1.8  | —     |                    |
|                  |                               |                                    |  | ICLK = 4 MHz      |                 | 1.2  | —     |                    |
|                  |                               |                                    |  | ICLK = 1 MHz      |                 | 0.8  | —     |                    |
|                  |                               | Deep sleep mode                    | No peripheral operation*6                | ICLK = 24 MHz     |                 | 0.8  | —     |                    |
|                  |                               |                                    |  | ICLK = 8 MHz      |                 | 0.6  | —     |                    |
|                  |                               |                                    |  | ICLK = 4 MHz      |                 | 0.1  | —     |                    |
|                  |                               |                                    |  | ICLK = 1 MHz      |                 | 0.1  | —     |                    |
|                  |                               | All peripheral operation: Normal*7 |  | ICLK = 24 MHz     |                 | 3.2  | —     |                    |
|                  |                               |                                    |  | ICLK = 8 MHz      |                 | 1.5  | —     |                    |
|                  |                               |                                    |  | ICLK = 4 MHz      |                 | 1.0  | —     |                    |
|                  |                               |                                    |  | ICLK = 1 MHz      |                 | 0.7  | —     |                    |
|                  |                               | Increase during flash rewrite*5    |  |                   |                 | 2.1  | —     |                    |
|                  | Middle-speed operating mode 2 | Normal operating mode              | No peripheral operation*8                | ICLK = 1 MHz      |                 | 0.1  | —     |                    |
|                  |                               |                                    | All peripheral operation: Normal*9       | ICLK = 1 MHz      |                 | 0.9  | —     |                    |
|                  |                               |                                    | All peripheral operation: Max.*9         | ICLK = 1 MHz      |                 | —    | 3.3   |                    |
|                  |                               | Sleep mode                         | No peripheral operation*8                | ICLK = 1 MHz      |                 | 0.1  | —     |                    |
|                  |                               |                                    | All peripheral operation: Normal*9       | ICLK = 1 MHz      |                 | 0.7  | —     |                    |
|                  |                               | Deep sleep mode                    | No peripheral operation*8                | ICLK = 1 MHz      |                 | 0.1  | —     |                    |
|                  |                               |                                    | All peripheral operation: Normal*9       | ICLK = 1 MHz      |                 | 0.7  | —     |                    |
|                  |                               | Increase during flash rewrite*5    |  |                   |                 | 1.4  | —     |                    |
|                  | Low-speed operating mode      | Normal operating mode              | No peripheral operation*10               | ICLK = 32.768 kHz | I <sub>CC</sub> | 2.6  | —     | μA                 |
|                  |                               |                                    | All peripheral operation: Normal*11, *12 | ICLK = 32.768 kHz |                 | 9.4  | —     |                    |
|                  |                               |                                    | All peripheral operation: Max. *11, *12  | ICLK = 32.768 kHz |                 | —    | 175.4 |                    |
|                  |                               | Sleep mode                         | No peripheral operation*10               | ICLK = 32.768 kHz |                 | 1.5  | —     |                    |
|                  |                               |                                    | All peripheral operation: Normal*11      | ICLK = 32.768 kHz |                 | 5.1  | —     |                    |
|                  |                               | Deep sleep mode                    | No peripheral operation*10               | ICLK = 32.768 kHz |                 | 1.3  | —     |                    |
|                  |                               |                                    | All peripheral operation: Normal*11      | ICLK = 32.768 kHz |                 | 4.1  | —     |                    |

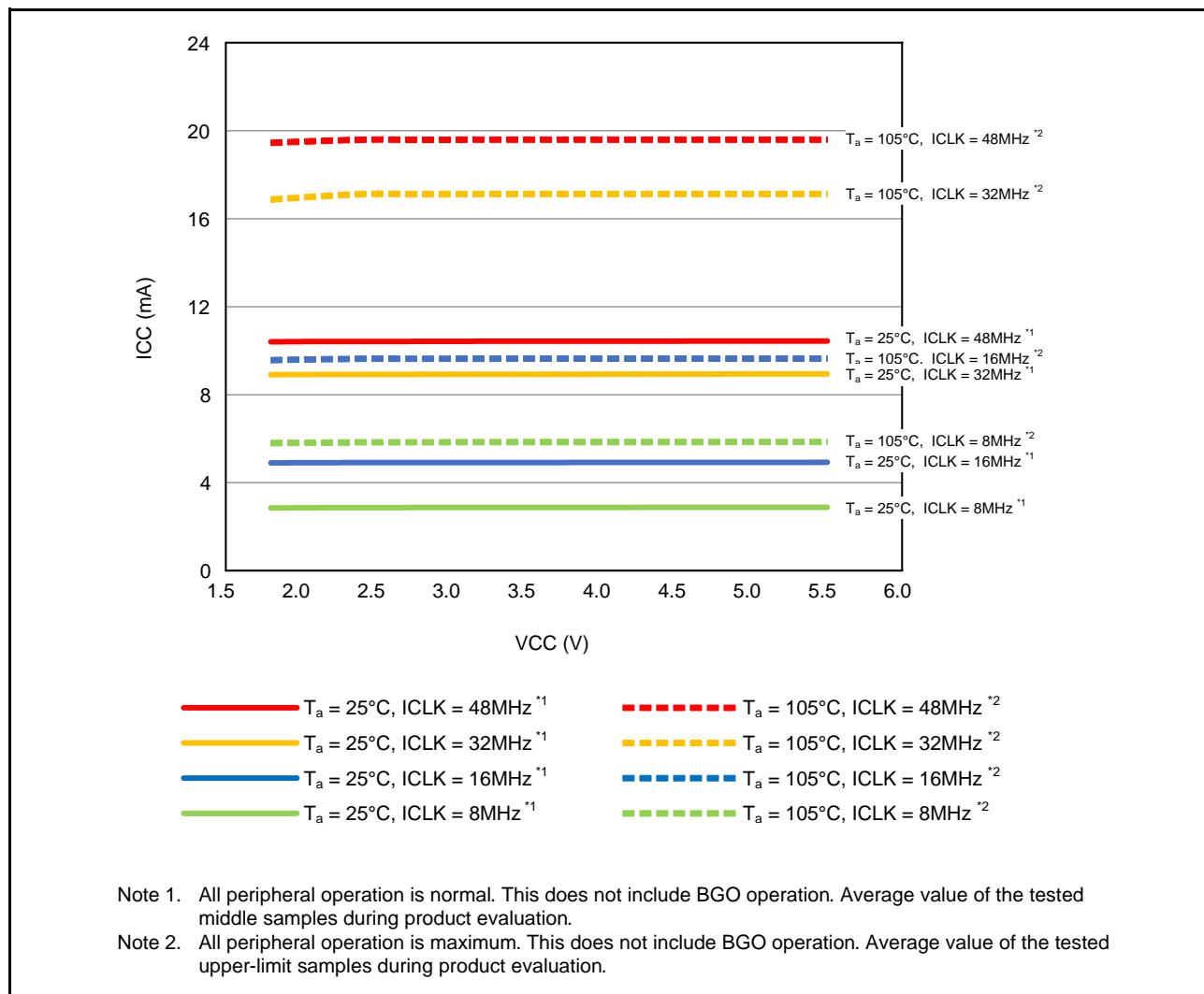
Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.

Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are set to divided by 64.

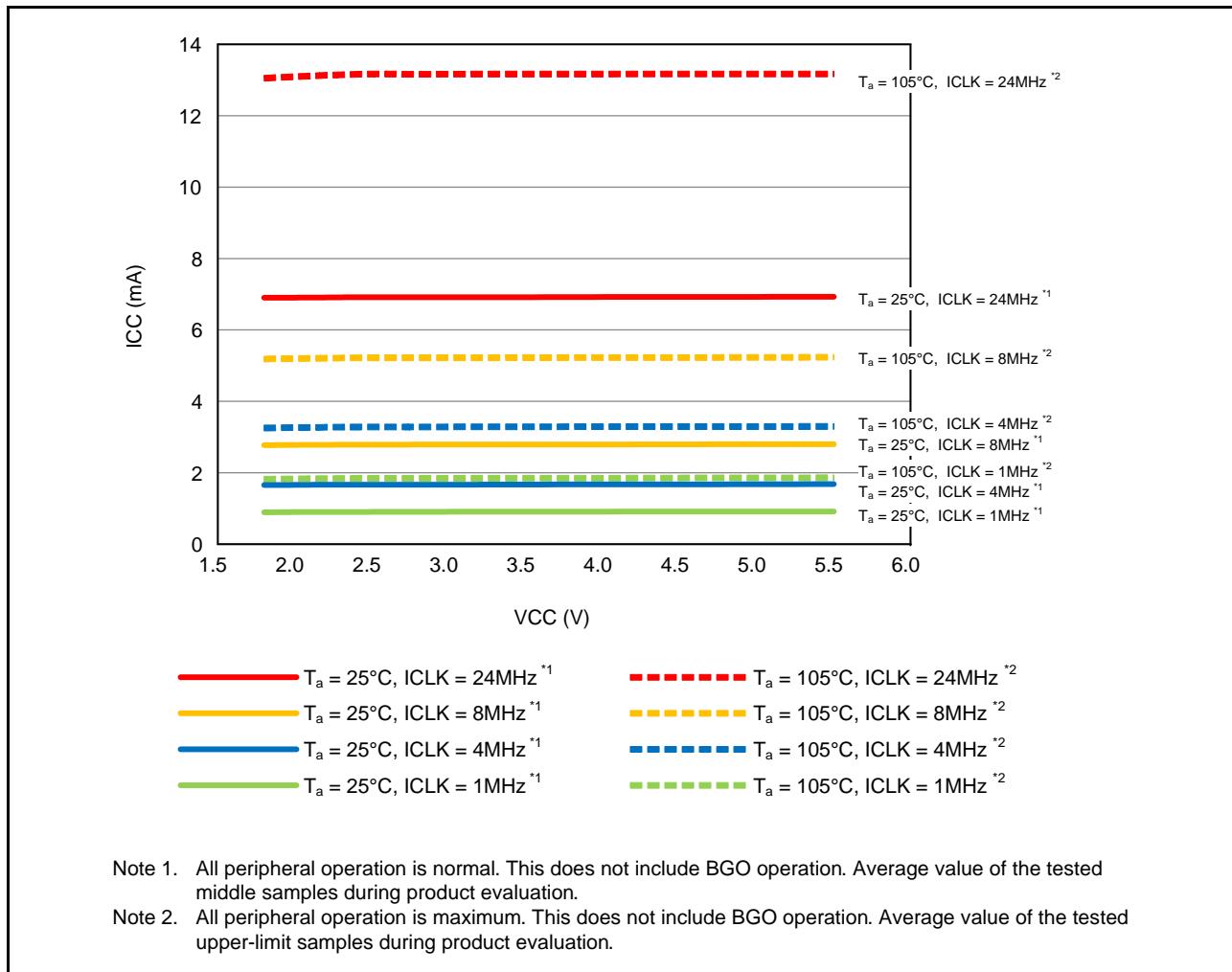
Note 3. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL. FCLK is set to the same frequency as ICLK and PCLK is set to divided by 2 when ICLK is 48 MHz. FCLK and PCLK are set to the same frequency as ICLK when ICLK is 32 MHz or less.

Note 4. Values when VCC = 3.3 V.

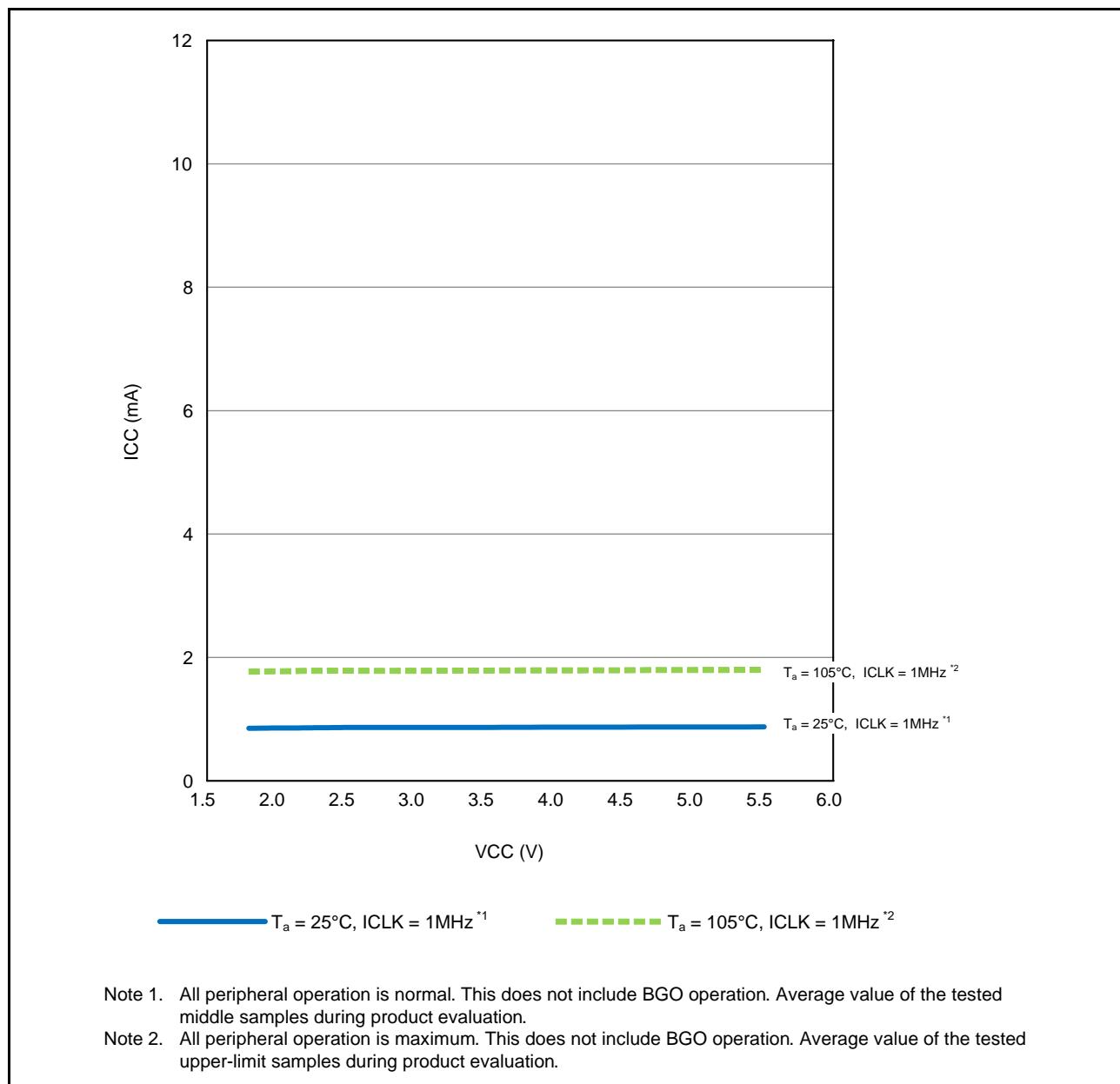
- Note 5. This is the increase for programming or erasure of the ROM or E2 DataFlash during program execution.
- Note 6. Clock supply to the peripheral function is stopped. The clock source is PLL when ICLK is 24 MHz, HOCO when ICLK is 8 MHz, and LOCO otherwise. FCLK and PCLK are set to divided by 64.
- Note 7. Clocks are supplied to the peripheral functions. The clock source is PLL when ICLK is 24 MHz, HOCO when ICLK is (MHz, and LOCO otherwise. FCLK and PCLK are set to the same frequency as ICLK.
- Note 8. Clock supply to the peripheral function is stopped. The clock source is LOCO when ICLK is 1 MHz, FCLK and PCLK are set to divided by 64.
- Note 9. Clocks are supplied to the peripheral functions. The clock source is LOCO when ICLK is 1 MHz, FCLK and PCLK are set to the same frequency as ICLK.
- Note 10. Clock supply to the peripheral functions is stopped. The clock source is the sub-clock oscillator. FCLK and PCLK are set to divided by 64.
- Note 11. Clocks are supplied to the peripheral functions. The clock source is the sub-clock oscillator. FCLK and PCLK are set to the same frequency as ICLK.
- Note 12. Values when the MSTPCRA.MSTPA17 bit (12-bit A/D converter module stop bit) is set to "transition to the module stop state is made".



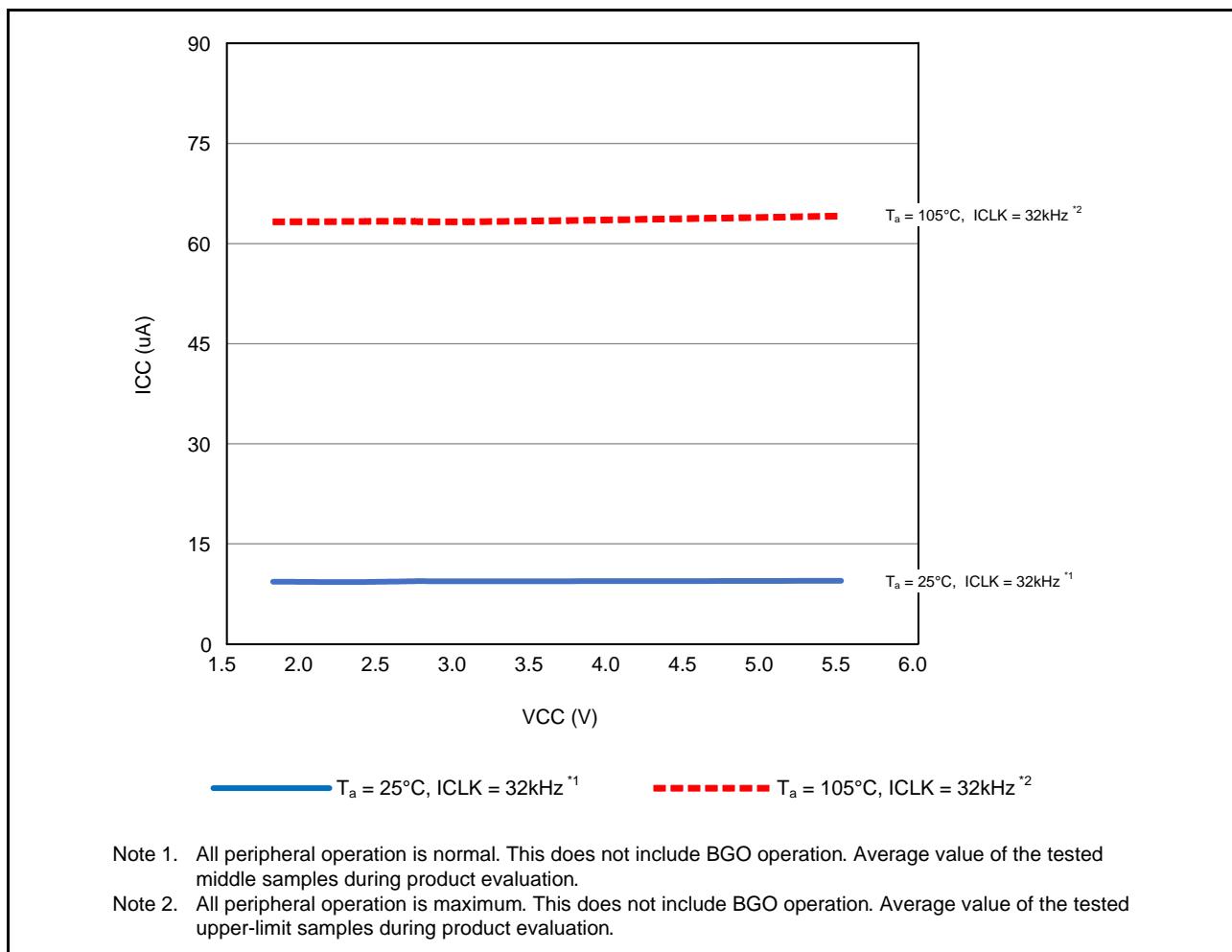
**Figure 2.5 Voltage Dependency in High-Speed Operating Mode (Reference Data for Products with 128-Kbyte or Larger ROM)**



**Figure 2.6 Voltage Dependency in Middle-Speed Operating Mode (Reference Data for Products with 128-Kbyte or Larger ROM)**



**Figure 2.7      Voltage Dependency in Middle-Speed Operating Mode 2 (Reference Data for Products with 128-Kbyte or Larger ROM)**



**Figure 2.8      Voltage Dependency in Low-Speed Operating Mode (Reference Data for Products with 128-Kbyte or Larger ROM)**

[Products with 64-Kbyte ROM]

**Table 2.10 DC Characteristics (6)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

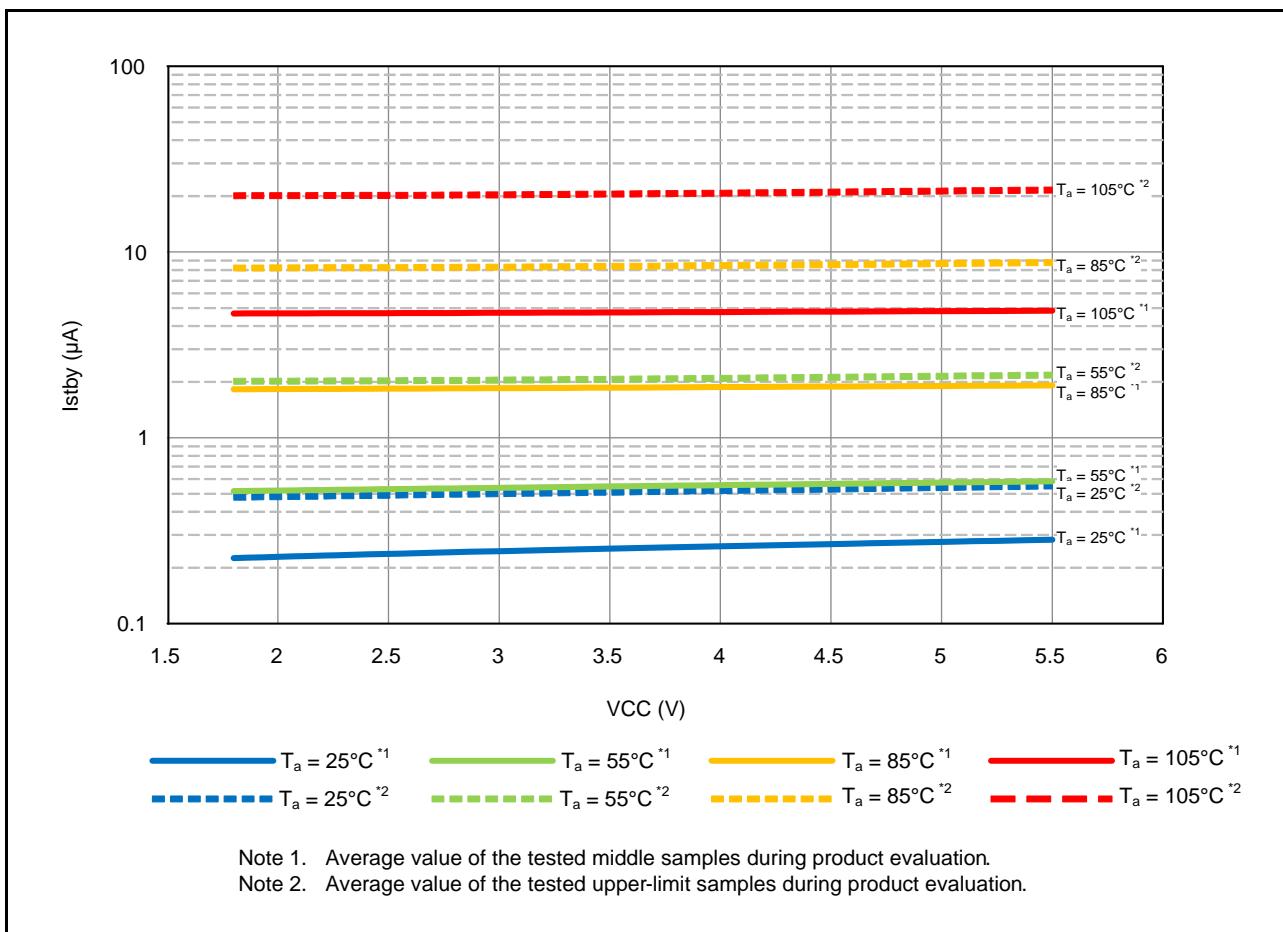
| Item                         |  | Symbol          | Typ.* <sup>3</sup> | Max.  | Unit | Test Conditions  |  |
|------------------------------|--|-----------------|--------------------|-------|------|--|--|
| Supply current* <sup>1</sup> | Software standby mode* <sup>2</sup>                | I <sub>CC</sub> | 0.25               | 1.56  | μA   |  |  |
|                              |  |                 | 0.54               | 4.66  |      |  |  |
|                              |  |                 | 1.86               | 18.09 |      |  |  |
|                              |  |                 | 4.72               | 43.74 |      |  |  |
|                              | Increment for RTC operation* <sup>4</sup>          |                 | 0.97               | —     |      | SOMCR.SODRV[1:0] set to drive capacity for standard CL     |  |
|                              |  |                 | 0.52               | —     |      | SOMCR.SODRV[1:0] set to high drive capacity for low CL     |  |
|                              |  |                 | 0.27               | —     |      | SOMCR.SODRV[1:0] set to middle drive capacity for low CL   |  |
|                              |  |                 | 0.17               | —     |      | SOMCR.SODRV[1:0] set to low drive capacity for low CL      |  |
|                              |  |                 | 0.28               | —     |      | LPTCR1.LPCNTCKSEL set to IWDT-dedicated on-chip oscillator |  |
|                              |  |                 | 15.97              | —     |      | LPTCR1.LPCNTCKSEL 2 set to Low-speed on-chip oscillator    |  |
|                              | Increment for independent watchdog timer operation |                 | 0.26               | —     |      |  |  |

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.

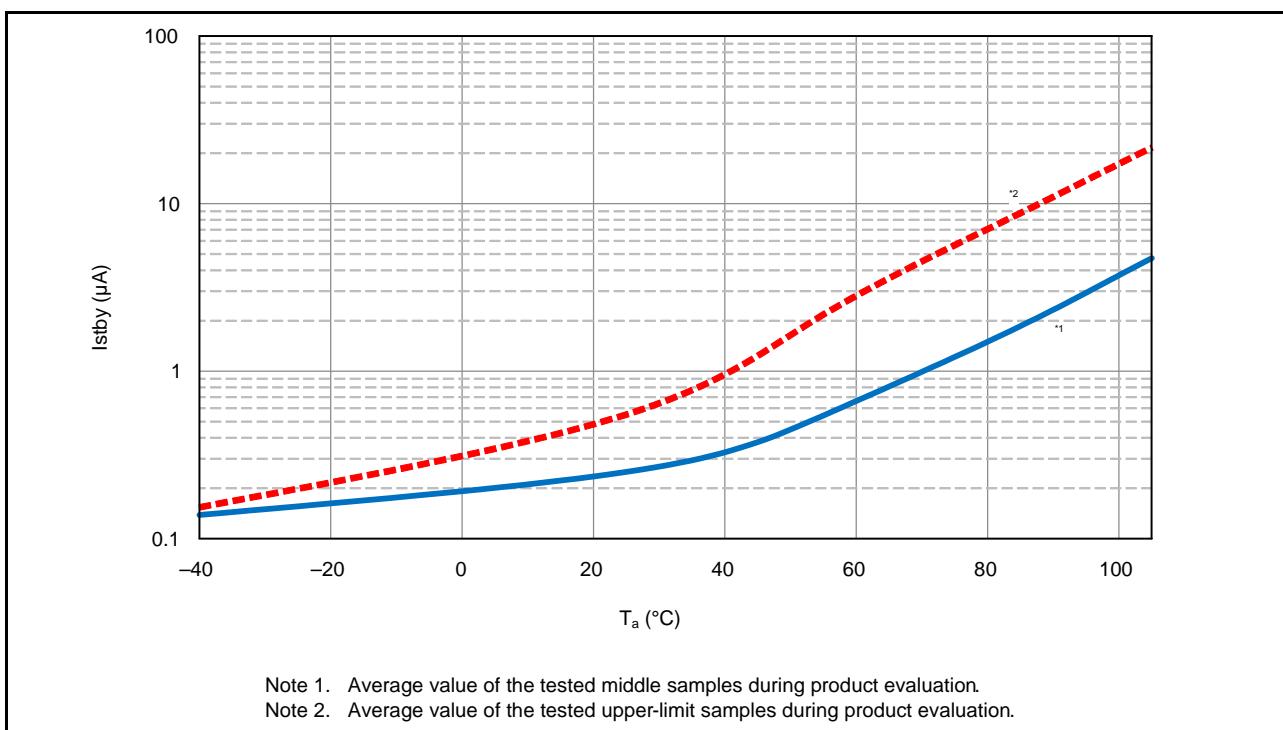
Note 2. The IWDT, LVD, and CMPB are stopped.

Note 3. VCC = 3.3 V.

Note 4. Includes the oscillation circuit.



**Figure 2.9** Voltage Dependency in Software Standby Mode (Reference Data for Products with 64-Kbyte ROM)



**Figure 2.10** Temperature Dependency in Software Standby Mode (Reference Data for Products with 64-Kbyte ROM)

[Products with 128-Kbyte or larger ROM]

**Table 2.11 DC Characteristics (6)**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

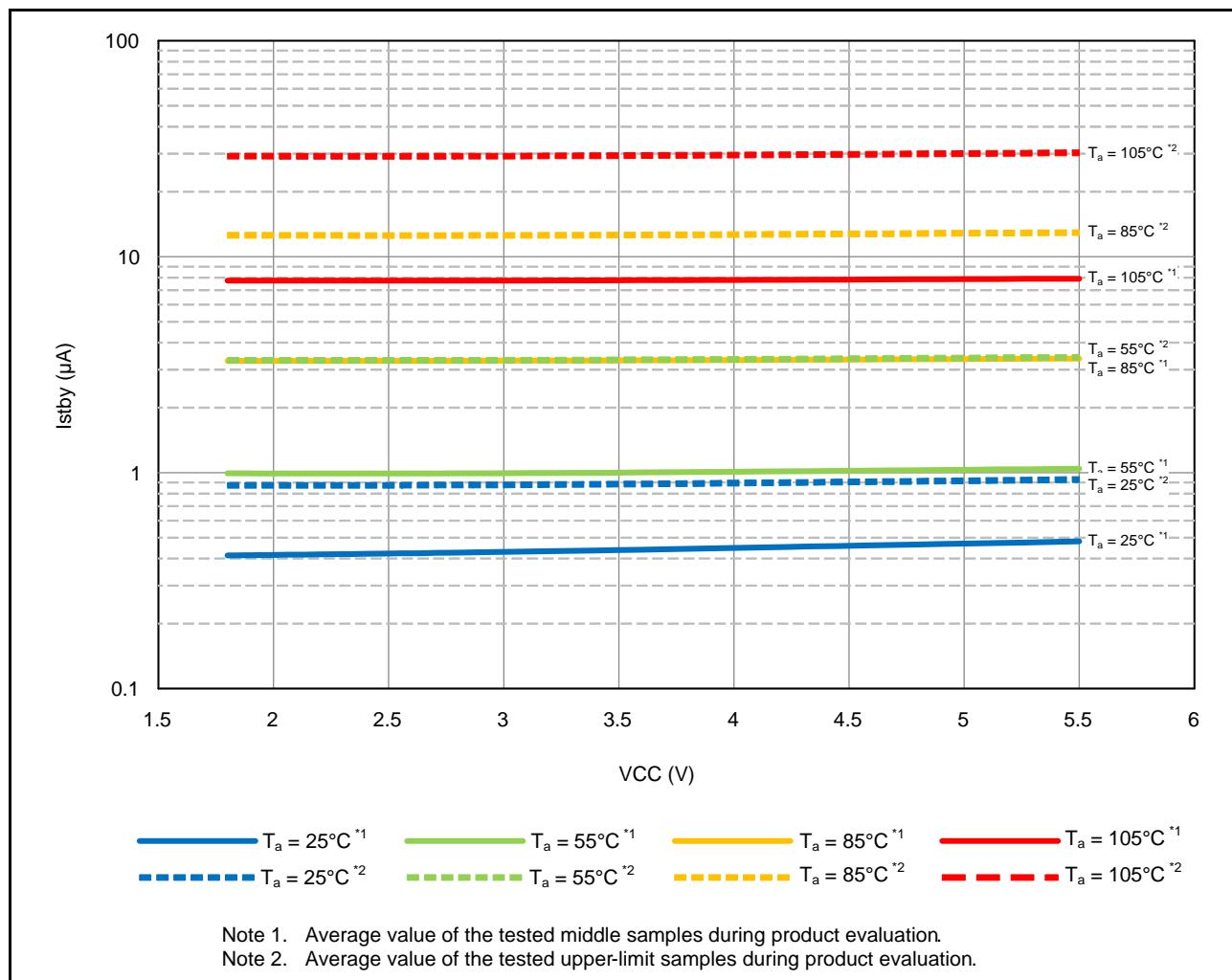
| Item                         |  |                           | Symbol   | Typ.* <sup>3</sup> | Max.  |               | Test Conditions  |  |
|------------------------------|--|---------------------------|----------|--------------------|-------|---------------|--|--|
| Supply current* <sup>1</sup> | Software standby mode* <sup>2</sup>                | $T_a = 25^\circ\text{C}$  | $I_{CC}$ | 0.43               | 2.07  | $\mu\text{A}$ |  |  |
|                              |  | $T_a = 55^\circ\text{C}$  |          | 1.00               | 8.46  |               |  |  |
|                              |  | $T_a = 85^\circ\text{C}$  |          | 3.30               | 31.14 |               |  |  |
|                              |  | $T_a = 105^\circ\text{C}$ |          | 7.76               | 71.36 |               |  |  |
|                              | Increment for RTC operation* <sup>4</sup>          |                           |          | 0.99               | —     |               | SOMCR.SODRV[1:0] set to drive capacity for standard CL     |  |
|                              |  |                           |          | 0.55               | —     |               | SOMCR.SODRV[1:0] set to high drive capacity for low CL     |  |
|                              |  |                           |          | 0.32               | —     |               | SOMCR.SODRV[1:0] set to middle drive capacity for low CL   |  |
|                              |  |                           |          | 0.22               | —     |               | SOMCR.SODRV[1:0] set to low drive capacity for low CL      |  |
|                              | Increment for low-power timer operation            |                           |          | 0.33               | —     |               | LPTCR1.LPCNTCKSEL set to IWDT-dedicated on-chip oscillator |  |
|                              |  |                           |          | 15.89              | —     |               | LPTCR1.LPCNTCKSEL 2 set to Low-speed on-chip oscillator    |  |
|                              | Increment for independent watchdog timer operation |                           |          | 0.32               | —     |               |  |  |

Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.

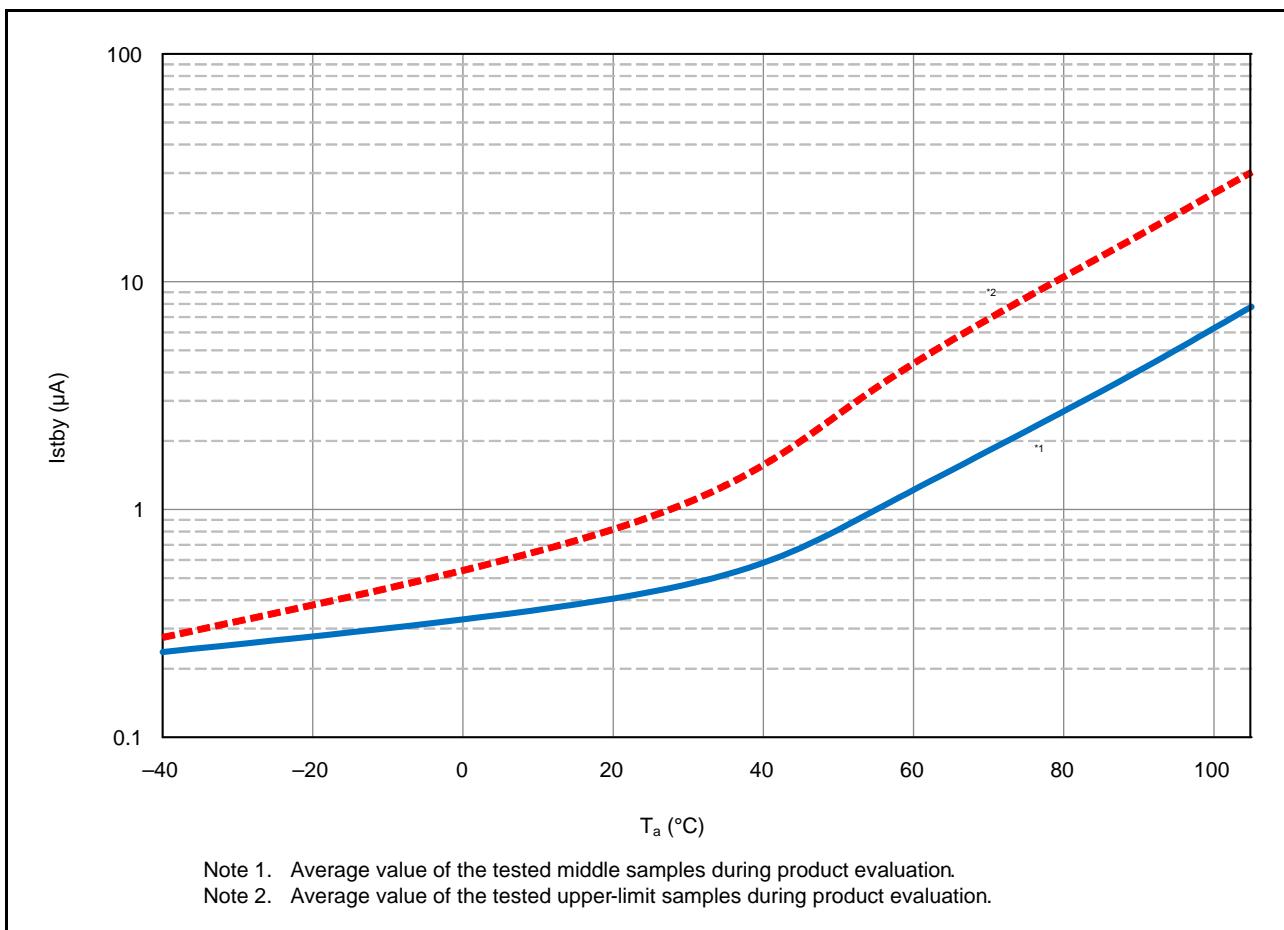
Note 2. The IWDT, LVD, and CMPB are stopped.

Note 3.  $\text{VCC} = 3.3 \text{ V}$ .

Note 4. Includes the oscillation circuit.



**Figure 2.11 Voltage Dependency in Software Standby Mode (Reference Data for Products with 128-Kbyte or Larger ROM)**



**Figure 2.12 Temperature Dependency in Software Standby Mode (Reference Data for Products with 128-Kbyte or Larger ROM)**

**Table 2.12 DC Characteristics (7)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item   |   | Symbol                | Min. | Typ.* <sup>4</sup> | Max. | Unit          | Test Conditions |
|--|---|-----------------------|------|--------------------|------|---------------|-----------------|
| Analog power supply current                  | During A/D conversion (at high-speed conversion)  | $I_{\text{AVCC}}$     | —    | 0.6                | 1.3  | mA            |                 |
|  | During A/D conversion (at low-speed conversion)   |                       | —    | 0.3                | 0.7  |               |                 |
|  | During D/A conversion (per channel)* <sup>1</sup> |                       | —    | —                  | 0.5  |               |                 |
|  | Waiting for A/D and D/A conversion                |                       | —    | —                  | 2.0  | $\mu\text{A}$ |                 |
| Reference power supply current               | During A/D conversion (at high-speed conversion)  | $I_{\text{REFH0}}$    | —    | 49.6               | 120  | $\mu\text{A}$ |                 |
|  | Waiting for A/D conversion                        |                       | —    | —                  | 0.3  | nA            |                 |
| LVD0   | —   | $I_{\text{LVD}}$      | —    | 0.04               | —    | $\mu\text{A}$ |                 |
| LVD1, 2                                      | Per channel                                       |                       | —    | 0.12               | —    | $\mu\text{A}$ |                 |
| Temperature sensor* <sup>3</sup>             | —   | $I_{\text{TEMP}}$     | —    | 120                | —    | $\mu\text{A}$ |                 |
| Comparator B operating current* <sup>3</sup> | Window function enabled                           | $I_{\text{CMP}}^{*2}$ | —    | 7.5                | 12.5 | $\mu\text{A}$ |                 |
|  | Comparator high-speed mode (per channel)          |                       | —    | 5.0                | 10.0 | $\mu\text{A}$ |                 |
|  | Comparator low-speed mode (per channel)           |                       | —    | 1.5                | 3.0  | $\mu\text{A}$ |                 |

Note 1. The value of the D/A converter is the value of the power supply current including the reference current.

Note 2. Current consumed only by the comparator B module.

Note 3. IC current consumed by the power supply (VCC).

Note 4. When  $\text{VCC} = \text{AVCC0} = 3.3 \text{ V}$ .**Table 2.13 DC Characteristics (8)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                | Symbol           | Min. | Typ. | Max. | Unit | Test Conditions |  |
|---------------------|------------------|------|------|------|------|-----------------|--|
| RAM standby voltage | $V_{\text{RAM}}$ | 1.8  | —    | —    | V    |                 |  |

**Table 2.14 DC Characteristics (9)**Conditions:  $0 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $0 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                         |   | Symbol            | Min. | Typ. | Max. | Unit | Test Conditions |
|------------------------------|---|-------------------|------|------|------|------|-----------------|
| Power-on VCC rising gradient | At normal startup* <sup>1</sup>                                 | $S_{\text{rVCC}}$ | 0.02 | —    | 20   | ms/V |                 |
|                              | During fast startup time* <sup>2</sup>                          |                   | 0.02 | —    | 2    |      |                 |
|                              | Voltage monitoring 0 reset enabled at startup* <sup>3, *4</sup> |                   | 0.02 | —    | —    |      |                 |

Note 1. When  $\text{OFS1.(FASTSTUP, LVDAS)} = 11\text{b}$ .Note 2. When  $\text{OFS1.(FASTSTUP, LVDAS)} = 01\text{b}$ .Note 3. When  $\text{OFS1.LVDAS} = 0$ .

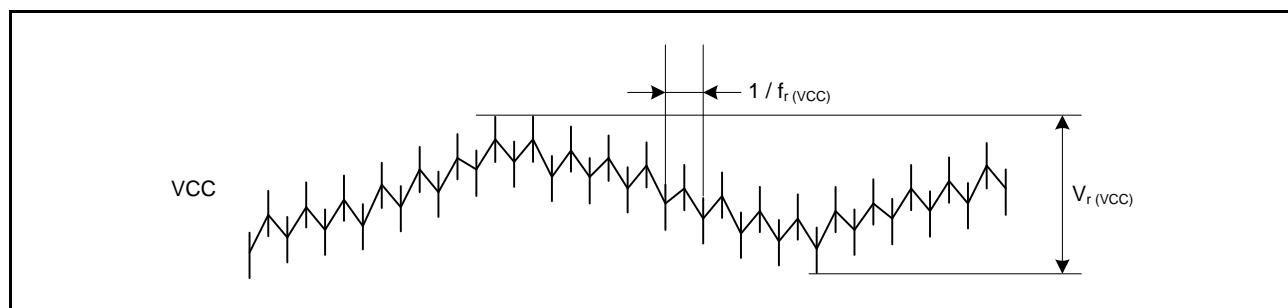
Note 4. Turn on the power supply voltage according to the normal startup rising gradient because the register settings set by OFS1 are not read in boot mode.

**Table 2.15 DC Characteristics (10)**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC}_0 \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS}_0 = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

The ripple voltage must meet the allowable ripple frequency  $f_r(\text{VCC})$  within the range between the VCC upper limit and lower limit. When VCC change exceeds  $\text{VCC} \pm 10\%$ , the allowable voltage change rising/falling gradient  $dt/d\text{VCC}$  must be met.

| Item   | Symbol            | Min. | Typ. | Max. | Unit | Test Conditions  |
|--|-------------------|------|------|------|------|--|
| Allowable ripple frequency                       | $f_r(\text{VCC})$ | —    | —    | 10   | kHz  | Figure 2.13<br>$V_r(\text{VCC}) \leq 0.2 \times \text{VCC}$  |
|  |                   | —    | —    | 1    | MHz  | Figure 2.13<br>$V_r(\text{VCC}) \leq 0.08 \times \text{VCC}$ |
|  |                   | —    | —    | 10   | MHz  | Figure 2.13<br>$V_r(\text{VCC}) \leq 0.06 \times \text{VCC}$ |
| Allowable voltage change rising/falling gradient | $dt/d\text{VCC}$  | 1.0  | —    | —    | ms/V | When $\text{VCC}$ change exceeds $\text{VCC} \pm 10\%$       |

**Figure 2.13 Ripple Waveform**

**Table 2.16 Permissible Output Currents (1)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +85^\circ\text{C}$ 

| Item  | Symbol          | Max. | Unit |
|---|-----------------|------|------|
| Permissible output low current<br>(average value per pin)<br><br>P03 to P07,<br>P40 to P47,<br>PJ6, PJ7 | $I_{OL}$        | 8.0  | mA   |
| Ports other than above  |                 | 8.0  |      |
| Permissible output low current<br>(maximum value per pin)<br><br>P03 to P07,<br>P40 to P47,<br>PJ6, PJ7 | $I_{OL}$        | 8.0  | mA   |
| Ports other than above  |                 | 8.0  |      |
| Permissible output low current<br><br>Total of P03 to P07,<br>P40 to P47,<br>PJ6, PJ7                   | $\Sigma I_{OL}$ | 40   | mA   |
| Total of P12 to P17,<br>P20, P21, P26 to P27,<br>P30 to P32, P34 to P37,<br>PG7, PH2, PH3,<br>PJ1       |                 | 40   |      |
| Total of P54, P55,<br>PB0 to PB7,<br>PC2 to PC7,<br>PH0, PH1  |                 | 40   |      |
| Total of PA0 to PA6,<br>PD0 to PD2,<br>PE0 to PE5   |                 | 40   |      |
| Total of all output pins  |                 | 80   |      |
| Permissible output high current<br>(average value per pin)<br><br>P03 to P07,<br>P40 to P47, PJ6, PJ7   | $I_{OH}$        | -4.0 | mA   |
| Ports other than above  |                 | -4.0 |      |
| Permissible output high current<br>(maximum value per pin)<br><br>P03 to P07,<br>P40 to P47, PJ6, PJ7   | $I_{OH}$        | -4.0 | mA   |
| Ports other than above  |                 | -4.0 |      |
| Permissible output high current<br><br>Total of P03 to P07,<br>P40 to P47,<br>PJ6, PJ7                  | $\Sigma I_{OH}$ | -40  | mA   |
| Total of P12 to P17,<br>P20, P21, P26 to P27,<br>P30 to P32, P34 to P37,<br>PG7, PH2, PH3,<br>PJ1       |                 | -40  |      |
| Total of P54, P55,<br>PB0 to PB7,<br>PC2 to PC7,<br>PH0, PH1  |                 | -40  |      |
| Total of PA0 to PA6,<br>PD0 to PD2,<br>PE0 to PE5   |                 | -40  |      |
| Total of all output pins  |                 | -80  |      |

Note: Do not exceed the permissible total supply current.

**Table 2.17 Permissible Output Currents (2)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item  | Symbol          | Max. | Unit |
|---|-----------------|------|------|
| Permissible output low current<br>(average value per pin)   | $I_{OL}$        | 8.0  | mA   |
| Ports other than above  |                 | 8.0  |      |
| Permissible output low current<br>(maximum value per pin)   | $I_{OL}$        | 8.0  | mA   |
| Ports other than above  |                 | 8.0  |      |
| Permissible output low current  | $\Sigma I_{OL}$ | 30   | mA   |
| Total of P03 to P07,<br>P40 to P47,<br>PJ6, PJ7   |                 | 30   |      |
| Total of P12 to P17,<br>P20, P21, P26 to P27,<br>P30 to P32, P34 to P37,<br>PG7, PH2, PH3,<br>PJ1 |                 | 30   |      |
| Total of P54, P55,<br>PB0 to PB7,<br>PC2 to PC7,<br>PH0, PH1                                      |                 | 30   |      |
| Total of PA0 to PA6,<br>PD0 to PD2,<br>PE0 to PE5   |                 | 30   |      |
| Total of all output pins  |                 | 60   |      |
| Permissible output high current<br>(average value per pin)  | $I_{OH}$        | -4.0 | mA   |
| Ports other than above  |                 | -4.0 |      |
| Permissible output high current<br>(maximum value per pin)  | $I_{OH}$        | -4.0 | mA   |
| Ports other than above  |                 | -4.0 |      |
| Permissible output high current   | $\Sigma I_{OH}$ | -30  | mA   |
| Total of P03 to P07,<br>P40 to P47,<br>PJ6, PJ7   |                 | -30  |      |
| Total of P12 to P17,<br>P20, P21, P26 to P27,<br>P30 to P32, P34 to P37,<br>PG7, PH2, PH3,<br>PJ1 |                 | -30  |      |
| Total of P54, P55,<br>PB0 to PB7,<br>PC2 to PC7,<br>PH0, PH1                                      |                 | -30  |      |
| Total of PA0 to PA6,<br>PD0 to PD2,<br>PE0 to PE5   |                 | -30  |      |
| Total of all output pins  |                 | -60  |      |

Note: Do not exceed the permissible total supply current.

**Table 2.18 Output Values of Voltage (1)**Conditions:  $1.8 \text{ V} \leq \text{VCC} < 2.7 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} < 2.7 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item        |   | Symbol   | Min.                 | Max. | Unit | Test Conditions            |
|-------------|---|----------|----------------------|------|------|----------------------------|
| Output low  | All output ports (except for RIIC)                      | $V_{OL}$ | —                    | 0.3  | V    | $I_{OL} = 1.0 \text{ mA}$  |
| Output high | All output ports<br>P03 to P07, P40 to P47,<br>PJ6, PJ7 | $V_{OH}$ | $\text{AVCC0} - 0.3$ | —    | V    | $I_{OH} = -0.5 \text{ mA}$ |
|             |   |          | $\text{VCC} - 0.3$   | —    | V    |                            |

**Table 2.19 Output Values of Voltage (2)**Conditions:  $2.7 \text{ V} \leq \text{VCC} < 4.0 \text{ V}$ ,  $2.7 \text{ V} \leq \text{AVCC0} < 4.0 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item        |   | Symbol   | Min.                 | Max. | Unit | Test Conditions            |
|-------------|---|----------|----------------------|------|------|----------------------------|
| Output low  | All output ports (except for RIIC)                      | $V_{OL}$ | —                    | 0.5  | V    | $I_{OL} = 2.0 \text{ mA}$  |
|             |   |          | —                    | 0.6  |      | $I_{OL} = 6.0 \text{ mA}$  |
| Output high | All output ports<br>P03 to P07, P40 to P47,<br>PJ6, PJ7 | $V_{OH}$ | $\text{AVCC0} - 0.5$ | —    | V    | $I_{OH} = -1.0 \text{ mA}$ |
|             |   |          | $\text{VCC} - 0.5$   | —    |      |                            |

**Table 2.20 Output Values of Voltage (3)**Conditions:  $4.0 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $4.0 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item        |   | Symbol   | Min.                 | Max. | Unit | Test Conditions            |
|-------------|---|----------|----------------------|------|------|----------------------------|
| Output low  | All output ports (except for RIIC)                      | $V_{OL}$ | —                    | 0.8  | V    | $I_{OL} = 4.0 \text{ mA}$  |
|             |   |          | —                    | 0.6  |      | $I_{OL} = 6.0 \text{ mA}$  |
| Output high | All output ports<br>P03 to P07, P40 to P47,<br>PJ6, PJ7 | $V_{OH}$ | $\text{AVCC0} - 0.8$ | —    | V    | $I_{OH} = -2.0 \text{ mA}$ |
|             |   |          | $\text{VCC} - 0.8$   | —    |      |                            |

**Table 2.21 Thermal Resistance Value (Reference Values)**

| Item               | Package                     | Symbol        | Min. | Typ. | Max.                | Unit                      | Test Conditions                 |
|--------------------|-----------------------------|---------------|------|------|---------------------|---------------------------|---------------------------------|
| Thermal resistance | 80-pin LFQFP (PLQP0080KB-B) | $\theta_{ja}$ | —    | —    | 52.60               | $^\circ\text{C}/\text{W}$ | JESD51-2 and JESD51-7 compliant |
|                    | 64-pin LFQFP (PLQP0064KB-C) |               | —    | —    | 54.70               |                           |                                 |
|                    | 64-pin LQFP (PLQP0064GA-A)  |               | —    | —    | 54.30               |                           |                                 |
|                    | 48-pin LFQFP (PLQP0048KB-B) |               | —    | —    | 63.50               |                           |                                 |
|                    | 48-pin HWQFN (PWQN0048KC-A) |               | —    | —    | 21.20* <sup>1</sup> |                           |                                 |
|                    | 32-pin LQFP (PLQP0032GB-A)  |               | —    | —    | 62.20               |                           |                                 |
|                    | 32-pin HWQFN (PWQN0032KE-A) |               | —    | —    | 23.60* <sup>1</sup> |                           |                                 |
|                    | 80-pin LFQFP (PLQP0080KB-B) | $\Psi_{jt}$   | —    | —    | 1.54                |                           |                                 |
|                    | 64-pin LFQFP (PLQP0064KB-C) |               | —    | —    | 2.29                |                           |                                 |
|                    | 64-pin LQFP (PLQP0064GA-A)  |               | —    | —    | 2.29                |                           |                                 |
|                    | 48-pin LFQFP (PLQP0048KB-B) |               | —    | —    | 2.78                |                           |                                 |
|                    | 48-pin HWQFN (PWQN0048KC-A) |               | —    | —    | 0.21* <sup>1</sup>  |                           |                                 |
|                    | 32-pin LQFP (PLQP0032GB-A)  |               | —    | —    | 2.78                |                           |                                 |
|                    | 32-pin HWQFN (PWQN0032KE-A) |               | —    | —    | 0.23* <sup>1</sup>  |                           |                                 |

Note: The values are reference values when the 4-layer board is used. Thermal resistance depends on the number of layers or size of the board. For details, refer to the JEDEC standards.

Note 1. This value applies when the exposed die pad for this purpose is connected to VSS.

## 2.4 Normal I/O Pin Output Characteristics

**Table 2.22 Normal I/O Pin VOH Voltage Characteristics (Reference Values)**Conditions: VCC = AVCC0 = 2.0 V, VSS = AVSS0 = 0 V, T<sub>a</sub> = 25°C

| Item                      |                 | Symbol          | Min. | Typ.       | Max. | Unit | Test Conditions           |
|---------------------------|-----------------|-----------------|------|------------|------|------|---------------------------|
| Output high level voltage | All output pins | V <sub>OH</sub> | —    | VCC – 0.05 | —    | V    | I <sub>OH</sub> = –0.5 mA |
|                           |                 |                 | —    | VCC – 0.09 | —    |      | I <sub>OH</sub> = –1.0 mA |
|                           |                 |                 | —    | VCC – 0.20 | —    |      | I <sub>OH</sub> = –2.0 mA |
|                           |                 |                 | —    | VCC – 0.49 | —    |      | I <sub>OH</sub> = –4.0 mA |

**Table 2.23 Normal I/O Pin VOH Voltage Characteristics (Reference Values)**Conditions: VCC = AVCC0 = 3.3 V, VSS = AVSS0 = 0 V, T<sub>a</sub> = 25°C

| Item                      |                 | Symbol          | Min. | Typ.       | Max. | Unit | Test Conditions           |
|---------------------------|-----------------|-----------------|------|------------|------|------|---------------------------|
| Output high level voltage | All output pins | V <sub>OH</sub> | —    | VCC – 0.02 | —    | V    | I <sub>OH</sub> = –0.5 mA |
|                           |                 |                 | —    | VCC – 0.05 | —    |      | I <sub>OH</sub> = –1.0 mA |
|                           |                 |                 | —    | VCC – 0.10 | —    |      | I <sub>OH</sub> = –2.0 mA |
|                           |                 |                 | —    | VCC – 0.22 | —    |      | I <sub>OH</sub> = –4.0 mA |

**Table 2.24 Normal I/O Pin VOH Voltage Characteristics (Reference Values)**Conditions: VCC = AVCC0 = 5.0 V, VSS = AVSS0 = 0 V, T<sub>a</sub> = 25°C

| Item                      |                 | Symbol          | Min. | Typ.       | Max. | Unit | Test Conditions           |
|---------------------------|-----------------|-----------------|------|------------|------|------|---------------------------|
| Output high level voltage | All output pins | V <sub>OH</sub> | —    | VCC – 0.02 | —    | V    | I <sub>OH</sub> = –0.5 mA |
|                           |                 |                 | —    | VCC – 0.04 | —    |      | I <sub>OH</sub> = –1.0 mA |
|                           |                 |                 | —    | VCC – 0.08 | —    |      | I <sub>OH</sub> = –2.0 mA |
|                           |                 |                 | —    | VCC – 0.15 | —    |      | I <sub>OH</sub> = –4.0 mA |

**Table 2.25 Normal I/O Pin VOH Voltage Characteristics (Reference Values)**Conditions: VCC = AVCC0 = 2.0 V, VSS = AVSS0 = 0 V, T<sub>a</sub> = 25°C

| Item               |                 | Symbol          | Min. | Typ. | Max. | Unit | Test Conditions          |
|--------------------|-----------------|-----------------|------|------|------|------|--------------------------|
| Output low voltage | All output pins | V <sub>OL</sub> | —    | 0.02 | —    | V    | I <sub>OL</sub> = 0.5 mA |
|                    |                 |                 | —    | 0.04 | —    |      | I <sub>OL</sub> = 1.0 mA |
|                    |                 |                 | —    | 0.08 | —    |      | I <sub>OL</sub> = 2.0 mA |
|                    |                 |                 | —    | 0.17 | —    |      | I <sub>OL</sub> = 4.0 mA |
|                    |                 |                 | —    | 0.43 | —    |      | I <sub>OL</sub> = 8.0 mA |

**Table 2.26 Normal I/O Pin VOH Voltage Characteristics (Reference Values)**Conditions: VCC = AVCC0 = 3.3 V, VSS = AVSS0 = 0 V, T<sub>a</sub> = 25°C

| Item               |                 | Symbol          | Min. | Typ. | Max. | Unit | Test Conditions          |
|--------------------|-----------------|-----------------|------|------|------|------|--------------------------|
| Output low voltage | All output pins | V <sub>OL</sub> | —    | 0.01 | —    | V    | I <sub>OL</sub> = 0.5 mA |
|                    |                 |                 | —    | 0.02 | —    |      | I <sub>OL</sub> = 1.0 mA |
|                    |                 |                 | —    | 0.04 | —    |      | I <sub>OL</sub> = 2.0 mA |
|                    |                 |                 | —    | 0.08 | —    |      | I <sub>OL</sub> = 4.0 mA |
|                    |                 |                 | —    | 0.17 | —    |      | I <sub>OL</sub> = 8.0 mA |

**Table 2.27 Normal I/O Pin VOH Voltage Characteristics (Reference Values)**

Conditions: VCC = AVCC0 = 5.0 V, VSS = AVSS0 = 0 V, Ta = 25°C

| Item               |                 | Symbol          | Min. | Typ. | Max. | Unit | Test Conditions          |
|--------------------|-----------------|-----------------|------|------|------|------|--------------------------|
| Output low voltage | All output pins | V <sub>OL</sub> | —    | 0.01 | —    | V    | I <sub>OL</sub> = 0.5 mA |
|                    |                 |                 | —    | 0.01 | —    |      | I <sub>OL</sub> = 1.0 mA |
|                    |                 |                 | —    | 0.03 | —    |      | I <sub>OL</sub> = 2.0 mA |
|                    |                 |                 | —    | 0.06 | —    |      | I <sub>OL</sub> = 4.0 mA |
|                    |                 |                 | —    | 0.12 | —    |      | I <sub>OL</sub> = 8.0 mA |

## 2.5 AC Characteristics

### 2.5.1 Clock Timing

**Table 2.28 Operating Frequency Value (High-Speed Operating Mode)**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V, Ta = -40 to +105°C

| Item                          |                                   | Symbol | Min. | Typ. | Max. | Unit |
|-------------------------------|-----------------------------------|--------|------|------|------|------|
| Maximum operating frequency*4 | System clock (ICLK)               | f      | —    | —    | 48   | MHz  |
|                               | FlashIF clock (FCLK)*1, *2        |        | —    | —    | 48   |      |
|                               | Peripheral module clock (PCLKB)   |        | —    | —    | 32   |      |
|                               | Peripheral module clock (PCLKD)*3 |        | —    | —    | 48   |      |

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note 2. The frequency accuracy of FCLK should be ±3.5%.

Note 3. The lower-limit frequency of PCLKD is 1 MHz when the A/D converter is in use.

Note 4. The maximum operating frequency does not include HOCO error or PLL jitter. See Table 2.35, HOCO Clock Timing (ROM capacity: product with 128 Kbytes or more) or Table 2.36, HOCO Clock Timing (ROM capacity: product with 64 Kbytes).

**Table 2.29 Operating Frequency Value (Middle-Speed Operating Mode)**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V, Ta = -40 to +105°C

| Item                          |                                   | Symbol | Min. | Typ. | Max. | Unit |
|-------------------------------|-----------------------------------|--------|------|------|------|------|
| Maximum operating frequency*4 | System clock (ICLK)               | f      | —    | —    | 24   | MHz  |
|                               | FlashIF clock (FCLK)*1, *2        |        | —    | —    | 24   |      |
|                               | Peripheral module clock (PCLKB)   |        | —    | —    | 24   |      |
|                               | Peripheral module clock (PCLKD)*3 |        | —    | —    | 24   |      |

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note 2. The frequency accuracy of FCLK should be ±3.5%.

Note 3. The lower-limit frequency of PCLKD is 1 MHz when the A/D converter is in use.

Note 4. The maximum operating frequency does not include HOCO error or PLL jitter. See Table 2.35, HOCO Clock Timing (ROM capacity: product with 128 Kbytes or more) or Table 2.36, HOCO Clock Timing (ROM capacity: product with 64 Kbytes).

**Table 2.30 Operating Frequency Value (Middle-Speed Operating Mode 2)**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V, Ta = -40 to +105°C

| Item                          |                                   | Symbol | Min. | Typ. | Max. | Unit |
|-------------------------------|-----------------------------------|--------|------|------|------|------|
| Maximum operating frequency*4 | System clock (ICLK)               | f      | —    | —    | 1    | MHz  |
|                               | FlashIF clock (FCLK)*1, *2        |        | —    | —    | 1    |      |
|                               | Peripheral module clock (PCLKB)   |        | —    | —    | 1    |      |
|                               | Peripheral module clock (PCLKD)*3 |        | —    | —    | 1    |      |

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory.

Note 2. The frequency accuracy of FCLK should be ±3.5%.

Note 3. The lower-limit frequency of PCLKD is 4 MHz when the A/D converter is in use.

**Table 2.31 Operating Frequency Value (Low-Speed Operating Mode)**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V, Ta = -40 to +105°C

| Item                        |                                   | Symbol | Min. | Typ. | Max.   | Unit |
|-----------------------------|-----------------------------------|--------|------|------|--------|------|
| Maximum operating frequency | System clock (ICLK)               | f      | —    | —    | 32.768 | kHz  |
|                             | FlashIF clock (FCLK)*1            |        | —    | —    | 32.768 |      |
|                             | Peripheral module clock (PCLKB)   |        | —    | —    | 32.768 |      |
|                             | Peripheral module clock (PCLKD)*2 |        | —    | —    | 32.768 |      |

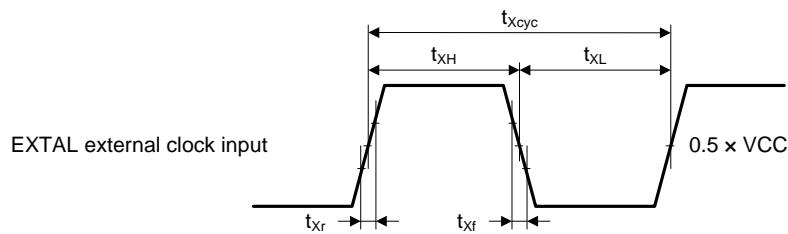
Note 1. Programming and erasing the flash memory is impossible.

Note 2. The A/D converter cannot be used.

**Table 2.32 EXTAL Clock Timing**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item  | Symbol     | Min. | Typ. | Max. | Unit | Test Conditions |
|---|------------|------|------|------|------|-----------------|
| EXTAL external clock input cycle time       | $t_{Xcyc}$ | 50   | —    | —    | ns   | Figure 2.14     |
| EXTAL external clock input high pulse width | $t_{xH}$   | 20   | —    | —    | ns   |                 |
| EXTAL external clock input low pulse width  | $t_{xL}$   | 20   | —    | —    | ns   |                 |
| EXTAL external clock rise time              | $t_{xr}$   | —    | —    | 5    | ns   |                 |
| EXTAL external clock fall time              | $t_{xf}$   | —    | —    | 5    | ns   |                 |
| EXTAL external clock input wait time*1      | $t_{xWT}$  | 0.5  | —    | —    | μs   |                 |

Note 1. Time until the clock can be used after the main clock oscillator stop bit (MOSCCR.MOSTP) is set to 0 (operating).

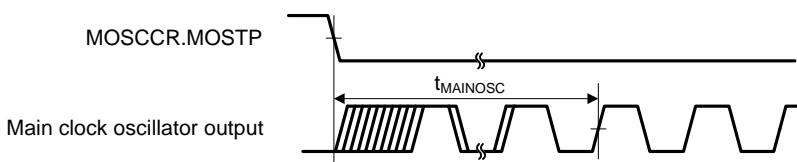
**Figure 2.14 EXTAL External Clock Input Timing****Table 2.33 Main Clock Timing**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item  | Symbol        | Min. | Typ. | Max. | Unit | Test Conditions |
|---|---------------|------|------|------|------|-----------------|
| Main clock oscillator oscillation frequency                     | $f_{MAIN}$    | 1    | —    | 20   | MHz  |                 |
| Main clock oscillation stabilization time (crystal)*1           | $t_{MAINOSC}$ | —    | 3    | —    | ms   | Figure 2.15     |
| Main clock oscillation stabilization time (ceramic resonator)*1 | $t_{MAINOSC}$ | —    | 50   | —    | μs   |                 |

Note 1. Reference values when an 8-MHz resonator is used.

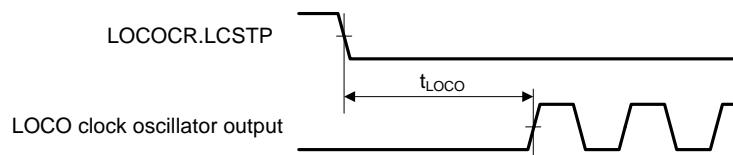
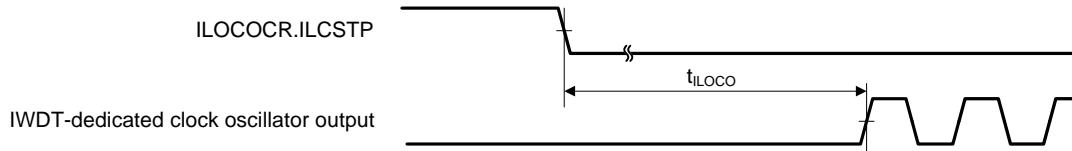
When specifying the main clock oscillator stabilization time, set the MOSCWTCR register with a stabilization time value that is equal to or greater than the resonator-manufacturer-recommended value.

After changing the setting of the MOSCCR.MOSTP bit so that the main clock oscillator operates, read the OSCOVFSR.MOOVF flag to confirm that it has become 1, and then start using the main clock.

**Figure 2.15 Main Clock Oscillation Start Timing**

**Table 2.34 LOCO and IWDT-Dedicated Low-Speed Clock Timing**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item  | Symbol                    | Min.  | Typ. | Max.     | Unit          | Test Conditions |
|---|---------------------------|-------|------|----------|---------------|-----------------|
| LOCO clock oscillation frequency                    | $f_{\text{LOCO}}$         | 3.44  | 4.0  | 4.56     | MHz           |                 |
| LOCO clock oscillation frequency error              | $\Delta f_{\text{LOCO}}$  | —     | —    | $\pm 14$ | %             |                 |
| LOCO clock oscillation stabilization time           | $t_{\text{LOCO}}$         | —     | —    | 0.5      | $\mu\text{s}$ | Figure 2.16     |
| IWDT-dedicated clock oscillation frequency          | $f_{\text{ILOCO}}$        | 12.75 | 15   | 17.25    | kHz           |                 |
| IWDT-dedicated clock oscillation frequency error    | $\Delta f_{\text{ILOCO}}$ | —     | —    | $\pm 15$ | %             |                 |
| IWDT-dedicated clock oscillation stabilization time | $t_{\text{ILOCO}}$        | —     | —    | 80       | $\mu\text{s}$ | Figure 2.17     |

**Figure 2.16 LOCO Clock Oscillation Start Timing****Figure 2.17 IWDT-Dedicated Clock Oscillation Start Timing**

**Table 2.35 HOCO Clock Timing (ROM capacity: product with 128 Kbytes or more)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

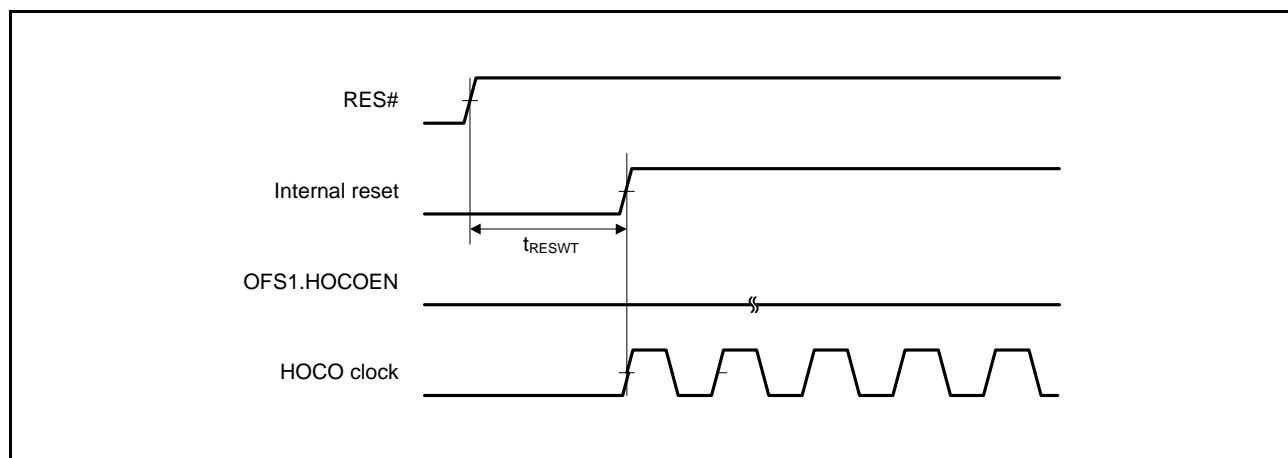
| Item   | Symbol                   | Min.  | Typ. | Max.      | Unit          | Test Conditions                            |
|--|--------------------------|-------|------|-----------|---------------|--|
| HOCO clock oscillation frequency <sup>*1</sup> | $f_{\text{HOCO}}$        | 23.76 | 24   | 24.24     | MHz           | $T_a = -40 \text{ to } +105^\circ\text{C}$ |
|  |                          | 31.68 | 32   | 32.32     |               |  |
|  |                          | 47.52 | 48   | 48.48     |               |  |
| HOCO oscillation frequency error <sup>*1</sup> | $\Delta f_{\text{HOCO}}$ | —     | —    | $\pm 1.0$ | %             | $T_a = -40 \text{ to } +105^\circ\text{C}$ |
| HOCO clock oscillation stabilization time      | $t_{\text{HOCO}}$        | —     | —    | 4.95      | $\mu\text{s}$ | Figure 2.19                                |

Note 1. Accuracy at production test.

**Table 2.36 HOCO Clock Timing (ROM capacity: product with 64 Kbytes)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item   | Symbol                   | Min.  | Typ. | Max.      | Unit          | Test Conditions                            |
|--|--------------------------|-------|------|-----------|---------------|--|
| HOCO clock oscillation frequency <sup>*1</sup> | $f_{\text{HOCO}}$        | 23.64 | 24   | 24.36     | MHz           | $T_a = -40 \text{ to } -20^\circ\text{C}$  |
|  |                          | 23.76 |      | 24.24     |               | $T_a = -20 \text{ to } +85^\circ\text{C}$  |
|  |                          | 23.52 |      | 24.48     |               | $T_a = +85 \text{ to } +105^\circ\text{C}$ |
|  |                          | 31.52 | 32   | 32.48     | MHz           | $T_a = -40 \text{ to } -20^\circ\text{C}$  |
|  |                          | 31.68 |      | 32.32     |               | $T_a = -20 \text{ to } +85^\circ\text{C}$  |
|  |                          | 31.36 |      | 32.64     |               | $T_a = +85 \text{ to } +105^\circ\text{C}$ |
|  |                          | 47.28 | 48   | 48.72     | MHz           | $T_a = -40 \text{ to } -20^\circ\text{C}$  |
|  |                          | 47.52 |      | 48.48     |               | $T_a = -20 \text{ to } +85^\circ\text{C}$  |
|  |                          | 47.04 |      | 48.96     |               | $T_a = +85 \text{ to } +105^\circ\text{C}$ |
| HOCO oscillation frequency error <sup>*1</sup> | $\Delta f_{\text{HOCO}}$ | —     | —    | $\pm 1.5$ | %             | $T_a = -40 \text{ to } -20^\circ\text{C}$  |
|  |                          | —     | —    | $\pm 1.0$ |               | $T_a = -20 \text{ to } +85^\circ\text{C}$  |
|  |                          | —     | —    | $\pm 2.0$ |               | $T_a = +85 \text{ to } +105^\circ\text{C}$ |
| HOCO clock oscillation stabilization time      | $t_{\text{HOCO}}$        | —     | —    | 4.95      | $\mu\text{s}$ | Figure 2.19                                |

Note 1. Accuracy at production test.

**Figure 2.18 HOCO Clock Oscillation Start Timing (After Reset is Canceled by Setting OFS1.HOCOEN Bit to 0)**

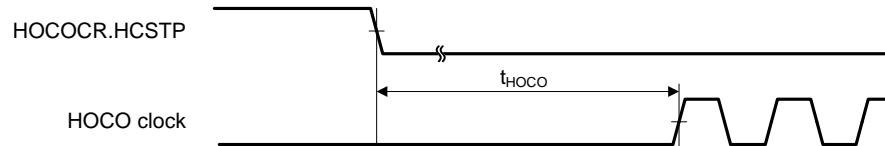


Figure 2.19 HOCO Clock Oscillation Start Timing (Oscillation is Started by Setting HOCOCR.HCSTP Bit)

Table 2.37 PLL Clock Timing

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

| Item                                     | Symbol             | Min. | Typ. | Max. | Unit          | Test Conditions |
|--|--------------------|------|------|------|---------------|-----------------|
| PLL input frequency                      | $f_{\text{PLLIN}}$ | 4    | —    | 12   | MHz           |                 |
| PLL circuit oscillation frequency        | $f_{\text{PLL}}$   | 24   | —    | 48   | MHz           |                 |
| PLL clock oscillation stabilization time | $t_{\text{PLL}}$   | —    | —    | 81.4 | $\mu\text{s}$ | Figure 2.20     |
| PLL free-running oscillation frequency   | $f_{\text{PLLFR}}$ | —    | 9    | —    | MHz           |                 |

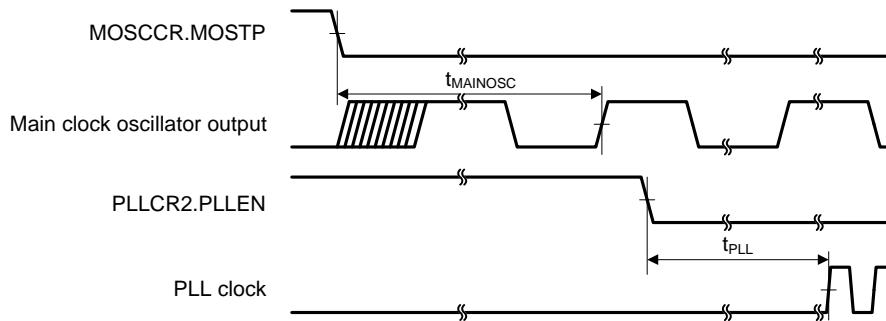


Figure 2.20 PLL Clock Oscillation Start Timing (PLL is Operated after Main Clock Oscillation Has Settled)

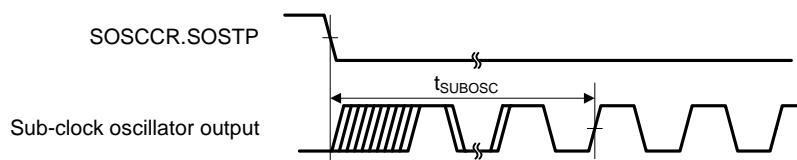
**Table 2.38 Sub-Clock Timing**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item   | Symbol              | Min. | Typ.   | Max. | Unit | Test Conditions |
|--|---------------------|------|--------|------|------|-----------------|
| Sub-clock oscillator oscillation frequency <sup>*2</sup> | $f_{\text{SUB}}$    | —    | 32.768 | —    | kHz  |                 |
| Sub-clock oscillation stabilization time <sup>*1</sup>   | $t_{\text{SUBOSC}}$ | —    | 0.5    | —    | s    | Figure 2.21     |

Note 1. Reference value when a 32.768-kHz resonator is used.

After changing the setting of the SOSCCR.SOSTP bit so that the sub-clock oscillator operates, only start using the sub-clock after the sub-clock oscillation stabilization wait time that is equal to or greater than the oscillator-manufacturer-recommended value has elapsed.

Note 2. Only 32.768-kHz can be used.

**Figure 2.21 Sub-Clock Oscillation Start Timing**

## 2.5.2 Reset Timing

**Table 2.39 Reset Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

| Item   |                            | Symbol       | Min. | Typ. | Max. | Unit | Test Conditions |
|--|----------------------------|--------------|------|------|------|------|-----------------|
| RES# pulse width   | At power-on                | $t_{RESWP}$  | 10.5 | —    | —    | ms   | Figure 2.22     |
|  | Other than above           | $t_{RESW}$   | 30   | —    | —    | μs   | Figure 2.23     |
| Wait time after RES# cancellation (at power-on)                        | At normal startup*1        | $t_{RESWT}$  | —    | 8.5  | —    | ms   | Figure 2.22     |
|  | During fast startup time*2 | $t_{RESWT}$  | —    | 850  | —    | μs   |                 |
| Wait time after RES# cancellation (during powered-on state)            | LVD0 disabled*3            | $t_{RESWT}$  | —    | 120  | —    | μs   | Figure 2.23     |
|  | LVD0 enabled*4             |              | —    | 850  | —    | μs   |                 |
| Internal reset time (independent watchdog timer reset, software reset) | LVD0 disabled*3            | $t_{RESWT2}$ | —    | 190  | —    | μs   |                 |
|  | LVD0 enabled*4             |              | —    | 890  | —    | μs   |                 |

Note 1. When OFS1.(LVDAS, FASTSTUP) = 11b.

Note 2. When OFS1.(LVDAS, FASTSTUP) = a value other than 11b.

Note 3. When OFS1.LVDAS = 1b.

Note 4. When OFS1.LVDAS = 0b.

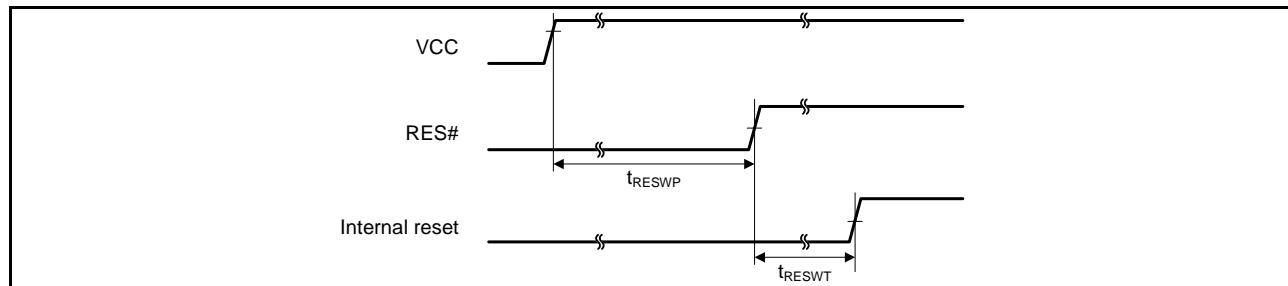


Figure 2.22 Reset Input Timing at Power-On

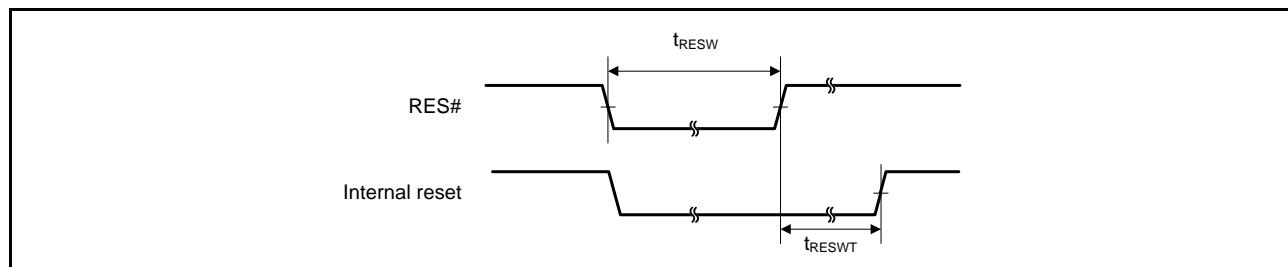


Figure 2.23 Reset Input Timing (1)

### 2.5.3 Timing of Recovery from Low Power Consumption Modes

**Table 2.40 Timing of Recovery from Low Power Consumption Modes (1)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item   | Symbol  | Min.                            | Typ.               | Max.                             |                                 | Unit   | Test Conditions  |               |             |
|--|---|---------------------------------|--------------------|----------------------------------|---------------------------------|--|--|---------------|-------------|
|  |   |                                 |                    | $t_{\text{SBYOSCW}}^{\text{*2}}$ | $t_{\text{SBYSEQ}}^{\text{*3}}$ |  |  |               |             |
| Recovery time from software standby mode <sup>*1</sup> | Main clock oscillator operating                 | Main clock oscillator operating | $t_{\text{SBYMC}}$ | —                                | —                               | $t_{\text{LOCO}} + (16 + \text{Number of cycles specified in MOSCWTCR}) / f_{\text{LOCO}} + 2 / f_{\text{MOSC}} + 4 / f_{\text{ICLK}}$ | $4 / f_{\text{LOCO}} + 11 / f_{\text{ICLK}} + 3 / f_{\text{PCLKB}} + 3n / f_{\text{source clock}}$ | $\mu\text{s}$ | Figure 2.24 |
|  | Main clock oscillator and PLL circuit operating |                                 | $t_{\text{SBYPC}}$ |                                  |                                 | $t_{\text{LOCO}} + (288 + \text{Number of cycles specified in MOSCWTCR}) / f_{\text{LOCO}} + 2 / f_{\text{PLL}} + 4 / f_{\text{ICLK}}$ |  |               |             |
|  | Sub-clock oscillator operating                  |                                 | $t_{\text{SBYSC}}$ |                                  |                                 | $3 / f_{\text{SOSC}} + 1 / f_{\text{ICLK}}$  |  |               |             |
|  | HOCO clock oscillator operating                 |                                 | $t_{\text{SBYHO}}$ |                                  |                                 | $t_{\text{LOCO}} + 16 / f_{\text{LOCO}} + 2 / f_{\text{HOCO}} + 4 / f_{\text{ICLK}}$   |  |               |             |
|  | Low-speed on-chip oscillator                    |                                 | $t_{\text{SBYLO}}$ |                                  |                                 | $t_{\text{LOCO}} + 1 / f_{\text{ICLK}}$  |  |               |             |

Note 1. The time for recovery from software standby mode is determined by the value obtained by adding the oscillation stabilization waiting time ( $t_{\text{SBYOSCW}}$ ) and the time required for operations by the software standby release sequencer ( $t_{\text{SBYSEQ}}$ ).

Note 2. When several oscillators were running before the transition to software standby, the greatest value of the oscillation stabilization waiting time  $t_{\text{SBYOSCW}}$  is selected.

Note 3. For n, the greatest value is selected from among the internal clock division settings.

**Table 2.41 Timing of Recovery from Low Power Consumption Modes (2)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item   | Symbol  | Min.                            | Typ.               | Max.                             |                                 | Unit   | Test Conditions   |               |             |
|--|---|---------------------------------|--------------------|----------------------------------|---------------------------------|--|---|---------------|-------------|
|  |   |                                 |                    | $t_{\text{SBYOSCW}}^{\text{*2}}$ | $t_{\text{SBYSEQ}}^{\text{*3}}$ |  |   |               |             |
| Recovery time from software standby mode <sup>*1</sup> | Main clock oscillator operating                 | Main clock oscillator operating | $t_{\text{SBYMC}}$ | —                                | —                               | $t_{\text{LOCO}} + (16 + \text{Number of cycles specified in MOSCWTCR}) / f_{\text{LOCO}} + 2 / f_{\text{MOSC}} + 4 / f_{\text{ICLK}}$ | $9 / f_{\text{ICLK}} + 3 / f_{\text{PCLKB}} + 3n / f_{\text{source clock}}$ | $\mu\text{s}$ | Figure 2.24 |
|  | Main clock oscillator and PLL circuit operating |                                 | $t_{\text{SBYPC}}$ |                                  |                                 | $t_{\text{LOCO}} + (288 + \text{Number of cycles specified in MOSCWTCR}) / f_{\text{LOCO}} + 2 / f_{\text{PLL}} + 4 / f_{\text{ICLK}}$ |   |               |             |
|  | Sub-clock oscillator operating                  |                                 | $t_{\text{SBYSC}}$ |                                  |                                 | $3 / f_{\text{SOSC}} + 1 / f_{\text{ICLK}}$  |   |               |             |
|  | HOCO clock oscillator operating                 |                                 | $t_{\text{SBYHO}}$ |                                  |                                 | $t_{\text{LOCO}} + 16 / f_{\text{LOCO}} + 2 / f_{\text{HOCO}} + 4 / f_{\text{ICLK}}$   |   |               |             |
|  | Low-speed on-chip oscillator                    |                                 | $t_{\text{SBYLO}}$ |                                  |                                 | $t_{\text{LOCO}} + 1 / f_{\text{ICLK}}$  |   |               |             |

Note 1. The time for recovery from software standby mode is determined by the value obtained by adding the oscillation stabilization waiting time ( $t_{\text{SBYOSCW}}$ ) and the time required for operations by the software standby release sequencer ( $t_{\text{SBYSEQ}}$ ).

Note 2. When several oscillators were running before the transition to software standby, the greatest value of the oscillation stabilization waiting time  $t_{\text{SBYOSCW}}$  is selected.

Note 3. For n, the greatest value is selected from among the internal clock division settings.

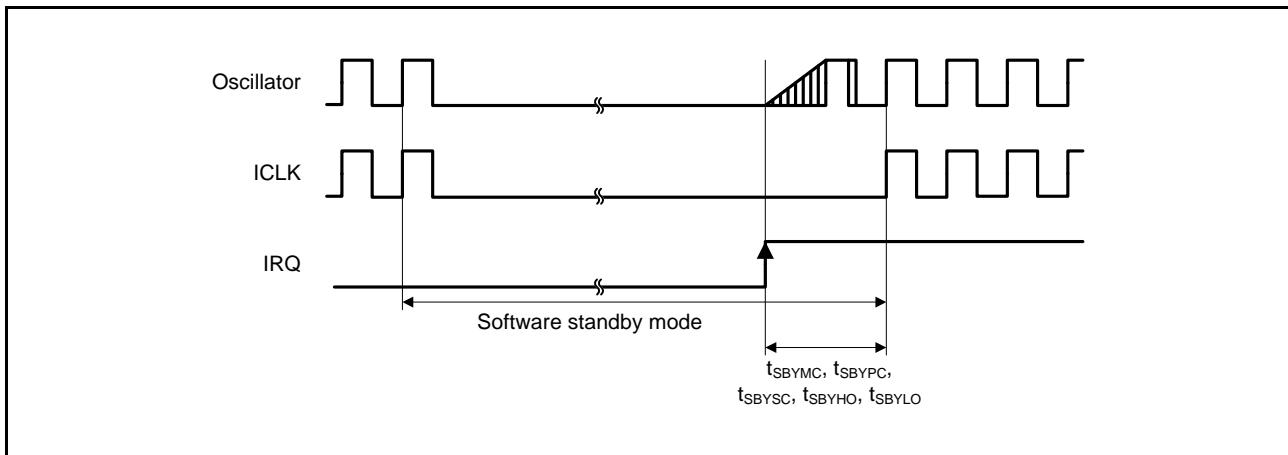


Figure 2.24 Software Standby Mode Recovery Timing

Table 2.42 Timing of Recovery from Low Power Consumption Modes (3)

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item  | Symbol    | Min. | Typ. | Max.   |   | Unit          | Test Conditions |
|---|-----------|------|------|--|---|---------------|-----------------|
|   |           |      |      | $t_{SBYOSCWT}^{*2}$  | $t_{SBYSEQ}^{*3}$                             |               |                 |
| Time to shift to the snooze mode from the software standby mode <sup>*1</sup> | $t_{SNZ}$ | —    | —    | $t_{LOCO} + (16 + \text{Number of cycles specified in MOSCWTCR}) / f_{LOCO} + 2 / f_{MOSC} + 4 / f_{ICLK}$ | $3 / f_{ICLK} + 2n / f_{\text{source clock}}$ | $\mu\text{s}$ | Figure 2.25     |
|   |           |      |      | $t_{LOCO} + (288 + \text{Number of cycles specified in MOSCWTCR}) / f_{LOCO} + 2 / f_{PLL} + 4 / f_{ICLK}$ |   |               |                 |
|   |           |      |      | $3 / f_{SOSC} + 1 / f_{ICLK}$  |   |               |                 |
|   |           |      |      | $t_{LOCO} + 16 / f_{LOCO} + 2 / f_{HOCO} + 4 / f_{ICLK}$   |   |               |                 |
|   |           |      |      | $t_{LOCO} + 1 / f_{ICLK}$  |   |               |                 |

Note 1. The time for recovery from software standby mode is determined by the value obtained by adding the oscillation stabilization waiting time ( $t_{SBYOSCWT}$ ) and the time required for operations by the software standby release sequencer ( $t_{SBYSEQ}$ ).

Note 2. When several oscillators were running before the transition to software standby, the greatest value of the oscillation stabilization waiting time  $t_{SBYOSCWT}$  is selected.

Note 3. For n, the greatest value is selected from among the internal clock division settings.

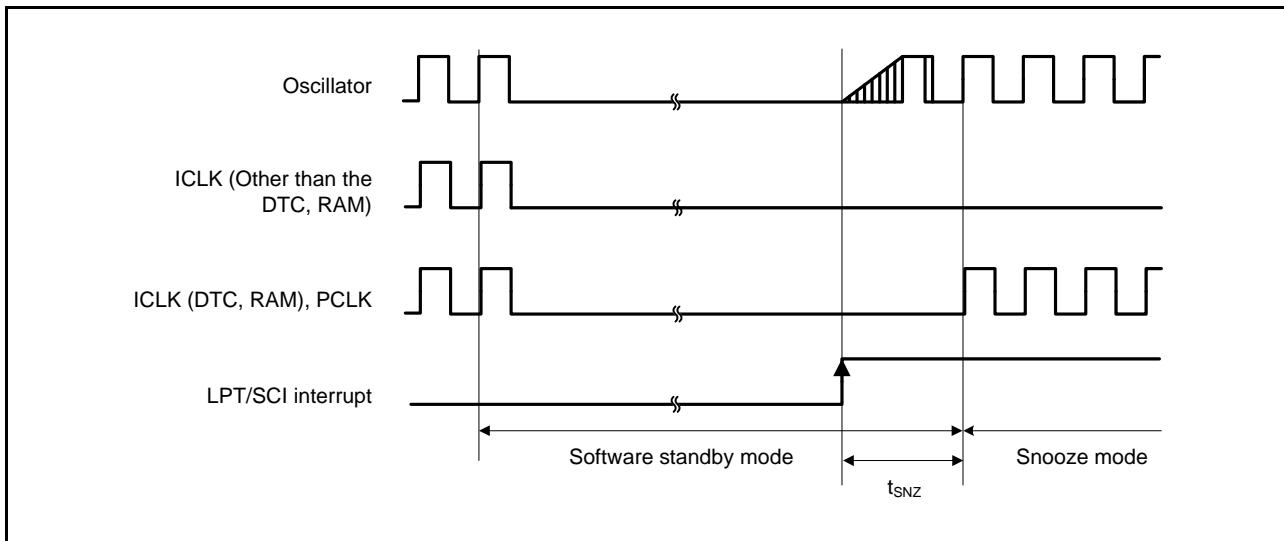


Figure 2.25 Timing to shift to the Snooze Mode from the Software Standby Mode

Table 2.43 Timing of Recovery from Low Power Consumption Modes (4)

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

| Item                                 | Symbol     | Min. | Typ. | Max.*2   | Unit          | Test Conditions |
|--------------------------------------|------------|------|------|--|---------------|-----------------|
| Recovery time from deep sleep mode*1 | $t_{DSLP}$ | —    | —    | $4 / f_{LOCO} + 10 / f_{ICLK} + 3n / f_{source clock}$ | $\mu\text{s}$ | Figure 2.26     |
|                                      |            |      |      | $4 / f_{LOCO} + 10 / f_{ICLK} + 3n / f_{source clock}$ |               |                 |
|                                      |            |      |      | $8 / f_{ICLK} + 3n / f_{source clock}$                 |               |                 |
|                                      |            |      |      | $8 / f_{ICLK} + 3n / f_{source clock}$                 |               |                 |

Note 1. Oscillators continue oscillating in deep sleep mode.

Note 2. n represents the largest frequency divisor among those for the internal clock signals.

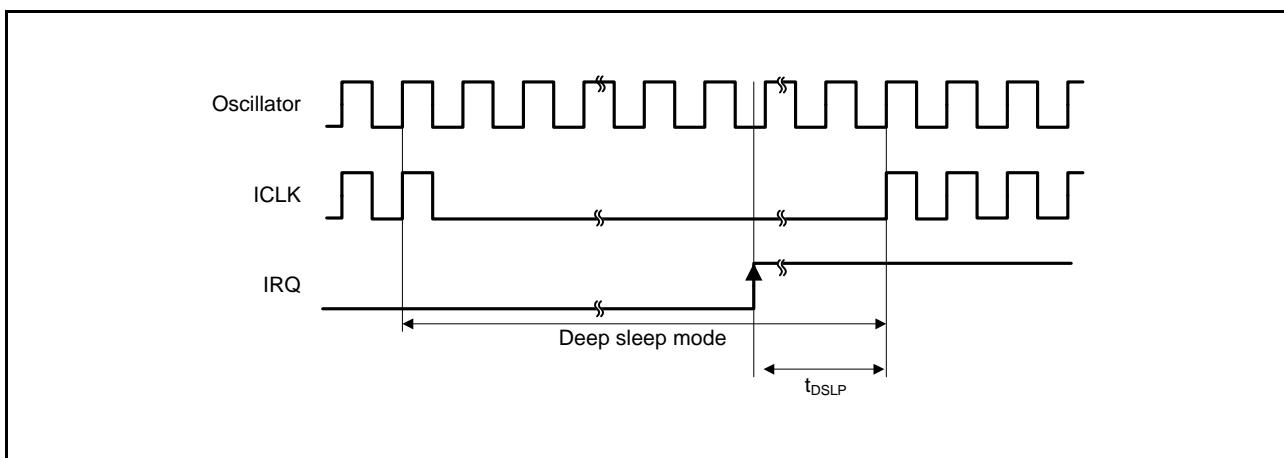


Figure 2.26 Deep Sleep Mode Recovery Timing

**Table 2.44 Operating Mode Transition Time**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Mode before Transition        | Mode after Transition                                  | ICLK Frequency | Transition Time |   |      | Unit |
|-------------------------------|--|----------------|-----------------|---|------|------|
|                               |  |                | Min.            | Typ.  | Max. |      |
| High-speed operating mode     | Middle-speed operating mode                            | 24 MHz         | —               | $5 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Middle-speed operating mode 2                          | 1 MHz          | —               | $5 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Low-speed operating mode                               | 32.768 kHz     | —               | $3 / f_{\text{ICLK}} + 2 / f_{\text{FCLK}}$ | —    | μs   |
| Middle-speed operating mode   | High-speed operating mode                              | 24 MHz         | —               | $5 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Middle-speed operating mode 2                          | 1 MHz          | —               | $5 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Low-speed operating mode                               | 32.768 kHz     | —               | $3 / f_{\text{ICLK}} + 2 / f_{\text{FCLK}}$ | —    | μs   |
| Middle-speed operating mode 2 | High-speed operating mode                              | 1 MHz          | —               | $5 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Middle-speed operating mode                            | 1 MHz          | —               | $5 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Low-speed operating mode                               | 32.768 kHz     | —               | $3 / f_{\text{ICLK}} + 2 / f_{\text{FCLK}}$ | —    | μs   |
| Low-speed operating mode      | Middle-speed operating mode, high-speed operating mode | 32.768 kHz     | —               | $5 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Middle-speed operating mode                            | 32.768 kHz     | —               | $3 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |
|                               | Middle-speed operating mode 2                          | 32.768 kHz     | —               | $3 / f_{\text{ICLK}} + 3 / f_{\text{FCLK}}$ | —    | μs   |

### 2.5.4 Control Signal Timing

**Table 2.45 Control Signal Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

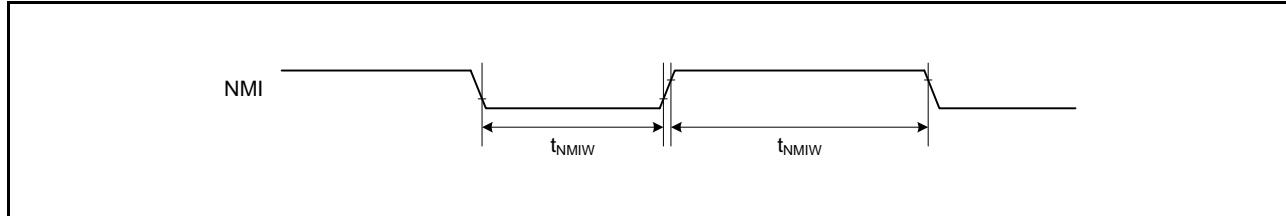
| Item            | Symbol            | Min.                               | Typ. | Max. | Unit | Test Conditions                                      |   |
|-----------------|-------------------|------------------------------------|------|------|------|--|---|
| NMI pulse width | $t_{\text{NMIW}}$ | 200                                | —    | —    | ns   | NMI digital filter disabled<br>(NMIFLTE.NFLTEN = 0)  | $t_{\text{Pcyc}} \times 2 \leq 200 \text{ ns}$  |
|                 |                   | $t_{\text{Pcyc}} \times 2^{*1}$    | —    | —    |      |  | $t_{\text{Pcyc}} \times 2 > 200 \text{ ns}$     |
|                 |                   | 200                                | —    | —    |      | NMI digital filter enabled<br>(NMIFLTE.NFLTEN = 1)   | $t_{\text{NMICK}} \times 3 \leq 200 \text{ ns}$ |
|                 |                   | $t_{\text{NMICK}} \times 3.5^{*2}$ | —    | —    |      |  | $t_{\text{NMICK}} \times 3 > 200 \text{ ns}$    |
| IRQ pulse width | $t_{\text{IRQW}}$ | 200                                | —    | —    | ns   | IRQ digital filter disabled<br>(IRQFLTE0.FLTENi = 0) | $t_{\text{Pcyc}} \times 2 \leq 200 \text{ ns}$  |
|                 |                   | $t_{\text{Pcyc}} \times 2^{*1}$    | —    | —    |      |  | $t_{\text{Pcyc}} \times 2 > 200 \text{ ns}$     |
|                 |                   | 200                                | —    | —    |      | IRQ digital filter enabled<br>(IRQFLTE0.FLTENi = 1)  | $t_{\text{IRQCK}} \times 3 \leq 200 \text{ ns}$ |
|                 |                   | $t_{\text{IRQCK}} \times 3.5^{*3}$ | —    | —    |      |  | $t_{\text{IRQCK}} \times 3 > 200 \text{ ns}$    |

Note: 200 ns minimum in software standby mode.

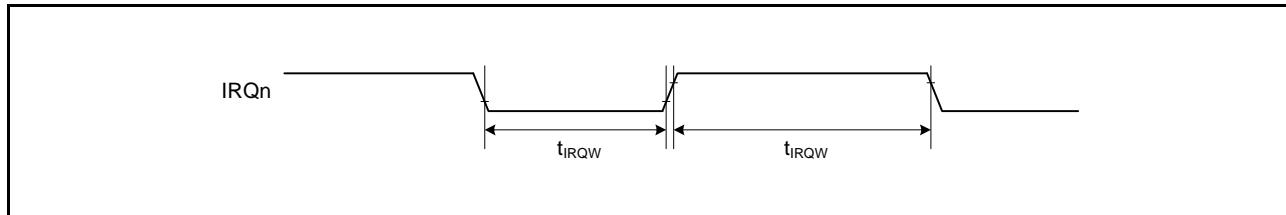
Note 1.  $t_{\text{Pcyc}}$  indicates the cycle of PCLKB.

Note 2.  $t_{\text{NMICK}}$  indicates the cycle of the NMI digital filter sampling clock.

Note 3.  $t_{\text{IRQCK}}$  indicates the cycle of the IRQ*i* digital filter sampling clock (*i* = 0 to 7).



**Figure 2.27 NMI Interrupt Input Timing**



**Figure 2.28 IRQ Interrupt Input Timing**

## 2.5.5 Timing of On-Chip Peripheral Modules

### 2.5.5.1 I/O Port Input Timing

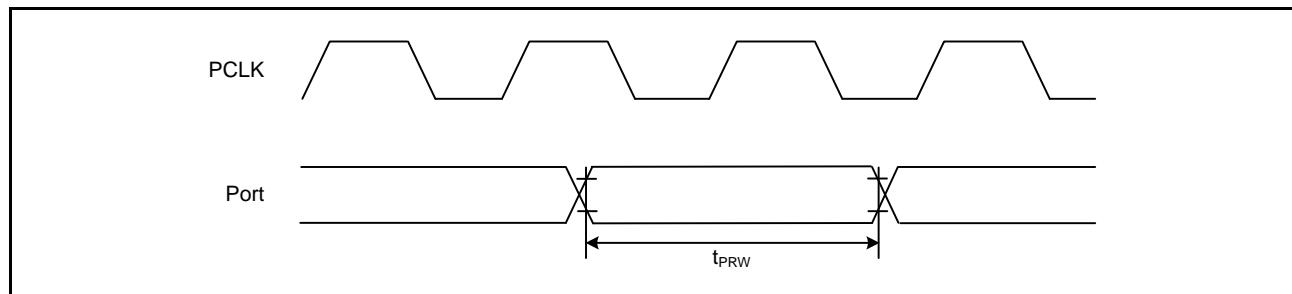
**Table 2.46 I/O Port Input Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item      |                        | Symbol    | Min. | Max. | Unit *1    | Test Conditions |
|-----------|------------------------|-----------|------|------|------------|-----------------|
| I/O ports | Input data pulse width | $t_{PRW}$ | 1.5  | —    | $t_{Pcyc}$ | Figure 2.29     |

Note 1.  $t_{Pcyc}$ : PCLK cycle



**Figure 2.29 I/O Port Input Timing**

### 2.5.5.2 MTU2

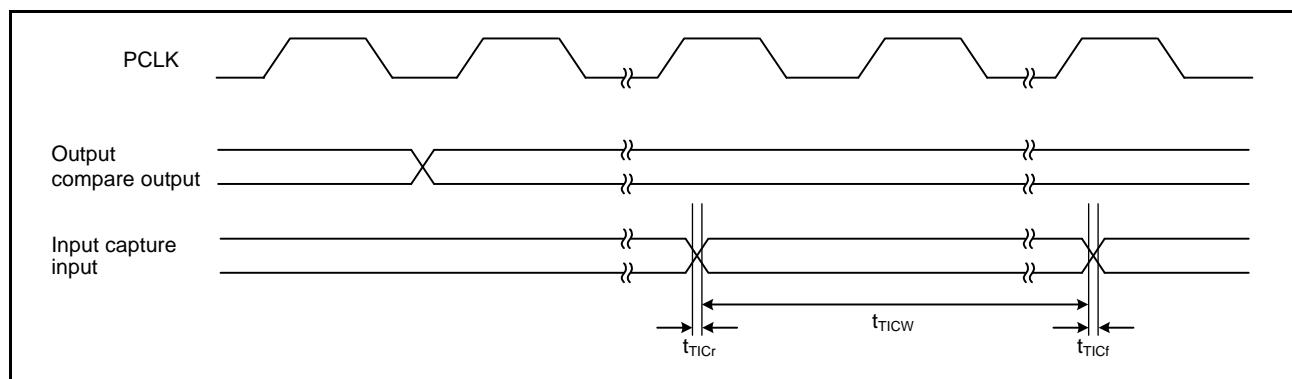
**Table 2.47 MTU2 Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item |                                    |                     | Symbol                       | Min. | Max. | Unit *1                | Test Conditions |
|------|------------------------------------|---------------------|------------------------------|------|------|------------------------|-----------------|
| MTU2 | Input capture input pulse width    | Single-edge setting | $t_{TICW}$                   | 1.5  | —    | $t_{Pcyc}$             | Figure 2.30     |
|      |                                    | Both-edge setting   |                              | 2.5  | —    |                        |                 |
|      | Input capture input rise/fall time |                     | $t_{TICr}$ ,<br>$t_{TICf}$   | —    | 0.1  | $\mu\text{s}/\text{V}$ |                 |
|      |                                    |                     |                              | —    | 0.1  | $\mu\text{s}/\text{V}$ |                 |
|      | Timer clock pulse width            | Single-edge setting | $t_{TCKWH}$ ,<br>$t_{TCKWL}$ | 1.5  | —    | $t_{Pcyc}$             | Figure 2.31     |
|      |                                    | Both-edge setting   |                              | 2.5  | —    |                        |                 |
|      |                                    | Phase counting mode |                              | 2.5  | —    |                        |                 |
|      | Timer clock rise/fall time         |                     | $t_{TCKR}$ ,<br>$t_{TCKf}$   | —    | 0.1  | $\mu\text{s}/\text{V}$ |                 |

Note 1.  $t_{Pcyc}$ : PCLK cycle



**Figure 2.30 MTU2 Input/Output Timing**

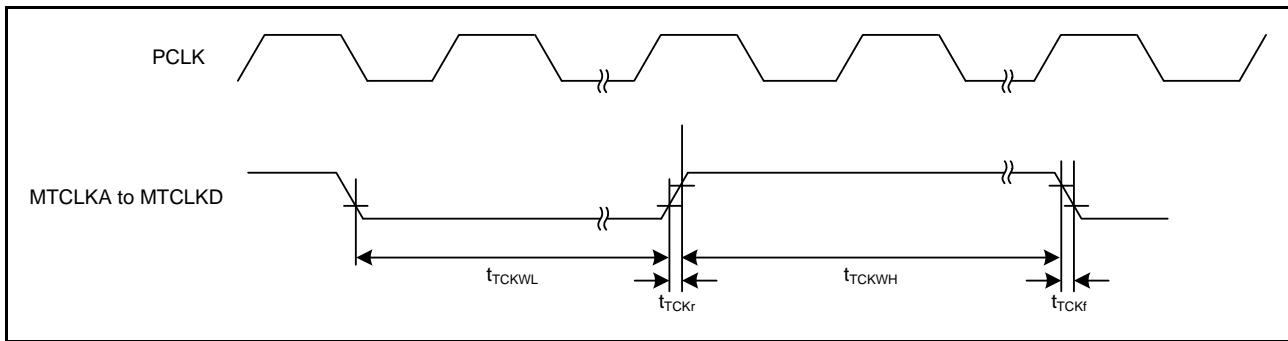


Figure 2.31 MTU2 Clock Input Timing

### 2.5.5.3 POE2

**Table 2.48 POE2 Timing**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$ 

| Item |  | Symbol                     | Min. | Max.               | Unit *1                | Test Conditions   |
|------|--|----------------------------|------|--------------------|------------------------|---|
| POE2 | POE# input pulse width                 | $t_{POEW}$                 | 1.5  | —                  | $t_{Pcyc}$             | Figure 2.32   |
|      | POE# input rise/fall time              | $t_{POEr}$ ,<br>$t_{POEf}$ | —    | 0.1                | $\mu\text{s}/\text{V}$ |   |
|      | Output disable time                    | $t_{POEDI}$                | —    | $5t_{Pcyc} + 0.24$ | $\mu\text{s}$          | Figure 2.33<br>When detecting falling edges (ICSRm.POEnM[3:0] = 0000 (m = 1, 2; n = 0, 1, 2,3,8)) |
|      | Simultaneous conduction of output pins | $t_{POEDO}$                | —    | $3t_{Pcyc} + 0.2$  |                        | Figure 2.34   |
|      | Register setting                       | $t_{POEDS}$                | —    | $1t_{Pcyc} + 0.2$  |                        | Figure 2.35<br>Time for access to the register is not included.                                   |
|      | Oscillation stop detection             | $t_{POEDOS}$               | —    | 21                 |                        | Figure 2.36   |

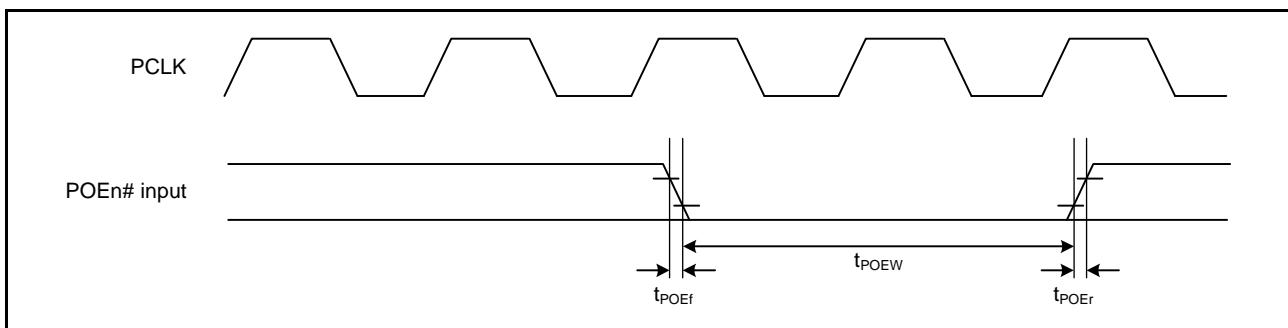
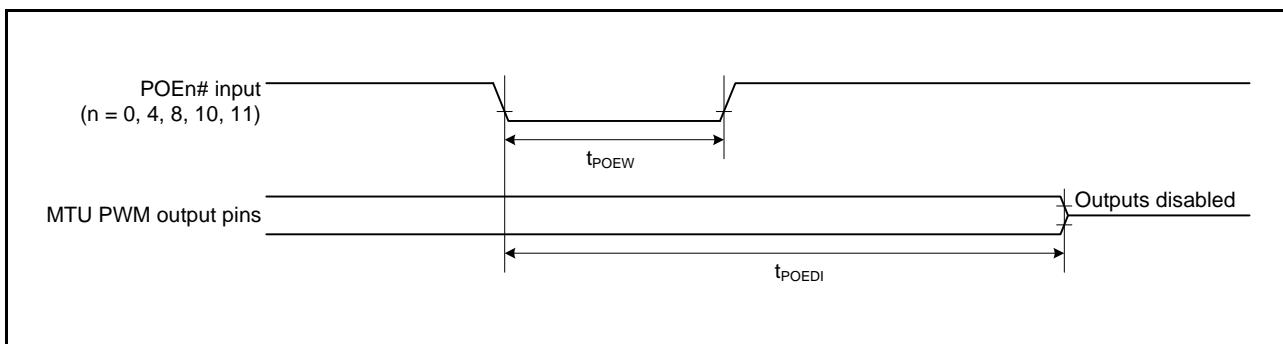
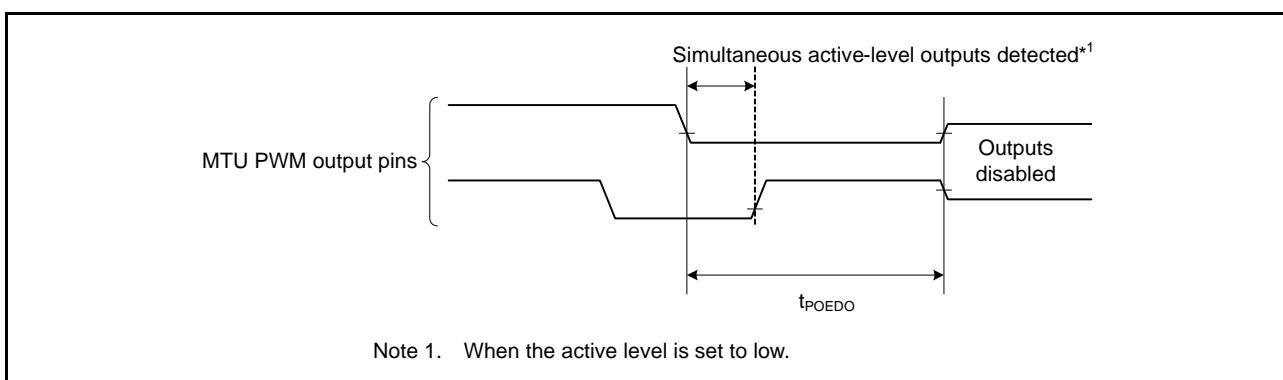
Note 1.  $t_{Pcyc}$ : PCLK cycle

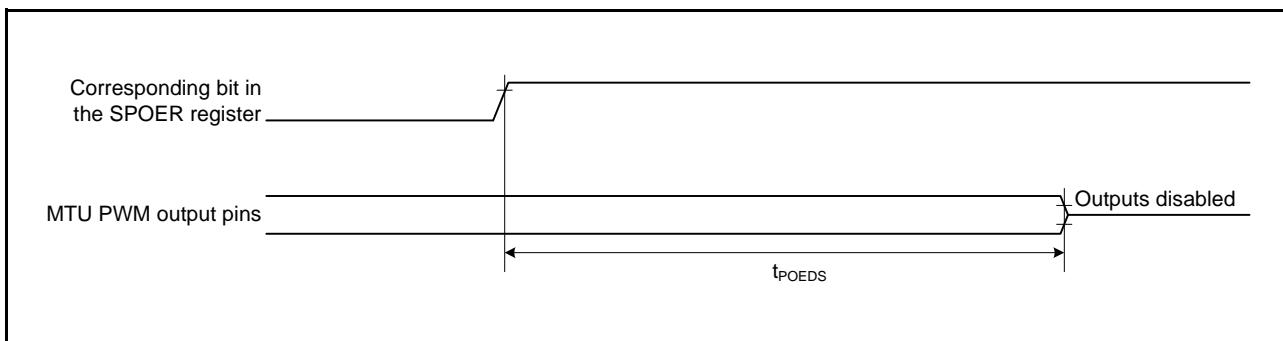
Figure 2.32 POE# Input Timing



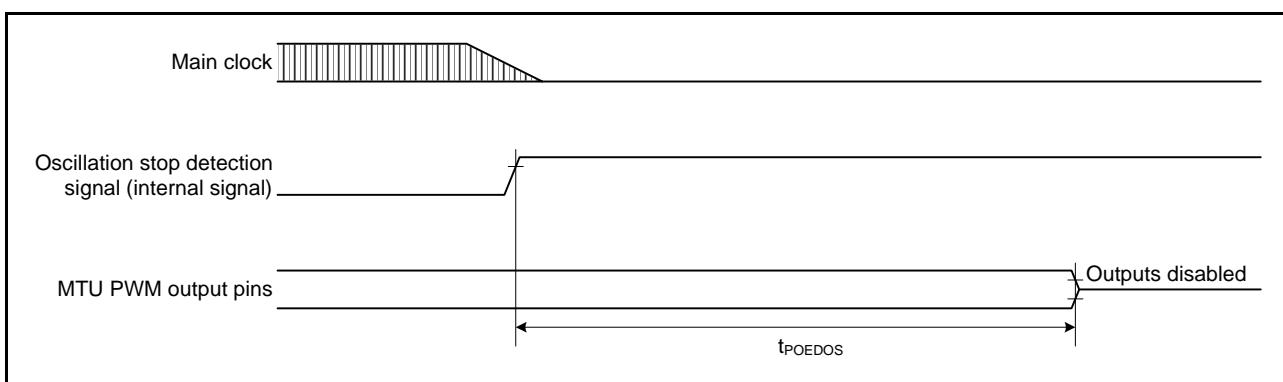
**Figure 2.33 Output Disable Time for POE in Response to Transition of the POEn# Signal Level**



**Figure 2.34 Output Disable Time for POE in Response to the Simultaneous Conduction of Output Pins**



**Figure 2.35 Output Disable Time for POE in Response to the Register Setting**



**Figure 2.36 Output Disable Time for POE in Response to the Oscillation Stop Detection**

### 2.5.5.4 TMR

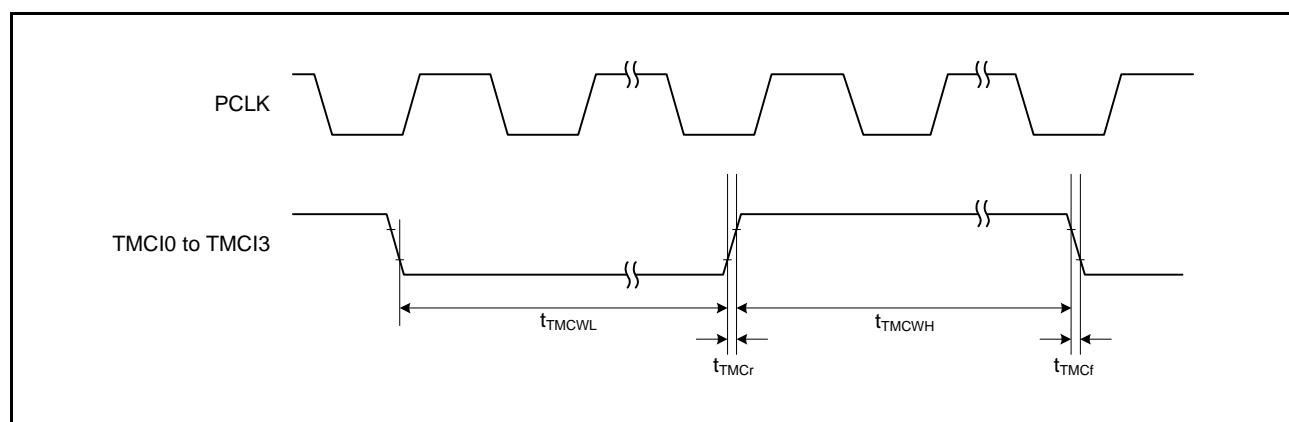
**Table 2.49 TMR Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item |                            | Symbol                 | Min. | Max. | Unit *1                | Test Conditions |
|------|----------------------------|------------------------|------|------|------------------------|-----------------|
| TMR  | Timer clock pulse width    | $t_{TMCWH}, t_{TMCWL}$ | 1.5  | —    | $t_{Pcyc}$             | Figure 2.37     |
|      |                            |                        | 2.5  | —    |                        |                 |
|      | Timer clock rise/fall time | $t_{TMCr}, t_{TMCF}$   | —    | 0.1  | $\mu\text{s}/\text{V}$ |                 |

Note 1.  $t_{Pcyc}$ : PCLK cycle



**Figure 2.37 TMR Clock Input Timing**

### 2.5.5.5 SCI

**Table 2.50 SCI Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.5 \times \text{VCC}$ ,  $V_{OL} = 0.5 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item                      |                                   |                     | Symbol            | Min.              | Max. | Unit *1           | Test Conditions   |  |  |  |
|---------------------------|-----------------------------------|---------------------|-------------------|-------------------|------|-------------------|-------------------|--|--|--|
| SCI<br>(channel 1, 5)     | Input clock cycle time            |                     | t <sub>Scyc</sub> | 4                 | —    | t <sub>Pcyc</sub> | Figure 2.38       |  |  |  |
|                           | Asynchronous                      |                     |                   | 6                 | —    |                   |                   |  |  |  |
|                           | Clock synchronous                 |                     |                   | t <sub>SCKW</sub> | 0.4  | 0.6               | t <sub>Scyc</sub> |  |  |  |
|                           | Input clock rise time             |                     |                   | t <sub>SCKr</sub> | —    | 20                | ns                |  |  |  |
|                           | Input clock fall time             |                     |                   | t <sub>SCKf</sub> | —    | 20                | ns                |  |  |  |
|                           | Output clock cycle time           | Asynchronous        |                   | t <sub>Scyc</sub> | 6    | —                 | t <sub>Pcyc</sub> |  |  |  |
|                           |                                   | Clock synchronous   |                   |                   | 4    | —                 |                   |  |  |  |
|                           |                                   | 2.4 V ≤ VCC ≤ 5.5 V |                   |                   | 8    | —                 |                   |  |  |  |
|                           |                                   | 1.8 V ≤ VCC < 2.4 V |                   |                   | 4    | —                 |                   |  |  |  |
|                           | 24 MHz < PCLKB ≤ 32 MHz           |                     |                   | t <sub>SCKW</sub> | 0.4  | 0.6               | t <sub>Scyc</sub> |  |  |  |
|                           | PCLKB ≤ 24 MHz                    |                     |                   | t <sub>SCKr</sub> | —    | 20                | ns                |  |  |  |
|                           | Output clock fall time            |                     |                   | t <sub>SCKf</sub> | —    | 20                | ns                |  |  |  |
|                           | Transmit data delay time (master) |                     | t <sub>TXD</sub>  | —                 | 40   | ns                | Figure 2.39       |  |  |  |
|                           | Clock synchronous                 |                     |                   | —                 | 55   | ns                |                   |  |  |  |
|                           | Transmit data delay time (slave)  |                     |                   | —                 | 60   | ns                |                   |  |  |  |
|                           |                                   |                     |                   | —                 | 100  | ns                |                   |  |  |  |
|                           | Receive data setup time (master)  |                     | t <sub>RXS</sub>  | 2.7 V or above    | 45   | —                 |                   |  |  |  |
|                           |                                   |                     |                   | 2.4 V or above    | 55   | —                 |                   |  |  |  |
|                           |                                   |                     |                   | 1.8 V or above    | 90   | —                 |                   |  |  |  |
|                           | Receive data setup time (slave)   |                     |                   | —                 | 40   | —                 |                   |  |  |  |
|                           | Receive data hold time            |                     | t <sub>RXH</sub>  | 40                | —    | ns                |                   |  |  |  |
| SCI<br>(channel 6,8,9,12) | Input clock cycle time            |                     | t <sub>Scyc</sub> | 4                 | —    | t <sub>Pcyc</sub> | Figure 2.38       |  |  |  |
|                           | Asynchronous                      |                     |                   | 6                 | —    |                   |                   |  |  |  |
|                           | Clock synchronous                 |                     |                   | t <sub>SCKW</sub> | 0.4  | 0.6               | t <sub>Scyc</sub> |  |  |  |
|                           | Input clock pulse width           |                     |                   | t <sub>SCKr</sub> | —    | 20                | ns                |  |  |  |
|                           | Input clock rise time             |                     |                   | t <sub>SCKf</sub> | —    | 20                | ns                |  |  |  |
|                           | Input clock fall time             |                     |                   | t <sub>Scyc</sub> | 16   | —                 | t <sub>Pcyc</sub> |  |  |  |
|                           | Output clock cycle time           | Asynchronous        |                   | 4                 | —    |                   |                   |  |  |  |
|                           |                                   | Clock synchronous   |                   | 8                 | —    |                   |                   |  |  |  |
|                           |                                   | 2.4 V ≤ VCC ≤ 5.5 V |                   | 4                 | —    |                   |                   |  |  |  |
|                           |                                   | 1.8 V ≤ VCC < 2.4 V |                   | 8                 | —    |                   |                   |  |  |  |
|                           | 24 MHz < PCLKB ≤ 32 MHz           |                     |                   | t <sub>SCKW</sub> | 0.4  | 0.6               | t <sub>Scyc</sub> |  |  |  |
|                           | PCLKB ≤ 24 MHz                    |                     |                   | t <sub>SCKr</sub> | —    | 20                | ns                |  |  |  |
|                           | Output clock fall time            |                     |                   | t <sub>SCKf</sub> | —    | 20                | ns                |  |  |  |
|                           | Transmit data delay time (master) |                     | t <sub>TXD</sub>  | —                 | 40   | ns                |                   |  |  |  |
|                           | Clock synchronous                 |                     |                   | —                 | 65   | ns                |                   |  |  |  |
|                           | Transmit data delay time (slave)  |                     |                   | —                 | 100  | ns                |                   |  |  |  |
|                           | Receive data setup time (master)  |                     |                   | t <sub>RXS</sub>  | 65   | —                 |                   |  |  |  |
|                           | Clock synchronous                 |                     |                   | 90                | —    | ns                |                   |  |  |  |
|                           | 1.8 V or above                    |                     |                   | 40                | —    | ns                |                   |  |  |  |
|                           | Receive data setup time (slave)   |                     |                   | t <sub>RXH</sub>  | 40   | —                 | ns                |  |  |  |
|                           | Receive data hold time            |                     |                   | t <sub>RXH</sub>  | 40   | —                 | ns                |  |  |  |

Note 1. t<sub>Pcyc</sub>: PCLK cycle

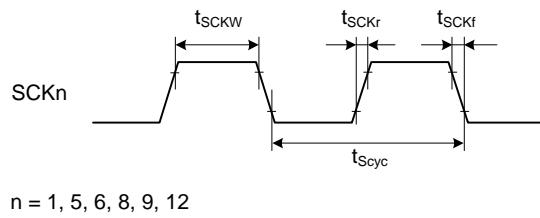


Figure 2.38 SCK Clock Input Timing

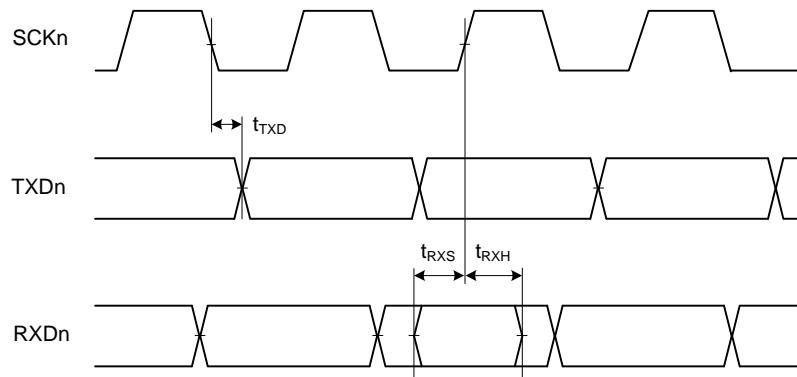
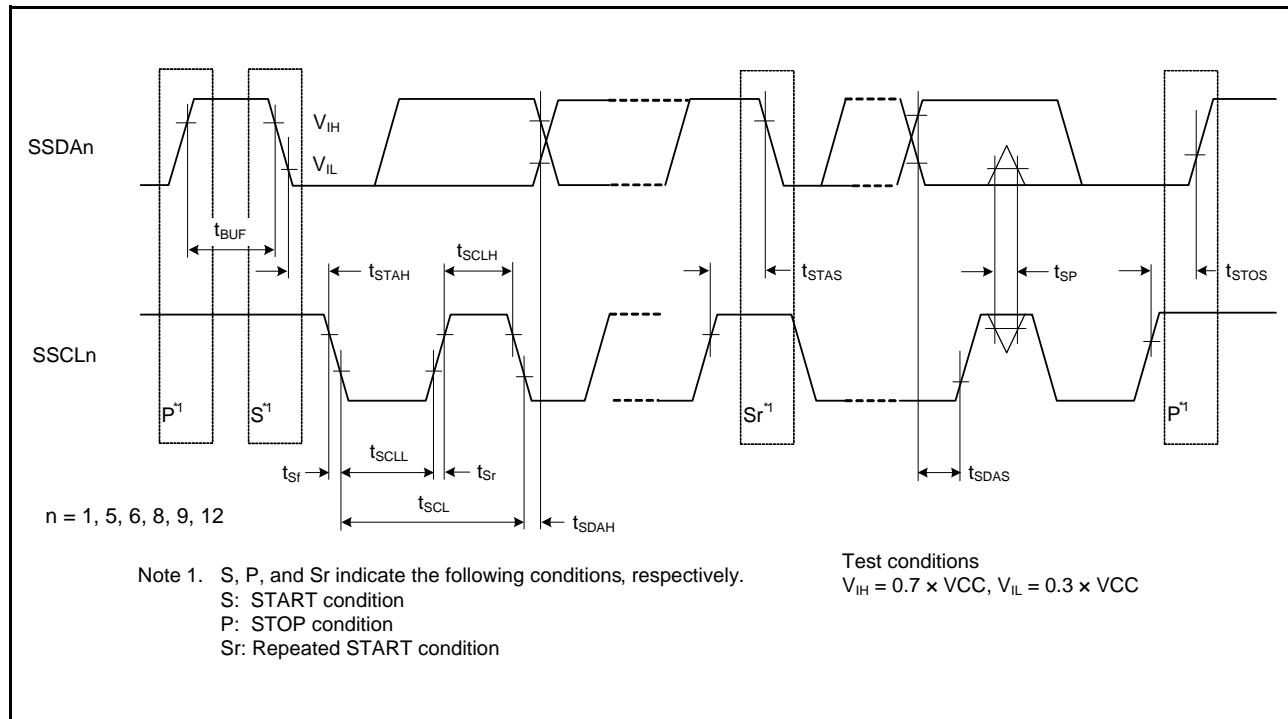


Figure 2.39 SCI Input/Output Timing: Clock Synchronous Mode

**Table 2.51 Simple I<sup>2</sup>C Timing**Conditions:  $2.7 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $2.7 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$ 

| Item                                       |                              | Symbol     | Min. | Max.                | Unit | Test Conditions |
|--|------------------------------|------------|------|---------------------|------|-----------------|
| Simple I <sup>2</sup> C<br>(standard mode) | SDA rise time                | $t_{Sr}$   | —    | 1000                | ns   | Figure 2.40     |
|  | SDA fall time                | $t_{Sf}$   | —    | 300                 | ns   |                 |
|  | SDA spike pulse removal time | $t_{SP}$   | 0    | $4 \times t_{Pcyc}$ | ns   |                 |
|  | Data setup time              | $t_{SDAS}$ | 250  | —                   | ns   |                 |
|  | Data hold time               | $t_{SDAH}$ | 0    | —                   | ns   |                 |
|  | SCL, SDA capacitive load     | $C_b^*$    | —    | 400                 | pF   |                 |
| Simple I <sup>2</sup> C<br>(fast mode)     | SDA rise time                | $t_{Sr}$   | —    | 300                 | ns   | Figure 2.40     |
|  | SDA fall time                | $t_{Sf}$   | —    | 300                 | ns   |                 |
|  | SDA spike pulse removal time | $t_{SP}$   | 0    | $4 \times t_{Pcyc}$ | ns   |                 |
|  | Data setup time              | $t_{SDAS}$ | 100  | —                   | ns   |                 |
|  | Data hold time               | $t_{SDAH}$ | 0    | —                   | ns   |                 |
|  | SCL, SDA capacitive load     | $C_b^*$    | —    | 400                 | pF   |                 |

Note:  $t_{Pcyc}$ : PCLK cycleNote 1.  $C_b$  is the total capacitance of the bus lines.**Figure 2.40 Output Timing and Simple I<sup>2</sup>C Bus Interface Input/Output Timing**

**Table 2.52 Simple SPI Timing**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$ 

| Item                      |                                 |                                | Symbol      | Min.                   | Max.  | Unit*1     | Test Conditions             |  |
|---------------------------|---------------------------------|--------------------------------|-------------|------------------------|-------|------------|-----------------------------|--|
| Simple SPI                | SCK clock cycle output (master) | 2.4 V $\leq$ VCC $\leq$ 5.5 V  | $t_{SPcyc}$ | 4                      | 65536 | $t_{Pcyc}$ | Figure 2.41                 |  |
|                           |                                 | 1.8 V $\leq$ VCC $<$ 2.4 V     |             | 8                      | 65536 |            |                             |  |
|                           |                                 | 24 MHz $<$ PCLKB $\leq$ 32 MHz |             | 4                      | 65536 |            |                             |  |
|                           | PCLKB $\leq$ 24 MHz             |                                |             | 6                      | —     | $t_{Pcyc}$ |                             |  |
|                           | SCK clock cycle input (slave)   |                                |             | $t_{SPCKWH}$           | 0.4   | 0.6        | $t_{SPcyc}$                 |  |
|                           | SCK clock high pulse width      |                                |             | $t_{SPCKWL}$           | 0.4   | 0.6        | $t_{SPcyc}$                 |  |
|                           | SCK clock low pulse width       |                                |             | $t_{SPCKr}, t_{SPCKf}$ | —     | 20         | ns                          |  |
|                           | Data input setup time (master)  | 2.7 V or above                 | $t_{SU}$    | 45                     | —     | ns         |                             |  |
|                           |                                 | 2.4 V or above                 |             | 55                     | —     |            |                             |  |
|                           |                                 | 1.8 V or above                 |             | 80                     | —     |            |                             |  |
|                           | Data input setup time (slave)   |                                |             | 40                     | —     | ns         | Figure 2.42,<br>Figure 2.43 |  |
|                           | Data input hold time            |                                |             | $t_H$                  | 40    | —          |                             |  |
|                           | SSL input setup time            |                                |             | $t_{LEAD}$             | 1     | —          |                             |  |
|                           | SSL input hold time             |                                |             | $t_{LAG}$              | 1     | —          |                             |  |
|                           | Data output delay time (master) |                                |             | $t_{OD}$               | —     | 40         | ns                          |  |
|                           | Data output delay time (slave)  | 2.7 V or above                 | $t_{OD}$    | —                      | 65    |            |                             |  |
|                           |                                 | 1.8 V or above                 |             | —                      | 100   |            |                             |  |
|                           | Data output hold time (master)  | 2.7 V or above                 |             | $t_{OH}$               | -10   | —          | ns                          |  |
|                           |                                 | 1.8 V or above                 |             |                        | -20   | —          |                             |  |
|                           | Data output hold time (slave)   |                                |             |                        | -10   | —          |                             |  |
|                           | Data rise/fall time             |                                |             | $t_{Dr}, t_{Df}$       | —     | 20         | ns                          |  |
|                           | SSL input rise/fall time        |                                |             | $t_{SSLr}, t_{SSLf}$   | —     | 20         | ns                          |  |
| Slave access time         | 2.4 V $\leq$ VCC $\leq$ 5.5 V   |                                | $t_{SA}$    | —                      | 6     | $t_{Pcyc}$ | Figure 2.44,<br>Figure 2.45 |  |
|                           | 1.8 V $\leq$ VCC $<$ 2.4 V      | 24 MHz $<$ PCLKB $\leq$ 32 MHz |             | —                      | 7     |            |                             |  |
|                           |                                 | PCLKB $\leq$ 24 MHz            |             | —                      | 6     |            |                             |  |
| Slave output release time | 2.4 V $\leq$ VCC $\leq$ 5.5 V   |                                | $t_{REL}$   | —                      | 6     | $t_{Pcyc}$ |                             |  |
|                           | 1.8 V $\leq$ VCC $<$ 2.4 V      | 24 MHz $<$ PCLKB $\leq$ 32 MHz |             | —                      | 7     |            |                             |  |
|                           |                                 | PCLKB $\leq$ 24 MHz            |             | —                      | 6     |            |                             |  |

Note 1.  $t_{Pcyc}$ : PCLK cycle

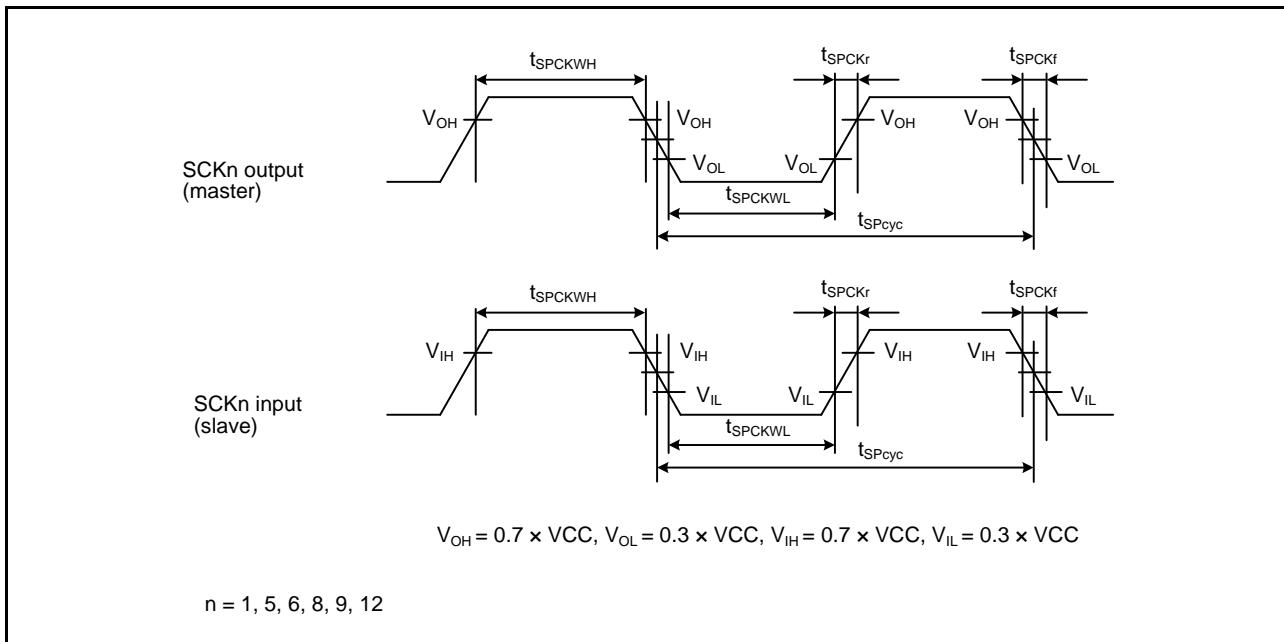


Figure 2.41 Simple SPI Clock Timing

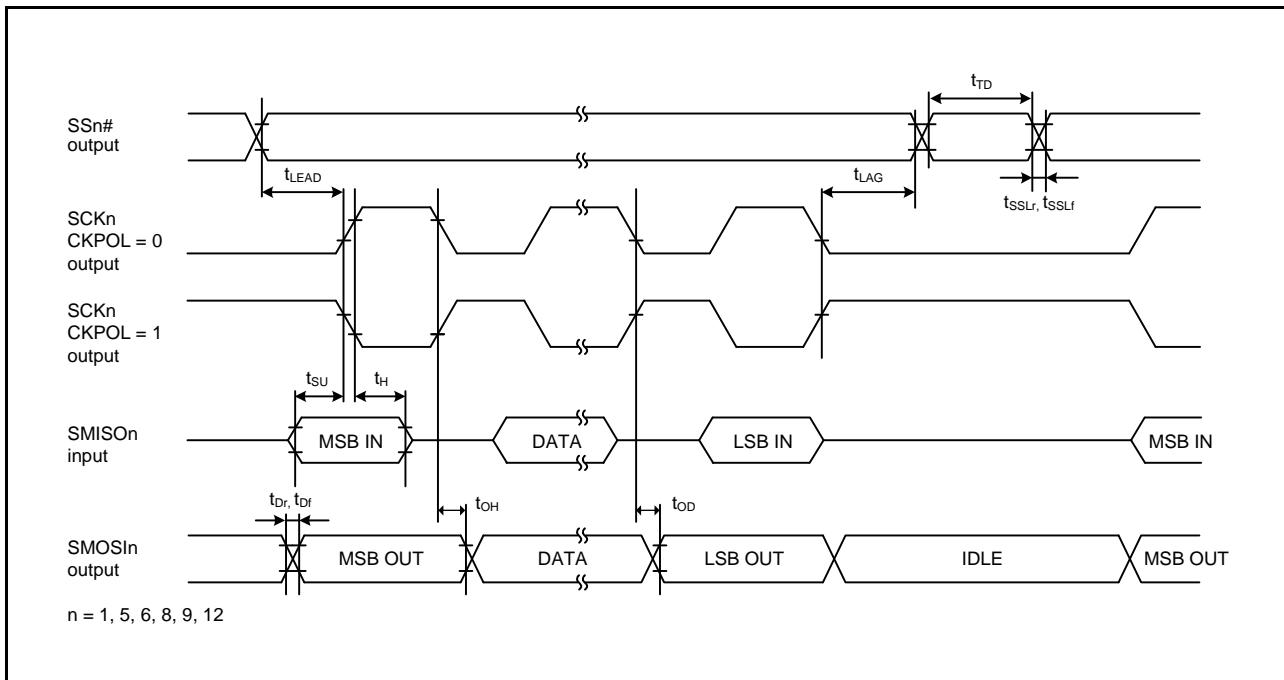


Figure 2.42 Simple SPI Clock Timing (Master, CKPH = 1)

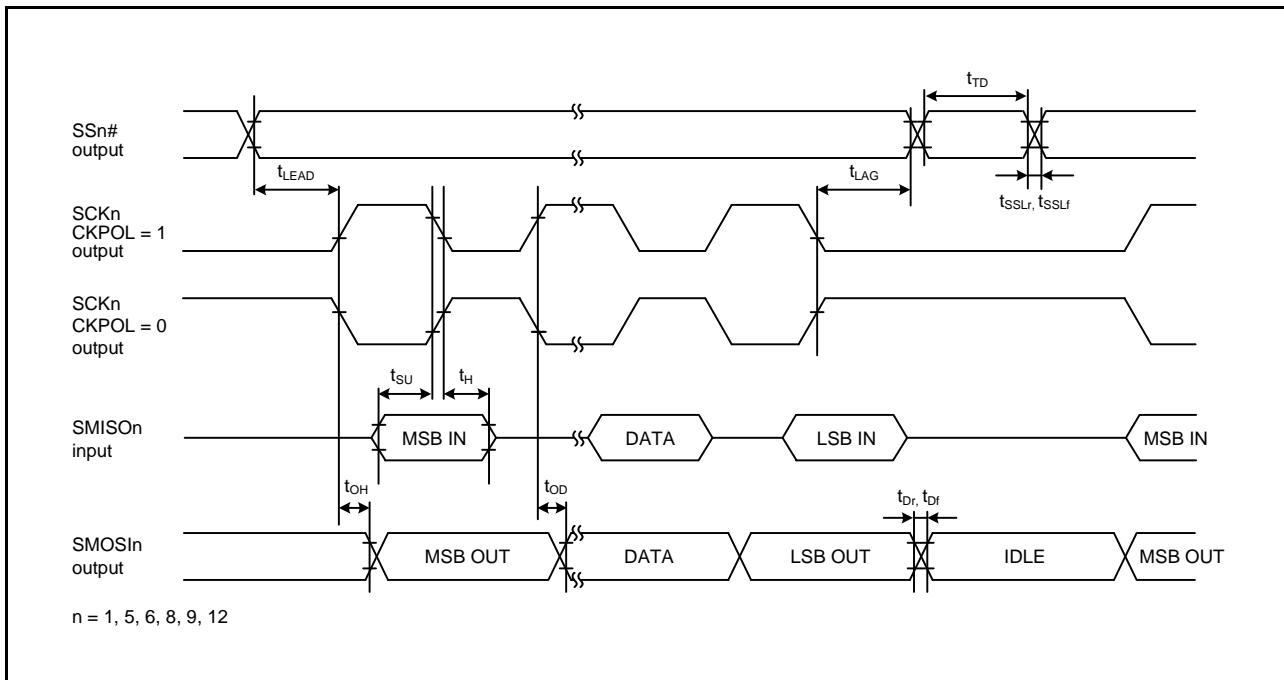


Figure 2.43 Simple SPI Clock Timing (Master, CKPH = 0)

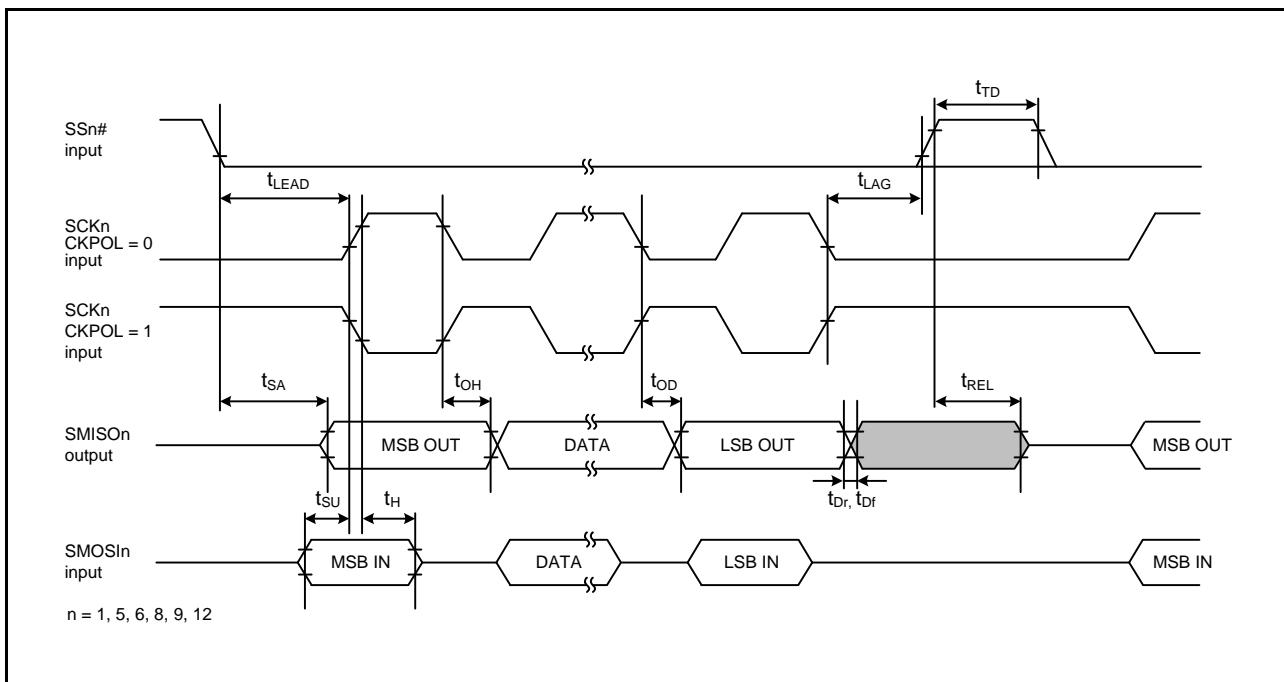


Figure 2.44 Simple SPI Clock Timing (Slave, CKPH = 1)

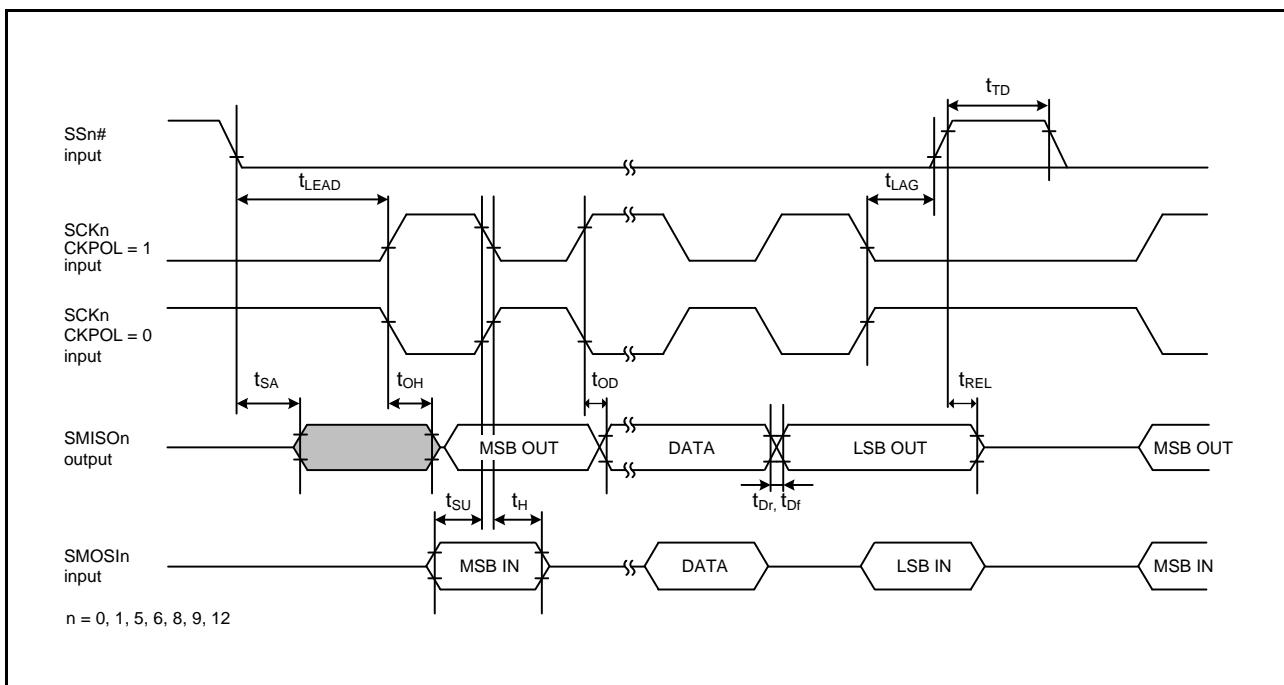


Figure 2.45 Simple SPI Clock Timing (Slave, CKPH = 0)

### 2.5.5.6 RIIC

**Table 2.53 RIIC Timing**

Conditions:  $2.7 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $2.7 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item                           |                                     | Symbol     | Min.*1                           | Max.                     | Unit | Test Conditions |
|--------------------------------|-------------------------------------|------------|----------------------------------|--------------------------|------|-----------------|
| RIIC<br>(standard mode, SMBus) | SCL cycle time                      | $t_{SCL}$  | $6(12) \times t_{IICcyc} + 1300$ | —                        | ns   | Figure 2.46     |
|                                | SCL high pulse width                | $t_{SCLH}$ | $3(6) \times t_{IICcyc} + 300$   | —                        | ns   |                 |
|                                | SCL low pulse width                 | $t_{SCLL}$ | $3(6) \times t_{IICcyc} + 300$   | —                        | ns   |                 |
|                                | SCL, SDA rise time                  | $t_{Sr}$   | —                                | 1000                     | ns   |                 |
|                                | SCL, SDA fall time                  | $t_{Sf}$   | —                                | 300                      | ns   |                 |
|                                | SCL, SDA spike pulse removal time   | $t_{SP}$   | 0                                | $1(4) \times t_{IICcyc}$ | ns   |                 |
|                                | SDA bus free time                   | $t_{BUF}$  | $3(6) \times t_{IICcyc} + 300$   | —                        | ns   |                 |
|                                | START condition hold time           | $t_{STAH}$ | $t_{IICcyc} + 300$               | —                        | ns   |                 |
|                                | Repeated START condition setup time | $t_{STAS}$ | 1000                             | —                        | ns   |                 |
|                                | STOP condition setup time           | $t_{STOS}$ | 1000                             | —                        | ns   |                 |
|                                | Data setup time                     | $t_{SDAS}$ | $t_{IICcyc} + 50$                | —                        | ns   |                 |
|                                | Data hold time                      | $t_{SDAH}$ | 0                                | —                        | ns   |                 |
|                                | SCL, SDA capacitive load            | $C_b^{*2}$ | —                                | 400                      | pF   |                 |
| RIIC<br>(fast mode)            | SCL cycle time                      | $t_{SCL}$  | $6(12) \times t_{IICcyc} + 600$  | —                        | ns   | Figure 2.46     |
|                                | SCL high pulse width                | $t_{SCLH}$ | $3(6) \times t_{IICcyc} + 300$   | —                        | ns   |                 |
|                                | SCL low pulse width                 | $t_{SCLL}$ | $3(6) \times t_{IICcyc} + 300$   | —                        | ns   |                 |
|                                | SCL, SDA rise time                  | $t_{Sr}$   | —                                | 300                      | ns   |                 |
|                                | SCL, SDA fall time                  | $t_{Sf}$   | —                                | 300                      | ns   |                 |
|                                | SCL, SDA spike pulse removal time   | $t_{SP}$   | 0                                | $1(4) \times t_{IICcyc}$ | ns   |                 |
|                                | SDA bus free time                   | $t_{BUF}$  | $3(6) \times t_{IICcyc} + 300$   | —                        | ns   |                 |
|                                | START condition hold time           | $t_{STAH}$ | $t_{IICcyc} + 300$               | —                        | ns   |                 |
|                                | Repeated START condition setup time | $t_{STAS}$ | 300                              | —                        | ns   |                 |
|                                | STOP condition setup time           | $t_{STOS}$ | 300                              | —                        | ns   |                 |
|                                | Data setup time                     | $t_{SDAS}$ | $t_{IICcyc} + 50$                | —                        | ns   |                 |
|                                | Data hold time                      | $t_{SDAH}$ | 0                                | —                        | ns   |                 |
|                                | SCL, SDA capacitive load            | $C_b^{*2}$ | —                                | 400                      | pF   |                 |

Note:  $t_{IICcyc}$ : RIIC internal reference count clock (IICp) cycle

Note 1. The value in parentheses is used when the ICMR3.NF[1:0] bits are set to 11b while a digital filter is enabled with the ICFER.NFE bit = 1.

Note 2.  $C_b$  is the total capacitance of the bus lines.

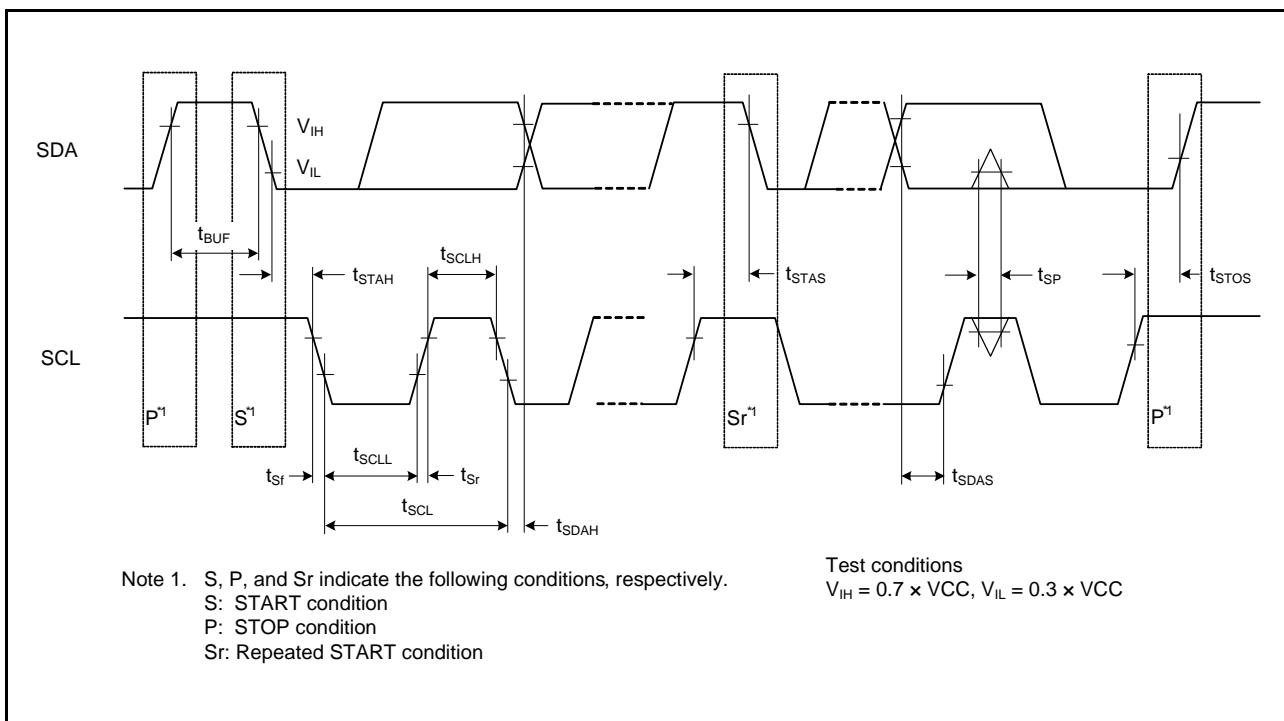


Figure 2.46 RIIC Bus Interface Input/Output Timing

### 2.5.5.7 RSPI

**Table 2.54 RSPI Timing (1/2)**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ ,  $C = 30 \text{ pF}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item                                     |                      |   | Symbol                 | Min.  | Max.                                     | Unit                   | Test Conditions                  |
|--|----------------------|---|------------------------|---|--|------------------------|----------------------------------|
| RSPI<br>clock cycle                      | RSPCK<br>clock cycle | Master  | $t_{SPcyc}$            | 2   | 4096                                     | $t_{Pcyc}^{*1}$        | Figure 2.47                      |
|  |                      | Slave   |                        | 4   | —  |                        |                                  |
| RSPCK<br>clock high<br>pulse width       |                      | Master  | $t_{SPCKWH}$           | $(t_{SPcyc} - t_{SPCKr} - t_{SPCKf}) / 2 - 3$ | —  | ns                     |                                  |
|  |                      | Slave   |                        | $(t_{SPcyc} - t_{SPCKr} - t_{SPCKf}) / 2$     | —  |                        |                                  |
| RSPCK<br>clock low<br>pulse width        |                      | Master  | $t_{SPCKWL}$           | $(t_{SPcyc} - t_{SPCKr} - t_{SPCKf}) / 2 - 3$ | —  | ns                     |                                  |
|  |                      | Slave   |                        | $(t_{SPcyc} - t_{SPCKr} - t_{SPCKf}) / 2$     | —  |                        |                                  |
| RSPCK<br>clock rise/<br>fall time        | Output               | 2.7 V or above  | $t_{SPCKr}, t_{SPCKf}$ | —   | 10                                       | ns                     | Figure 2.48<br>to<br>Figure 2.51 |
|  |                      | 2.4 V or above  |                        | —   | 15                                       |                        |                                  |
|  |                      | 1.8 V or above  |                        | —   | 20                                       |                        |                                  |
|  | Input                |   |                        | —   | 0.1                                      | $\mu\text{s}/\text{V}$ |                                  |
| Data input<br>setup time                 | Master               | 2.7 V or above  | $t_{SU}$               | 10  | —  | ns                     | Figure 2.48<br>to<br>Figure 2.51 |
|  |                      | 1.8 V or above  |                        | 30  | —  |                        |                                  |
|  | Slave                | 2.7 V or above  |                        | 10  | —  |                        |                                  |
|  |                      | 1.8 V or above  |                        | 15  | —  |                        |                                  |
| Data input<br>hold time                  | Master               | RSPCK set to a division ratio other than PCLKB divided by 2 | $t_H$                  | $t_{Pcyc}$                                    | —  | ns                     |                                  |
|  |                      | RSPCK set to PCLKB divided by 2                             | $t_{HF}$               | 0   | —  |                        |                                  |
|  | Slave                |   | $t_H$                  | 20  | —  |                        |                                  |
| SSL setup<br>time                        | Master               |   | $t_{LEAD}$             | $-30 + N^{*2} \times t_{SPcyc}$               | —  | ns                     |                                  |
|  | Slave                |   |                        | 6   | —  |                        |                                  |
| SSL hold<br>time                         | Master               |   | $t_{LAG}$              | $-30 + N^{*3} \times t_{SPcyc}$               | —  | ns                     |                                  |
|  | Slave                |   |                        | 6   | —  |                        |                                  |
| Data output<br>delay time                | Master               | 2.7 V or above  | $t_{OD}$               | —   | 14                                       | ns                     |                                  |
|  |                      | 2.4 V or above  |                        | —   | 20                                       |                        |                                  |
|  |                      | 1.8 V or above  |                        | —   | 25                                       |                        |                                  |
|  | Slave                | 2.7 V or above  |                        | —   | 50                                       |                        |                                  |
|  |                      | 2.4 V or above  |                        | —   | 60                                       |                        |                                  |
|  |                      | 1.8 V or above  |                        | —   | 85                                       |                        |                                  |
| Data output<br>hold time                 | Master               |   | $t_{OH}$               | 0   | —  | ns                     |                                  |
|  | Slave                |   |                        | 0   | —  |                        |                                  |
| Successive<br>transmission<br>delay time | Master               |   | $t_{TD}$               | $t_{SPcyc} + 2 \times t_{Pcyc}$               | $8 \times t_{SPcyc} + 2 \times t_{Pcyc}$ | ns                     |                                  |
|  | Slave                |   |                        | $6 \times t_{Pcyc}$                           | —  |                        |                                  |
| MOSI and<br>MISO rise/<br>fall time      | Output               | 2.7 V or above  | $t_{Dr}, t_{Df}$       | —   | 10                                       | ns                     |                                  |
|  |                      | 2.4 V or above  |                        | —   | 15                                       |                        |                                  |
|  |                      | 1.8 V or above  |                        | —   | 20                                       |                        |                                  |
|  | Input                |   |                        | —   | 1  | $\mu\text{s}$          |                                  |

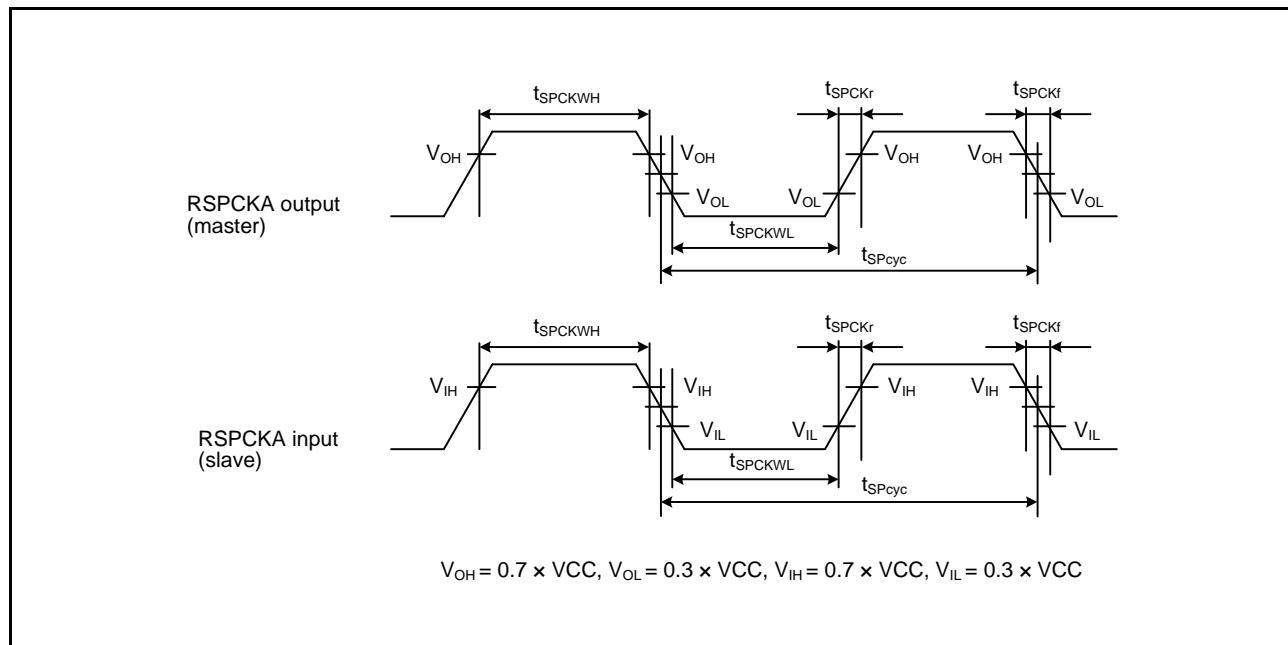
**Table 2.54 RSPI Timing (2/2)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ ,  $C = 30 \text{ pF}$ Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$ 

| Item                       |                |                | Symbol               | Min. | Max.                      | Unit | Test Conditions            |
|----------------------------|----------------|----------------|----------------------|------|---------------------------|------|----------------------------|
| RSPI<br>SSL rise/fall time | Output         | 2.7 V or above | $t_{SSLr}, t_{SSLf}$ | —    | 10                        | ns   | Figure 2.48 to Figure 2.51 |
|                            |                | 2.4 V or above |                      | —    | 15                        | ns   |                            |
|                            |                | 1.8 V or above |                      | —    | 20                        | ns   |                            |
|                            | Input          |                |                      | —    | 1                         | μs   |                            |
| Slave access time          | 2.4 V or above |                | $t_{SA}$             | —    | $2 \times t_{Pcyc} + 100$ | ns   | Figure 2.50, Figure 2.51   |
|                            | 1.8 V or above |                |                      | —    | $2 \times t_{Pcyc} + 140$ | ns   |                            |
| Slave output release time  | 2.4 V or above |                | $t_{REL}$            | —    | $2 \times t_{Pcyc} + 100$ | ns   |                            |
|                            | 1.8 V or above |                |                      | —    | $2 \times t_{Pcyc} + 140$ | ns   |                            |

Note 1.  $t_{Pcyc}$ : PCLK cycle

Note 2. N: An integer from 1 to 8 that can be set by the RSPI clock delay register (SPCKD)

Note 3. N: An integer from 1 to 8 that can be set by the RSPI slave select negation delay register (SSLND)

**Figure 2.47 RSPI Clock Timing**

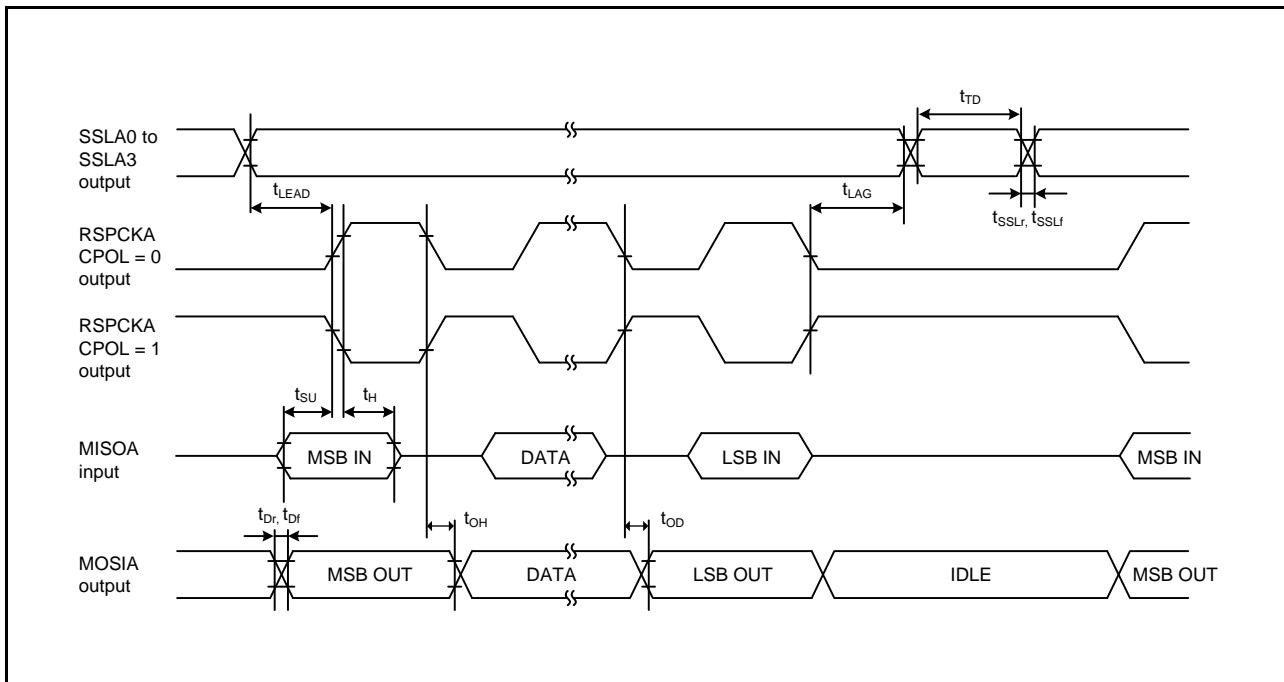


Figure 2.48 RSPI Timing (Master, CPHA = 0)

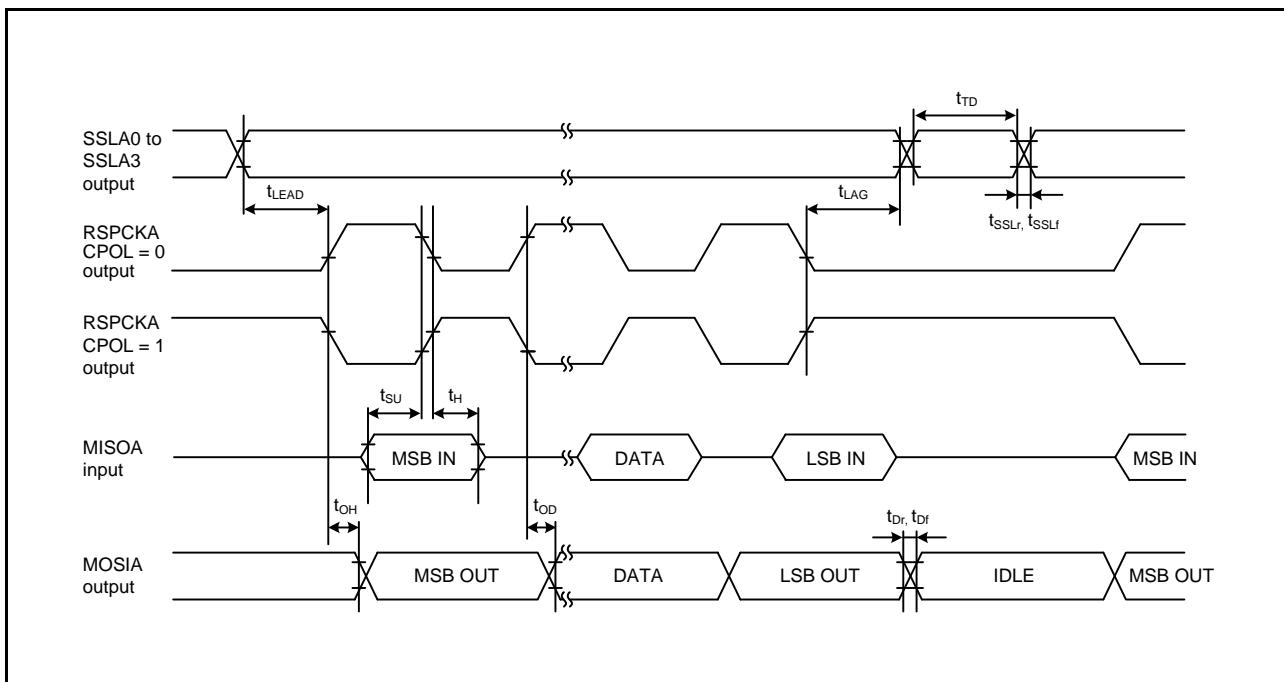


Figure 2.49 RSPI Timing (Master, CPHA = 1)

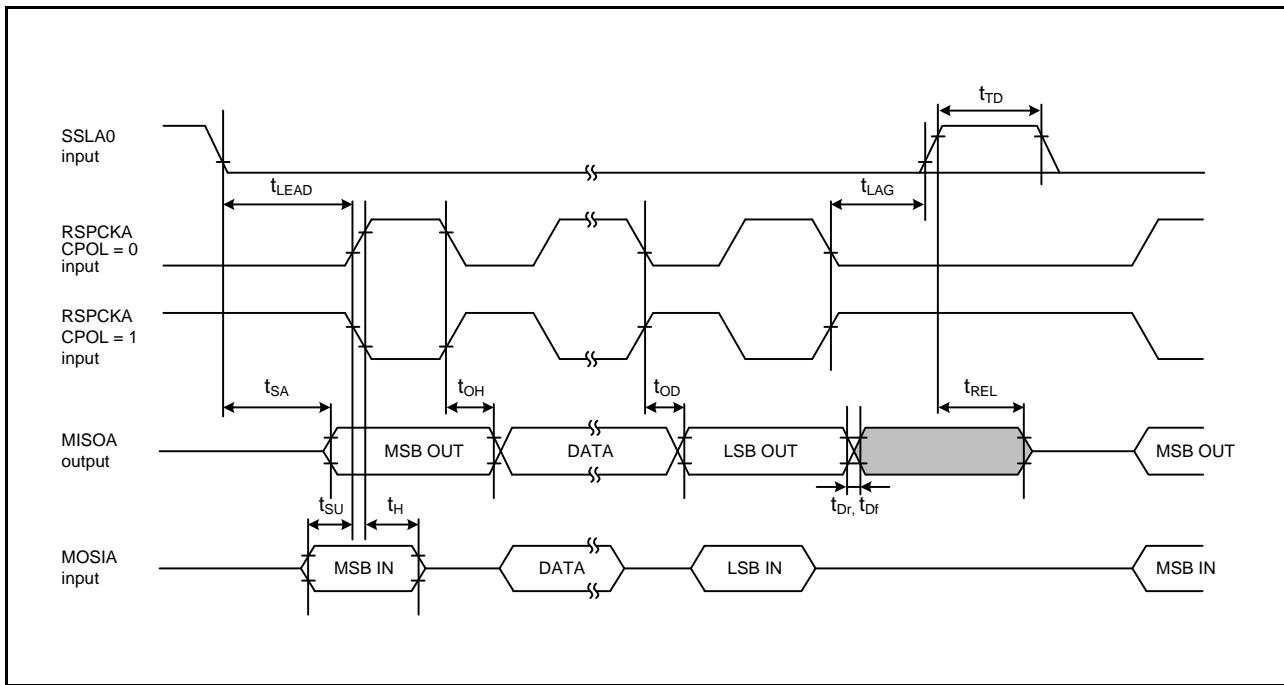


Figure 2.50 RSPI Timing (Slave, CPHA = 0)

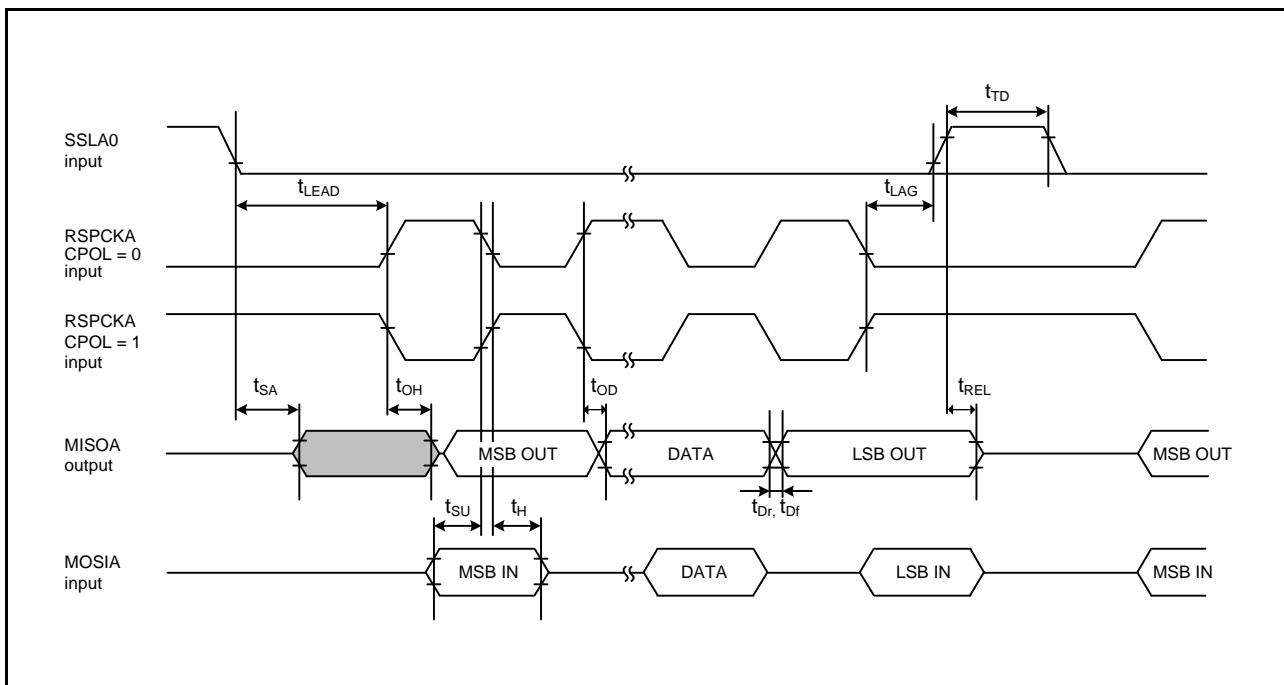


Figure 2.51 RSPI Timing (Slave, CPHA = 1)

### 2.5.5.8 A/D Converter Trigger

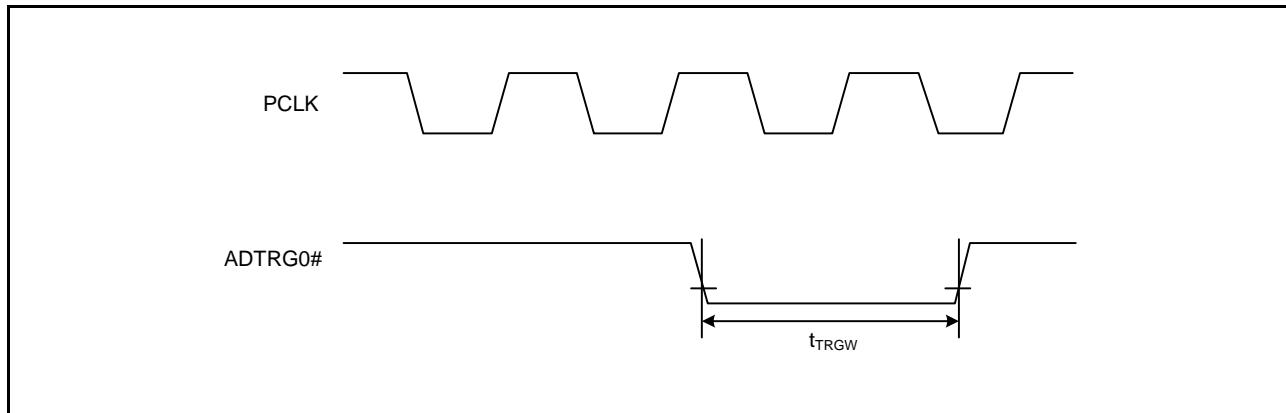
**Table 2.55 A/D Converter Trigger Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item                                    | Symbol     | Min. | Max. | Unit *1    | Test Conditions |
|---|------------|------|------|------------|-----------------|
| A/D converter Trigger input pulse width | $t_{TRGW}$ | 1.5  | —    | $t_{Pcyc}$ | Figure 2.52     |

Note 1.  $t_{Pcyc}$ : PCLK cycle



**Figure 2.52 A/D Converter External Trigger Input Timing**

### 2.5.5.9 CAC

**Table 2.56 CAC Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item                        | Symbol                     | Min.                       | Max. | Unit *1                | Test Conditions |
|-----------------------------|----------------------------|----------------------------|------|------------------------|-----------------|
| CAC                         | $t_{CACREF}$               | $4.5 t_{cac} + 3 t_{Pcyc}$ | —    | ns                     |                 |
|                             | $t_{CACREF}$               | $5 t_{cac} + 6.5 t_{Pcyc}$ | —    | —                      |                 |
| CACREF input rise/fall time | $t_{CACREFr}, t_{CACREFf}$ | —                          | 0.1  | $\mu\text{s}/\text{V}$ |                 |

Note 1.  $t_{Pcyc}$ : PCLK cycle

Note 2.  $t_{cac}$ : CAC count clock source cycle

### 2.5.5.10 CLKOUT

**Table 2.57 CLKOUT Timing**

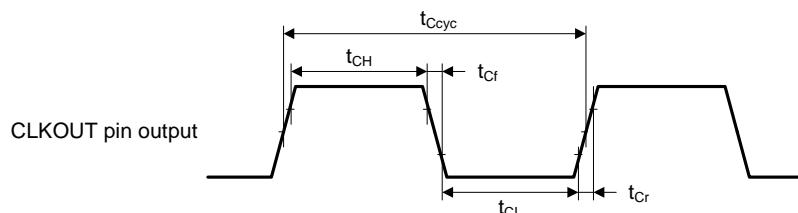
Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

Output load conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $C = 30 \text{ pF}$

| Item   |                               | Symbol    | Min. | Max. | Unit | Test Conditions |
|--------|-------------------------------|-----------|------|------|------|-----------------|
| CLKOUT | CLKOUT pin output cycle*2     | $t_{Cyc}$ | 62.5 | —    | ns   | Figure 2.53     |
|        |                               |           | 125  | —    | ns   |                 |
|        | CLKOUT pin high pulse width*1 | $t_{CH}$  | 15   | —    | ns   |                 |
|        |                               |           | 30   | —    | ns   |                 |
|        | CLKOUT pin low pulse width*1  | $t_{CL}$  | 15   | —    | ns   |                 |
|        |                               |           | 30   | —    | ns   |                 |
|        | CLKOUT pin output rise time   | $t_{Cr}$  | —    | 12   | ns   |                 |
|        |                               |           | —    | 25   | ns   |                 |
|        | CLKOUT pin output fall time   | $t_{Cf}$  | —    | 12   | ns   |                 |
|        |                               |           | —    | 25   | ns   |                 |

Note 1. When the LOCO is selected as the clock output source (CKOCR.CKOSEL[3:0] bits = 0000b), set the clock output division ratio selection to divided by 2 (CKOCR.CKODIV[2:0] bits = 001b).

Note 2. When the XTAL external clock input or an oscillator is used with divided by 1 (CKOCR.CKOSEL[3:0] bits = 010b and CKOCR.CKODIV[2:0] bits = 000b) to output from CLKOUT, the above should be satisfied with an input duty cycle of 45 to 55%.



Test conditions:  $V_{OH} = 0.7 \times \text{VCC}$ ,  $V_{OL} = 0.3 \times \text{VCC}$ ,  $I_{OH} = -1.0 \text{ mA}$ ,  $I_{OL} = 1.0 \text{ mA}$ ,  $C = 30 \text{ pF}$

**Figure 2.53 CLKOUT Output Timing**

## 2.6 A/D Conversion Characteristics

**Table 2.58 A/D Conversion Characteristics (1)**

Conditions:  $2.7 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $2.7 \text{ V} \leq \text{VREFH0} = \text{AVCC0} \leq 5.5 \text{ V}$ <sup>\*1</sup>,  $\text{VSS} = \text{AVSS0} = \text{VREFL0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ ,  
signal source impedance =  $0.3 \text{ k}\Omega$   
Reference voltage =  $\text{VREFH0}$

| Item  | Min.                          | Typ. | Max.   | Unit              | Test Conditions  |
|---|-------------------------------|------|--------|-------------------|--|
| Frequency   | 1                             | —    | 48     | MHz               |  |
| Resolution  | —                             | —    | 12     | Bit               |  |
| Conversion time*2<br>(operation at<br>$\text{PCLKD} = 48 \text{ MHz}$ ) | 0.67<br>(0.208) <sup>*3</sup> | —    | —      | μs                | High-precision channel<br>$\text{ADCSR.ADHSC} = 0$<br>$\text{ADSSTRn} = 0Ah$<br>$\text{ADCCR.CCS} = 1$   |
|   | 1.29<br>(0.833) <sup>*3</sup> | —    | —      | μs                | Normal-precision channel<br>$\text{ADCSR.ADHSC} = 0$<br>$\text{ADSSTRn} = 28h$<br>$\text{ADCCR.CCS} = 1$ |
| Analog input capacitance  | Cs                            | —    | —      | 9 <sup>*4</sup>   | pF High-precision channel  |
|   |                               | —    | —      | 10 <sup>*4</sup>  | Normal-precision channel   |
| Analog input resistance   | Rs                            | —    | —      | 1.9 <sup>*4</sup> | kΩ High-precision channel  |
|   |                               | —    | —      | 6.0 <sup>*4</sup> | Normal-precision channel   |
| Analog input effective range  | 0                             | —    | VREFH0 | V                 |  |
| Offset error  | —                             | ±1.0 | ±4.5   | LSB               | High-precision channel   |
|   |                               |      | ±6.0   | LSB               | Other than above   |
| Full-scale error  | —                             | ±1.0 | ±4.5   | LSB               | High-precision channel   |
|   |                               |      | ±6.0   | LSB               | Other than above   |
| Quantization error  | —                             | ±0.5 | —      | LSB               |  |
| Absolute accuracy   | —                             | ±2.5 | ±5.5   | LSB               | High-precision channel   |
|   |                               |      | ±8.5   | LSB               | Other than above   |
| DNL differential nonlinearity error                                     | —                             | ±1.0 | —      | LSB               |  |
| INL integral nonlinearity error   | —                             | ±1.5 | ±3.0   | LSB               |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. For 32-pin products,  $\text{VREFH0} = \text{AVCC0}$ .

Note 2. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 3. The values in ( ) show the sampling times.

Note 4. The values are reference values.

**Table 2.59 A/D Conversion Characteristics (2)**

Conditions:  $2.4 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $2.4 \text{ V} \leq \text{VREFH0} = \text{AVCC0} \leq 5.5 \text{ V}^*{}^1$ ,  $\text{VSS} = \text{AVSS0} = \text{VREFL0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ ,  
signal source impedance =  $1.3 \text{ k}\Omega$   
Reference voltage =  $\text{VREFH0}$

| Item  |    | Min.                          | Typ. | Max.              | Unit | Test Conditions   |
|---|----|-------------------------------|------|-------------------|------|---|
| Frequency   |    | 1                             | —    | 32                | MHz  |   |
| Resolution  |    | —                             | —    | 12                | Bit  |   |
| Conversion time* <sup>2</sup><br>(Operation at<br>PCLKD = 32 MHz) |    | 1.00<br>(0.313)* <sup>3</sup> | —    | —                 | μs   | High-precision channel<br>ADCSR.ADHSC bit = 0<br>ADSSTRn = 0Ah<br>ADCCR.CCS = 1   |
|   |    | 1.94<br>(1.250)* <sup>3</sup> | —    | —                 | μs   | Normal-precision channel<br>ADCSR.ADHSC bit = 0<br>ADSSTRn = 28h<br>ADCCR.CCS = 1 |
| Analog input capacitance  | Cs | —                             | —    | 9* <sup>4</sup>   | pF   | High-precision channel  |
|   |    | —                             | —    | 10* <sup>4</sup>  |      | Normal-precision channel  |
| Analog input resistance   | Rs | —                             | —    | 2.2* <sup>4</sup> | kΩ   | High-precision channel  |
|   |    | —                             | —    | 7.0* <sup>4</sup> |      | Normal-precision channel  |
| Analog input effective range                                      |    | 0                             | —    | VREFH0            | V    |   |
| Offset error  |    | —                             | ±1.0 | ±4.5              | LSB  | High-precision channel  |
|   |    | —                             | —    | ±6.0              | LSB  | Other than above  |
| Full-scale error  |    | —                             | ±1.0 | ±4.5              | LSB  | High-precision channel  |
|   |    | —                             | —    | ±6.0              | LSB  | Other than above  |
| Quantization error  |    | —                             | ±0.5 | —                 | LSB  |   |
| Absolute accuracy   |    | —                             | ±2.5 | ±5.5              | LSB  | High-precision channel  |
|   |    | —                             | —    | ±8.5              | LSB  | Other than above  |
| DNL differential nonlinearity error                               |    | —                             | ±1.0 | —                 | LSB  |   |
| INL integral nonlinearity error                                   |    | —                             | ±1.5 | ±3.0              | LSB  |   |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. For 32-pin products,  $\text{VREFH0} = \text{AVCC0}$ .

Note 2. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 3. The values in ( ) show the sampling times.

Note 4. The values are reference values.

**Table 2.60 A/D Conversion Characteristics (3)**

Conditions: 2.7 V ≤ VCC ≤ 5.5 V, 2.7 V ≤ VREFH0 = AVCC0 ≤ 5.5 V<sup>\*1</sup>, VSS = AVSS0 = VREFL0 = 0 V, T<sub>a</sub> = -40 to +105°C,  
signal source impedance = 1.1 kΩ  
Reference voltage = VREFH0

| Item  |    | Min.                          | Typ.  | Max.              | Unit | Test Conditions   |  |
|---|----|-------------------------------|-------|-------------------|------|---|--|
| Frequency   |    | 1                             | —     | 24                | MHz  |   |  |
| Resolution  |    | —                             | —     | 12                | Bit  |   |  |
| Conversion time <sup>*2</sup><br>(operation at<br>PCLKD = 24 MHz) |    | 1.58<br>(0.417) <sup>*3</sup> | —     | —                 | μs   | High-precision channel<br>ADCSR.ADHSC bit = 1<br>ADSSTRn = 0Ah<br>ADCCR.CCS = 1   |  |
|   |    | 2.00<br>(0.833) <sup>*3</sup> | —     | —                 |      | Normal-precision channel<br>ADCSR.ADHSC bit = 1<br>ADSSTRn = 14h<br>ADCCR.CCS = 1 |  |
| Analog input capacitance  | Cs | —                             | —     | 9 <sup>*4</sup>   | pF   | High-precision channel  |  |
|   |    | —                             | —     | 10 <sup>*4</sup>  |      | Normal-precision channel  |  |
| Analog input resistance   | Rs | —                             | —     | 1.9 <sup>*4</sup> | kΩ   | High-precision channel  |  |
|   |    | —                             | —     | 6 <sup>*4</sup>   |      | Normal-precision channel  |  |
| Analog input effective range                                      |    | 0                             | —     | VREFH0            | V    |   |  |
| Offset error  |    | —                             | ±1.25 | ±4.5              | LSB  | High-precision channel  |  |
|   |    |                               |       | ±6.0              | LSB  | Other than above  |  |
| Full-scale error  |    | —                             | ±1.0  | ±4.5              | LSB  | High-precision channel  |  |
|   |    |                               |       | ±6.0              | LSB  | Other than above  |  |
| Quantization error  |    | —                             | ±0.5  | —                 | LSB  |   |  |
| Absolute accuracy   |    | —                             | ±2.5  | ±5.5              | LSB  | High-precision channel  |  |
|   |    |                               |       | ±8.5              | LSB  | Other than above  |  |
| DNL differential nonlinearity error                               |    | —                             | ±1.0  | —                 | LSB  |   |  |
| INL integral nonlinearity error                                   |    | —                             | ±1.5  | ±3.0              | LSB  |   |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. For 32-pin products, VREFH0 = AVCC0.

Note 2. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 3. The values in ( ) show the sampling times.

Note 4. The values are reference values.

**Table 2.61 A/D Conversion Characteristics (4)**

Conditions:  $2.4 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $2.4 \text{ V} \leq \text{VREFH0} = \text{AVCC0} \leq 5.5 \text{ V}^*{}^1$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ , signal source impedance =  $2.2 \text{ k}\Omega$   
 Reference voltage = VREFH0

| Item  |    | Min.                          | Typ.  | Max.              | Unit | Test Conditions   |
|---|----|-------------------------------|-------|-------------------|------|---|
| Frequency   |    | 1                             | —     | 16                | MHz  |   |
| Resolution  |    | —                             | —     | 12                | Bit  |   |
| Conversion time* <sup>2</sup><br>(operation at<br>PCLKD = 16 MHz) |    | 2.38<br>(0.625)* <sup>3</sup> | —     | —                 | μs   | High-precision channel<br>ADCSR.ADHSC bit = 1<br>ADSSTRn = 0Ah<br>ADCCR.CCS = 1   |
|   |    | 3.00<br>(1.250)* <sup>3</sup> | —     | —                 |      | Normal-precision channel<br>ADCSR.ADHSC bit = 1<br>ADSSTRn = 14h<br>ADCCR.CCS = 1 |
| Analog input capacitance  | Cs | —                             | —     | 9* <sup>4</sup>   | pF   | High-precision channel  |
|   |    | —                             | —     | 10* <sup>4</sup>  |      | Normal-precision channel  |
| Analog input resistance   | Rs | —                             | —     | 2.2* <sup>4</sup> | kΩ   | High-precision channel  |
|   |    | —                             | —     | 7* <sup>4</sup>   |      | Normal-precision channel  |
| Analog input effective range                                      |    | 0                             | —     | VREFH0            | V    |   |
| Offset error  |    | —                             | ±1.25 | ±4.5              | LSB  | High-precision channel  |
|   |    | —                             |       | ±6.0              | LSB  | Other than above  |
| Full-scale error  |    | —                             | ±1.0  | ±4.5              | LSB  | High-precision channel  |
|   |    | —                             |       | ±6.0              | LSB  | Other than above  |
| Quantization error  |    | —                             | ±0.5  | —                 | LSB  |   |
| Absolute accuracy   |    | —                             | ±2.5  | ±5.5              | LSB  | High-precision channel  |
|   |    | —                             |       | ±8.5              | LSB  | Other than above  |
| DNL differential nonlinearity error                               |    | —                             | ±1.0  | —                 | LSB  |   |
| INL integral nonlinearity error                                   |    | —                             | ±1.5  | ±3.0              | LSB  |   |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. or 32-pin products, VREFH0 = AVCC0.

Note 2. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 3. The values in ( ) show the sampling times.

Note 4. The values are reference values.

**Table 2.62 A/D Conversion Characteristics (5)**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ VREFH0 = AVCC0 ≤ 5.5 V<sup>\*1</sup>, VSS = AVSS0 = VREFL0 = 0 V, T<sub>a</sub> = -40 to +105°C,  
signal source impedance = 5 kΩ  
Reference voltage = VREFH0

| Item   |    | Min.                          | Typ.  | Max.             | Unit | Test Conditions   |  |
|--|----|-------------------------------|-------|------------------|------|---|--|
| Frequency  |    | 1                             | —     | 8                | MHz  |   |  |
| Resolution   |    | —                             | —     | 12               | Bit  |   |  |
| Conversion time <sup>*2</sup><br>(operation at<br>PCLKD = 8 MHz) |    | 4.75<br>(1.250) <sup>*3</sup> | —     | —                | μs   | High-precision channel<br>ADCSR.ADHSC bit = 1<br>ADSSTRn = 0Ah<br>ADCCR.CCS = 1   |  |
|  |    | 6.00<br>(2.500) <sup>*3</sup> | —     | —                |      | Normal-precision channel<br>ADCSR.ADHSC bit = 1<br>ADSSTRn = 14h<br>ADCCR.CCS = 1 |  |
| Analog input capacitance   | Cs | —                             | —     | 9 <sup>*4</sup>  | pF   | High-precision channel  |  |
|  |    | —                             | —     | 10 <sup>*4</sup> |      | Normal-precision channel  |  |
| Analog input resistance  | Rs | —                             | —     | 6 <sup>*4</sup>  | kΩ   | High-precision channel  |  |
|  |    | —                             | —     | 14 <sup>*4</sup> |      | Normal-precision channel  |  |
| Analog input effective range                                     |    | 0                             | —     | VREFH0           | V    |   |  |
| Offset error   |    | —                             | ±1.25 | ±7.5<br>±10.0    | LSB  | High-precision channel<br>Other than above  |  |
| Full-scale error   |    | —                             | ±1.5  | ±7.5<br>±10.0    | LSB  | High-precision channel<br>Other than above  |  |
| Quantization error   |    | —                             | ±0.5  | —                | LSB  |   |  |
| Absolute accuracy  |    | —                             | ±3.0  | ±8.0<br>±11.0    | LSB  | High-precision channel<br>Other than above  |  |
| DNL differential nonlinearity error                              |    | —                             | ±1.25 | —                | LSB  |   |  |
| INL integral nonlinearity error                                  |    | —                             | ±1.5  | ±3.5             | LSB  |   |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

- Note 1. For 32-pin products, VREFH0 = AVCC0.
- Note 2. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.
- Note 3. The values in ( ) show the sampling times.
- Note 4. The values are reference values.

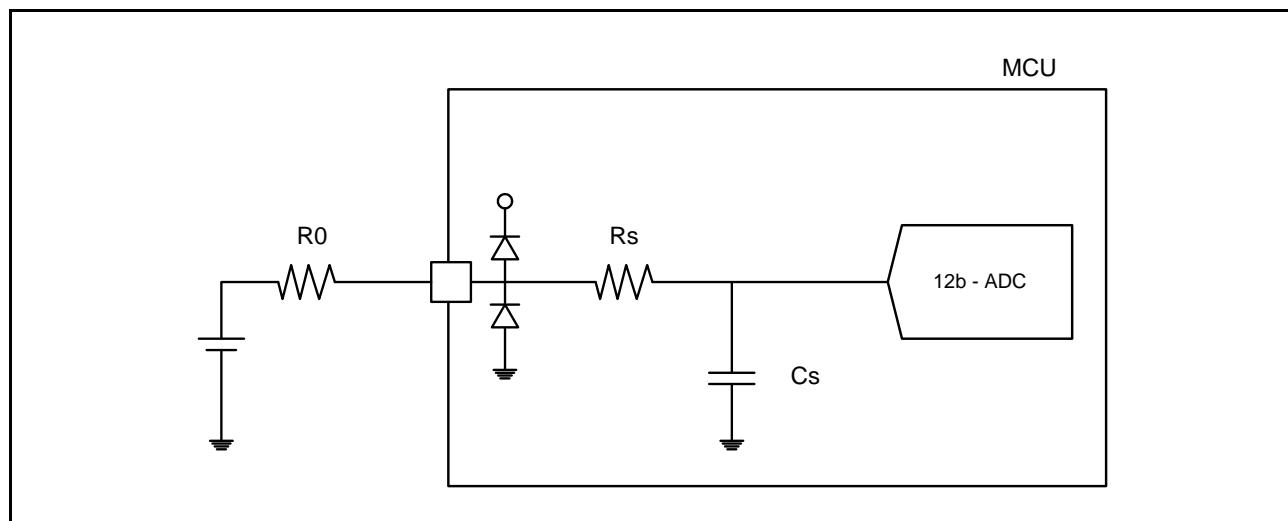
**Table 2.63 A/D Converter Channel Classification**

| Classification                           | Channel                           | Conditions           | Remarks   |
|--|-----------------------------------|----------------------|---|
| High-precision channel                   | AN000 to AN007                    | AVCC0 = 1.8 to 5.5 V | Pins AN000 to AN007 cannot be used as digital outputs when the A/D converter is in use. |
| Normal-precision channel                 | AN016 to AN021,<br>AN024 to AN026 |                      |   |
| Internal reference voltage input channel | Internal reference voltage        | AVCC0 = 1.8 to 5.5 V |   |
| Temperature sensor input channel         | Temperature sensor output         | AVCC0 = 1.8 to 5.5 V |   |
| CTSU input channels                      | AN008                             | AVCC0 = 1.8 to 5.5V  |   |

**Table 2.64 A/D Internal Reference Voltage Characteristics**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{VREFH0} = \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = \text{VREFL0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                                       | Min. | Typ. | Max. | Unit | Test Conditions |
|--|------|------|------|------|-----------------|
| Internal reference voltage input channel*1 | 1.42 | 1.48 | 1.54 | V    |                 |

Note 1. The A/D internal reference voltage indicates the voltage when the internal reference voltage is input to the A/D converter.

**Figure 2.54 Equivalent Circuit**

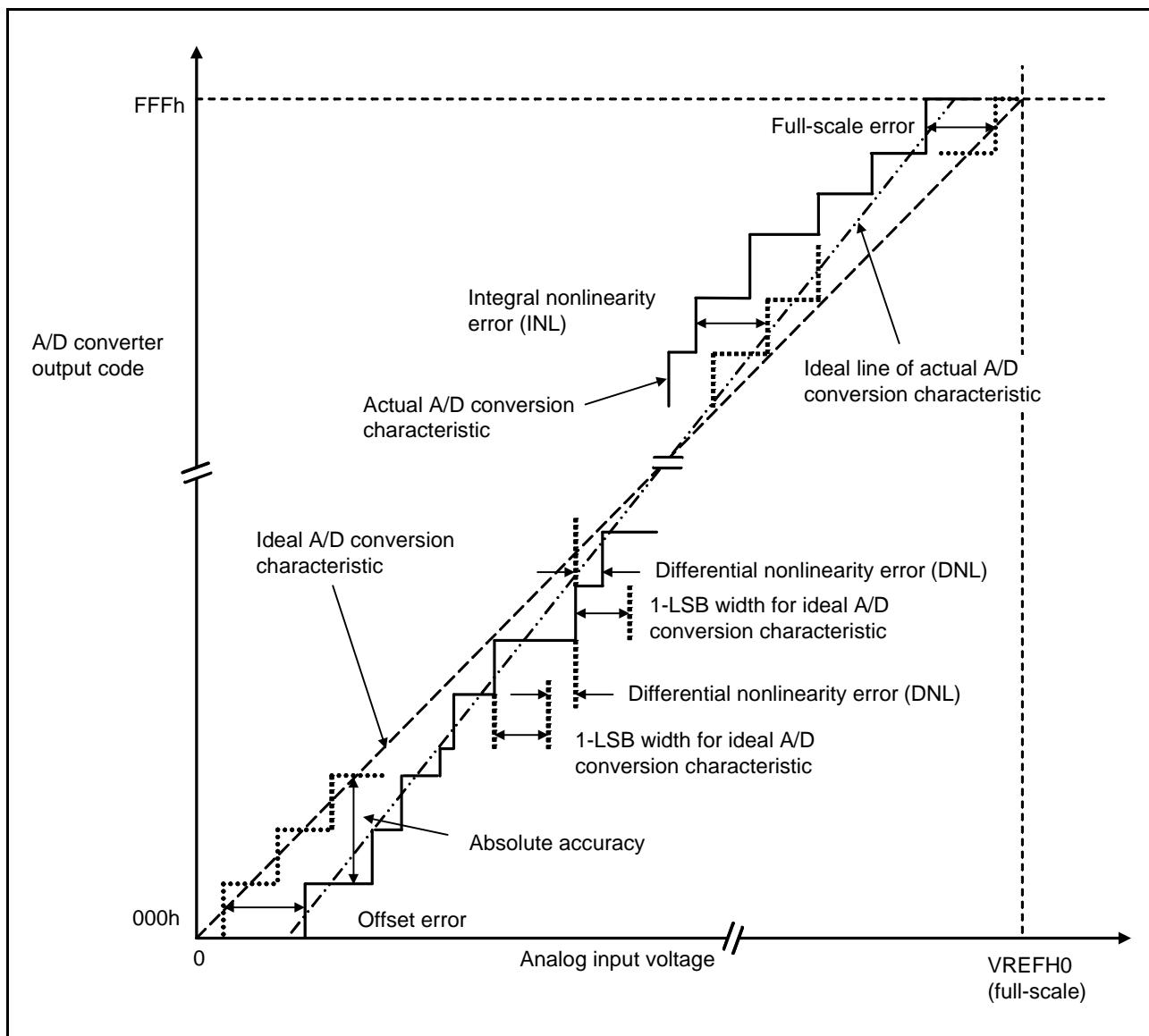


Figure 2.55 Illustration of A/D Converter Characteristic Terms

### Absolute accuracy

Absolute accuracy is the difference between output code based on the theoretical A/D conversion characteristics, and the actual A/D conversion result. When measuring absolute accuracy, the voltage at the midpoint of the width of analog input voltage (1-LSB width), that can meet the expectation of outputting an equal code based on the theoretical A/D conversion characteristics, is used as an analog input voltage. For example, if 12-bit resolution is used and if reference voltage ( $VREFH0 = 3.072\text{ V}$ ), then 1-LSB width becomes  $0.75\text{ mV}$ , and  $0\text{ mV}, 0.75\text{ mV}, 1.5\text{ mV}, \dots$  are used as analog input voltages.

If analog input voltage is  $6\text{ mV}$ , absolute accuracy =  $\pm 5\text{ LSB}$  means that the actual A/D conversion result is in the range of  $003\text{h}$  to  $00D\text{h}$  though an output code,  $008\text{h}$ , can be expected from the theoretical A/D conversion characteristics.

### Integral nonlinearity error (INL)

Integral nonlinearity error is the maximum deviation between the ideal line when the measured offset and full-scale errors are zeroed, and the actual output code.

**Differential nonlinearity error (DNL)**

Differential nonlinearity error is the difference between 1 LSB width based on the ideal A/D conversion characteristics and the width of the actual output code.

**Offset error**

Offset error is the difference between a transition point of the ideal first output code and the actual first output code.

**Full-scale error**

Full-scale error is the difference between a transition point of the ideal last output code and the actual last output code.

## 2.7 D/A Conversion Characteristics

**Table 2.65 D/A Conversion Characteristics (1)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                 |  | Symbol             | Min. | Typ. | Max.      | Unit          | Test Conditions             |
|----------------------|--|--------------------|------|------|-----------|---------------|-----------------------------|
| Resolution           |  | —                  | —    | —    | 8         | Bit           |                             |
| Conversion time      | $\text{VCC} = 1.8 \text{ to } 5.5 \text{ V}$ | $t_{\text{DCONV}}$ | —    | —    | 3.0       | $\mu\text{s}$ | 35-pF capacitive load       |
| Absolute accuracy    | $\text{VCC} = 2.4 \text{ to } 5.5 \text{ V}$ | —                  | —    | —    | $\pm 3.0$ | LSB           | 2-M $\Omega$ resistive load |
|                      | $\text{VCC} = 1.8 \text{ to } 2.4 \text{ V}$ | —                  | —    | —    | $\pm 3.5$ |               |                             |
|                      | $\text{VCC} = 2.4 \text{ to } 5.5 \text{ V}$ | —                  | —    | —    | $\pm 2.0$ | LSB           | 4-M $\Omega$ resistive load |
|                      | $\text{VCC} = 1.8 \text{ to } 2.4 \text{ V}$ | —                  | —    | —    | $\pm 2.5$ |               |                             |
| RO output resistance |  | —                  | —    | 9.0  | —         | k $\Omega$    |                             |

## 2.8 Temperature Sensor Characteristics

**Table 2.66 Temperature Sensor Characteristics**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                                  | Symbol             | Min. | Typ.      | Max. | Unit  | Test Conditions              |
|---------------------------------------|--------------------|------|-----------|------|-------|------------------------------|
| Relative accuracy                     | —                  | —    | $\pm 1.5$ | —    | °C    | 2.4 V or above               |
|                                       |                    | —    | $\pm 2.0$ | —    |       | Below 2.4 V                  |
| Temperature slope                     | —                  | —    | -3.3      | —    | mV/°C |                              |
| Output voltage ( $25^\circ\text{C}$ ) | —                  | —    | 1.05      | —    | V     | $\text{VCC} = 3.3 \text{ V}$ |
| Temperature sensor start time         | $t_{\text{START}}$ | —    | —         | 5    | μs    |                              |
| Sampling time                         | —                  | 5    | —         | —    | μs    |                              |

## 2.9 Comparator Characteristics

**Table 2.67 Comparator Characteristics**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item   | Symbol  | Min. | Typ.                     | Max.               | Unit | Test Conditions  |
|--|---|------|--------------------------|--------------------|------|--|
| CVREFB0 to CVREFB1 input reference voltage   | VREF  | 0    | —                        | $\text{VCC} - 1.4$ | V    |  |
| CMPB0 to CMPB1 input voltage   | VI  | 0    | —                        | VCC                | V    |  |
| Internal reference voltage   | —   | 1.34 | 1.44                     | 1.54               | V    |  |
| Offset   | Comparator high-speed mode                            | —    | —                        | 50                 | mV   |  |
|  | Comparator high-speed mode<br>Window function enabled | —    | —                        | 60                 | mV   |  |
|  | Comparator low-speed mode                             | —    | —                        | 40                 | mV   |  |
| Comparator output delay time   | Comparator high-speed mode                            | Td   | —                        | 1.2                | μs   | $\text{VCC} = 3 \text{ V}$ ,<br>input slew rate $\geq 50 \text{ mV}/\mu\text{s}$ |
|  | Comparator high-speed mode<br>Window function enabled | Tdw  | —                        | 2.0                | μs   |  |
|  | Comparator low-speed mode                             | Td   | —                        | 9.0                | μs   |  |
| High-side reference voltage<br>(comparator high-speed mode, window function enabled) | VRFH  | —    | $0.76 \times \text{VCC}$ | —                  | V    |  |
| Low-side reference voltage<br>(comparator high-speed mode, window function enabled)  | VRFL  | —    | $0.24 \times \text{VCC}$ | —                  | V    |  |
| Operation stabilization wait time  | Tcmp  | 100  | —                        | —                  | μs   |  |

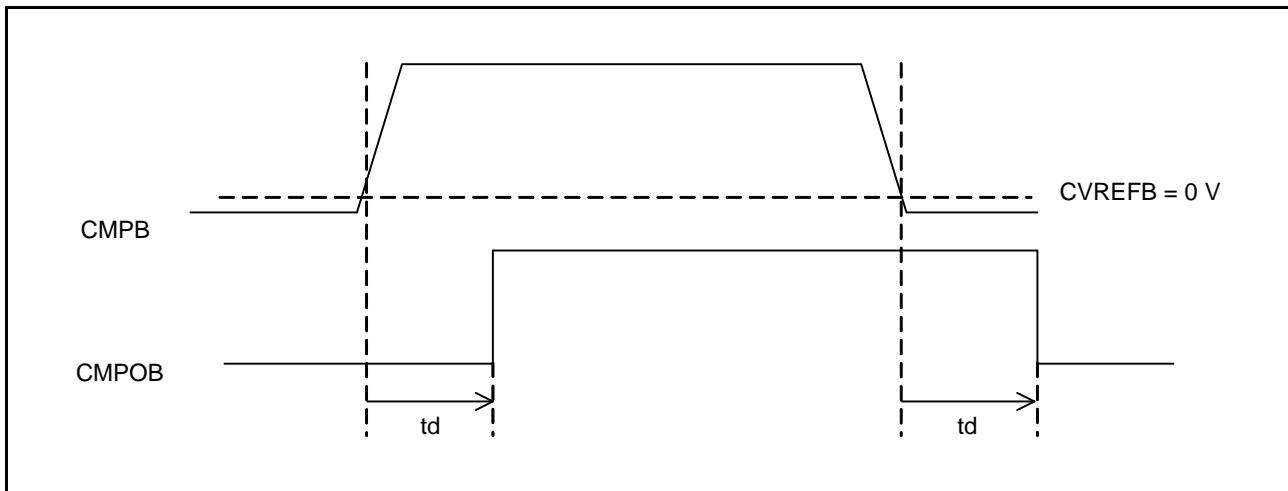


Figure 2.56 Comparator Output Delay Time in Comparator High-Speed Mode and Low-Speed Mode

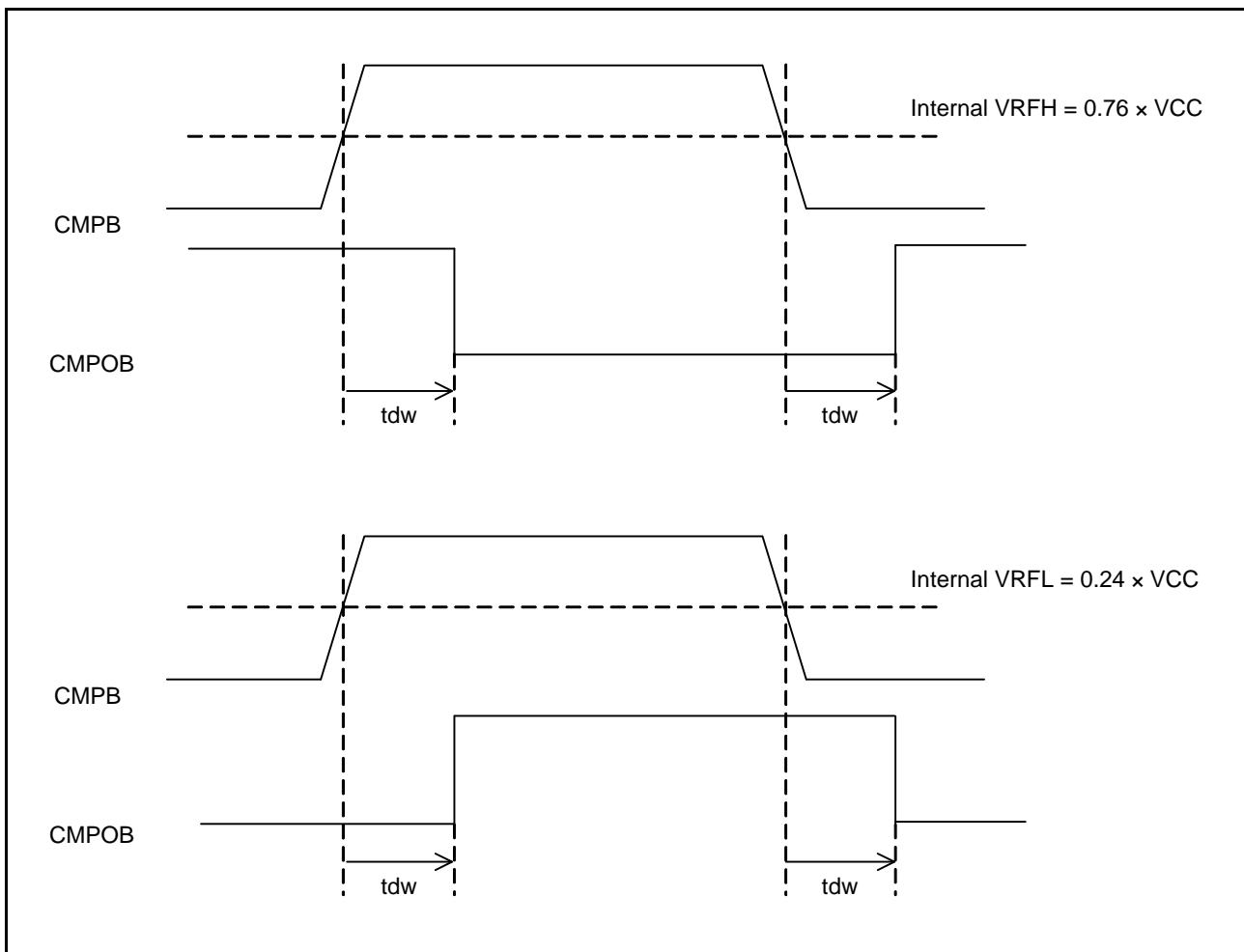


Figure 2.57 Comparator Output Delay Time in High-Speed Mode with Window Function Enabled

## 2.10 CTSU Characteristics

**Table 2.68 CTSU Characteristics**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item  | Symbol                              | Min. | Typ. | Max. | Unit | Test Conditions  |
|---|-------------------------------------|------|------|------|------|--|
| External capacitance connected to TSCAP pin | $C_{tscap}$                         | 9    | 10   | 11   | nF   |  |
| Permissible output high/low current         | $ \Sigma I_{OH}  +  \Sigma I_{OL} $ | —    | —    | 24   | mA   | When VXSEL = 0   |
|   |                                     | —    | —    | 16   | mA   | [Products with 64 Kbytes of flash memory or less] When VXSEL = 0   |
|   |                                     | —    | —    | 16   | mA   | [Products with at least 128 Kbytes of flash memory] When VXSEL = 0 |

## 2.11 Power-On Reset Circuit and Voltage Detection Circuit Characteristics

**Table 2.69 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (1)**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                    | Symbol   | Min.               | Typ. | Max. | Unit | Test Conditions |                                    |
|-------------------------|--|--------------------|------|------|------|-----------------|------------------------------------|
| Voltage detection level | Power-on reset (POR)                           | $V_{POR}$          | 1.35 | 1.50 | 1.65 | V               | Figure 2.58, Figure 2.59           |
|                         | Voltage detection circuit (LVD0) <sup>*1</sup> | $V_{det0\_0}$      | 3.67 | 3.85 | 3.97 | V               | Figure 2.60<br>At falling edge VCC |
|                         |  | $V_{det0\_1}$      | 2.70 | 2.85 | 3.00 |                 |                                    |
|                         |  | $V_{det0\_2}$      | 2.37 | 2.53 | 2.67 |                 |                                    |
|                         |  | $V_{det0\_3}$      | 1.80 | 1.90 | 1.99 |                 |                                    |
|                         | Voltage detection circuit (LVD1) <sup>*2</sup> | $V_{det1\_0}$      | 4.12 | 4.29 | 4.42 | V               | Figure 2.61<br>At falling edge VCC |
|                         |  | $V_{det1\_1}$      | 3.98 | 4.16 | 4.28 |                 |                                    |
|                         |  | $V_{det1\_2}$      | 3.86 | 4.03 | 4.16 |                 |                                    |
|                         |  | $V_{det1\_3}$      | 3.68 | 3.86 | 3.98 |                 |                                    |
|                         |  | $V_{det1\_4}$      | 2.99 | 3.10 | 3.29 |                 |                                    |
|                         |  | $V_{det1\_5}$      | 2.89 | 3.00 | 3.19 |                 |                                    |
|                         |  | $V_{det1\_6}$      | 2.79 | 2.90 | 3.09 |                 |                                    |
|                         |  | $V_{det1\_7}$      | 2.68 | 2.80 | 2.98 |                 |                                    |
|                         |  | $V_{det1\_8}$      | 2.57 | 2.68 | 2.87 |                 |                                    |
|                         |  | $V_{det1\_9}$      | 2.47 | 2.59 | 2.67 |                 |                                    |
|                         |  | $V_{det1\_A}$      | 2.37 | 2.48 | 2.57 |                 |                                    |
|                         |  | $V_{det1\_B}$      | 2.10 | 2.20 | 2.30 |                 |                                    |
|                         |  | $V_{det1\_C}$      | 1.86 | 1.96 | 2.06 |                 |                                    |
|                         |  | $V_{det1\_D}$      | 1.80 | 1.86 | 1.96 |                 |                                    |
| Voltage detection level | Voltage detection circuit (LVD2) <sup>*3</sup> | $V_{det2\_0}^{*4}$ | 4.08 | 4.32 | 4.48 | V               | Figure 2.62<br>At falling edge VCC |
|                         |  | $V_{det2\_1}$      | 3.95 | 4.17 | 4.35 |                 |                                    |
|                         |  | $V_{det2\_2}$      | 3.82 | 4.03 | 4.22 |                 |                                    |
|                         |  | $V_{det2\_3}$      | 3.62 | 3.84 | 4.02 |                 |                                    |

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD2), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

- Note 1. n in the symbol Vdet0\_n denotes the value of the LDSEL1[1:0] bits.  
 Note 2. n in the symbol Vdet1\_n denotes the value of the LVDLVL.R.LVD1LVL[3:0] bits.  
 Note 3. n in the symbol Vdet2\_n denotes the value of the LVDLVL.R.LVD2LVL[1:0] bits.  
 Note 4. Vdet2\_0 selection can be used only when the CMPA2 pin input voltage is selected, and cannot be used when the power supply voltage (VCC) is selected.

**Table 2.70 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (2)**Conditions:  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item   |  | Symbol              | Min. | Typ. | Max. | Unit | Test Conditions                   |  |
|--|--|---------------------|------|------|------|------|-----------------------------------|--|
| Wait time after power-on reset cancellation              | At normal startup* <sup>1</sup>        | t <sub>POR</sub>    | —    | 12.5 | —    | ms   | Figure 2.59                       |  |
|  | During fast startup time* <sup>2</sup> | t <sub>POR</sub>    | —    | 5.0  | —    | μs   |                                   |  |
| Wait time after voltage monitoring 0 reset cancellation  |  | t <sub>LVD0</sub>   | —    | 860  | —    | μs   | Figure 2.60                       |  |
| Wait time after voltage monitoring 1 reset cancellation  | LVD0 disabled* <sup>4</sup>            | t <sub>LVD1</sub>   | —    | 160  | —    | μs   | Figure 2.61                       |  |
|  | LVD0 enabled* <sup>5</sup>             |                     | —    | 860  | —    | μs   |                                   |  |
| Wait time after voltage monitoring 2 reset cancellation  | LVD0 disabled* <sup>4</sup>            | t <sub>LVD2</sub>   | —    | 160  | —    | μs   | Figure 2.62                       |  |
|  | LVD0 enabled* <sup>5</sup>             |                     | —    | 860  | —    | μs   |                                   |  |
| PDR response delay time                                  |  | t <sub>det</sub>    | —    | —    | 500  | μs   | Figure 2.58                       |  |
| LVD0 response delay time                                 |  |                     | —    | —    | 500  | μs   | Figure 2.58                       |  |
| LVD1 response delay time                                 |  |                     | —    | —    | 360  | μs   | Figure 2.58                       |  |
| LVD2 response delay time                                 |  |                     | —    | —    | 600  | μs   | Figure 2.58                       |  |
| POR/LVD0 minimum VCC down time* <sup>3</sup>             |  | t <sub>VOFF</sub>   | 500  | —    | —    | μs   | Figure 2.58, VCC = 1.0 V or above |  |
| LVD1 minimum VCC down time* <sup>3</sup>                 |  |                     | 300  | —    | —    | μs   | Figure 2.58, VCC = 1.0 V or above |  |
| LVD2 minimum VCC down time* <sup>3</sup>                 |  |                     | 600  | —    | —    | μs   | Figure 2.58, VCC = 1.0 V or above |  |
| Power-on reset enable time                               |  | t <sub>W(POR)</sub> | 1    | —    | —    | ms   | Figure 2.59, VCC = below 1.0 V    |  |
| LVD1 operation stabilization time (after LVD is enabled) |  | t <sub>d(E-A)</sub> | —    | —    | 300  | μs   | Figure 2.61                       |  |
| LVD2 operation stabilization time (after LVD is enabled) |  | t <sub>d(E-A)</sub> | —    | —    | 1200 | μs   | Figure 2.62                       |  |
| Hysteresis width (power-on rest (POR))                   |  | V <sub>PORH</sub>   | —    | 110  | —    | mV   |                                   |  |
| Hysteresis width (LVD0, LVD1, and LVD2)                  |  | V <sub>LVH</sub>    | —    | 60   | —    | mV   | Vdet0_0 to Vdet0_3 selected       |  |
|  |  |                     | —    | 110  | —    |      | Vdet1_0 to Vdet1_2 selected       |  |
|  |  |                     | —    | 70   | —    |      | Vdet1_3 to 9 selected             |  |
|  |  |                     | —    | 60   | —    |      | Vdet1_A to B selected             |  |
|  |  |                     | —    | 50   | —    |      | Vdet1_C to D selected             |  |
|  |  |                     | —    | 90   | —    |      | LVD2 selected                     |  |

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD1), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

- Note 1. When OFS1.(LVDAS, FASTSTUP) = 11b.  
 Note 2. When OFS1.(LVDAS, FASTSTUP) ≠ 11b.  
 Note 3. The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V<sub>POR</sub>, V<sub>det0</sub>, V<sub>det1</sub>, and V<sub>det2</sub> for the POR/LVD.  
 Note 4. When OFS1.LVDAS = 1b.  
 Note 5. When OFS1.LVDAS = 0b.

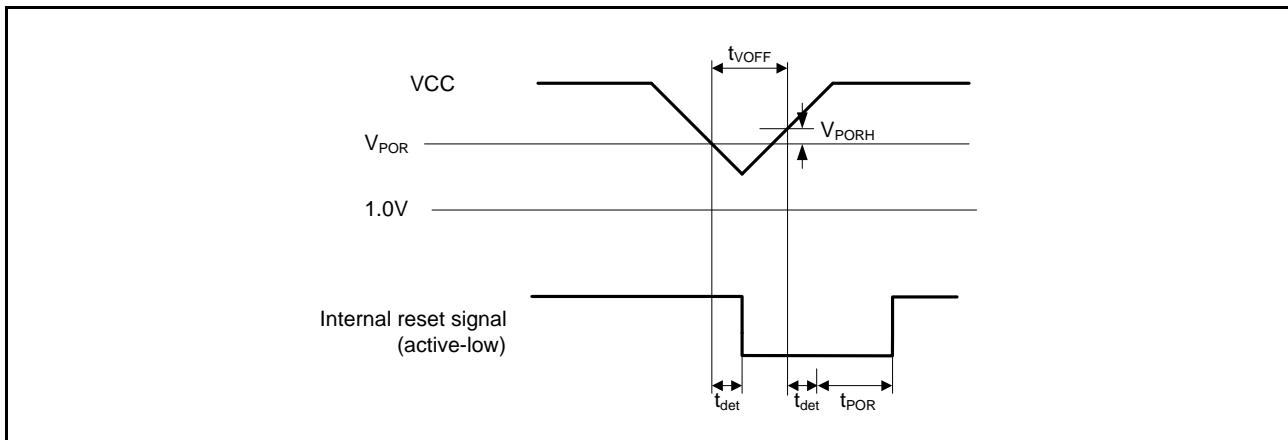


Figure 2.58 Voltage Detection Reset Timing

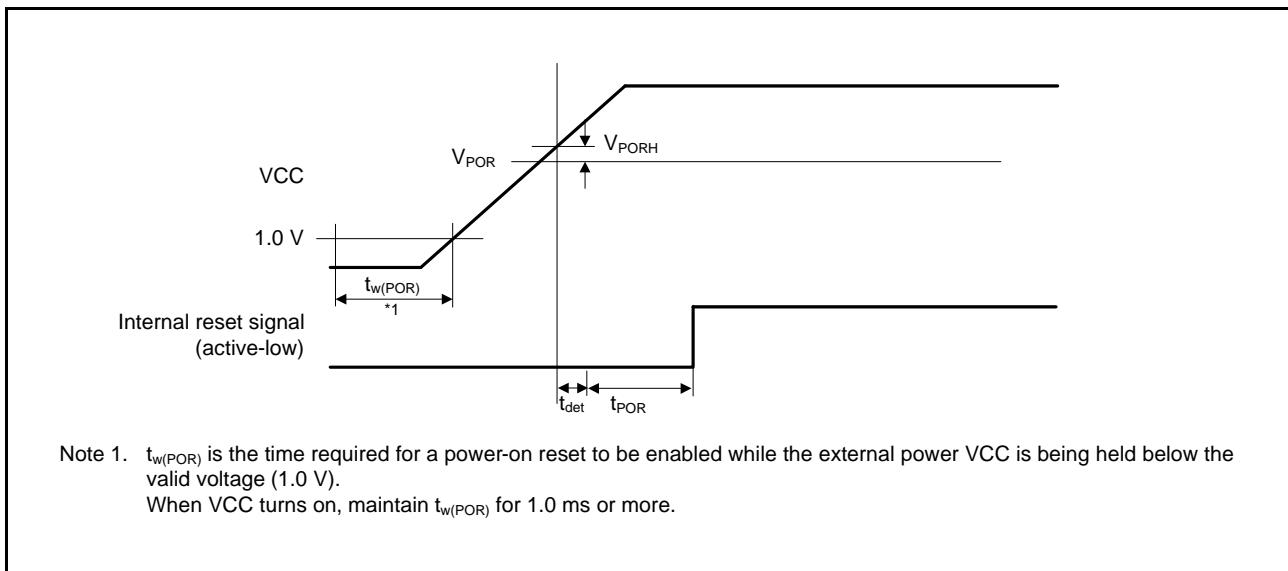
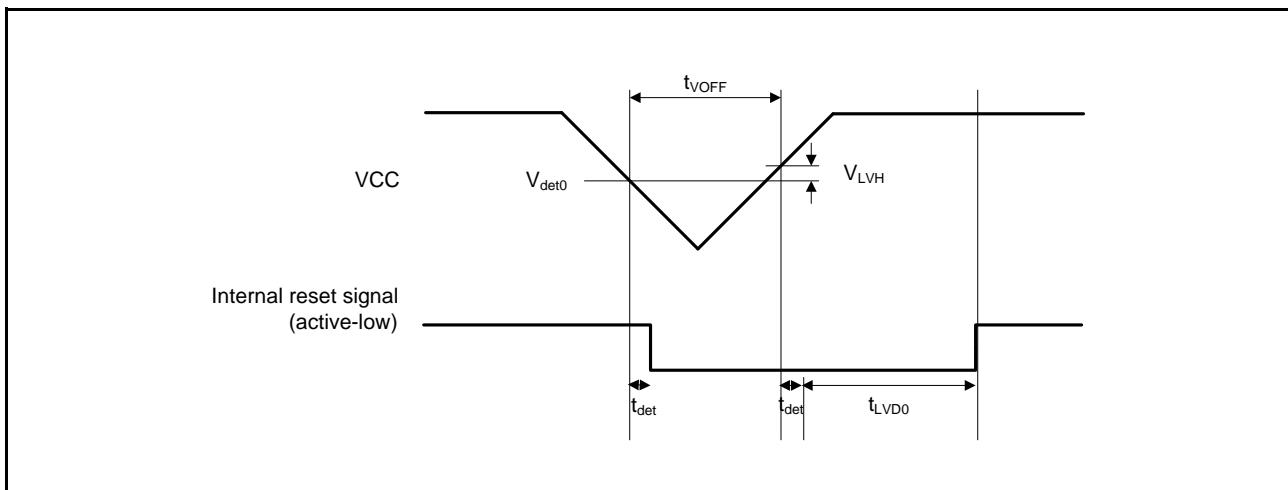
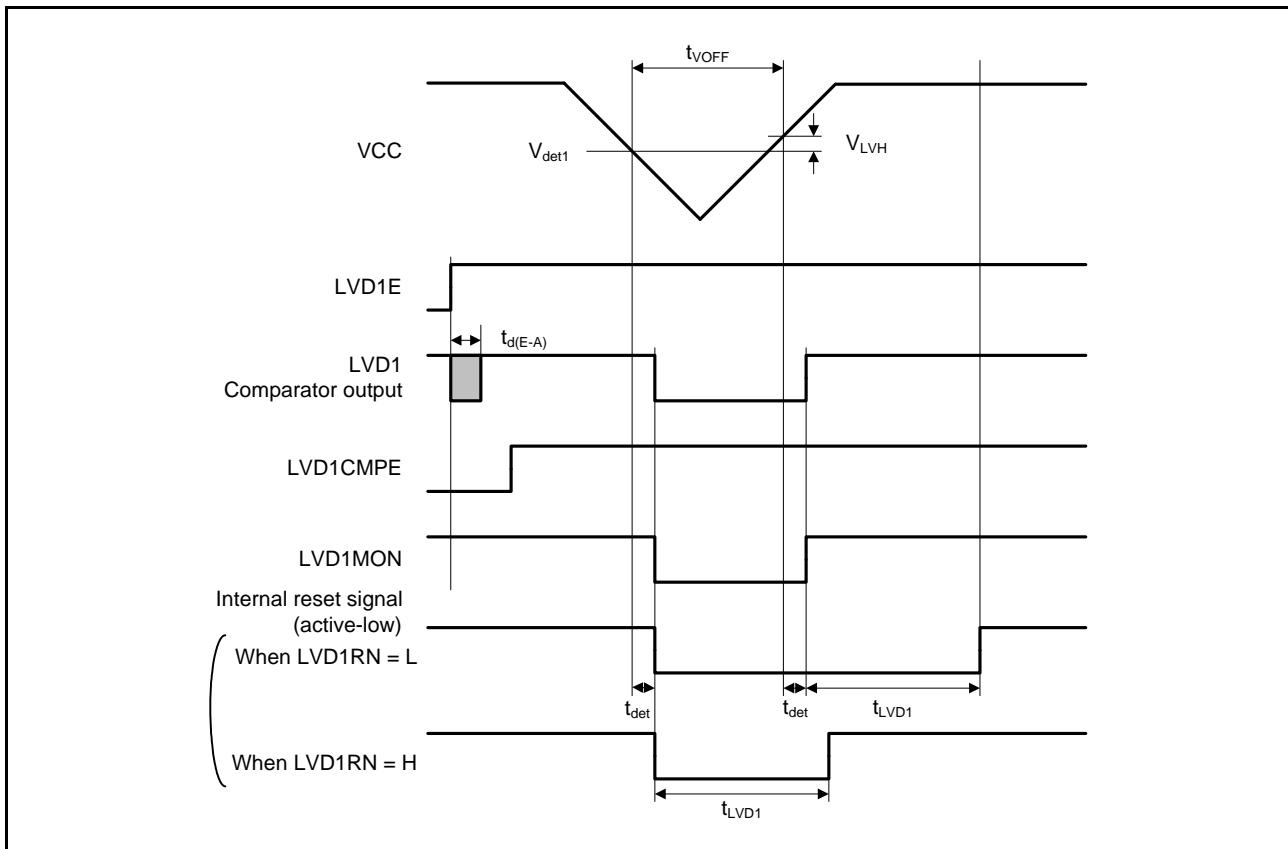
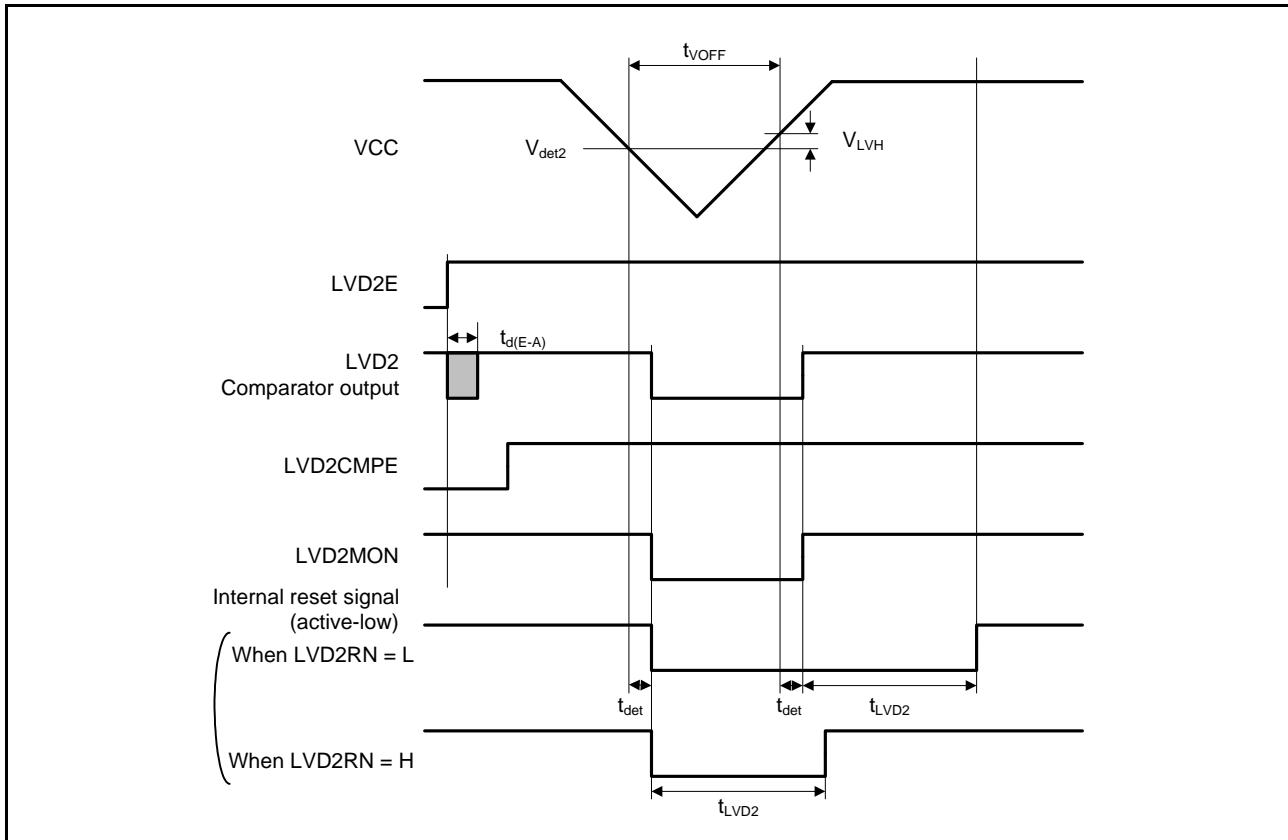


Figure 2.59 Power-On Reset Timing

Figure 2.60 Voltage Detection Circuit Timing ( $V_{det0}$ )

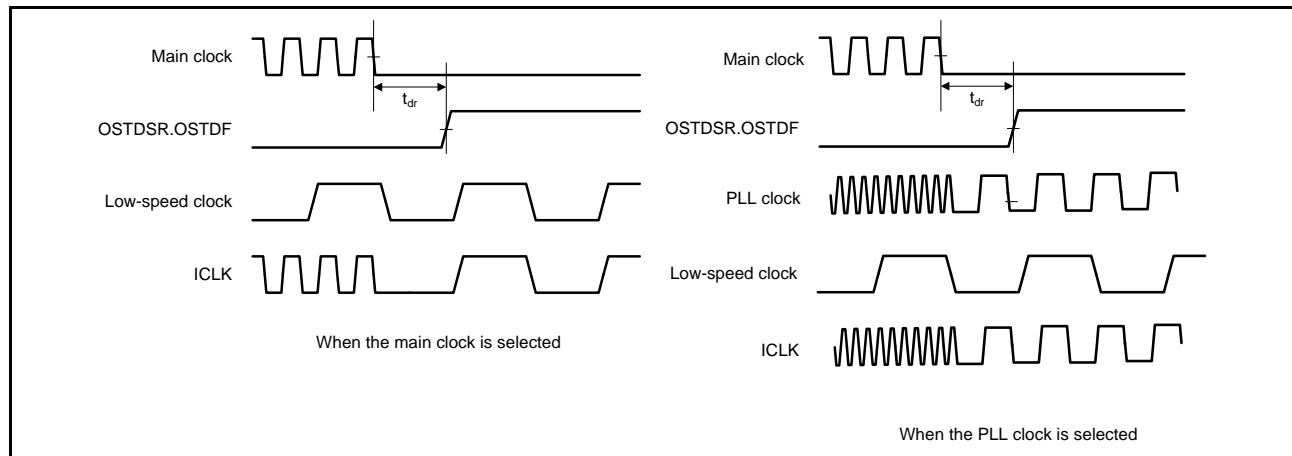
Figure 2.61 Voltage Detection Circuit Timing ( $V_{det1}$ )Figure 2.62 Voltage Detection Circuit Timing ( $V_{det2}$ )

## 2.12 Oscillation Stop Detection Timing

**Table 2.71 Oscillation Stop Detection Timing**

Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ ,  $T_a = -40 \text{ to } +105^\circ\text{C}$

| Item           | Symbol   | Min. | Typ. | Max. | Unit | Test Conditions |
|----------------|----------|------|------|------|------|-----------------|
| Detection time | $t_{dr}$ | —    | —    | 1    | ms   | Figure 2.63     |



**Figure 2.63 Oscillation Stop Detection Timing**

## 2.13 ROM (Flash Memory for Code Storage) Characteristics

**Table 2.72 ROM (Flash Memory for Code Storage) Characteristics (1)**

| Item                          | Symbol           | Min. | Typ. | Max. | Unit  | Conditions              |
|-------------------------------|------------------|------|------|------|-------|-------------------------|
| Reprogramming/erasure cycle*1 | N <sub>PEC</sub> | 1K   | —    | —    | Times |                         |
| Data retention*2, *3          | t <sub>DRP</sub> | 20   | —    | —    | Year  | T <sub>a</sub> = +105°C |

Note 1. Definition of reprogram/erase cycle: The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1K), erasing can be performed n times for each block. For instance, when 8-byte programming is performed 256 times for different addresses in 2-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. Characteristic when using the flash memory programmer and the self-programming library provided from Renesas Electronics.

Note 3. This result is obtained from reliability testing.

**Table 2.73 ROM (Flash Memory for Code Storage) Characteristics (2) High-Speed Operating Mode**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V

Temperature range for the programming/erasure operation: T<sub>a</sub> = -40 to +105°C

| Item                                 | Symbol           | FCLK = 1 MHz      |      |       | FCLK = 32 MHz |      |       | FCLK = 48 MHz |      |       | Unit  |    |
|--------------------------------------|------------------|-------------------|------|-------|---------------|------|-------|---------------|------|-------|-------|----|
|                                      |                  | Min.              | Typ. | Max.  | Min.          | Typ. | Max.  | Min.          | Typ. | Max.  |       |    |
| Programming time                     | t <sub>P8</sub>  | —                 | 94.0 | 843.5 | —             | 45.4 | 448.7 | —             | 45.1 | 446.0 | μs    |    |
| Erasure time                         | 2-Kbyte          | t <sub>E2K</sub>  | —    | 8.3   | 282.0         | —    | 5.4   | 220.4         | —    | 5.4   | 220.1 | ms |
|                                      | 64-Kbyte         | t <sub>E64K</sub> | —    | 105   | 2331          | —    | 12.7  | 375.4         | —    | 12.4  | 368.0 | ms |
| Blank check time                     | 8-byte           | t <sub>BC8</sub>  | —    | —     | 45.0          | —    | —     | 8.9           | —    | —     | 8.2   | μs |
|                                      | 2-Kbyte          | t <sub>BC2K</sub> | —    | —     | 1573          | —    | —     | 120           | —    | —     | 115   | μs |
| Erase operation forcible stop time   | t <sub>SED</sub> | —                 | —    | 22.8  | —             | —    | 11.1  | —             | —    | —     | 11.0  | μs |
| Start-up area switching setting time | t <sub>SAS</sub> | —                 | 8.2  | 503.3 | —             | 5.6  | 438.0 | —             | 5.6  | 437.7 | ms    |    |
| Access window setting time           | t <sub>AWS</sub> | —                 | 8.2  | 503.3 | —             | 5.6  | 438.0 | —             | 5.6  | 437.7 | ms    |    |
| ROM mode transition wait time 1      | t <sub>DIS</sub> | 2                 | —    | —     | 2             | —    | —     | 2             | —    | —     | μs    |    |
| ROM mode transition wait time 2      | t <sub>MS</sub>  | 15                | —    | —     | 15            | —    | —     | 15            | —    | —     | μs    |    |

Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note: The frequency accuracy of FCLK should be ±3.5%.

**Table 2.74 ROM (Flash Memory for Code Storage) Characteristics (3) Middle-Speed Operating Mode**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ Temperature range for the programming/erasure operation:  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                                 | Symbol    | FCLK = 1 MHz |      |       | FCLK = 24 MHz |      |       | Unit  |
|--------------------------------------|-----------|--------------|------|-------|---------------|------|-------|-------|
|                                      |           | Min.         | Typ. | Max.  | Min.          | Typ. | Max.  |       |
| Programming time                     | $t_{P8}$  | —            | 94.0 | 843.5 | —             | 45.7 | 450.7 | μs    |
| Erasure time                         | 2-Kbyte   | $t_{E2K}$    | —    | 8.3   | 282.0         | —    | 5.4   | 220.2 |
|                                      | 64-Kbyte  | $t_{E64K}$   | —    | 105   | 2331          | —    | 17.0  | 500.5 |
| Blank check time                     | 8-byte    | $t_{BC8}$    | —    | —     | 45            | —    | —     | 9     |
|                                      | 2-Kbyte   | $t_{BC2K}$   | —    | —     | 1573          | —    | —     | 115   |
| Erase operation forcible stop time   | $t_{SED}$ | —            | —    | 22.8  | —             | —    | 11.2  | μs    |
| Start-up area switching setting time | $t_{SAS}$ | —            | 8.2  | 503.3 | —             | 5.6  | 437.7 | ms    |
| Access window setting time           | $t_{AWS}$ | —            | 8.2  | 503.3 | —             | 5.6  | 437.7 | ms    |
| ROM mode transition wait time 1      | $t_{DIS}$ | 2            | —    | —     | 2             | —    | —     | μs    |
| ROM mode transition wait time 2      | $t_{MS}$  | 15           | —    | —     | 15            | —    | —     | μs    |

Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note: The frequency accuracy of FCLK should be ±3.5%.

**Table 2.75 ROM (Flash Memory for Code Storage) Characteristics (4) Middle-Speed Operating Mode 2**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ Temperature range for the programming/erasure operation:  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                                 | Symbol    | FCLK = 1 MHz |      |       | Unit |
|--------------------------------------|-----------|--------------|------|-------|------|
|                                      |           | Min.         | Typ. | Max.  |      |
| Programming time                     | $t_{P8}$  | —            | 94.0 | 843.5 | μs   |
| Erasure time                         | 2-Kbyte   | $t_{E2K}$    | —    | 8.3   | ms   |
|                                      | 64-Kbyte  | $t_{E64K}$   | —    | 105   | ms   |
| Blank check time                     | 8-byte    | $t_{BC8}$    | —    | —     | μs   |
|                                      | 2-Kbyte   | $t_{BC2K}$   | —    | —     | μs   |
| Erase operation forcible stop time   | $t_{SED}$ | —            | —    | 22.8  | μs   |
| Start-up area switching setting time | $t_{SAS}$ | —            | 8.2  | 503.3 | ms   |
| Access window setting time           | $t_{AWS}$ | —            | 8.2  | 503.3 | ms   |
| ROM mode transition wait time 1      | $t_{DIS}$ | 2            | —    | —     | μs   |
| ROM mode transition wait time 2      | $t_{MS}$  | 15           | —    | —     | μs   |

Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory.

Note: The frequency accuracy of FCLK should be ±3.5%.

## 2.14 E2 DataFlash Characteristics (Flash Memory for Data Storage)

**Table 2.76 E2 DataFlash Characteristics (1)**

| Item                          |  | Symbol            | Min.     | Typ.    | Max. | Unit  | Conditions              |
|-------------------------------|--|-------------------|----------|---------|------|-------|-------------------------|
| Reprogramming/erasure cycle*1 |  | N <sub>DPEC</sub> | 100K     | 1000K   | —    | Times |                         |
| Data retention                | After 10K times of N <sub>DPEC</sub>   | t <sub>DDRP</sub> | 20*2, *3 | —       | —    | Year  | T <sub>a</sub> = +105°C |
|                               | After 100K times of N <sub>DPEC</sub>  |                   | 5*2, *3  | —       | —    | Year  |                         |
|                               | After 1000K times of N <sub>DPEC</sub> |                   | —        | 1*2, *3 | —    | Year  | T <sub>a</sub> = +25°C  |

Note 1. The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 100K), erasing can be performed n times for each block. For instance, when 1-byte programming is performed 256 times for different addresses in 256-byte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. Characteristic when using the flash memory programmer and the self-programming library provided from Renesas Electronics.

Note 3. These results are obtained from reliability testing.

**Table 2.77 E2 DataFlash Characteristics (2) High-speed operating mode**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V

Temperature range for the programming/erasure operation: T<sub>a</sub> = -40 to +105°C

| Item                               |          | Symbol              | FCLK = 1 MHz |      |        | FCLK = 32 MHz |      |       | FCLK = 48MHz |      |       | Unit |
|------------------------------------|----------|---------------------|--------------|------|--------|---------------|------|-------|--------------|------|-------|------|
|                                    |          |                     | Min.         | Typ. | Max.   | Min.          | Typ. | Max.  | Min.         | Typ. | Max.  |      |
| Programming time                   | 1-byte   | t <sub>DP1</sub>    | —            | 83.0 | 729.5  | —             | 35.1 | 341.2 | —            | 34.8 | 338.8 | μs   |
| Erasure time                       | 256-byte | t <sub>DE256</sub>  | —            | 8.3  | 282.0  | —             | 5.4  | 220.4 | —            | 5.4  | 220.1 | ms   |
|                                    | 4-Kbyte  | t <sub>DE4K</sub>   | —            | 55.0 | 1273.7 | —             | 9.0  | 295.4 | —            | 8.8  | 291.7 | ms   |
| Blank check time                   | 1-byte   | t <sub>DBC1</sub>   | —            | —    | 44.6   | —             | —    | 8.9   | —            | —    | 8.2   | μs   |
|                                    | 256-byte | t <sub>DBC256</sub> | —            | —    | 1573   | —             | —    | 120   | —            | —    | 115   | μs   |
| Erase operation forcible stop time |          | t <sub>DSED</sub>   | —            | —    | 22.8   | —             | —    | 11.1  | —            | —    | 11.0  | μs   |
| DataFlash STOP recovery time       |          | t <sub>DSTOP</sub>  | 250          | —    | —      | 250           | —    | —     | 250          | —    | —     | ns   |

Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note: The frequency accuracy of FCLK should be ±3.5%.

**Table 2.78 E2 DataFlash Characteristics (3) Middle-speed operating mode**

Conditions: 1.8 V ≤ VCC ≤ 5.5 V, 1.8 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = 0 V

Temperature range for the programming/erasure operation: T<sub>a</sub> = -40 to +105°C

| Item                               |          | Symbol              | FCLK = 1 MHz |      |        | FCLK = 8 MHz |      |       | Unit |
|------------------------------------|----------|---------------------|--------------|------|--------|--------------|------|-------|------|
|                                    |          |                     | Min.         | Typ. | Max.   | Min.         | Typ. | Max.  |      |
| Programming time                   | 1-byte   | t <sub>DP1</sub>    | —            | 83.0 | 729.5  | —            | 35.3 | 343.2 | μs   |
| Erasure time                       | 256-byte | t <sub>DE256</sub>  | —            | 8.3  | 282.0  | —            | 5.4  | 220.2 | ms   |
|                                    | 4-Kbyte  | t <sub>DE4K</sub>   | —            | 55.0 | 1273.7 | —            | 8.8  | 291.8 | ms   |
| Blank check time                   | 1-byte   | t <sub>DBC1</sub>   | —            | —    | 44.6   | —            | —    | 9.0   | μs   |
|                                    | 256-byte | t <sub>DBC256</sub> | —            | —    | 1573   | —            | —    | 115   | ms   |
| Erase operation forcible stop time |          | t <sub>DSED</sub>   | —            | —    | 22.8   | —            | —    | 11.2  | μs   |
| DataFlash STOP recovery time       |          | t <sub>DSTOP</sub>  | 250          | —    | —      | 250          | —    | —     | ns   |

Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note: The frequency accuracy of FCLK should be ±3.5%.

**Table 2.79 E2 DataFlash Characteristics (4) Middle-speed operating mode 2**Conditions:  $1.8 \text{ V} \leq \text{VCC} \leq 5.5 \text{ V}$ ,  $1.8 \text{ V} \leq \text{AVCC0} \leq 5.5 \text{ V}$ ,  $\text{VSS} = \text{AVSS0} = 0 \text{ V}$ Temperature range for the programming/erasure operation:  $T_a = -40 \text{ to } +105^\circ\text{C}$ 

| Item                               | Symbol       | FCLK = 1 MHz |      |        | Unit |
|------------------------------------|--------------|--------------|------|--------|------|
|                                    |              | Min.         | Typ. | Max.   |      |
| Programming time                   | $t_{DP1}$    | —            | 83.0 | 729.5  | μs   |
| Erasure time                       | $t_{DE256}$  | —            | 8.3  | 282.0  | ms   |
|                                    | $t_{DE4K}$   | —            | 55.0 | 1273.7 | ms   |
| Blank check time                   | $t_{DBC1}$   | —            | —    | 44.6   | μs   |
|                                    | $t_{DBC256}$ | —            | —    | 1573   | ms   |
| Erase operation forcible stop time | $t_{DSED}$   | —            | —    | 22.8   | μs   |
| DataFlash STOP recovery time       | $t_{DSTOP}$  | 250          | —    | —      | ns   |

Note: Does not include the time until each operation of the flash memory is started after instructions are executed by software.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory.

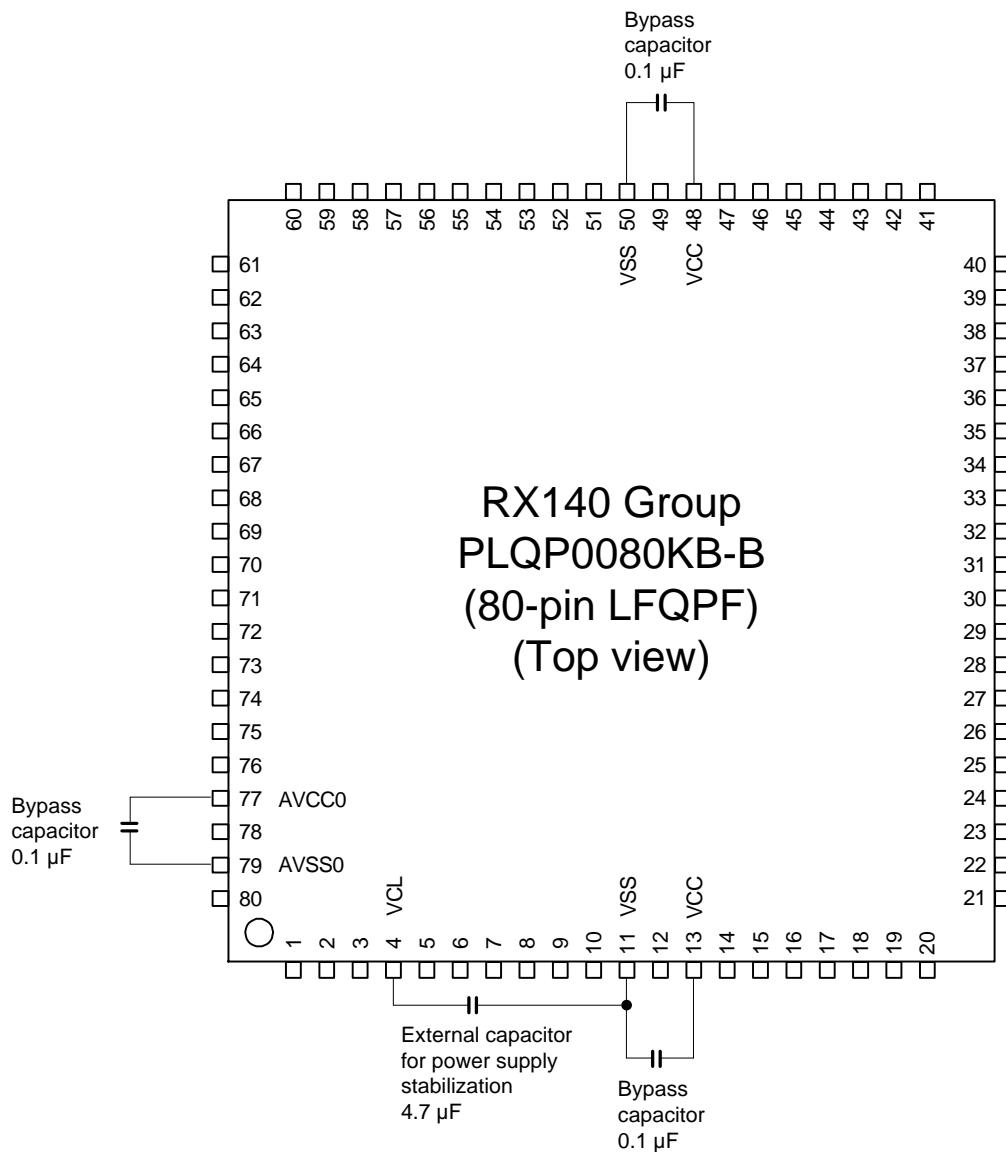
Note: The frequency accuracy of FCLK should be ±3.5%.

## 2.15 Usage Notes

### 2.15.1 Connecting VCL Capacitor and Bypass Capacitors

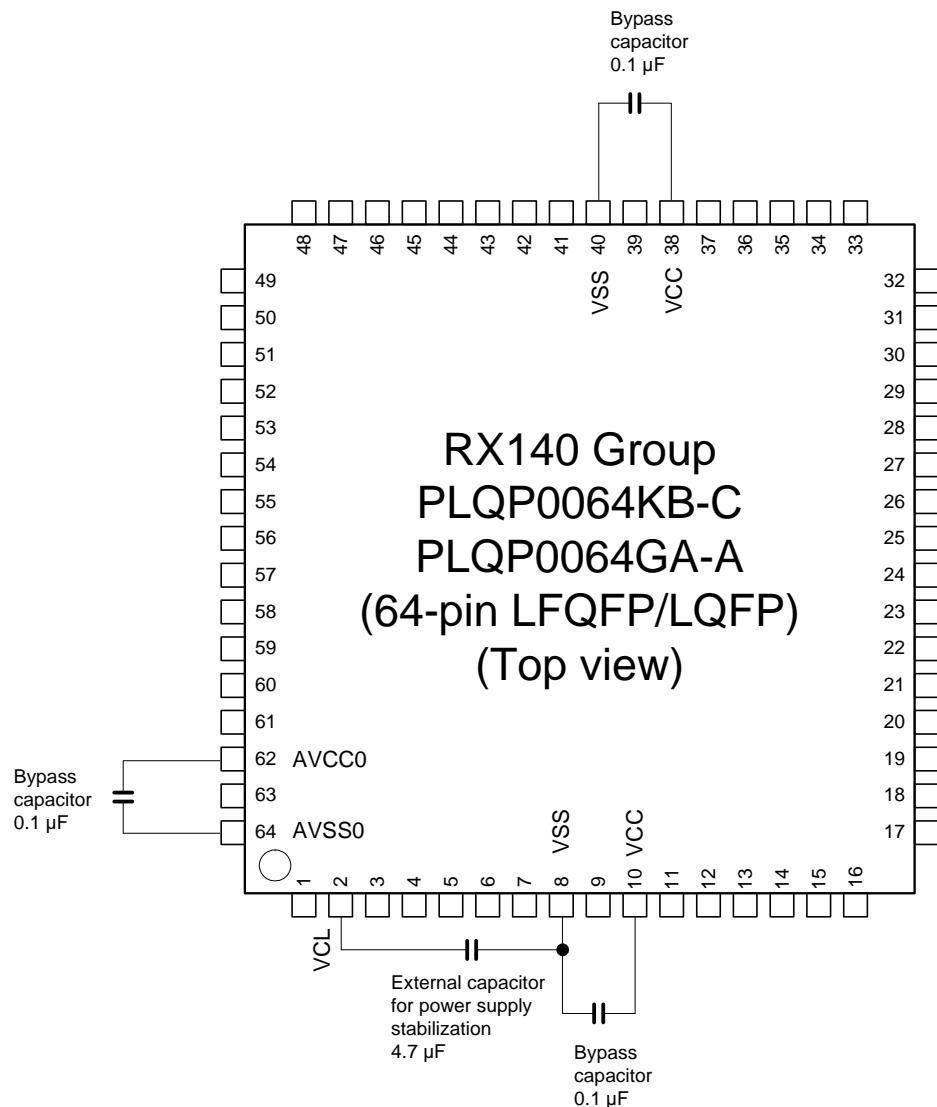
This MCU integrates an internal voltage-down circuit, which is used for lowering the power supply voltage in the internal MCU to adjust automatically to the optimum level. A 4.7- $\mu$ F capacitor needs to be connected between this internal voltage-down power supply (VCL pin) and VSS pin. Figure 2.64 to Figure 2.66 shows how to connect external capacitors. Place an external capacitor close to the pins. Do not apply the power supply voltage to the VCL pin. Insert a multilayer ceramic capacitor as a bypass capacitor between each pair of the power supply pins. Implement a bypass capacitor to the MCU power supply pins as close as possible. Use a recommended value of 0.1  $\mu$ F as the capacitance of the capacitors. For the capacitors related to crystal oscillation, see section 9, Clock Generation Circuit in the User's Manual: Hardware. For the capacitors related to analog modules, also see section 35, 12-Bit A/D Converter (S12ADE) in the User's Manual: Hardware.

For notes on designing the printed circuit board, see the descriptions of the application note "Hardware Design Guide" (R01AN1411EJ). The latest version can be downloaded from Renesas Electronics Website.



Note. Do not apply the power supply voltage to the VCL pin.  
 Use a 4.7-µF multilayer ceramic for the VCL pin and place it close to the pin.  
 A recommended value is shown for the capacitance of the bypass capacitors.

**Figure 2.64 Connecting Capacitors (80 Pins)**



Note. Do not apply the power supply voltage to the VCL pin.  
Use a 4.7-µF multilayer ceramic for the VCL pin and place it close to the pin.  
A recommended value is shown for the capacitance of the bypass capacitors.

**Figure 2.65     Connecting Capacitors (64 Pins)**

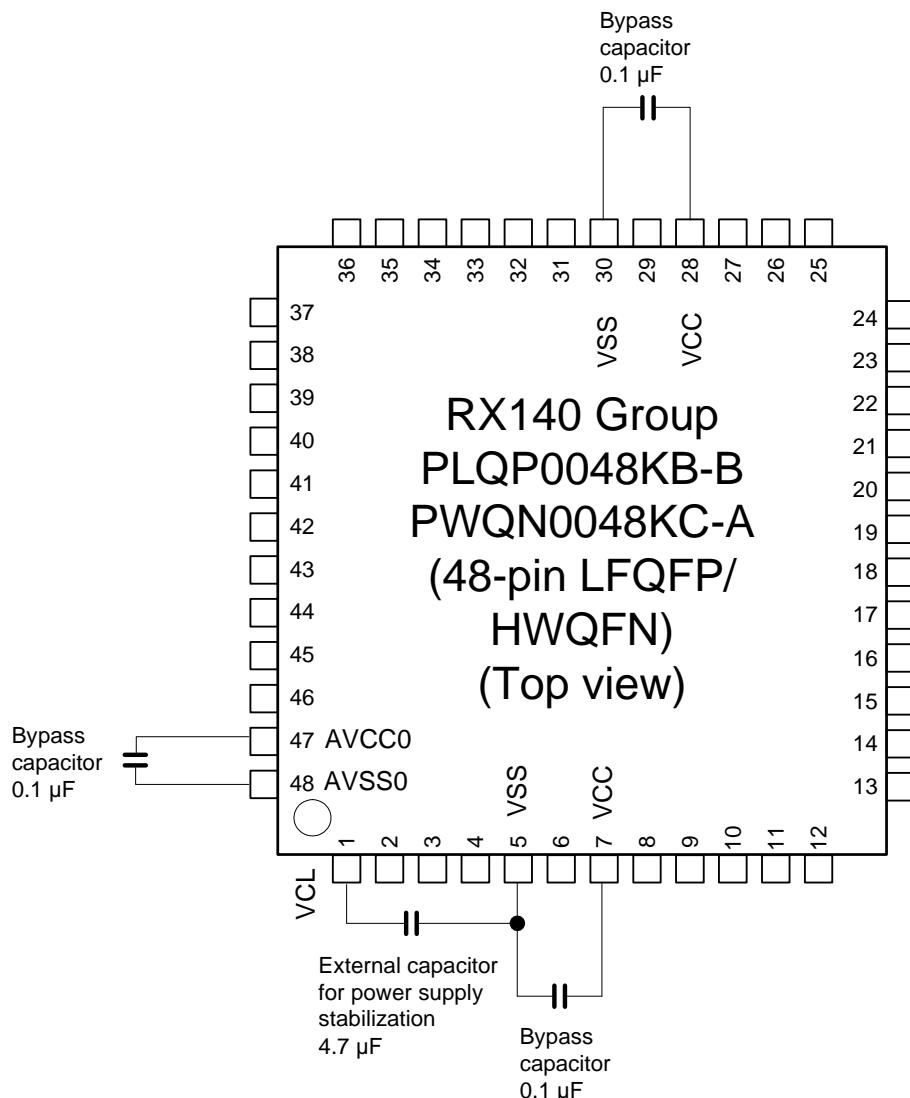


Figure 2.66 Connecting Capacitors (48 Pins)

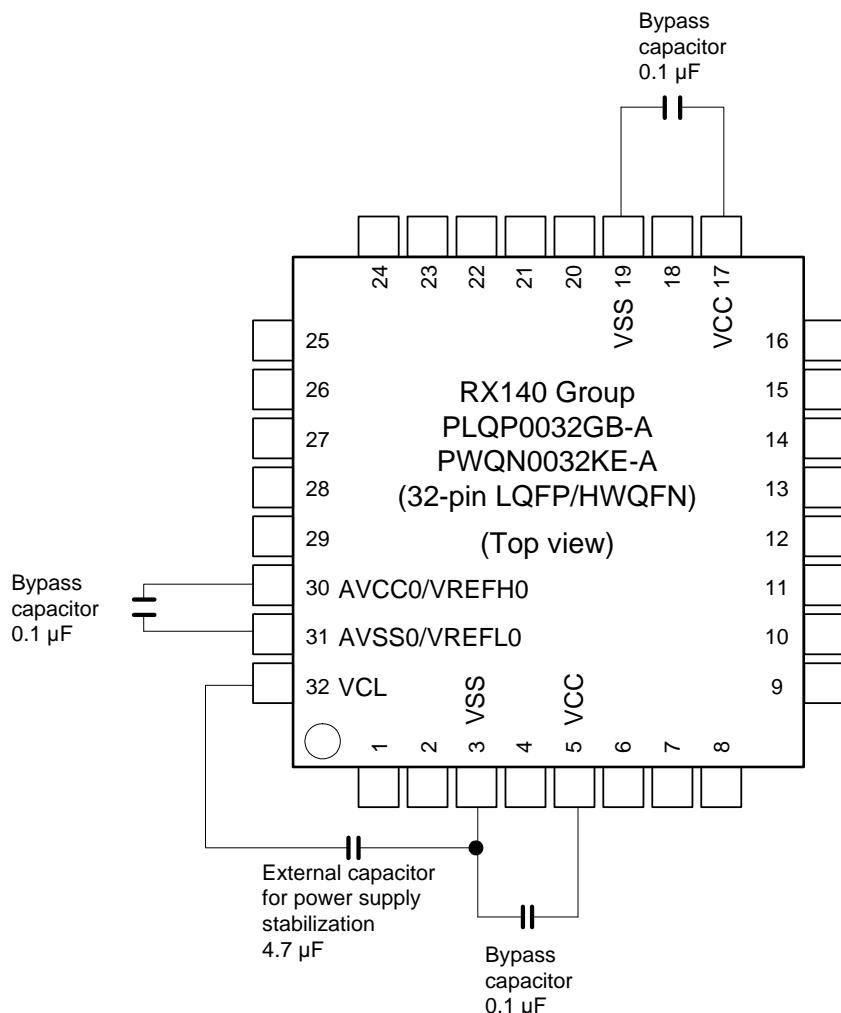


Figure 2.67 Connecting Capacitors (32 Pins)

## Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in “Packages” on Renesas Electronics Corporation website.

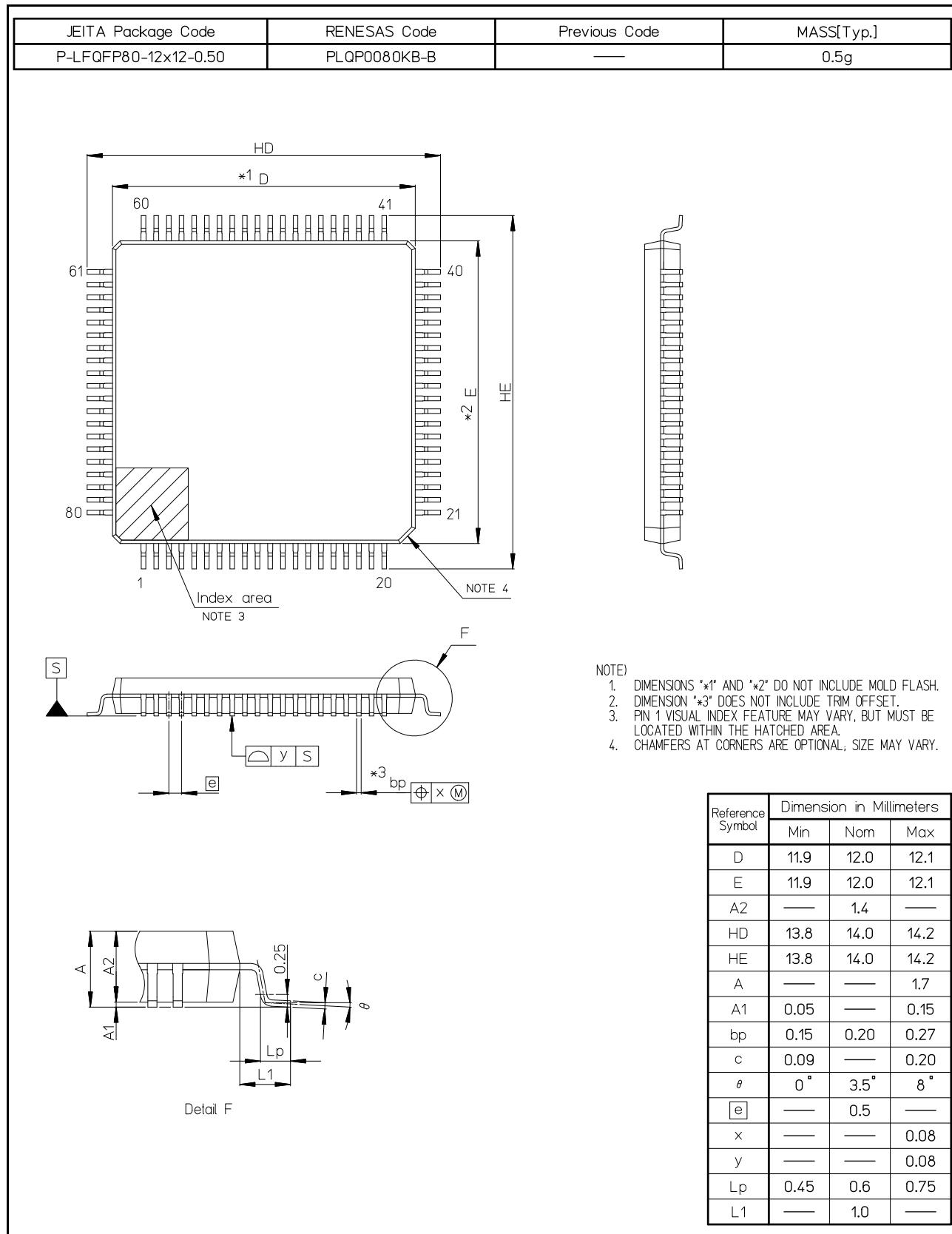


Figure A 80-Pin LFQFP (PLQP0080KB-B)

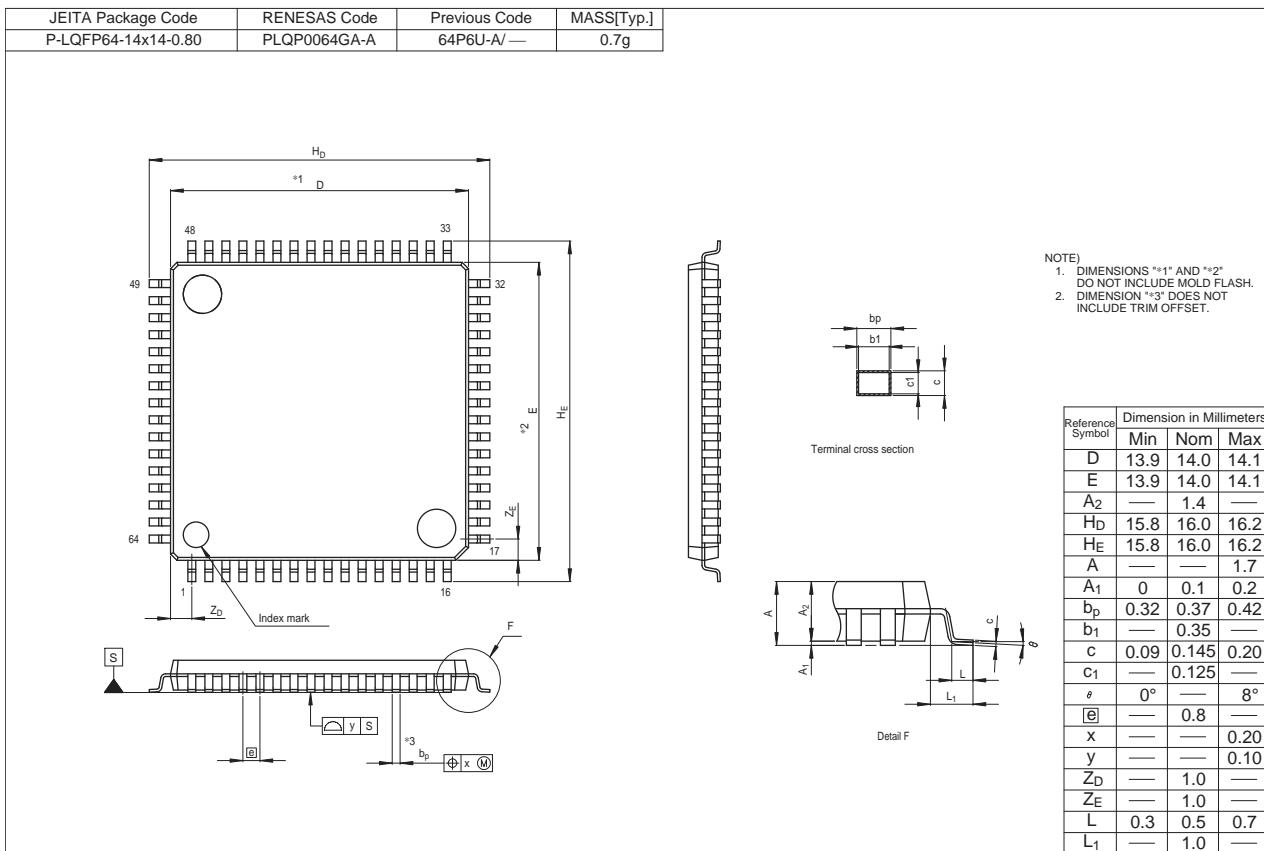


Figure B 64-Pin LQFP (PLQP0064GA-A)

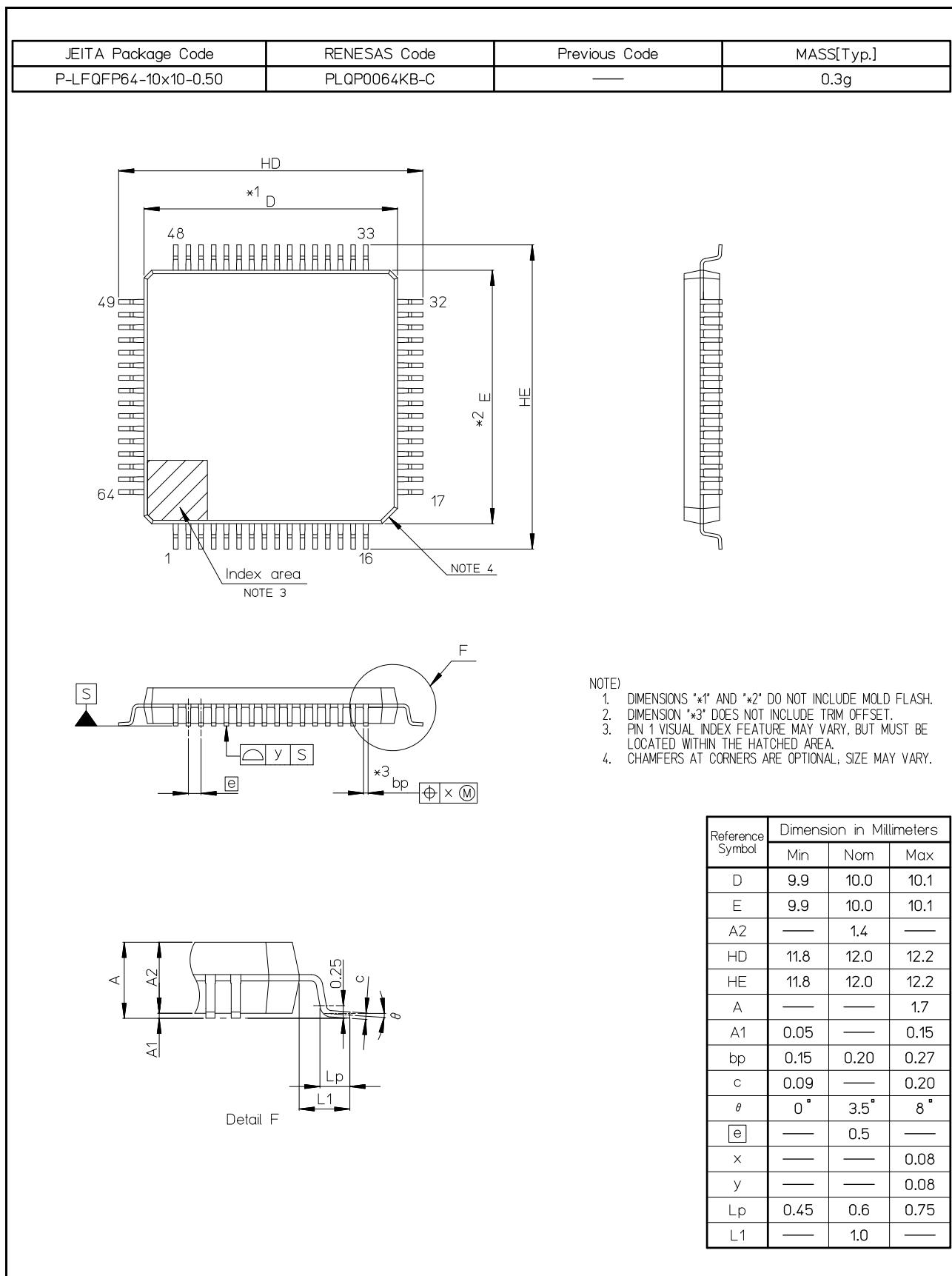


Figure C 64-Pin LFQFP (PLQP0064KB-C)

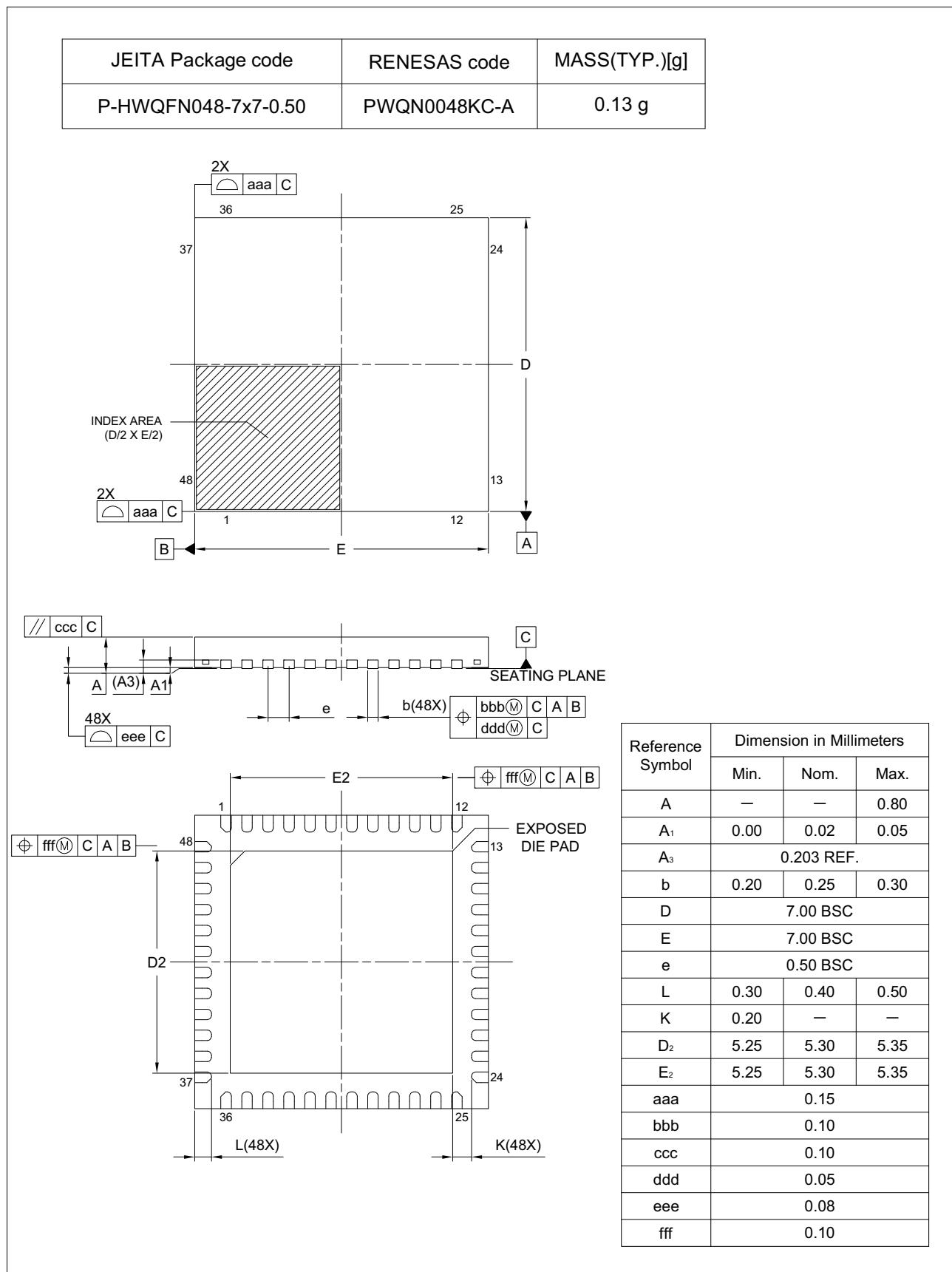


Figure D 48-Pin HWQFN (PWQN0048KC-A)

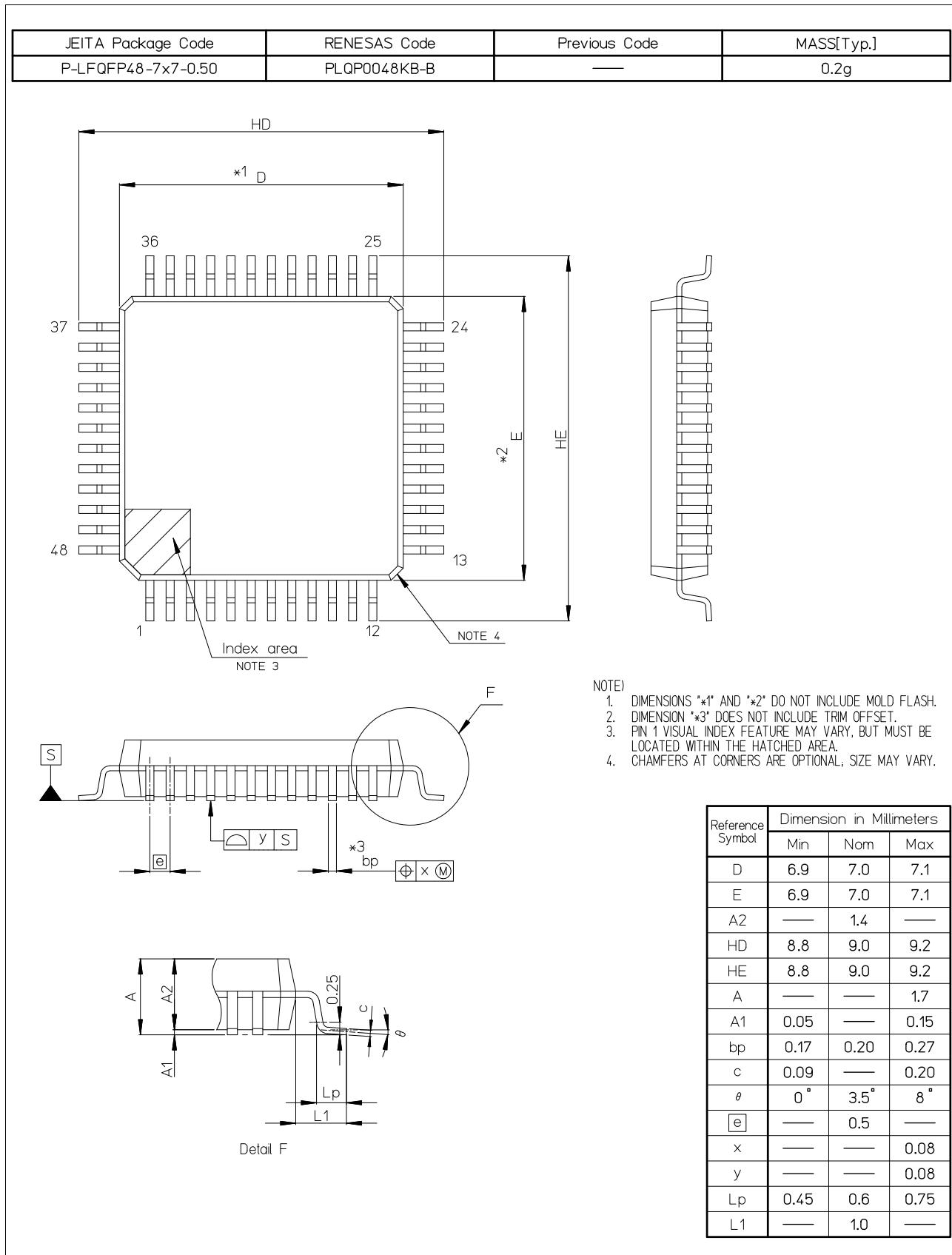


Figure E 48-Pin LFQFP (PLQP0048KB-B)

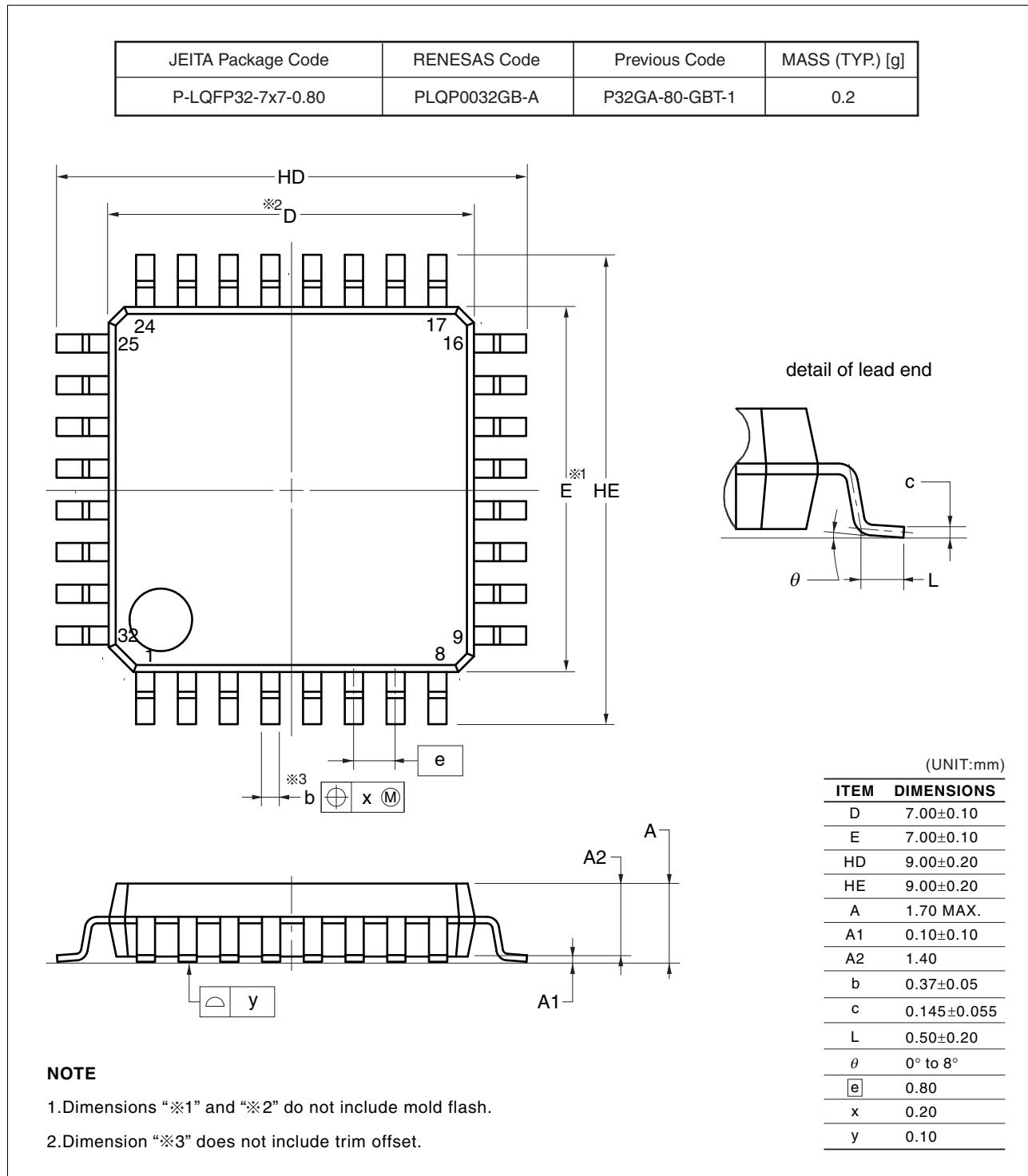


Figure F 32-Pin LQFP (PLQP0032GB-A)

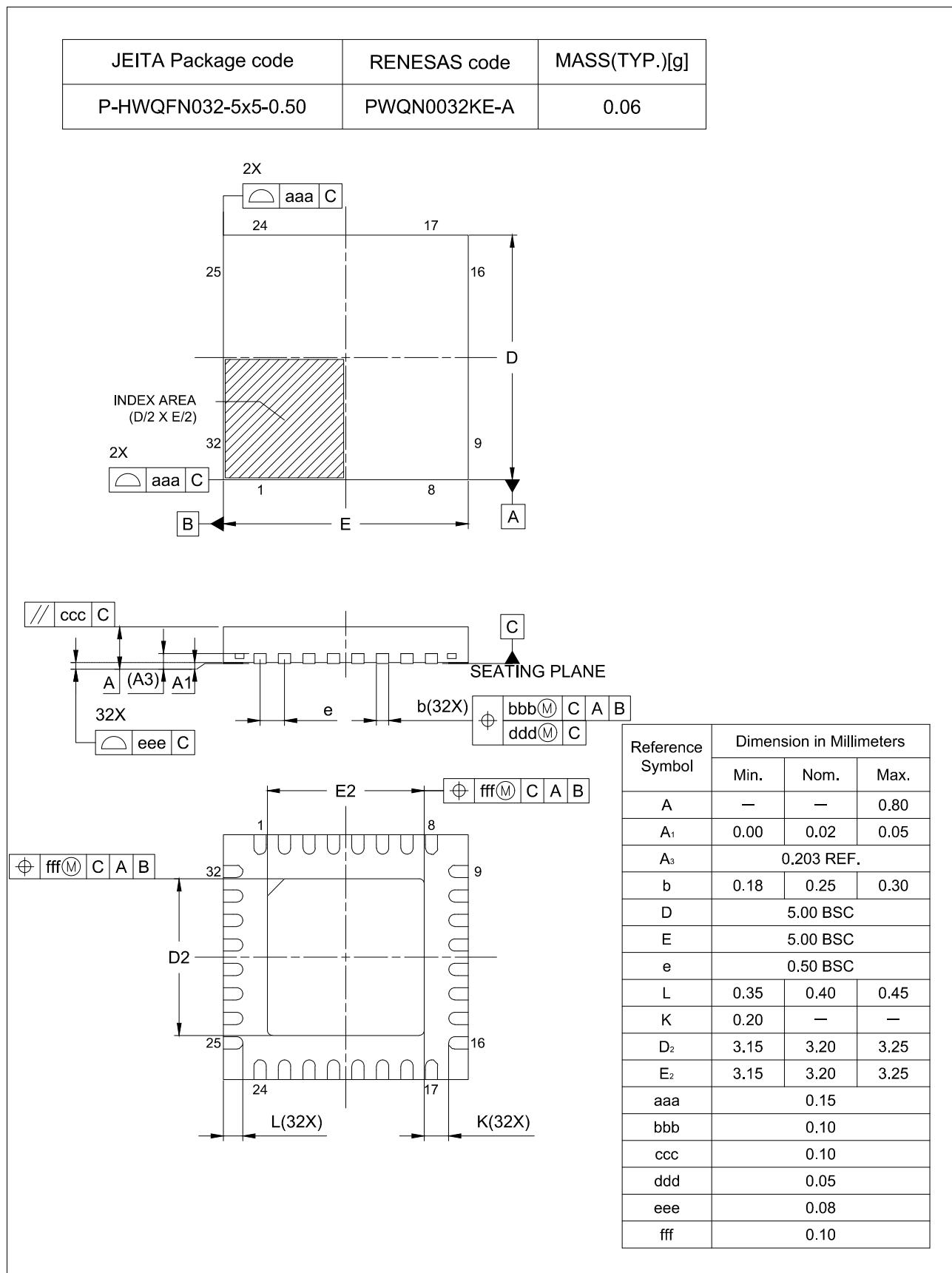


Figure G 32-Pin HWQFN (PWQN0032KE-A)

| REVISION HISTORY |  | RX140 Group Datasheet |
|------------------|--|-----------------------|
|------------------|--|-----------------------|

## Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

| Rev. | Date         | Description                    |   | Classification  |
|------|--------------|--------------------------------|---|-----------------|
|      |              | Page                           | Summary   |                 |
| 1.00 | Aug 05, 2021 | —                              | First edition, issued   |                 |
| 1.10 | Apr 20, 2022 | Features                       |   |                 |
|      |              | 1                              | ■ Low power design and architecture, changed  | TN-RX*-A0258A/E |
|      |              | 1. Overview                    |   |                 |
|      |              | 3                              | Table 1.1 Outline of Specifications (2/4), changed                                  |                 |
|      |              | 7, 8                           | Table 1.3 List of Products, changed   |                 |
|      |              | 9                              | Figure 1.1 How to Read the Product Part Number, changed                             |                 |
|      |              | 13                             | Table 1.4 Pin Functions (3/3), changed  |                 |
|      |              | 14                             | Figure 1.3 Pin Assignments of the 80-Pin LFQFP, changed                             |                 |
|      |              | 15                             | Figure 1.4 Pin Assignments of the 64-Pin LFQFP, 64-Pin LQFP, changed                |                 |
|      |              | 16                             | Figure 1.5 Pin Assignments of the 48-Pin LQFP, changed                              |                 |
|      |              | 16                             | Figure 1.6 Pin Assignments of the 48-Pin HWQFN, changed                             |                 |
|      |              | 18                             | Table 1.5 List of Pins and Pin Functions (80-Pin LFQFP) (1/2), changed              |                 |
|      |              | 20                             | Table 1.6 List of Pins and Pin Functions (64-Pin LFQFP, 64-Pin LQFP) (1/2), changed |                 |
|      |              | 24                             | Table 1.8 List of Pins and Pin Functions (32-Pin LQFP, 32-Pin HWQFN), changed       |                 |
|      |              | 2. Electrical Characteristics  |   |                 |
|      |              | All                            | Characteristics of PH7 and PH6, added   |                 |
|      |              | All                            | Characteristics of products with ROM capacity of 128 Kbytes or more, added          |                 |
|      |              | 46                             | Table 2.14 DC Characteristics (9), changed  | TN-RX*-A0258A/E |
|      |              | 49                             | Table 2.17 Permissible Output Currents (2), changed                                 |                 |
|      |              | 50                             | Table 2.21 Thermal Resistance Value (Reference Values), Note 1, added               |                 |
|      |              | 56                             | Table 2.36 HOCO Clock Timing (ROM capacity: product with 64 Kbytes) Note 1, added   | TN-RX*-A0258A/E |
|      |              | 85                             | Table 2.59 A/D Conversion Characteristics (2), changed                              |                 |
|      |              | 88                             | Table 2.62 A/D Conversion Characteristics (5), changed                              | TN-RX*-A0258A/E |
|      |              | 102                            | Table 2.77 E2 DataFlash Characteristics (2): high-speed operating mode, changed     |                 |
|      |              | Appendix 1. Package Dimensions |   |                 |
|      |              | 114                            | Figure F 32-Pin LQFP (PLQP0032GB-A), added  |                 |

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

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